
rtVAX 300

rtVAX 300 Hardware User's Guide

Order Number: EK–382AB–UG–002

This manual contains technical and physical specifications of the rtVAX 300 processor and information necessary for configuring it into host and target configurations—that is, information on the following interfaces: memory system, console and boot ROM, network interconnect, and I/O device.

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Preface

The rtVAX 300 is a target processor designed to be embedded in a Digital Equipment Corporation computing network. The rtVAX 300 processor permits the coupling of realtime instruments, peripheral devices, sensors, and similar devices to DECnet, VAX computers, servers, workstations, and terminals. The rtVAX 300 processor is also compatible with DECwindows applications.

The rtVAX 300 is the minimal hardware that you apply by adding required memory, I/O devices, interrupt logic, and peripheral chips in order to customize it to the specific application that you have designed. You can also interface your own proprietary LSI/VLSI custom integrated circuits to your design, because the rtVAX 300 permits direct access to its microprocessor bus.

Intended Audience

This book is intended for hardware and software technical personnel who design and program subsystems and hardware configurations based on the rtVAX 300 processor. Readers should be familiar with the information presented in the *VAX Architecture Reference Manual*.

Document Structure

This document consists of eight chapters and five appendixes:

- Chapter 1, Overview of the rtVAX 300 Processor, provides brief descriptions of the central processor, floating-point accelerator, Ethernet coprocessor, system support functions, and resident firmware.
- Chapter 2, Technical Specification, provides a functional description of the rtVAX 300 and describes the minimum hardware configuration, bus connections, pin and signal descriptions, memory and I/O space map and registers, and bus cycles and protocols.
- Chapter 3, Hardware Architecture, contains more detailed information on the central processor, floating-point accelerator, cache memory, hardware initialization, console interface registers, and Ethernet coprocessor.

- Chapter 4, Firmware, describes the system firmware ROM format, system firmware entry, console program, entity-based module and Ethernet listener, startup messages, hardware CSRs referenced by the rtVAX 300 firmware, a diagnostic test list, user-defined board-level boot and diagnostic ROMS, creation and down-line loading of test programs, and ROM bootstrap operations.
- Chapter 5, Memory System Interface, describes memory speed and performance, static and dynamic RAMs, basic memory interface, cycle status codes, byte mask lines, data parity checking, internal cache control, memory management unit, a memory system design example, memory timing considerations, memory system illustrations, and programmable array logic.
- Chapter 6, Console and Boot ROM Interface, discusses console system interface, booting from external ROM, the processor status LED register, console interface and boot ROM illustrations, and programmable array logic.
- Chapter 7, Network Interconnect Interface, describes the rtVAX 300 DECnet communications, Ethernet interface, thickwire network interconnect, ThinWire support, Ethernet coprocessor registers, and a hardware implementation example.
- Chapter 8, I/O Device Interfacing, discusses I/O device mapping, the interrupt structure, general bus interfacing techniques, DMA device mapping registers, an rtVAX 300-to-digital signal processor application example, reset/power-up, halting the processor, and I/O system illustrations.
- Appendix A describes the physical, electrical, and environmental characteristics of the rtVAX 300 processor.
- Appendix B lists and defines acronyms used frequently in this guide.
- Appendix C lists address assignments for memory space, input/output space, and local register input/output space.
- Appendix D is a template for user boot/diagnostic firmware routines.
- Appendix E contains a C program that builds a setup frame buffer for the hashing filtering mode.

Conventions

This manual adheres to the following numbering and signal-naming conventions.

Numbering Conventions

All computer addresses are hexadecimal numbers; for example, address 10000000 denotes 10000000_{16}. All other numbers are decimal-based, unless otherwise specified.

Digital Signal-Naming Conventions

A signal name begins with a letter and may end with either H or L.

- H means that the signal is active high—that is, the signal voltage is between 2.4V and 5.0V.
- L means that the signal is active low—that is, the signal voltage is between 0.0V and 0.8V.

The term "Asserted" means that a signal voltage is within the active voltage range for that signal. For example, the signal AS L is an active low signal; if this signal is asserted, a voltage between 0.0V and 0.8V is present.

All voltages are specified with respect to the +5V power supply ground that is used to power the rtVAX 300: 1 is equivalent to high; 0 is equivalent to low.

Signal buses are specified by the following notation:

Signal_Name<HIGHEST_BIT_IN_BUS:LOWEST_BIT_IN_BUS> assertion

For example, the signal DAL<31:00> H represents a 32-bit-wide bus named DAL, whose bits are numbers 0 to 31; each signal in this bus is active high. Therefore, if bit number 5 of this bus is connected to a gate, the signal name for that bit is DAL<05> H.

Associated Documents

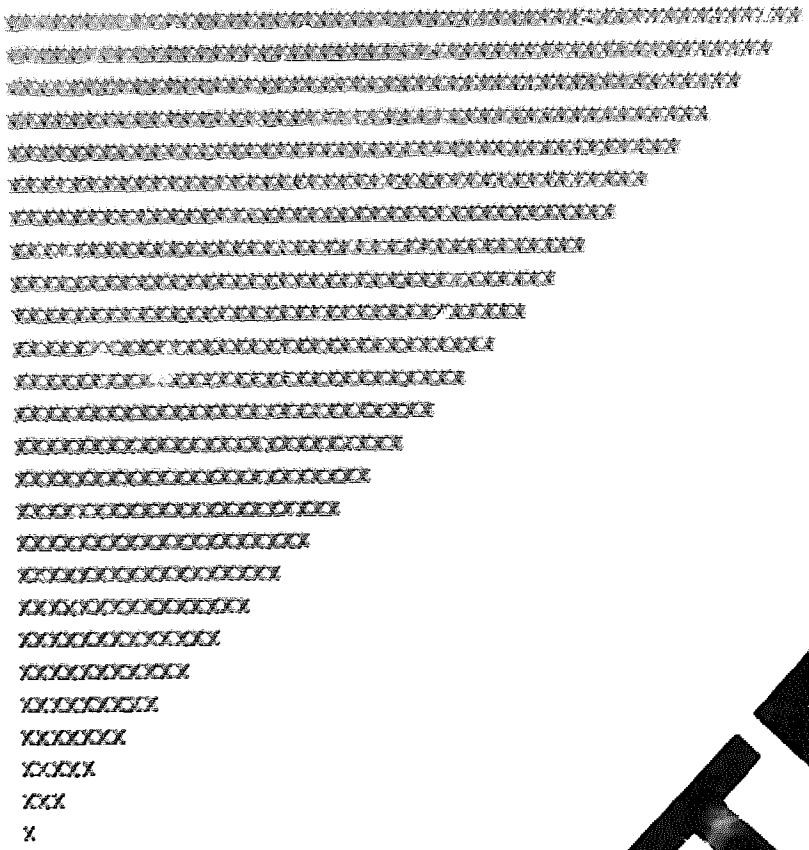
- Brunner, Richard A., ed. *VAX Architecture Reference Manual*. 2d ed. Bedford, MA: The Digital Press, 1990.
- Levy, Henry M., and Eckhouse, Richard H., Jr. *Computer Programming and Architecture: The VAX*. 2d ed. Bedford, MA: The Digital Press, 1989.
- *rtVAX 300 Programmer's Guide*
- *VAXELN–rtVAX 300 Supplement*

rtVAX 300 Test Box

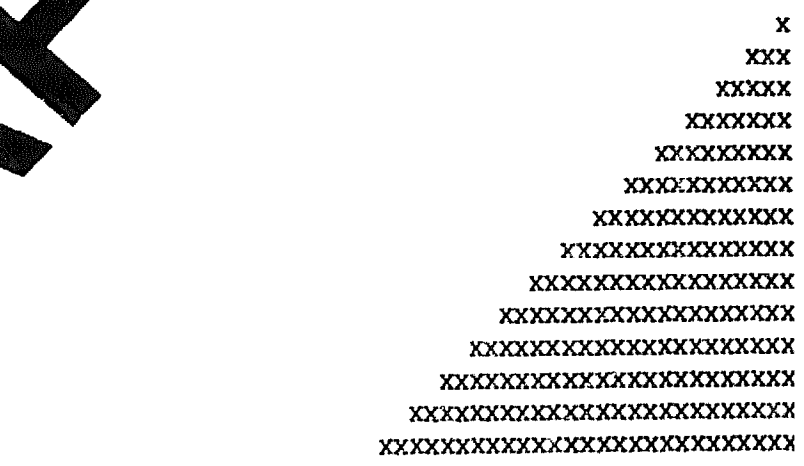
You can order an rtVAX 300 test box and user's guide from Design Analysis Associates. The Design Analysis Associates part number for the text box is DAA–20RTVX–01.

The address for Design Analysis Associates is:

Design Analysis Associates, Inc.
75 West 100 South
Logan, UT 84321 U.S.A.
Phone: (801) 753–2212
FAX: (801) 753–7669



CHAPTER 1



1

Overview of the rtVAX 300 Processor

The rtVAX 300 is a realtime target processor that is adaptable to running applications that benefit from a fully supported network connection. Designed to be embedded in a robust computing network, the rtVAX 300 processor is a 117 mm x 79 mm (4.61 in. x 3.11 in.) module encapsulated in a black painted metallic cover.

The rtVAX 300 processor is intended to work in the following situations:

- Distributed applications that are part of a Digital computing network
- Customized, embedded, standalone hardware
- Remote data acquisition and computing platform that can be linked to use Digital data communication message protocol (DDCMP) serial lines
- Applications that use proprietary I/O buses and industry-standard buses, such as the VME bus or the IBM PC/AT
- Applications that interface with industry-standard LSI/VLSI peripheral chips

The rtVAX 300 processor is the basic hardware element that you extend to handle your application, adding only the memory and I/O devices that you need.

Many facets of the final system, from memory and I/O to power and packaging, are under your control.

When a Signetics 2681 dual universal asynchronous receiver/transmitter (SCN 2681 DUART) serial-line chip is added to its configuration, the rtVAX 300 processor can support a console terminal.

1.1 Central Processor

The central processor is implemented by using Digital's CVAX chip. This chip contains about 180,000 transistors and supports full VAX memory management and a 4G-byte virtual address space.

The CVAX chip contains all VAX visible general-purpose registers (GPRs), a 1K-byte instruction/data cache, all memory management hardware, including a 28-entry translation buffer, and several system registers—such as the cache disable register (CADR), memory system error register (MSER), and system control block base register (SCBB).

The CVAX chip provides the following functions:

- Fetches all VAX instructions
- Executes 181 VAX instructions
- Assists in the execution of 21 additional instructions
- Passes 70 floating-point instructions to the CFPA chip

The remaining 32 VAX instructions (including H-floating and octaword) must be emulated in macrocode.

The CVAX chip provides the following subset of the VAX data types:

- Byte
- Word
- Longword
- Quadword
- Character-string
- Variable-length bit field

Macrocode emulation can provide support for the remaining VAX data types.

The cache is a 1K-byte, 2-way associative, write-through cache memory that is implemented within the CVAX chip.

1.2 Floating-Point Accelerator

The floating-point accelerator is implemented by the CVAX floating-point accelerator (CFPA) chip. The CFPA chip contains about 60,000 transistors and executes 70 floating-point instructions. The CFPA chip receives operations code information from the CVAX chip and receives operands directly from memory or from the CVAX chip. The floating-point result is always returned to the CVAX chip.

1.3 Ethernet Coprocessor

The rtVAX 300 processor contains the second-generation Ethernet coprocessor (SGEC) chip and can pass data and instructions to and from other stations on a network without processor intervention.

The Ethernet coprocessor has the following attributes:

- Supports ThinWire and thickwire Ethernet interfaces to the rtVAX 300 processor[1]
- Contains 16 control and status registers (CSRs) that control its operation
- Resets hardware and software and handles interrupts
- Supports the full IEEE 802.3 frame encapsulation and media access control
- Supports three levels of testing and diagnostics

1.4 System Support Functions

System support functions provided by the rtVAX 300 processor include:

- Halt/boot-request arbitration logic
- Interval timer with 10 ms interrupts
- Flexible interface to the rtVAX 300 processor's DAL bus
- Ethernet thickwire connections
- Control logic to attach a console terminal

1.5 Resident Firmware

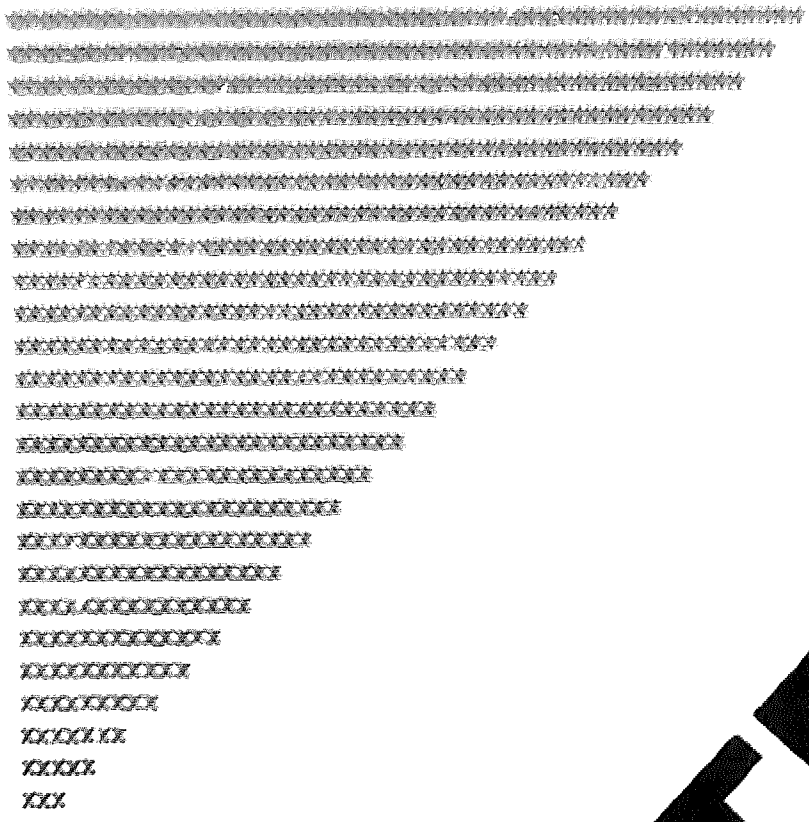
Resident firmware consists of 256K bytes of ROM. Firmware gains control when the processor halts; it contains programs that provide the following services:

- Board initialization
- Power-up self-testing of the rtVAX 300 processor and its attached memory system

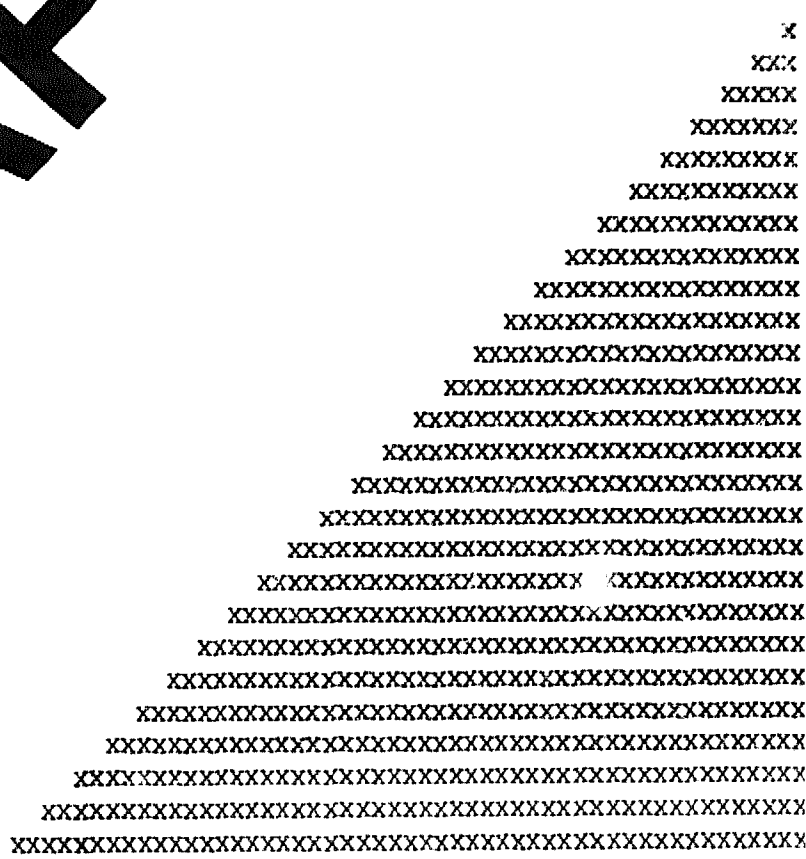
[1] Ethernet is synonymous with IEEE 802.3; ThinWire, with IEEE 802.3 10BASE2; thickwire, with IEEE 802.3 10BASE5.

- Emulation of a subset of the VAX standard console (automatic/manual bootstrap and a simple command language for examining/altering the state of the processor)
- Booting from ROM, network, or DECnet DDCMP

The rtVAX 300's firmware interface is extensible: you can use it to add your own power-up initialization and self-test diagnostics.



CHAPTER 2



2

Technical Specification

This chapter discusses the technical specifications of the rtVAX 300 processor, covering the following subjects:

- Functional description (Section 2.1)
- Minimum hardware configuration (Section 2.2)
- Bus connections (Section 2.3)
- Pin and signal description (Section 2.4)
- Memory and I/O space (Section 2.5)
- Bus cycles and protocols (Section 2.6)

2.1 Functional Description

The functional description of the rtVAX 300 processor consists of the following:

- Architecture summary (Section 2.1.1)
- Processor and floating-point accelerator (Section 2.1.2)
- ROM and reserved memory locations (Section 2.1.3)
- Network Interface (Section 2.1.4)
- Decode and control logic (Section 2.1.5)
- Interrupt structure (Section 2.1.6)
- DMA structure (Section 2.1.7)
- Interval timer (Section 2.1.8)
- Internal cache (Section 2.1.9)

2.1.1 Architecture Summary

Based on Digital's CVAX microprocessor chip, the rtVAX 300 processor contains an Ethernet coprocessor, a floating-point accelerator, an interval timer, control logic, and a diagnostic and boot ROM. Figure 2–1 shows a block diagram of the rtVAX 300 processor.

The rtVAX 300 processor provides a common interface to the user logic as close to the CVAX microprocessor bus interface as possible. The rtVAX 300 processor can access up to 510M bytes of physical memory; 256M bytes are read/write memory, and 254M bytes are read/only memory. All memory is directly accessible by its Ethernet coprocessor and is cacheable by the CVAX. The rtVAX 300 also provides access to 512M bytes for I/O space. Accesses in I/O space are not cached.

2.1.2 CPU and CFPA

The processor on the rtVAX 300 is Digital's CVAX chip with its associated CVAX floating-point accelerator (CFPA). The rtVAX 300 runs VAXELN software based on the VAX instruction set. The VMS and ULTRIX operating systems are not supported on the rtVAX 300.

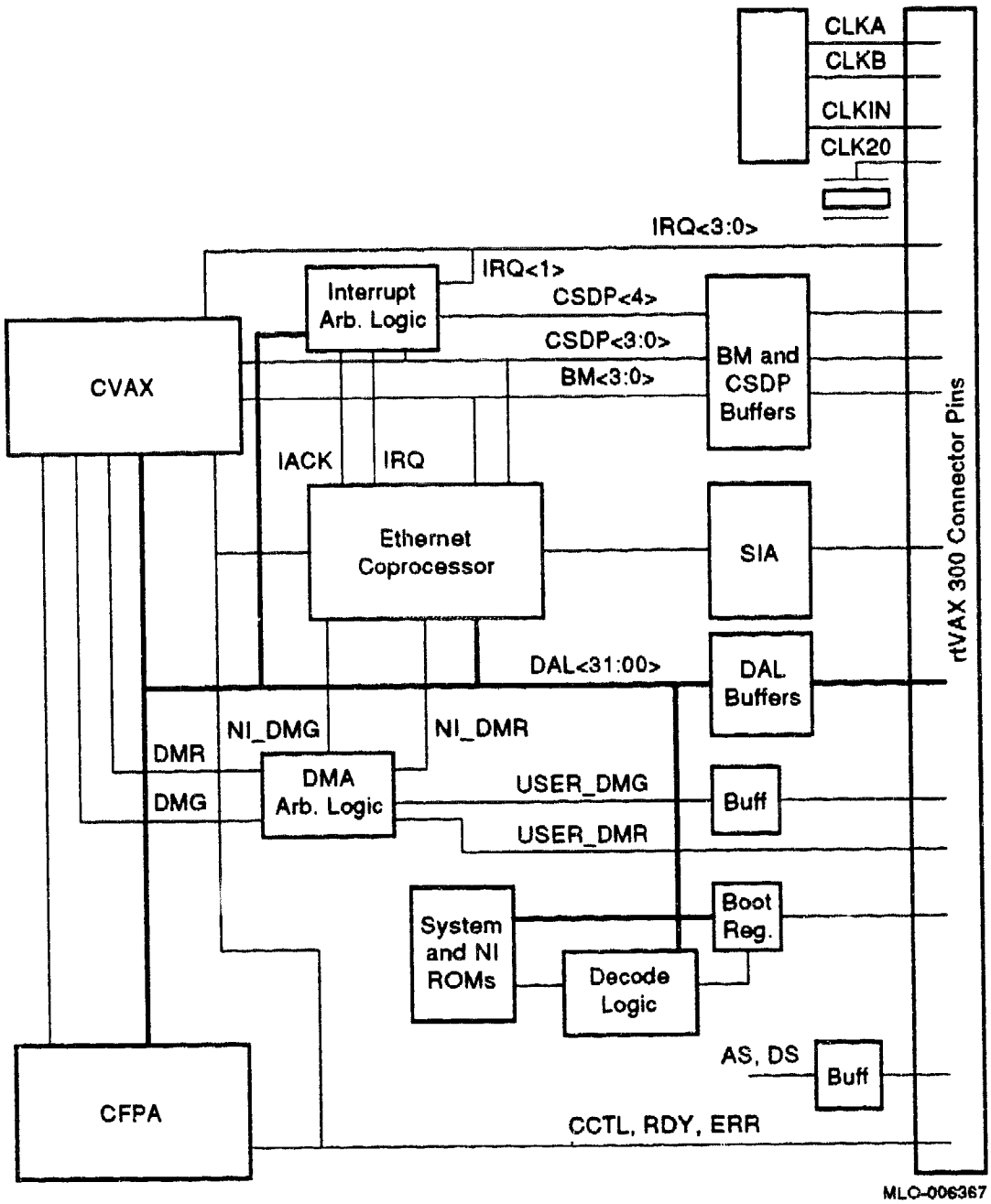
2.1.3 ROM and Reserved Memory Locations

The upper 2M bytes of memory space are reserved for Digital. The lowest 2M bytes of I/O space are the rtVAX 300 local register I/O space intended for the user. The rtVAX 300 processor stores in I/O space its self-diagnostic routines, console emulation program, other routines that it needs to boot bootstrap-supported devices, registers, and the Network ID ROM. The rtVAX 300 tester, console serial-line unit (SLU), and board-level initialization and diagnostic ROMs can also use a portion of this I/O space.

2.1.4 Network Interface

The Ethernet controller, or Network Interface (NI), shown in Figure 2–1, connects the rtVAX 300 processor to the Ethernet. It consists of the Ethernet coprocessor, which interfaces to the CVAX chip data and address line (DAL) bus and the serial interface adapter (SIA), to allow users to connect to Ethernet. Details of the connection to thickwire and ThinWire Ethernet are in Chapter 7. The Ethernet coprocessor can perform direct memory access (DMA) to any location in memory space. This controller is programmed by reading from, and writing to, a set of registers in the Ethernet coprocessor, SGEC. (Refer to Section 2.5.)

Figure 2–1 rtVAX 300 Block Diagram



2.1.5 Decode and Control Logic

The control logic consists of state machines responsible for the following: RDY signal generation for the ROMs, DMA and interrupt arbitration between DMA devices and the Ethernet coprocessor, and decoding internal addresses to control the output buffer direction and to assert CSDP<4> L.

The control logic also provides the counters for generating the timeout error signal and the 10 ms interval timer interrupt.

2.1.6 Interrupt Structure

The rtVAX 300 processor has access to the four interrupt request lines that the CVAX chip uses. Interrupt request line 1 (IPL 15_{16}) is daisy-chained to the user through the Ethernet coprocessor, giving the Ethernet controller a higher priority than devices connected to this line.

Interrupt acknowledge cycles responding to the Ethernet coprocessor are marked as internal cycles and are indicated by the assertion of CSDP<4> L. Hardware external to the rtVAX 300 processor should ignore such cycles.

2.1.7 DMA Structure

The rtVAX 300 processor issues a DMA grant signal that is daisy-chained to the user through the Ethernet coprocessor, giving the Ethernet controller the highest DMA priority.

The rtVAX 300 processor relinquishes the bus once it grants DMA control to the user hardware; however, the rtVAX 300 processor monitors the AS L line, the CCTL L line, and the DAL lines to invalidate the appropriate cache entries during DMA write cycles, if the CCTL L line is asserted.

Note

A DMA device should not hold the rtVAX 300 bus for more than 6 µs. If such a device requires the bus for a longer time, it should relinquish the rtVAX 300 DAL lines by deasserting DMR L and request it again.

2.1.8 Interval Timer

The interval timer generates a 50% duty cycle 100 Hz TTL square wave. This signal interrupts the CVAX once every 10 ms for VAXELN system clock updates.

2.1.9 Internal Cache

The CVAX has a 1K-byte write-through cache as part of the chip. Chapter 3 describes the organization of this cache.

2.2 Minimum Hardware Configuration

The rtVAX 300 processor is a platform that requires additional hardware to be usable. Section 2.2.1 and Section 2.2.2 list the minimum hardware requirements needed for the rtVAX 300 processor.

2.2.1 System RAM

The rtVAX 300 processor contains no RAM; however, in order for the rtVAX 300 processor to run its power-on self-test diagnostics successfully and issue the console program prompt, the processor needs at least 64K bytes of RAM. Under DECnet Phase IV, at least 512K bytes are needed to boot a VAXELN system image with the Ethernet driver, local and remote debuggers, and a 200K-byte user application. The RAM resides in VAX memory space beginning at physical address 00000000.

2.2.2 Console

The rtVAX 300 processor needs no console; however, a console port is required in order for the processor to use the console emulation program, report errors and warnings, and display system crashes.

The rtVAX 300 processor supports the Signetics 2681 dual universal asynchronous receiver/transmitter (SCN 2681 DUART) or a compatible device as a console interface. The data lines of the SCN 2681 DUART should be connected to the DAL<07:00> H lines. When the DUART is read from or written to, the BM<0> L line should be asserted. The rtVAX 300 processor uses channel A of the DUART for the console. Channel B is available and can be used by the application, for example, to load an application image over serial lines. A VAXELN device driver supports both channels.

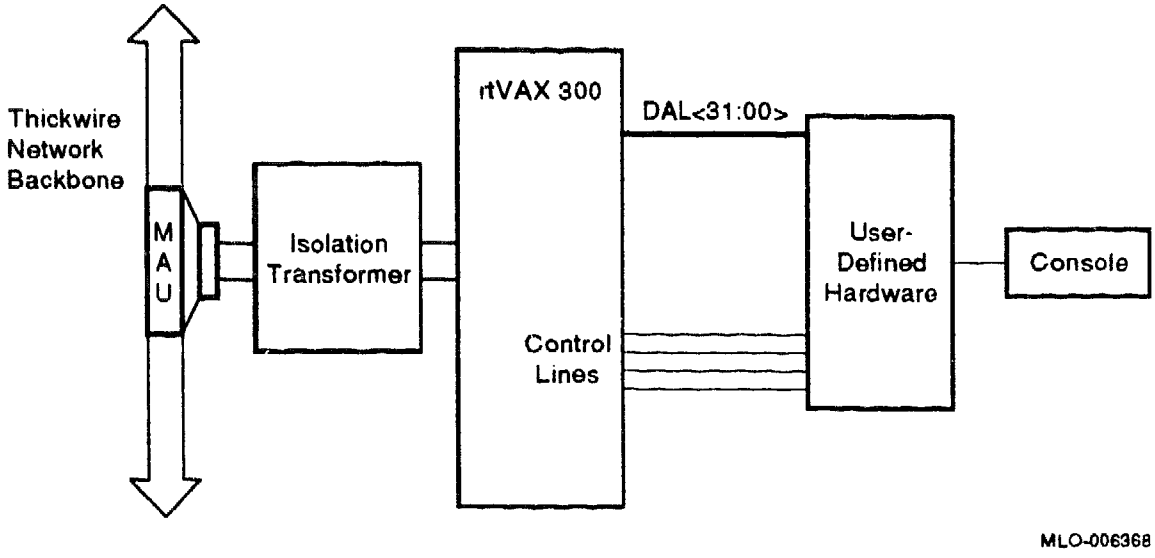
The console (IPL 14_{16}) is associated with interrupt request line IRQ<0> and the vector $02C0_{16}$.

The control logic has assigned locations for the registers that the SCN 2681 DUART uses. These registers are decoded/assigned addresses in the rtVAX 300's local register I/O space. (Table 3–13 lists the physical address of each register. Chapter 6 contains details on how to connect the SCN 2681 DUART to the rtVAX 300.)

2.3 Bus Connections

Figure 2–2 shows a typical interface configuration of the rtVAX 300 processor and includes control signals and bus connections. All signals are TTL levels, except for the Ethernet differential pairs.

Figure 2–2 Typical rtVAX 300 Environment



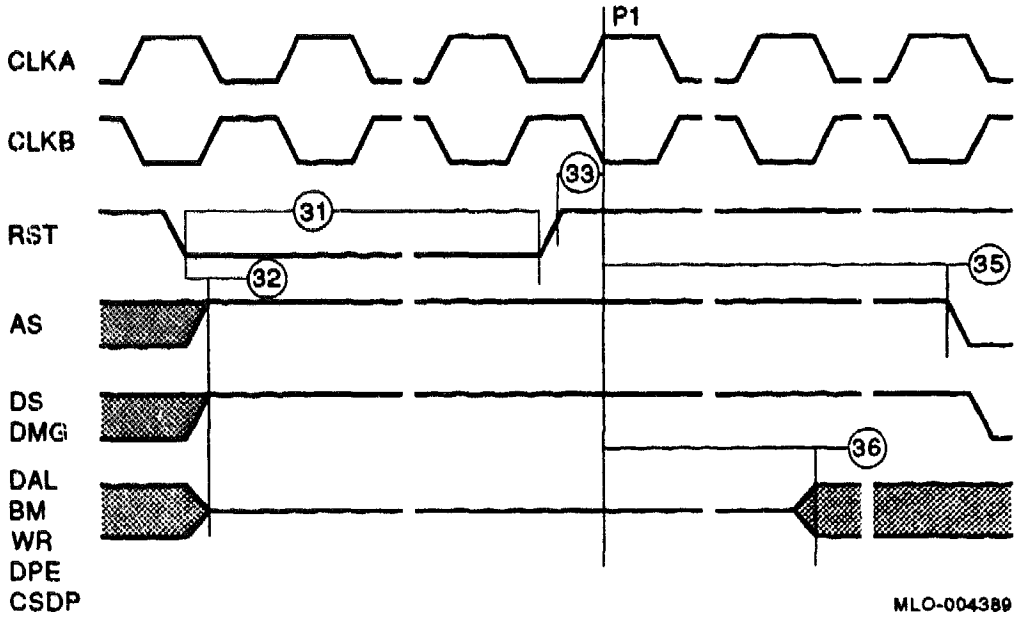
2.3.1 Power Connections

The rtVAX 300 processor requires a +5V/2A dc power supply. Seven pins are provided to connect to +5V, and seven pins for +5V return. The four mounting holes can also serve as a ground connection. The power decoupling and proper ground connections are very important. (Refer to Section A.2 for detailed information.

2.3.2 Reset and Power-Up Requirements

Asserting the RST L signal for a minimum of 30 clock periods resets the rtVAX 300 processor. This line must be deasserted within the specified time before the rising edge of CLKA. Figure 2–3 shows the timing cycle of the reset function.

Figure 2–3 Timing Cycle for Reset Function



Note

Timing diagrams within this manual often contain circled numbers; Table A–3 explains their meanings.

2.3.3 Power-Down Sequencing: Power-Fail

The system power supply conditions external power and transforms it for use by the processor. When external power fails, the power supply requests a power-fail interrupt of the processor by asserting the PWRFL L signal. The PWRFL L signal is a maskable interrupt at IPL $1E_{16}$.

The power supply must continue to provide power to the processor for at least 2 ms after the interrupt is requested, in order to allow the operating system to save state. When the power supply can no longer provide power to the processor, the processor halts through the assertion of the HLT L signal. (Refer to Appendix A for a summary of electrical characteristics.)

Section 2.4.8 and Table 2–1 define the PWRFL L control signal and its functions.

2.4 Pin and Signal Description

This section briefly describes the input-output signals and power and ground connections of the rtVAX 300 processor. Table 2–1 lists bus and interface signals and their functions. Table 2–2 lists pin assignments; Figure 2–4 shows the pin layout.

Table 2–1 Bus Interface Signals

Signal	Meaning
+5V	+5V power supply
AS L	Address strobe
BM<3:0> L	Byte masks
BOOT<3:0> L	Boot select pins
BTREQ L	Ethernet coprocessor boot request signal
CCTL L	Cache control, for cache invalidation and selective caching
CLK20	20 MHz clock output
CLKA/CLKB	CPU clock outputs
CLKIN	System clock input signal
COL+/COL–	Ethernet collision detect differential pair
CSDP<4:0> L	Control status/data parity
DAL<31:00> H	Data and address lines
DMG L	Direct memory grant
DMR L	Direct memory request
DPE L	Data parity enable
DS L	Data strobe
ERR L	Bus error input
GND	+5V ground (return)
HLT L	Halt processor interrupt
INTIM	10 ms timer—100 Hz 50% duty cycle output
IRQ<3:0> L	Interrupt request
PWRFL L	Powerfail
RCV+/RCV–	Ethernet receive data differential pair

(continued on next page)

Table 2–1 (Cont.) Bus Interface Signals

Signal	Meaning
RDY L	Bus ready input
RST L	Reset input
WR L	Read/write
XMT+/XMT–	Ethernet transmit data differential pair

Table 2–2 rtVAX 300 Processor Pin Description

Pin	Signal	In/Out	Definition/Function
A1, A15, A31, B6, B14, B32, B50	GND	–	+5V ground return
A2, A16, A32, B5, B13, B31, B49	+5V	–	+5V dc power
A6–A3	BOOT<3:0> L	I	Defines the boot device
A7	BTREQ L	OD	Remote Ethernet boot request from the coprocessor
A8	INTIM	O	100 Hz interval timer clock output
A12–A9	BM<3:0> L	O/Z	Byte masks
A13	DMG L	O	DMA grant
A14	DMR L	I	DMA request
A17	RST L	I	Reset
A18	HLT L	I	Halt processor
A19	PWRFL L	I	Indicates loss of ac power
A24–A21	IRQ<3:0> L	I	User-defined interrupt request lines
A25	CCTL L	I/O/Z	Cache control
A26	RDY L	I/O/Z	Bus ready
A27	ERR L	I/O/Z	Bus error
A28	DS L	O/Z	Data strobe
A29	WR L	O/Z	Read/write
A30	AS L	O/Z	Address strobe
A36	XMT–	O	Thickwire transmit data –

(continued on next page

Table 2–2 (Cont.) rtVAX 300 Processor Pin Description

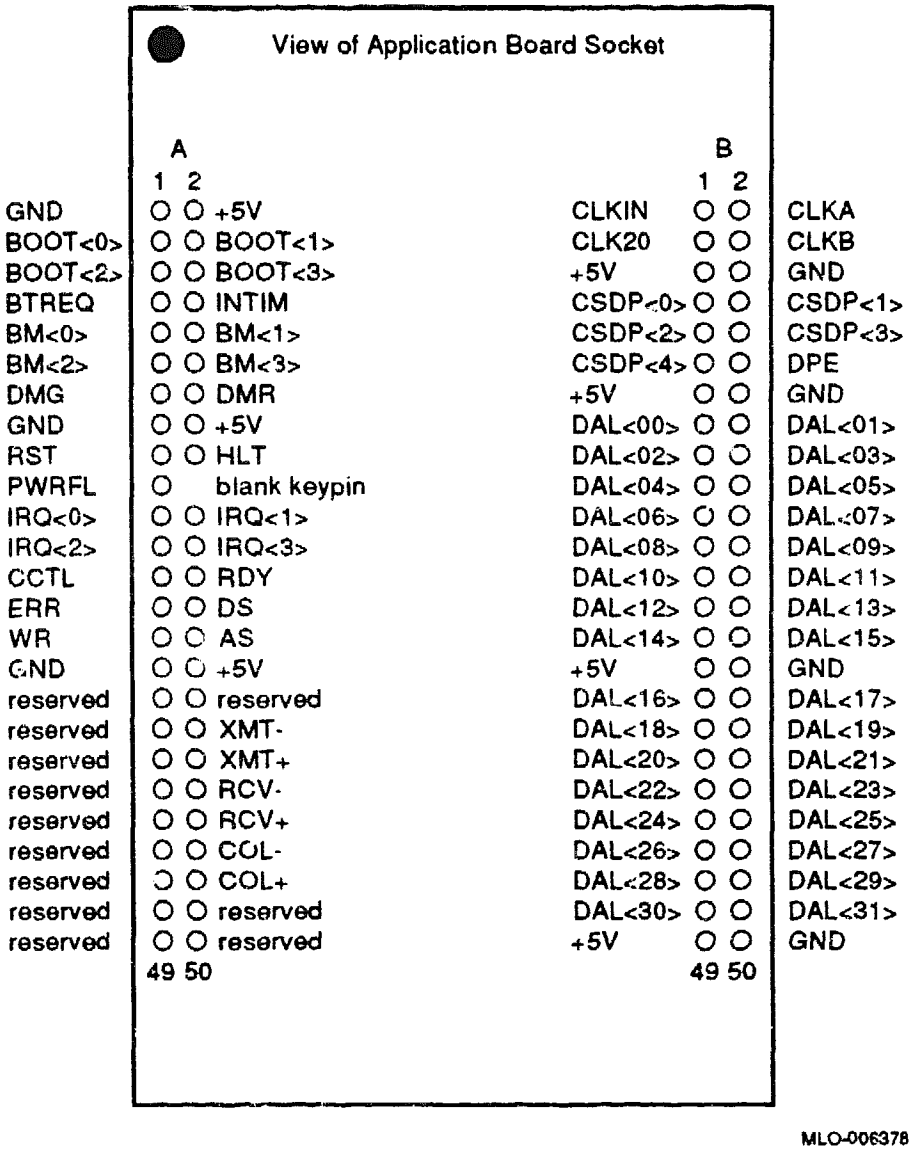
Pin	Signal	In/Out	Definition/Function
A38	XMT+	O	Thickwire transmit data +
A40	RCV–	I	Thickwire receive data –
A42	RCV+	I	Thickwire receive data +
A44	COL–	I	Thickwire collision detect –
A46	COL+	I	Thickwire collision detect +
B1	CLKIN	I	System clock input
B2	CLKA	O	Clock A output
B3	CLK20	O	20 MHz clock output
B4	CLKB	O	Clock B output
B10–B7	CSDP<3:0> L	I/O/Z	Control status and parity information
B11	CSDP<4> L	O/Z	Ethernet interrupt acknowledge cycle
B12	DPE L	I/O/Z	Data parity enable
B48–B33, B30–B15	DAL<31:00> H	I/O/Z	Data and address multiplexed bus

Note

All TTL inputs except CLKIN have an internal 2K Ω pull-up. All outputs are driven by the ACTQ 244 or ACTQ 245 buffers. Signal designations are as follows:

Signal Designation	Meaning
I	Input
O	Output
OD	Open-drain bidirectional
Z	Tri-stateable bidirectional

Figure 2–4 rtVAX 300 Pin Layout



MLO-006378

2.4.1 Data and Address Bus

The data and address lines, DAL<31:00> H (I/O/Z), form a time-multiplexed bidirectional bus that transfers address, data, and other information during bus cycles.

During the address portion of a bus cycle, the following occurs:

- DAL<31:30> H provide information on the type of cycle, as indicated in Table 2–3.
- DAL<29> H is asserted when the rtVAX 300 processor accesses I/O space; otherwise, it is deasserted.
- DAL<28:02> H provide the physical address of the device being accessed.
- DAL<01:00> H are reserved.

During the data portion of a bus cycle, the DAL lines carry data to or from the user hardware.

Table 2–3 DAL Lines

DAL>31> H	DAL<30> H	Description
0	1	Longword read/write
1	0	Quadword read (Quadword writes do not occur)
1	1	Octaword read/write

2.4.2 Ethernet Connections

The rtVAX 300 processor allows you to connect to Ethernet by means of standard thickwire connections through a 75 µH isolation transformer, as shown in Figure 2–5. Connection to ThinWire is also straightforward. (For more information, refer to Chapter 7.)

Signals are as follows:

- Collision Detect (COL+, COL–) (non-TTL)

  This differential pair of wires connects through a user-supplied isolation transformer to a user-supplied 15-pin D-sub connector, when the rtVAX 300 processor is connected to a media attachment unit (MAU) with a transceiver cable. See Figure 2–5. These two signals are used for the collision detect. The rtVAX 300 supplies 78 Ω termination on these lines. Chapter 7 discusses this connection in greater detail.

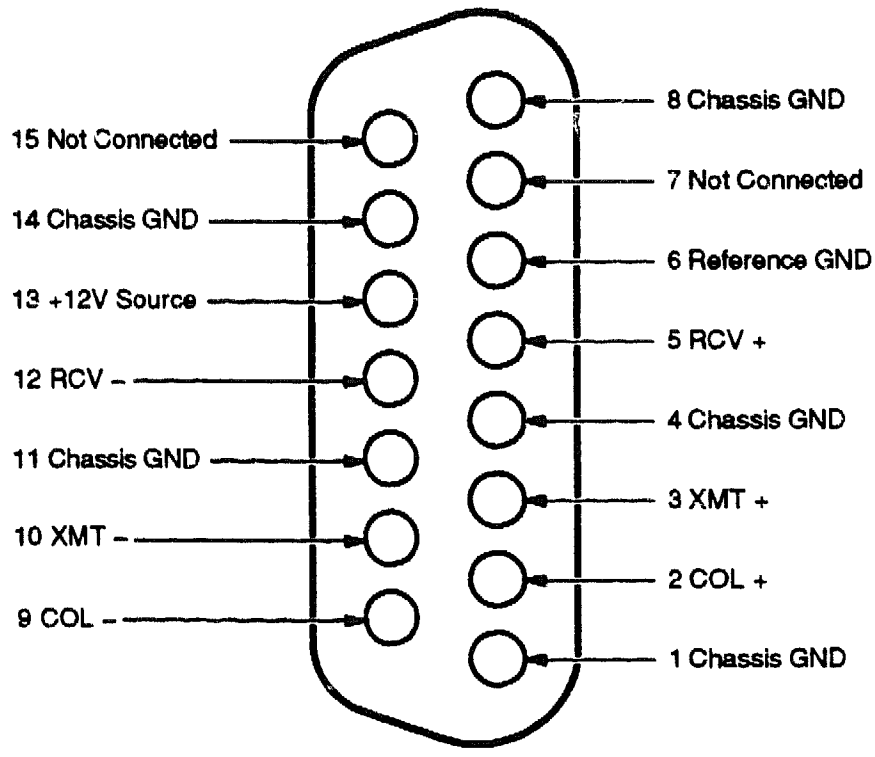
- Receive (RCV+, RCV–) (non-TTL)

  This differential pair of wires connects through a user-supplied isolation transformer to a user-supplied 15-pin D-sub connector, when the rtVAX 300 processor is connected to an MAU with a transceiver cable. The rtVAX 300 supplies 78 Ω termination on these lines. See Figure 2–5.

- Transmit (XMT+, XMT-) (non-TTL)

  This differential pair of wires connects through a user-supplied isolation transformer to a user-supplied 15-pin D-sub connector, when the rtVAX 300 processor is connected to an MAU with a transceiver cable. See Figure 2–5.

Figure 2–5 Thickwire Connections



2.4.3 Bus Control Signals

Bus control signals are as follows:

- Address Strobe (AS L) (O/Z)

  This signal indicates that valid address information is available on the DAL<29:02> H bus, and valid status information is on the BM<3:0> L, CSDP<4:0> L, and WR L lines. The leading edge of this signal can be used to latch the address and status information.

Note

BM<3:0> L must be latched during quadword and longword cycles and must flow through during octaword access cycles.

During a DMA transfer, the rtVAX 300 processor uses the assertion of AS L to latch the DMA address, which is used in a cache invalidate cycle when CCTL L is asserted.

- Data Strobe (DS L) (O/Z)

  This signal indicates that the DAL<31:00> H and CSDP<3:0> L lines are free to receive data and parity information during a read cycle or that valid data is on the DAL<31:00> H lines and valid parity on CSDP<3:0> L during a write cycle.

- Byte Masks (BM<3:0> L) (O/Z)

  These signals indicate which bytes of the DAL lines contain valid data, as listed in Table 2–4.

Table 2–4 Byte Masks

Byte Mask	Description	Data Byte
BM<0> L	Low byte of low word	DAL<07:00> H
BM<1> L	High byte of low word	DAL<15:08> H
BM<2> L	Low byte of high word	DAL<23:16> H
BM<3> L	High byte of high word	DAL<31:24> H

For a read cycle, byte masks indicate which bytes of the DAL lines must have data driven onto them; for a write cycle, they indicate which bytes of the DAL lines contain valid data. Lines BM<3:0> L are valid when the AS L signal is asserted during quadword and longword access cycles. Octaword transfer cycles require that these lines not be latched.

- Write/Read (WR L) (O/Z)

  This signal specifies the direction of a data transfer on the DAL bus for the current bus cycle. When the signal is asserted, the rtVAX 300 processor is performing a write operation; when the signal is deasserted, it is performing a read operation or interrupt acknowledge cycle. The WR L signal is valid when AS L is asserted.

- Ready (RDY L) (I/O/Z)

  External logic asserts this signal to indicate the completion of the current bus cycle. When this signal is not asserted, the rtVAX 300 processor extends the current bus cycle for a slower memory or peripheral device. The RDY L or ERR L signal must be asserted to end the current bus cycle. These signals must be driven by tri-state drivers. Both signals can be asserted simultaneously to force the rtVAX 300 processor to retry the current bus cycle.

  During internal cycles (CSDP<4> L asserted), the rtVAX 300 processor drives RDY L high. The rtVAX 300 processor asserts RDY L before the end of an internal cycle. The rtVAX 300 processor does not drive the RDY L signal on non-internal cycles.

  Note

  During quadword cache invalidate cycles, AS L must remain asserted for at least 250 ns, which equates to a 4-microcycle write cycle. (Two wait states must be added.) Memory systems faster than 400 ns must delay cache invalidate write cycles at least two microcycles by holding off the assertion of RDY L. Slower memory systems already adhere to the minimum AS L assertion requirement during cache invalidate cycles. Write cycles that do not involve cache invalidation (CCTL L not asserted) and read cycles can occur without wait states.

- Error (ERR L) (I/O/Z)

  External logic asserts this signal to indicate an error associated with the current bus cycle and to end the bus cycle. The rtVAX 300 processor asserts this signal when a bus timeout condition occurs. Either the ERR L or the RDY L signal must be asserted to end the current bus cycle. RDY L and ERR L are synchronous inputs and must be asserted within the timing values specified in Section 2.6.

  Note

  The rtVAX 300 processor has an internal timer that aborts any read or write cycle if an RDY L or an ERR L signal is not received from 16 to 32 µs after AS L is asserted. This provides for the bus timeout feature and prevents the rtVAX 300 processor from hanging when communicating with a nonexistent or faulty memory or I/O device.

- Cache Control Signal (CCTL L) (I/O/Z)

  During a DMA cycle, assertion of this signal by external logic initiates a conditional cache invalidate cycle. The internal Ethernet controller also asserts this signal during DMA write cycles.

  During an rtVAX 300 read cycle, this signal is asserted to prevent the accessed data from being stored in the internal cache memory of the rtVAX 300. CCTL L is level-sensitive and must be asserted synchronously with the timing sampling point for the rtVAX 300 processor read cycle.

2.4.4 Bus Retry Cycles

External hardware can force the rtVAX 300 processor to retry the current bus cycle by asserting both RDY L and ERR L at the same time. This has no effect on the current bus cycle; the data are transferred later, when the cycle is successfully retried. Only longword and quadword processor access cycles can be retried; octaword and Ethernet controller cycles cannot be retried.

2.4.5 Status and Parity Control Signals

Status and parity control signals are as follows:

- Data Parity Enable (DPE L) (I/O/Z)

  This signal controls the checking and generation of data parity. During an rtVAX 300 read cycle or an interrupt acknowledge cycle, DPE L is asserted by external logic to enable data parity checking by the rtVAX 300. During an rtVAX 300 write cycle, the rtVAX 300 asserts DPE L to indicate to external logic that valid parity information is on CSDP<3:0> L.

- Control Status and Data Parity (CSDP<4:0> L) (I/O/Z)

  These lines transfer cycle status and data parity information between the rtVAX 300 processor and external devices. During the first part of the bus cycle, CSDP<4:0> L and WR L provide status information about the current bus cycle, as listed in Table 2–5. CSDP<3> L indicates the set in internal cache memory that is being allocated during a cacheable read operation and is undefined during all other bus cycles. CSDP<3> L is asserted to specify set 1 and negated to specify set 2.

Table 2–5 rtVAX 300 Bus Status Signals

	CSDP				
WR L	**<4> L**	**<2> L**	**<1> L**	**<0> L**	**Bus Cycle Type**
H	H	L	L	L	Request D-stream read
H	H	L	L	H	Reserved
H	H	L	H	L	External IPR read
H	H	L	H	H	External interrupt acknowledge
H	H	H	L	L	Request I-stream read
H	H	H	L	H	Demand D-stream read (lock)
H	H	H	H	L	Demand D-stream read (modify intent)
H	H	H	H	H	Demand D-stream read (no lock or modify intent)
L	H	L	L	L	Reserved
L	H	L	L	H	Reserved
L	H	L	H	L	External IPR write
L	H	L	H	H	Reserved for use by DMA devices
L	H	H	L	L	Reserved
L	H	H	L	H	Write unlock
L	H	H	H	L	Reserved
L	H	H	H	H	Write no unlock
X	L	X	X	X	Reserved (rtVAX 300 internal interrupt acknowledge cycle only)

During the second part of the bus cycle, the CSDP<3:0> L lines are used to transfer byte parity information for the DAL line data during a read or write cycle. During the read cycle, the rtVAX 300 processor checks parity on all four bytes, regardless of the assertion of the BM<3:0> L signals. On a write cycle, the rtVAX 300 generates data parity on the CSDP<3:0> L lines.

2.4.6 Interrupt Control

The IRQ<3:0> L lines are asynchronous interrupt request lines. External logic uses them to indicate interrupt requests to the CVAX. The rtVAX 300 samples the lines every microcycle, and they must stay asserted until the end of the interrupt acknowledge cycle.

Although the rtVAX 300 Ethernet coprocessor shares IRQ<1> L on the CVAX, the coprocessor is serviced before the user interrupt. Table 2–6 lists the interrupt priority level (IPL) assignments as they relate to IRQ<0> L and IRQ<1> L.

Table 2–6 Interrupt Priority Assignments

IRQ L	IPL_{16}	Device
IRQ<0>	14	User-defined, shared with external console
IRQ<1>	15	User-defined, shared with the Ethernet coprocessor
IRQ<2>	16	User-defined, shared with the interval timer
IRQ<3>	17	User-defined

2.4.7 DMA Control Signals

DMA control signals are as follows:

- DMA Request (DMR L) (I)

  External logic uses this signal to request control of the DAL bus and its related control signals.

- DMA Grant (DMG L) (O)

  This signal indicates that the rtVAX 300 processor has granted the use of the DAL bus and its related control signals.

Note

Both DMA request and DMA grant signals are daisy-chained from the CVAX processor through the Ethernet coprocessor chip inside the rtVAX 300 to the user-defined hardware. Therefore, the Ethernet coprocessor has the first priority for a DMA. In addition, to prevent Ethernet FIFO overflows, a user device cannot remain bus master longer than 6 µs.

2.4.8 System Control Signals

System control signals are as follows:

- Reset (RST L) (I)

  This signal initializes the rtVAX 300 processor to a known state. This line must be asserted on power-up.

- Halt (HLT L) (I)

  This signal causes a nonmaskable interrupt at IPL $1F_{16}$ that causes the rtVAX 300 processor to enter the console emulation program in the firmware. This signal is negative-edge-triggered and internally synchronized.

- Power Failure (PWRFL L) (I)

  This signal allows external logic to notify the rtVAX 300 of a power failure. The rtVAX 300 processor samples the signal every microcycle. The PWRFL L signal generates an interrupt at IPL $1E_{16}$. This interrupt is internally acknowledged by the rtVAX 300 and does not use an interrupt acknowledge bus cycle. This signal is edge-sensitive and internally synchronized.

- Boot (BOOT<3:0> L) (I)

  These pins determine the default boot actions of the rtVAX 300. These signals are pulled up internally and default to 1. When a pin is low, it registers a 0. (See Table 3–12 for different allowable boot devices.)

- Boot Requests (BTREQ L) (OD)

  This signal is asserted low once a valid trigger request is received over the Ethernet from a host system. This lead is gated with a board-level remote trigger enable signal and fed into the HLT L signal.

2.4.9 Clock Signals

Clock signals are as follows:

- 20 MHz Clock Output (CLK20) (O)

  This taps into the internal oscillator and can be fed back into CLKIN to drive the rtVAX 300.

Note

Use this signal only to drive CLKIN.

- System Clock Input (CLKIN) (I)

  This system clock input must be a TTL-compatible oscillator at a maximum frequency of 20 MHz. A lower frequency clock can be used to lower power consumption or to match the processor to slower memory devices. The duty cycle must be 50%.

- Basic Clock Output (CLKA) (O)

  This TTL buffered clock must be used to synchronize the rtVAX 300 external logic and the CPU bus cycles. This clock provides the P1 and P3 timing reference.

Note

In the following two items, all timing is referenced to CLKA and CLKB.

- Basic Clock Output (CLKB) (O)

  This TTL buffered clock must be used to synchronize the rtVAX 300 system. This clock provides the P2 and P4 timing reference.

- 10 ms Interval Timer (INTIM) (O)

  This signal produces a 10 ms TTL square wave (50% duty cycle).

2.4.10 Power Supply Connections

Power supply connections are as follows:

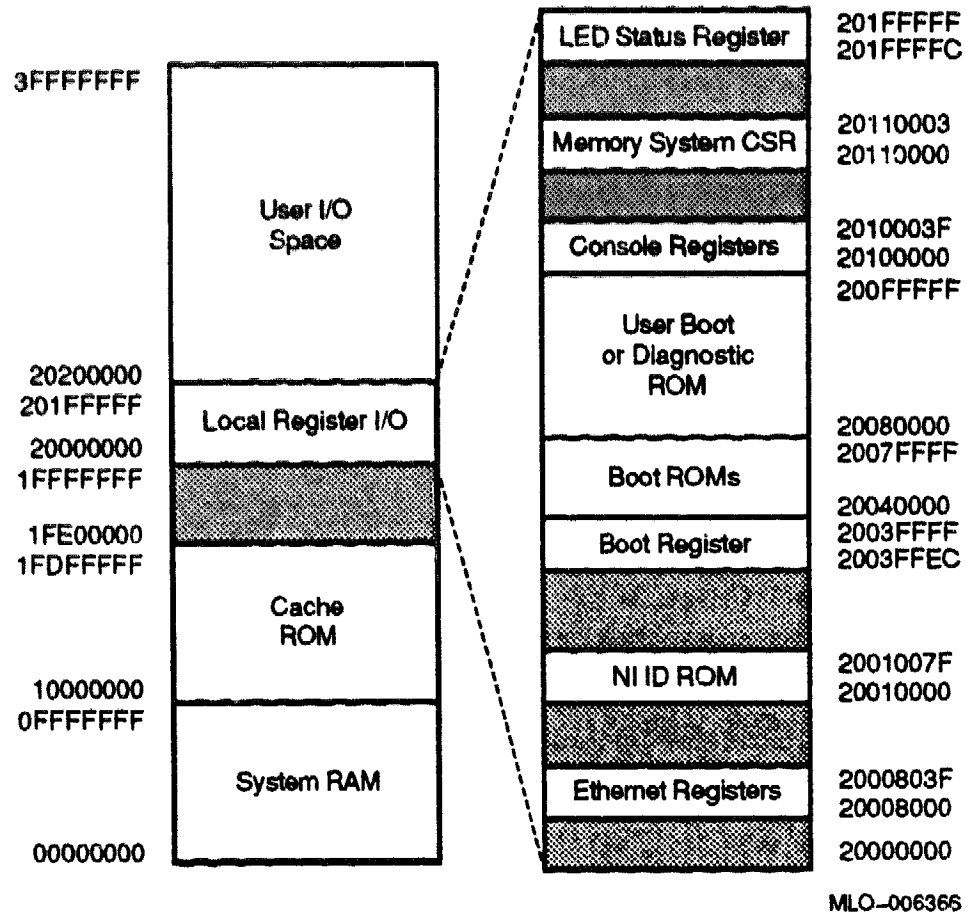
- +5V dc power (+5V)
- Reference ground, +5V return (GND)

2.5 Memory and I/O Space

The rtVAX 300 processor can access 510M bytes (256 R/W and 254 R/O) of memory space and an I/O space of 512M bytes. The Ethernet coprocessor has direct access to all memory space.

2M bytes of I/O space are used for local registers. (Refer to Appendix C.) Figure 2–6 shows the partitioning and layout of memory. (Undesignated shaded areas are reserved.) In addition to the registers shown in Figure 2–6, the rtVAX 300 processor contains internal processor registers, as described in Chapter 3. Table 3–3 lists and describes internal processor registers.

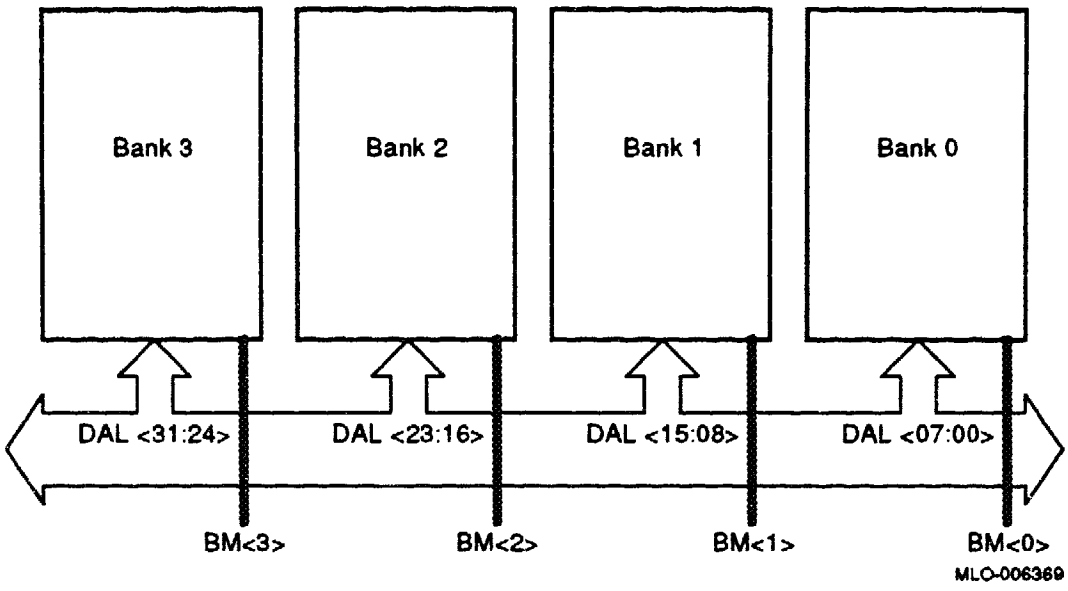
Figure 2–6 rtVAX 300 Memory and I/O Space



The rtVAX 300 accesses memory in bytes, words (2 bytes), longwords (4 bytes), quadwords (8 bytes), or octawords (16 bytes). However, quadword and octaword accesses are restricted to the system RAM portion of the memory space.

The rtVAX 300 read/write memory is organized into four banks, as shown in Figure 2–7. The rtVAX 300 issues longword addresses on the DAL bus. You can read from or write to any byte of any memory location by using the different byte mask signals.

Figure 2–7 rtVAX 300 Memory Bank Organization



2.5.1 Address Decode and Boot ROM

The internal ROM address latch logic latches the address on the DAL bus and drives it on the ROM address bus to the boot and diagnostic ROMs, the Network Interface address decode logic, and the Network Interface address ROMs. The ROM address decode logic decodes the address on the DAL bus to provide control signals for the ROMs and the boot register.

2.5.2 Boot ROM

The boot ROM contains the boot drivers, self-test diagnostics, and console emulation program. It also accesses the registers used by the Ethernet coprocessor and the registers used by the user-provided console ports.

The boot register is a read-only register that resides at address 2003FFEC. The firmware reads this register on power-up to determine the default boot device and whether or not to enable remote console and remote trigger. (For additional information on the boot register, see Figure 3–14.)

2.5.3 Programming the User ROMs

The system image generated by the VAXELN System Builder (EBUILD) is first down-line loaded by using the network as the booting device on the rtVAX 300 target. You can use the remote and local debuggers to debug the application software. Once the application software is running correctly, you should generate a new system file by selecting the ROM as the boot method and then run the resulting .SYS file through the PROMLINK program to create a loadable file for the EPROM burner. The ROMs are then inserted into the EPROM programmer, programmed, and then inserted into their correct sockets. Then, the BOOT pins <2:0> L can be connected, as shown in Table 3–12, and the rtVAX 300 will boot from these ROMs.

2.5.4 Network Interface Registers

The Network Interface on the rtVAX 300 is programmed by reading from and writing to a set of 16 Ethernet coprocessor registers located from 20008000 to 2000803F. In addition to the 16 registers, the Ethernet ID ROM, providing the physical network address for the rtVAX 300, is located from 20010000 to 2001007F.

For detailed information on programming the Ethernet coprocessor chip, refer to Chapter 3.

2.5.5 Board-Level Initialization and Diagnostic ROMs

I/O space locations 20080000 through 200FFFFF are available for use by the user-supplied board-level initialization and diagnostic ROMs. After the firmware finishes executing the processor, CFPA, and ROM self-tests, it checks for an external ROM mapped to 20080000. If the ROMs exist, control is transferred to them. They can then perform board-level initialization and diagnostics, define a new boot device, and execute the RET instruction to return to the internal firmware for memory testing and bootstrapping. If user/boot diagnostic ROMs do not exist, the rtVAX 300-resident firmware continues with memory tests and bootstrapping. Chapter 4 provides further programming information.

2.6 Bus Cycles and Protocols

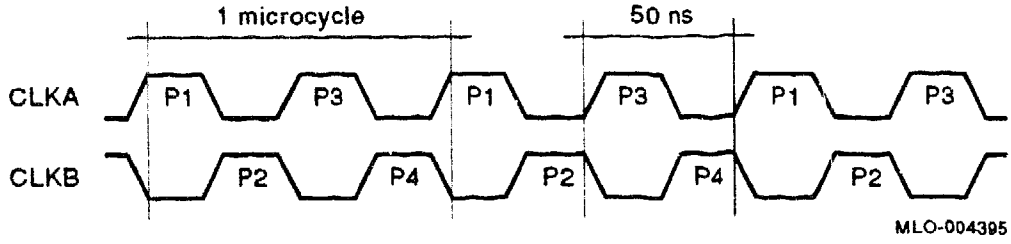
The rtVAX 300 processor performs bus cycles when one of the following occurs:

- The CVAX is reading or writing information to or from memory, internal or external ROM, internal or external registers, the Ethernet coprocessor, or any other external memory or peripheral device.
- The Ethernet coprocessor is reading from or writing to external RAM.
- The CVAX is acknowledging an interrupt internal or external to the rtVAX 300.

2.6.1 Microcycle Definition

A microcycle is the basic timing unit for a CVAX bus cycle. A microcycle is defined as four clock phases, as shown in Figure 2–8. A microcycle equals two CLKIN cycles.

Figure 2–8 Microcycle Timing



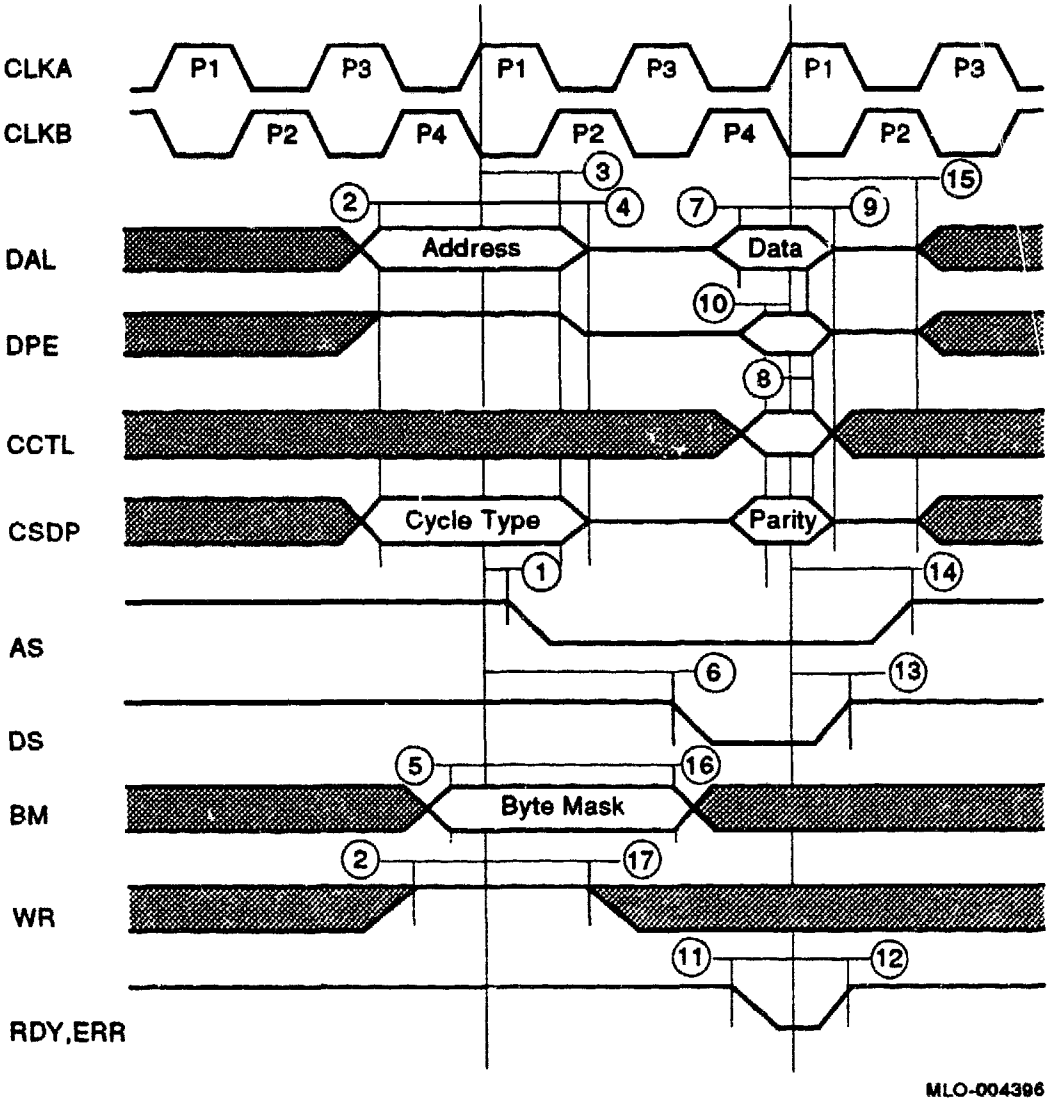
2.6.2 Single-Transfer Read Cycle

Both the CVAX and the Ethernet coprocessor inside the rtVAX 300 can initiate a single-transfer read cycle. This cycle requires at least two microcycles; microcycles can be added in increments of one microcycle Figure 2–9 shows the timing of a single-transfer read cycle.

Note

I/O space read references always occur as single-transfer read cycles.

Figure 2–9 Single-Transfer Read Cycle Timing



The sequence of events is as follows:

1. The CVAX transfers the physical address onto the DAL<29:02> H lines. The DAL<31:30> H lines are set to 01_2 to indicate a single longword transfer.
2. The BM<3:0> L and CSDP<4:0> L lines are asserted as required, and the WR L line is negated.

3. The CVAX asserts AS L, validating CSDP L, BM L, WR L, and address information.
4. The CVAX asserts DS L to indicate that the DAL lines are available to receive the incoming data.
5. The CVAX checks for a complete cycle once every two phases starting at the next possible P1 rising edge. External logic indicates that the cycle is complete by one of the following three responses:
   a. If no error occurs, external logic places the requested data on the DAL<31:00> H lines and parity information on CSDP<3:0> L, asserts DPE L if parity is to be checked, and asserts RDY L while ERR L is deasserted. If the CVAX detects a parity error, appropriate error information is logged in the memory system error register (MSER); the CVAX ignores the data on the DAL<31:00> H lines and generates a machine check if the cycle was a demand read cycle.
   b. If a bus error occurs, external logic asserts ERR L with RDY L deasserted. The CVAX ignores the data on the DAL<31:00> H lines and generates a machine check if the cycle was a demand read cycle. An error is recognized only if RDY L is deasserted for two consecutive P1 sample points.
   c. External logic can request a retry of the cycle by asserting RDY L and ERR L. Certain request read cycles do not reissue a bus cycle if they are retried. Specifically, if the retry occurs on a prefetch reference, the operation may not be reissued because the processor may execute a branch operation before the prefetch can be retried. In addition, Ethernet controller cycles cannot be retried.
6. The CVAX completes the read cycle by deasserting DS L and AS L.

2.6.3 Quadword-Transfer Read Cycle

During a quadword-transfer read cycle, the CVAX reads two longwords from main memory. A quadword-transfer read requires at least three microcycles. Each longword transfer may be increased in increments of one microcycle The sequence of events of a quadword-transfer read cycle is as follows:

1. The CVAX transfers the physical address of the preferred longword onto the DAL<29:02> H lines. This address can be aligned with either of the two longwords of the quadword. DAL <02> H indicates whether the upper or lower longword is transferred first. DAL<31:30> H lines are set to 10_2 to indicate a quadword transfer. The CVAX sends an address of only the initial longword (preferred). The address of the second associated longword

(cache fill) is implied and, therefore, is not transferred. External logic can generate the implied address by inverting bit 02 of the preferred address.

2. BM<3:0> L and CSDP<4:0> L are asserted as required, and WR L is negated.
3. The CVAX asserts AS L, validating CSDP<4:0> L, BM<3:0> L, WR L, and address information on DAL<31:02> H.
4. DS L is asserted for each data transfer to indicate that the DAL lines are available to receive the incoming data.
5. The CVAX checks for a complete cycle once every microcycle, after each longword cycle, starting at the next possible P1 rising edge. External logic indicates that the cycle is complete by one of the following three responses:
   a. If no error occurs, external logic places the requested data on the DAL<31:00> H lines and parity information on CSDP<3:0> L, asserts DPE L if parity is to be checked, asserts CCTL L if data caching is to be disabled, and asserts RDY L, while ERR L is deasserted for each data transfer. The CVAX reads the data and parity information and deasserts DS L for every transfer. If the caching is prevented (CCTL L asserted), the cycle immediately terminates without reading the second longword. If the CVAX detects a parity error, the appropriate error information is logged in the MSER; the CVAX ignores the data on the DAL<31:00> H lines and generates a machine check if the cycle was a demand read. If a parity error is detected on the first longword, the CVAX performs the second data transfer and ignores all the data.
   b. If an error occurs on either longword, external logic asserts ERR L with RDY L deasserted. The CVAX ignores the data on the DAL<31:00> H lines, terminates the cycle without reading any additional data, and generates a machine check if the cycle was a demand read. Only the first transfer can be a demand cycle. An error is recognized only if RDY L is deasserted for two consecutive P1 sample points.
   c. External logic can request a retry of the cycle by asserting RDY L and ERR L. If the retry occurs during the second longword transfer, the read cycle is not reissued.
6. The CVAX completes the read cycle by deasserting DS L and AS L.

Figure 2–10 illustrates quadword-transfer read cycle timing, and Table 2–7 shows responses to this cycle.

Figure 2–10 Quadword-Transfer Read Cycle Timing

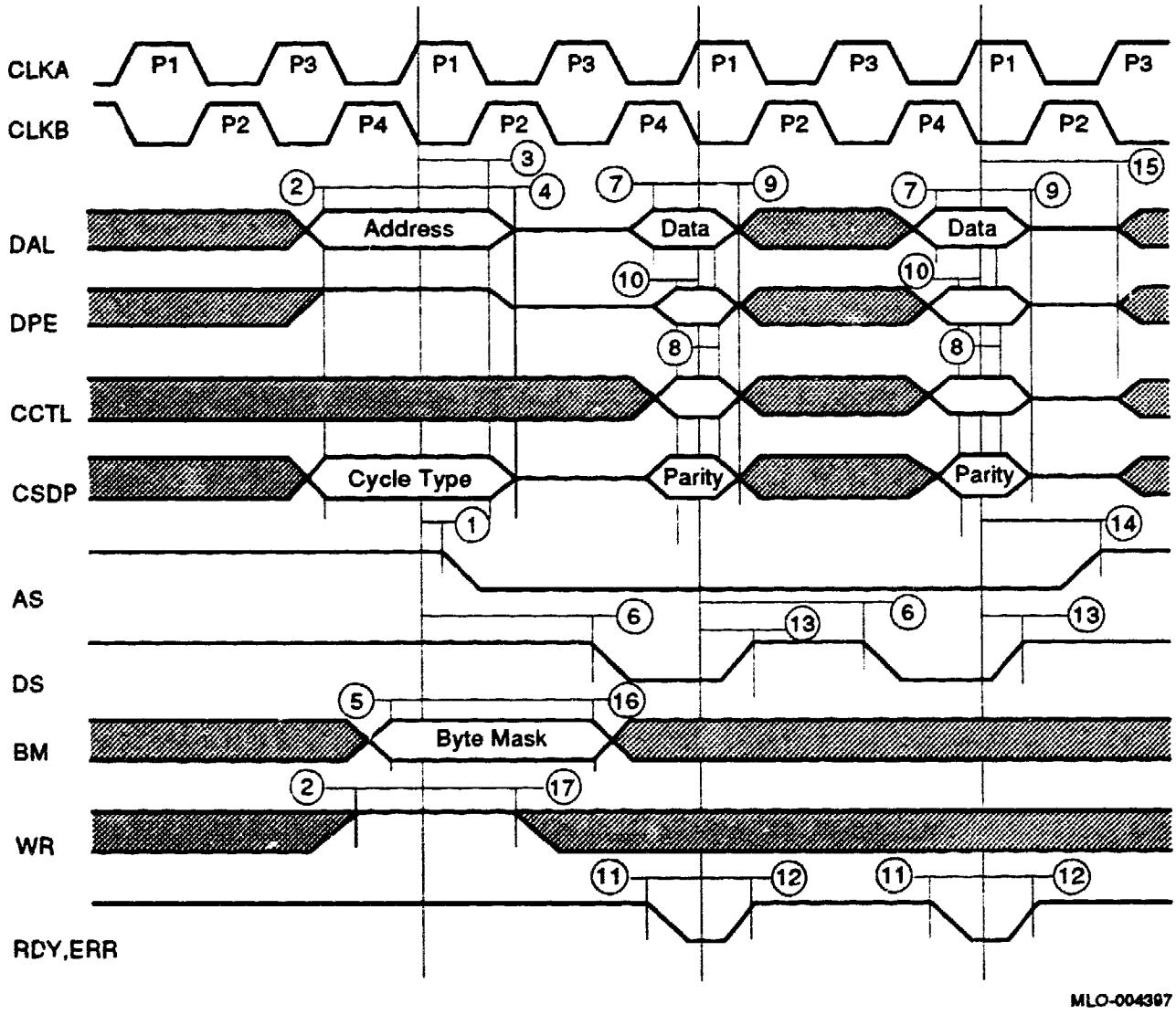


Table 2–7 rtVAX 300 Responses to a Quadword-Transfer Read Cycle

CCTL L	RDY L	ERR L	Parity Error	Action for First Reference	Action for Second Reference
X	H	H	X	Wait for data.	Wait for data.
X	H	L	X	Machine check if demand read. Invalidate cache entry. No second reference.	No machine check. Invalidate cache entry.
H	L	H	H	No machine check. Update cache. Proceed to second reference.	No machine check. Update cache.
L	L	H	H	No machine check. Invalidate cache entry. No second reference.	No machine check. Update cache.
H	L	H	L	Machine check if demand read. Invalidate cache entry. Log error in MSER. No second reference.	No machine check. Invalidate cache entry. Log error in MSER.
L	L	H	L	Machine check if demand read. Invalidate cache entry. Log error in MSER. No second reference.	No machine check. Invalidate cache entry. Log error in MSER.
X	L	L	X	No machine check. No cache change. No second reference-retry.	No machine check. Invalidate cache entry. No retry.

2.6.4 Octaword-Transfer Read Cycle

During an octaword-transfer read cycle, the rtVAX 300 reads four consecutive longwords, supplying the address of only the first longword. An octaword-transfer read cycle requires at least nine microcycles. Only the Ethernet coprocessor initiates octaword-transfer reads. The sequence of events of an octaword-transfer read cycle is as follows:

1. The rtVAX 300 transfers the physical address of the preferred longword onto the DAL<29:02> H lines. This address is always octaword-aligned, and DAL<03:02> H lines are always zero. The DAL<31:30> H lines are set to 11_2 to indicate an octaword transfer. The rtVAX 300 sends an address of only the initial longword (preferred). All other associated addresses are implied and, therefore, are not transferred. These implied addresses are generated by incrementing the count on address bits 2 and 3.
2. Lines CSDP<4:0> L are $1X111_2$ (demand read), and lines BM<3:0> L are asserted as required; WR L is negated.

3. The rtVAX 300 asserts AS L, validating lines CSDP<4:0> L, BM<3:0> L, WR L, and the address information on DAL<31:02> H.

4. Line DS L is asserted for each data transfer to indicate that the DAL lines are available to receive the incoming data. BM<3:0> L are changed with each assertion of DS.

5. The rtVAX 300 checks for a complete cycle after slipping one microcycle. This is done once every microcycle, starting at the second possible P1 rising edge. External logic indicates that the cycle is complete by one of the following three responses:

   a. If no error occurs, external logic places the requested data on the DAL<31:00> H lines and parity information on CSDP<3:0> L, asserts DPE L if parity is to be checked, and asserts RDY L, while ERR L is deasserted for each data transfer. The rtVAX 300 reads the data and parity information and deasserts DS L for every transfer. If the rtVAX 300 detects a parity error, the processor is interrupted, and the rtVAX 300 ignores the data on the DAL<31:00> H lines and terminates the cycle.

   b. If an error occurs on any longword, external logic asserts ERR L with RDY L deasserted. The rtVAX 300 ignores the data on the DAL<31:00> H lines and terminates the cycle without reading any additional data.

   c. External logic cannot request a retry of the cycle for octaword-transfer reads.

6. The rtVAX 300 completes the read cycle by deasserting DS L and AS L.

Figure 2–11 illustrates octaword-transfer read cycle timing, and Table 2–8 shows responses to this cycle.

Figure 2–11 Octaword-Transfer Read Cycle Timing

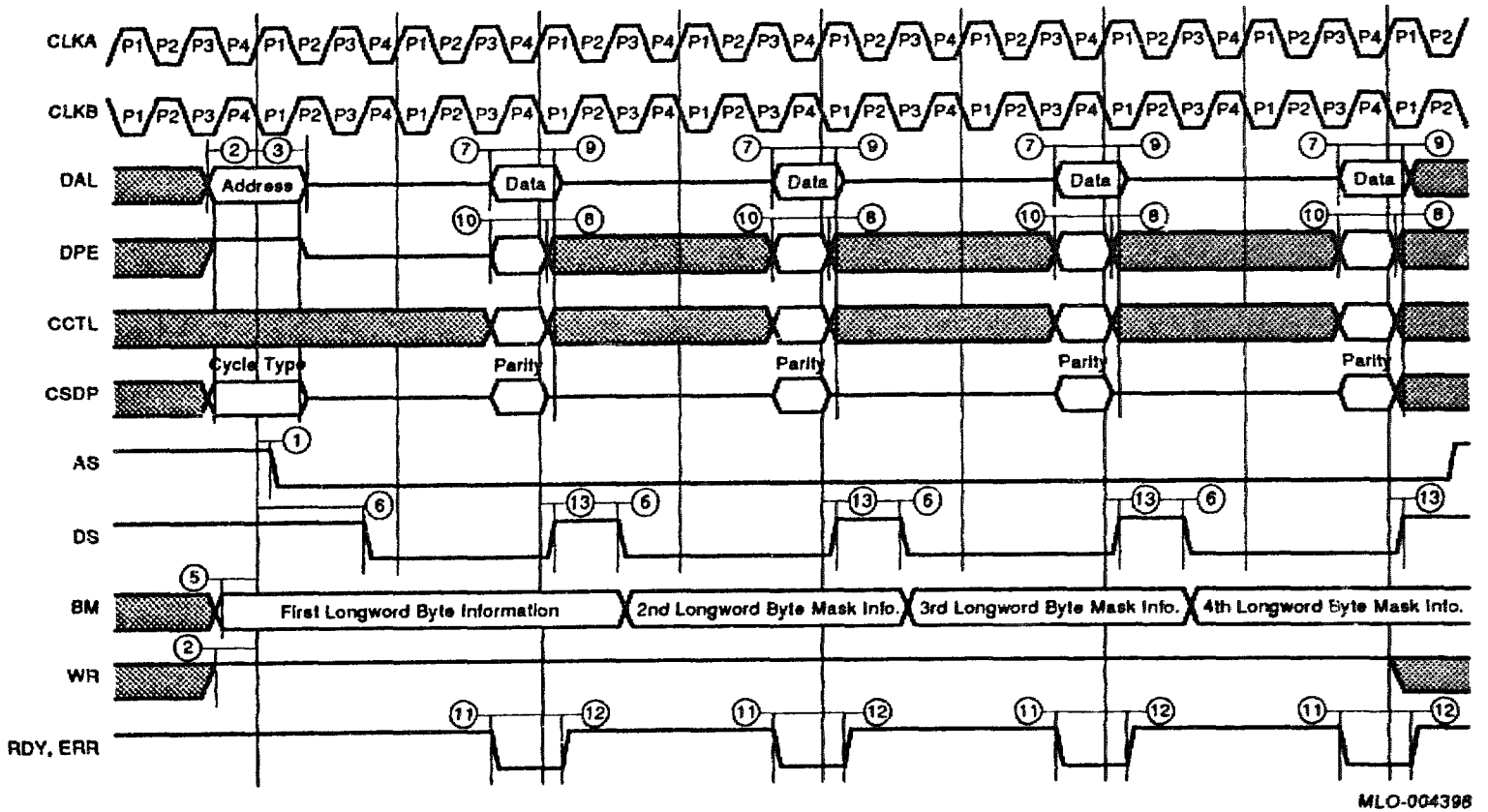


Table 2–8 rtVAX 300 Responses to Octaword-Transfer Read Cycle

CCTL L	RDY L	ERR L	Parity Error	Action for First Reference	Action for Other References
X	H	H	X	Wait for data.	Wait for data.
X	H	L	X	Cycle is aborted after end of reading current longword.	Cycle is aborted after end of reading current longword.
H	L	H	H	Proceed to second reference.	Proceed to next longword reference.
X	L	H	L	Interrupt processor. Abort cycle.	Interrupt processor. Abort cycle.
X	L	L	X	Finish reading longword. Abort cycle. No retry.	Finish reading longword. Abort cycle. No retry.

2.6.5 Single-Transfer Write Cycle

During an rtVAX 300 single-transfer write cycle, the rtVAX 300 writes one longword to the main memory or to an I/O device. An rtVAX 300 write cycle requires at least two microcycles. Each transfer can be increased in increments of one microcycle. The sequence of events of an rtVAX 300 write cycle is as follows:

1. The rtVAX 300 transfers the physical address onto the DAL<29:02> H lines. The DAL<31:30> H lines are set to 01_2 to indicate a single longword transfer.
2. BM<3:0> L and CSDP<4:0> L are asserted as required, and WR L is asserted.
3. The rtVAX 300 asserts AS L, validating CSDP<4:0> L, BM<3:0> L, WR L, and the address information on DAL<31:02> H.
4. The rtVAX 300 transfers the output data on the DAL<31:00> H lines and byte parity information onto CSDP<3:0> L, and CSDP<4> L is deasserted. The rtVAX 300 then asserts DPE L to indicate that valid parity information is available and asserts DS L to indicate that the DAL lines contain valid data.

5. The rtVAX 300 checks for a complete cycle once every two phases starting at the second possible P1 rising edge. External logic indicates that the cycle is complete by one of the following three responses:

   a. If no error occurs, external logic reads the DAL line's data and asserts RDY L while ERR L is deasserted.

   b. If an error occurs, external logic asserts ERR L with RDY L deasserted. The rtVAX 300 generates a machine check. An error is recognized only if RDY L is deasserted for two consecutive P1 sample points.

   c. External logic can request a retry of the cycle by asserting RDY L and ERR L. DAL arbitration occurs after the write operation is terminated.

6. The rtVAX 300 completes the write cycle by deasserting DS L and AS L.

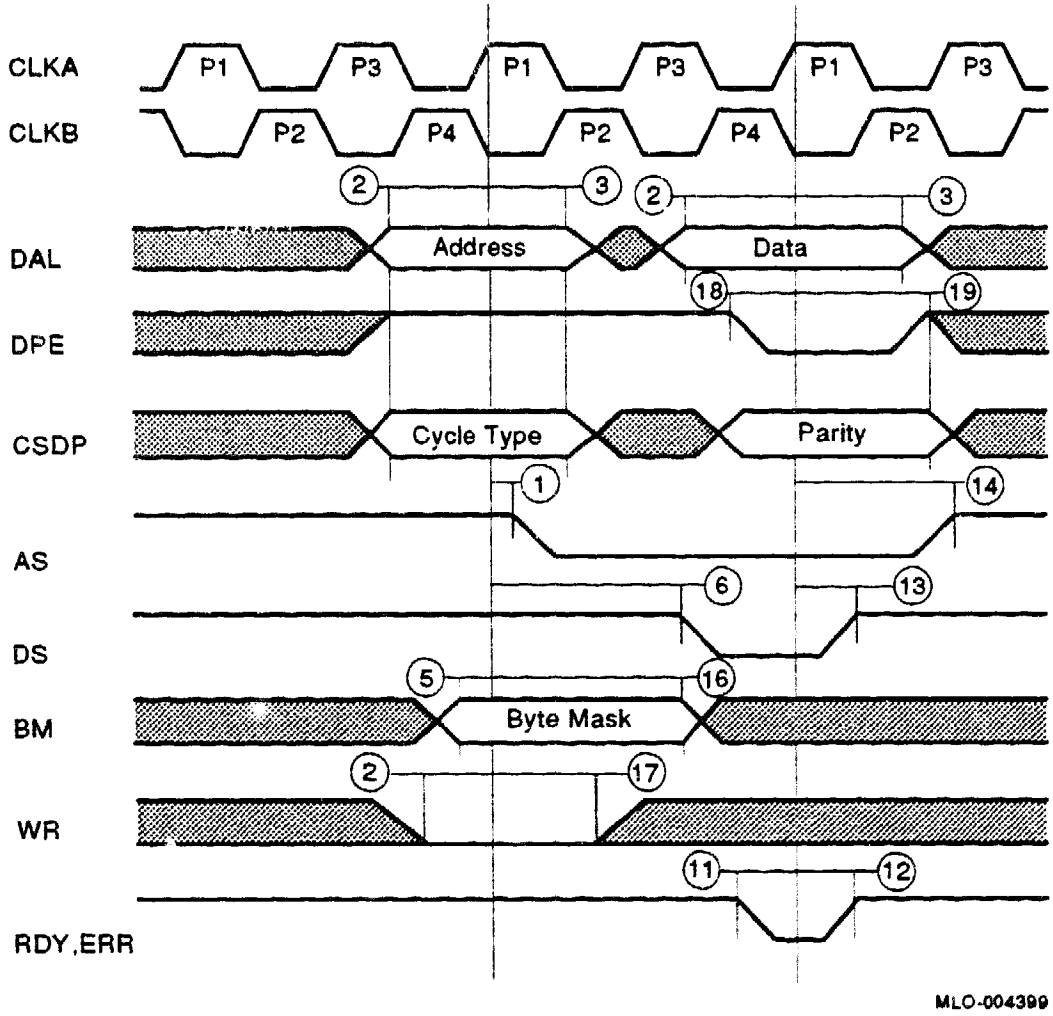
Figure 2–12 illustrates single-transfer write cycle timing.

Notes

1. I/O space writes always occur as single-transfer write cycles.

2. The Ethernet controller can issue longword write cycles. To maintain CPU cache consistency, it asserts CCTL L at the beginning of the write cycle to start a quadword cache invalidation cycle. Cache invalidation cycles require a minimum of four microcycles; therefore, if CCTL L is asserted at the beginning of the cycle, the memory system must add two wait states (a total cycle time of 400 ns) to the cycle by holding off the assertion of RDY L. If CCTL L is not asserted at the beginning of the cycle, this is a CPU longword write cycle, and 0 or 1 wait state (200 or 300 ns) memory access can be applied.

Figure 2–12 Single-Transfer Write Cycle Timing



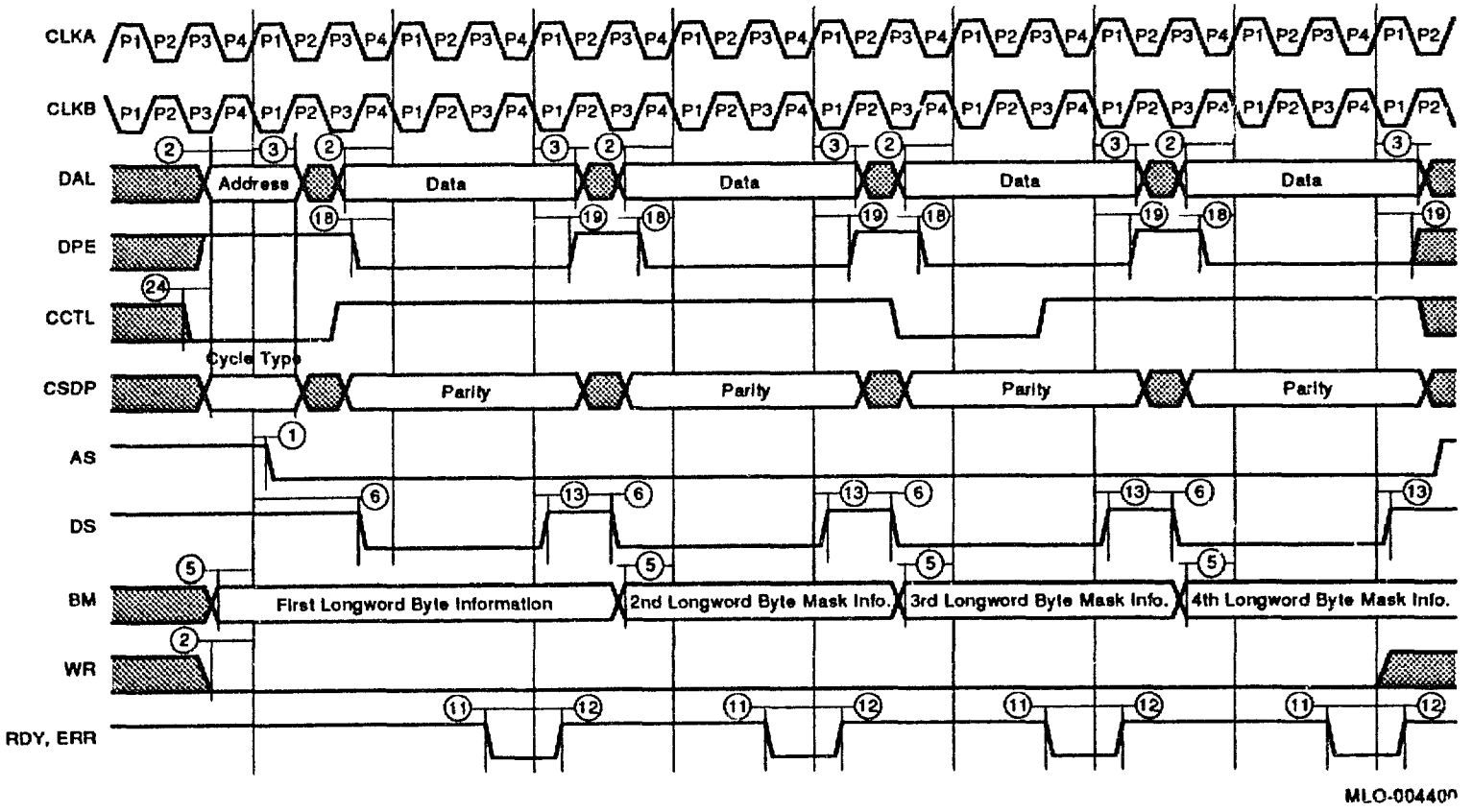
2.6.6 Octaword-Transfer Write Cycle

During an octaword-transfer write cycle, the rtVAX 300 writes four consecutive longwords, supplying the address of only the first longword. An octaword-transfer write cycle requires at least nine microcycles. Only the Ethernet coprocessor initiates octaword-transfer writes. The sequence of events of an octaword-transfer write cycle is as follows:

1. The rtVAX 300 transfers the physical address of the preferred longword onto the DAL<29:02> H lines. This address is always octaword-aligned. DAL<03:02> H are always zero. The DAL<31:30> H lines are set to 11_2 to indicate an octaword transfer. The rtVAX 300 sends an address only of the initial longword (preferred). All other associated addresses are implied and, therefore, are not transferred. These addresses are generated by incrementing the count on address bits 2 and 3.
2. The CSDP<4:0> L lines are $1X111_2$ (write no unlock); the BM<3:0> L lines are asserted as required, and WR L is asserted.
3. The rtVAX 300 asserts AS L, validating CSDP<4:0> L, BM<3:0> L, WR L, and the address information on DAL<29:02> H.
4. The rtVAX 300 drives the DAL<31:00> H lines with valid data, places parity information on CSDP<3:0> L, and CSDP<4> L remains deasserted. The rtVAX 300 then asserts DS L to indicate that the DAL lines contain valid data and asserts DPE L to indicate that CSDP<3:0> L contain valid parity information. BM<3:0> L are changed as required with each assertion of DS L.
5. The rtVAX 300 checks for a complete cycle once every microcycle, starting at the second possible P1 rising edge. External logic indicates that the cycle is complete by one of the following three responses:
   a. If no error occurs, external logic asserts RDY L, while ERR L is deasserted for each data transfer.
   b. If an error occurs on any longword, external logic asserts ERR L with RDY L deasserted. The rtVAX 300 continues the octaword write with BM<3:0> L set to 1, and only then completes the cycle.
   c. External logic cannot request a retry of the cycle for octaword-transfer reads.
6. The rtVAX 300 completes the write cycle by deasserting DS L and AS L.

Figure 2–13 illustrates octaword-transfer write cycle timing.

Figure 2–13 Octaword-Transfer Write Cycle Timing



2.6.7 Interrupt Acknowledge Cycle

An interrupt acknowledge cycle sequence is similar to a single-transfer read cycle. The sequence of events follows:

1. During the address portion of the cycle, DAL<06:02> H transfers the IPL of the interrupt being acknowledged. The DAL<31:30> H lines are set to 01_2, and the DAL<29:07> H and DAL<01:00> H lines are set to 0.
2. During the data portion of the cycle, external logic should transfer vector information on the DAL lines. Lines DAL<15:02> H contain the vector offset within the system control block. The new processor status longword priority level is determined either by the external interrupt request level that caused the interrupt or by DAL<00> H. If DAL<00> H is 0, the new IPL is determined by the interrupt being serviced; otherwise, the new IPL is changed to 17_{16}. Lines DAL<31:16> H and DAL<01> H are ignored.
3. Assertion of ERR L and RDY L in the proper sequence causes the rtVAX 300 to abort or retry the cycle. An abort or a data parity error causes the rtVAX 300 to ignore the data being read and to release the bus at the end of the cycle. This results in a passive release of the interrupt.

Figure 2–14 illustrates interrupt acknowledge cycle timing.

2.6.8 External IPR Cycles

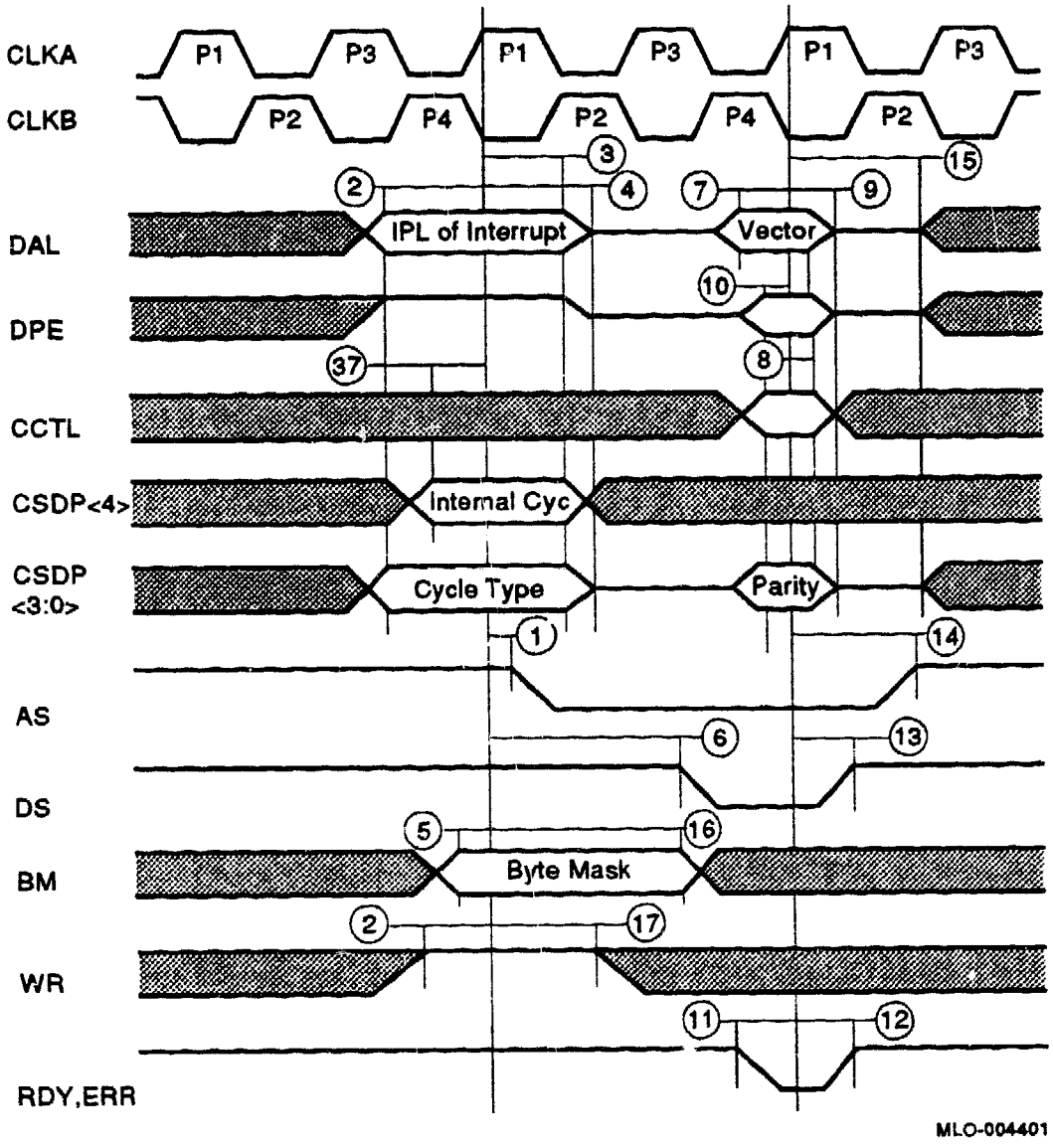
Section 2.6.8.1 and Section 2.6.8.2 discuss external IPR cycles.

2.6.8.1 External IPR Read Cycle

An external processor register read cycle is initiated when an MFPR (move from processor register) instruction reads a category 3 processor register. (Section 3.1.4.3 defines processor register categories.) The only IPR register that should be implemented externally is IPR 37_{16}. This is the I/O reset register, and any write to this register should reset all external devices. Implementing any other IPR externally may cause future software incompatibilities.

The external processor register read cycle protocol is the same as that of a single-transfer CPU read cycle, as shown in Figure 2–9; however, CSDP<2:0> L reads 010_2, indicating an external IPR cycle. This cycle requires at least two microcycles and can be extended in increments of one microcycle. The sequence of events for an external processor register read cycle is as follows:

Figure 2–14 Interrupt Acknowledge Cycle



1. The rtVAX 300 transfers the processor register onto DAL<07:02> H, and DAL<31:30> H are set to 01_2 to indicate a longword transfer. DAL<28:08> H and DAL<01:00> H are zero.
2. BM<3:0> L are all asserted, CSDP<2:0> L read 010_2, and WR L is unasserted.
3. The rtVAX 300 asserts AS L, indicating that the register number, BM<3:0> L, CSDP<3:0> L, and WR L are valid and can be latched.

4. The rtVAX 300 asserts DS L to indicate that DAL are available to receive incoming data.

5. The rtVAX 300 checks for a complete cycle once every two clock cycles, starting at the next possible P1. The response of external logic is as follows:

   a. If the processor register is implemented, external logic transfers the required data on DAL<31:00> H, asserts DPE L if parity is to be checked, and asserts RDY L with ERR L deasserted. The rtVAX 300 reads the data from DAL<31:00> H.

   b. If the processor register is not implemented, external logic asserts ERR L with RDY L deasserted. The rtVAX 300 ignores the data on DAL<31:00> H and internally forces the result to zero. A detected parity error will force the result to zero and is not reported. Therefore, it is recommended that DPE L remain asserted during a processor register read. The unimplemented response will be recognized only if RDY L is deasserted for two consecutive P1 sample points. If this response (ERR L asserted and RDY L deasserted) is detected at the first P1 sample point but RDY L is asserted at the second P1 sample point, the cycle will terminate according to the retry protocol.

   c. To request a retry, external logic asserts both RDY L and ERR L. DAL arbitration occurs after the initial read cycle is terminated.

6. The rtVAX 300 completes the read cycle by deasserting AS L and DS L.

2.6.8.2 External IPR Write Cycle

An external processor register write cycle is initiated when an MTPR (move to processor register) instruction writes a category 3 processor register. (Section 3.1.4.3 defines processor register categories.) The only IPR register that should be implemented externally is IPR 37_{16}. This is the I/O reset register, and any write to this register should reset all external devices. Implementing any other IPR externally may cause future software incompatibilities.

An external processor register write cycle protocol is the same as an rtVAX 300 write cycle, as shown in Figure 2–12; however, CSDP<2:0> L reads 010_2, indicating an external IPR cycle. The cycle requires at least two microcycles and may be extended in increments of one microcycle. The sequence of events for an external processor register write cycle is as follows:

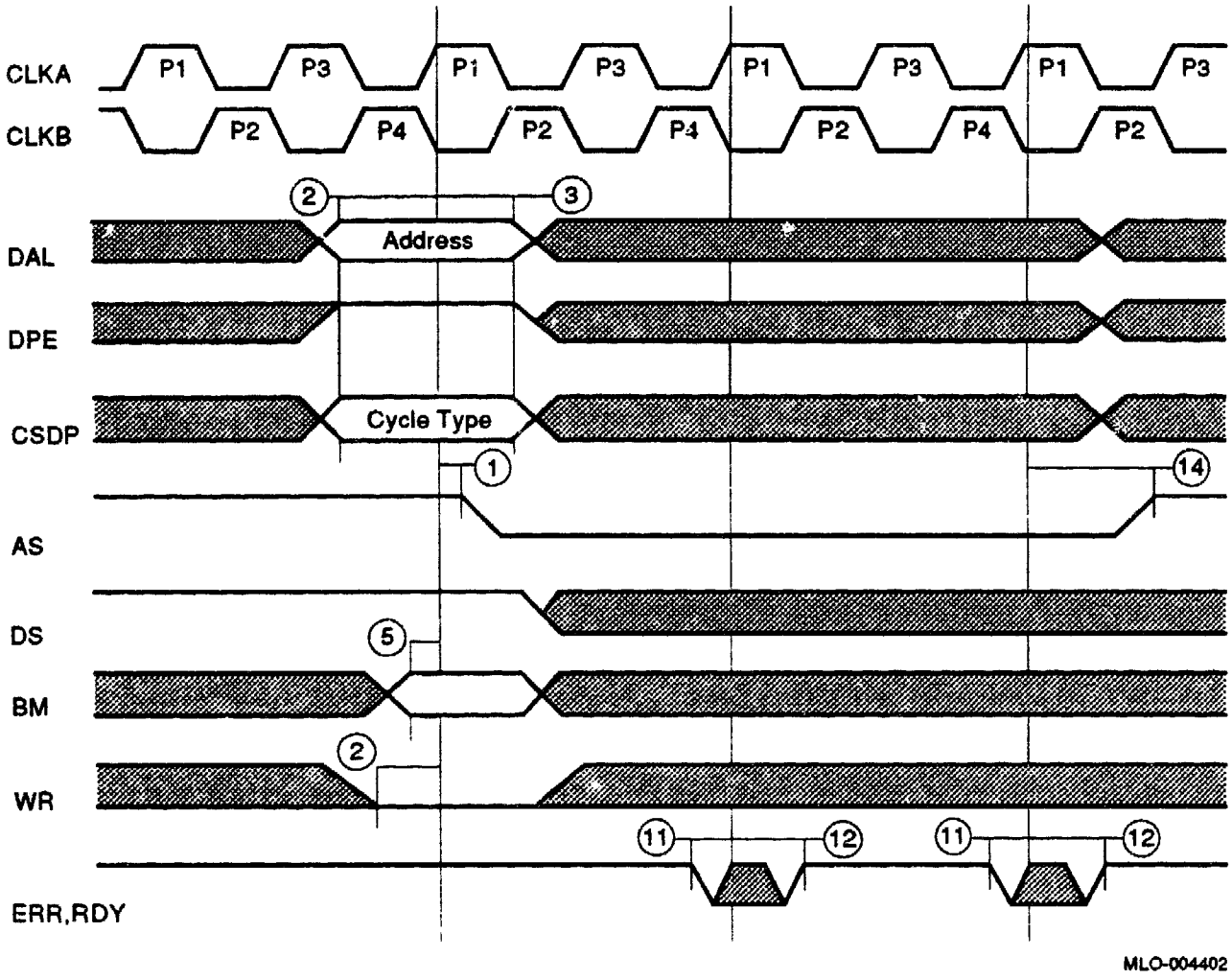
1. The rtVAX 300 transfers the processor register number onto DAL<07:02> H, and DAL<31:30> H are set to 01_2 to indicate a longword transfer. DAL<28:08> H and DAL<01:00> H are zero.

2. BM<3:0> L are all asserted, CSDP<2:0> L read 010_2, and WR L is unasserted.
3. The rtVAX 300 asserts AS L to indicate that the register number, BM<3:0> L, CSDP<3:0> L, and WR L are valid and can be latched.
4. The rtVAX 300 transfers the data onto DAL<31:00> H and asserts DS L to indicate that the DAL contains valid data.
5. The rtVAX 300 checks for a completed cycle once every two clock phases, starting at the next possible P1. The response of the external logic is as follows:
   a. If the processor register is implemented, external logic reads the data from DAL and asserts RDY L while ERR L is deasserted.
   b. If the processor register is not implemented, external logic responds either as if the register is unimplemented by asserting ERR L when RDY L is deasserted or as if the register is implemented by asserting RDY L with ERR L deasserted. Both responses have the same effect, and no special action is taken. The unimplemented response indicates no special action only if RDY L is deasserted for two consecutive P1 sample points. If this response is detected at the first P1 sample point but RDY L is asserted at the second P1 sample point, the cycle terminates according to the retry protocol.
   c. To request a retry, external logic asserts both RDY L and ERR L. DAL arbitration occurs after the initial write cycle is terminated.
6. The rtVAX 300 completes the write cycle by deasserting AS L and DS L.

2.6.9 Internal Cycles

The internal cycles start off as regular read/write cycles. However, by the end of the address portion of the cycle, all data lines are undefined. The beginning of an internal cycle is indicated by an address within the reserved space or the assertion of CSDP<4> L. The end of the cycle is indicated by the deassertion of AS L. See Figure 2–15.

Figure 2–15 Internal Read or Write Cycle



2.6.10 DMA Cycle

The rtVAX 300 can relinquish the DAL lines and related control signals upon request from an external DMA device or other processor. The sequence is as follows:

1. The external device requests control of the bus by asserting DMR L.
2. Once the rtVAX 300 finishes the current bus cycle and no pending DMA requests are present from the Ethernet coprocessor, the rtVAX 300 causes the DAL<31:00> H lines, AS L, DS L, WR L, BM<3:0> L, and CSDP<4:0> L to become high impedance and asserts DMG L. DAL bus arbitration occurs at the end of each bus cycle, so that DMA devices can intervene between bus retry cycles.

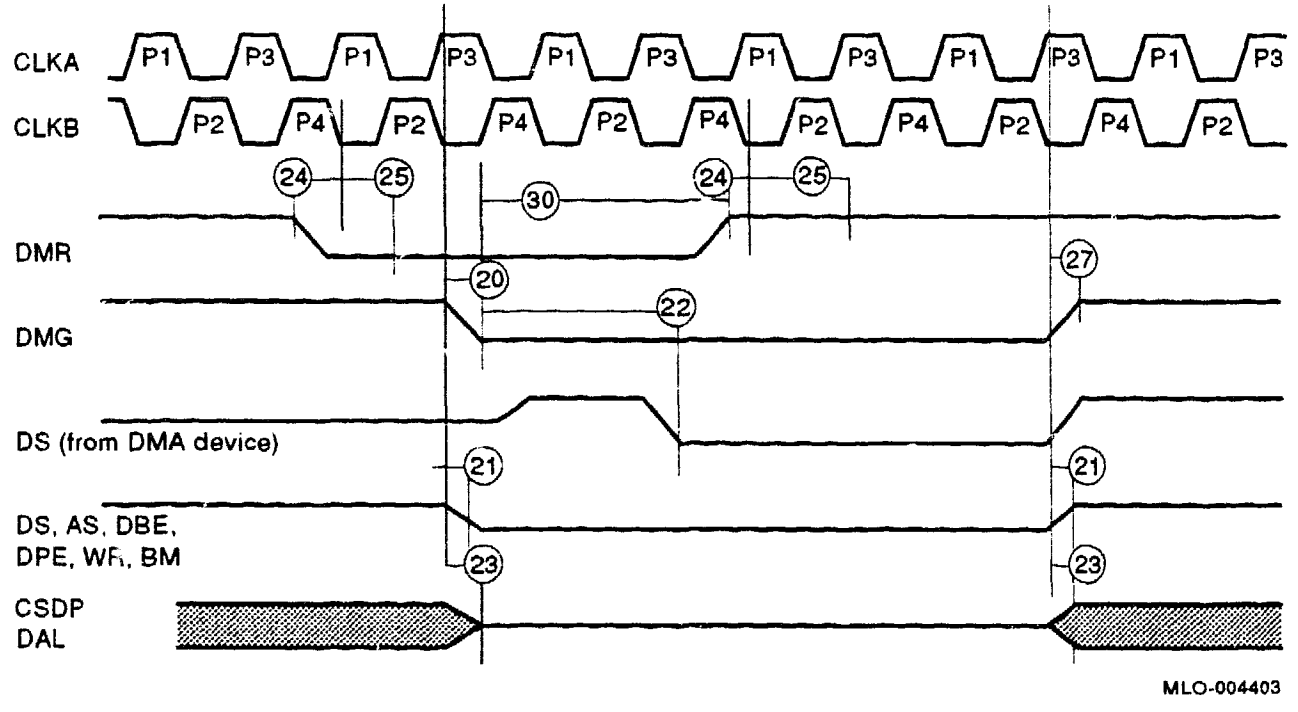
3. To return bus control to the rtVAX 300, the external device deasserts DMR L, and the rtVAX 300 responds by deasserting DMG L and returning to regular bus cycles. The rtVAX 300 does not invalidate cache entries, unless the CCTL L line is asserted appropriately.

Figure 2–16 illustrates DMA cycle timing.

Note

If an external DMA device remains DAL bus master longer than 6 μs, the Ethernet coprocessor FIFO may overflow when receiving packets. See Figure 2–16.

Figure 2–16 DMA Cycle



2.6.11 Cache Invalidate Cycle

External logic initiates a conditional cache invalidate cycle to allow the CVAX to detect and invalidate stale data stored in cache. A cache invalidate cycle requires at least four microcycles. The sequence of events is as follows:

1. After DMG L is asserted, external logic drives the address on the DAL<31:00> H lines and asserts AS L to latch the address into the rtVAX 300. External logic should also assert CCTL L to start the cache invalidate cycle.
2. The rtVAX 300 invalidates the quadword entry selected by the DMA address if the location is stored in cache.
3. External logic deasserts CCTL L and optionally reasserts CCTL L to conditionally invalidate the alternate quadword formed by inverting DAL<03> H. This allows external logic to detect and invalidate stale data stored in any naturally aligned octaword.
4. The cycle ends when external logic deasserts CCTL L and AS L.

If a cache parity error is detected during a conditional cache invalidate cycle, no machine check is generated, no invalidate occurs, and the error is logged in the MSER.

Figure 2–17 illustrates the octaword cache invalidate cycle. Figure 2–18 illustrates the quadword cache invalidate cycle.

Figure 2–17 Octaword Cache Invalidate Cycle

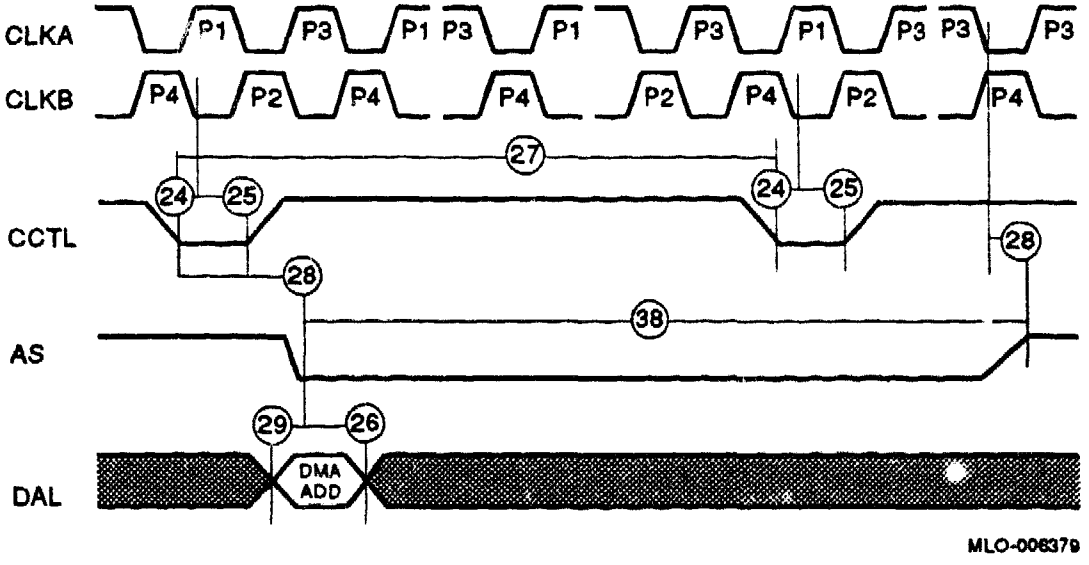
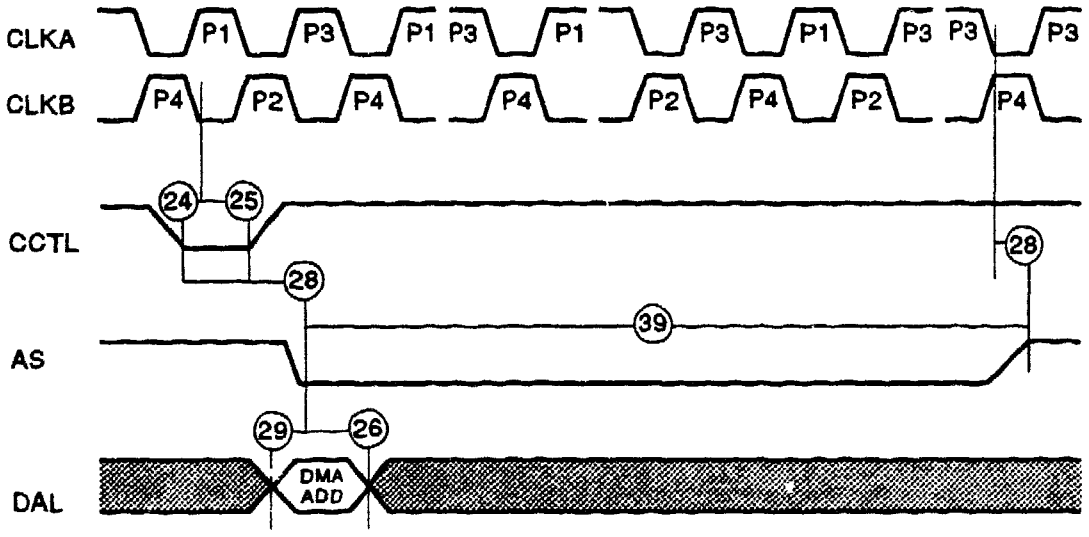
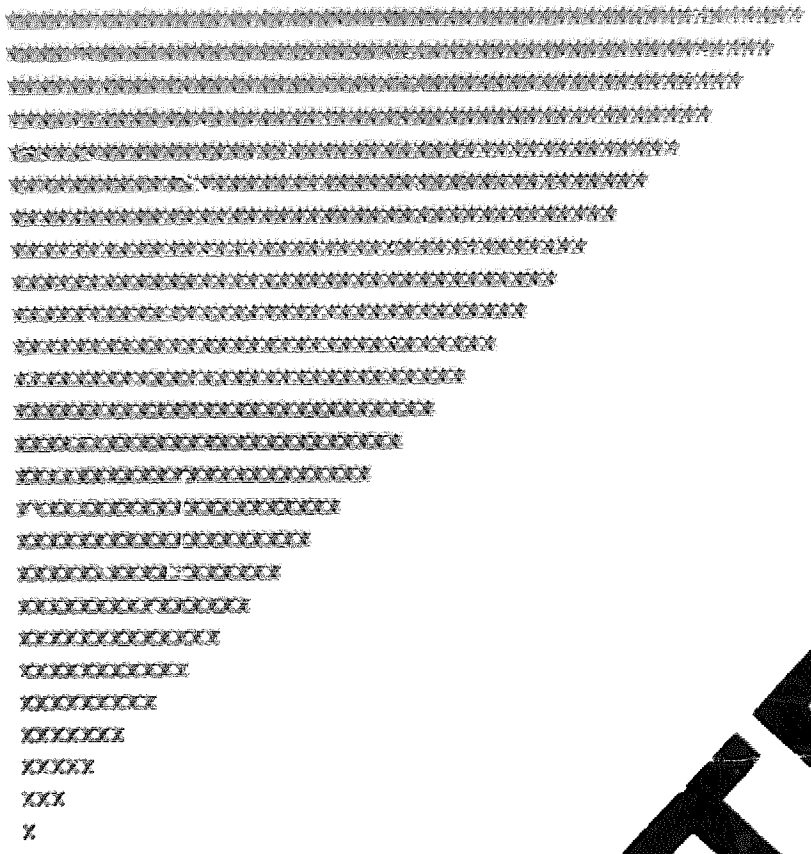
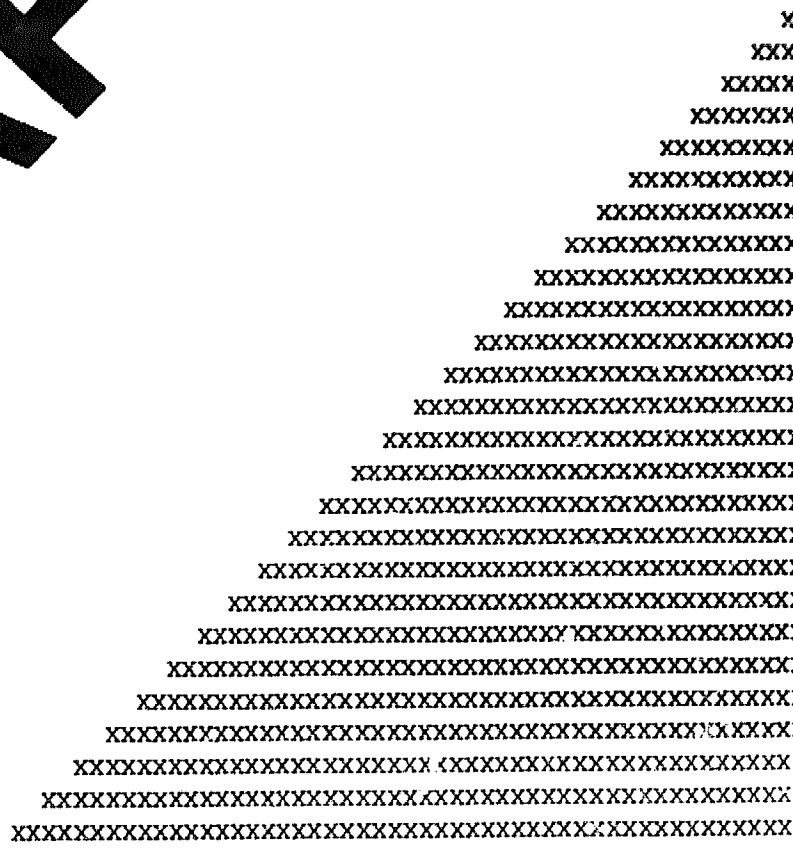


Figure 2–18 Quadword Cache Invalidate Cycle





CHAPTER 3



3

Hardware Architecture

This chapter discusses the hardware architecture features of the rtVAX 300 processor. The *VAX Architecture Reference Manual* discusses VAX hardware architecture in general and in detail.

The rtVAX 300 processor implements a compatible subset of the VAX architecture. Visible machine state consists of virtual and physical memory, 16 general-purpose registers, the processor status word, and 16 system registers.

The instruction set architecture responds to all 304 native-mode VAX instructions. Of these, 251 are implemented in the microprocessor, and the remaining 53 instructions may be implemented through software emulation, of which 21 are assisted by the chip's microcode.

All VAX data types are recognized. Of these, nine are implemented in the microprocessor: byte, word, longword, and quadword integers; variable length bit fields, variable length character strings, single precision, double precision, and extended double precision floating-point numbers. The remaining data types are supported through software emulation.

This chapter discusses the following topics:

- Central processor (Section 3.1)
- Floating-point accelerator (Section 3.2)
- Cache memory (Section 3.3)
- Hardware initialization (Section 3.4)
- Console interface registers (Section 3.5)
- Ethernet coprocessor (Section 3.6)

3.1 Central Processor

The central processor of the rtVAX 300 supports the CVAX chip subset (plus six additional string instructions) of the VAX instruction set and data types and full VAX memory management. It is implemented by a single VLSI chip called the CVAX.

3.1.1 Data Types

The rtVAX 300 processor supports the following subset of VAX data types:

- Byte
- Word
- Longword
- Quadword
- Character string
- Variable length bit field

Macrocode emulation can provide support for the remaining VAX data types.

3.1.2 Instruction Set

The rtVAX 300 processor implements the following subset of VAX instruction set types in microcode:

- Integer arithmetic and logical
- Address
- Variable length bit field
- Control
- Procedure call
- Miscellaneous
- Queue
- Character string moves (MOVC3, MOVC5, CMPC3, CMPC5, LOCC, SCANC, SKPC, and SPANC)
- Operating system support
- F_floating
- G_floating
- D_floating

The rtVAX 300 CVAX chip provides special microcode assistance to aid the macrocode emulation of the following instruction groups:

- Character string (except MOVC3, MOVC5, CMPC3, CMPC5, LOCC, SCANC, SKPC, and SPANC)
- Decimal string
- CRC
- EDITPC
- H_floating

Octaword instruction groups are not implemented but may be emulated by macrocode.

3.1.3 Microcode-Assisted Emulated Instructions

The rtVAX 300 processor provides microcode assistance for the emulation of these instructions by system software. The processor processes the operand specifiers, creates a standard argument list, and takes an emulated instruction fault. Table 3–1 describes microcode-assisted emulated instructions.

Table 3–1 Microcode-Assisted Emulated Instructions

OP	Mnemonic and Arguments	Description	n z v c	Exceptions[1]
20	ADDP4 addlen.rw, addaddr.ab, sumlen.rw, sumaddr.ab	Add packed 4-operand	* * * 0	rsv, dov
21	ADDP6 add1len.rw, add1addr.ab, add2len.rw, add2addr.ab, sumlen.rw, sumaddr.ab	Add packed 6-operand	* * * 0	rsv, dov
F8	ASHP cnt.rb, srclen.rw, srcaddr.ab, round.rb, dstlen.rw, dstaddr.ab	Arithmetic shift and round packed	* * * 0	rsv, dov
35	CMPP3 len.rw, src1addr.ab, src2addr.ab	Compare packed 3-operand	* * 0 0	
37	CMPP4 src1len.rw, src1addr.ab, src2len.rw, src2addr.ab	Compare packed 4-operand	* * 0 0	
0B	CRC tbl.ab, inicrc.rl, strlen.rw, stream.ab	Calculate cyclic redundancy check	* * 0 0	
F9	CVTLP src.rl, dstlen.rw, dstaddr.ab	Convert long to packed	* * * 0	rsv, dov

[1] **rsv** = reserved operand fault; **iov** = integer overflow trap; **dov** = decimal overflow trap; **ddvz** = decimal divide by zero trap.

(continued on next page)

Table 3–1 (Cont.) Microcode-Assisted Emulated Instructions

OP	Mnemonic and Arguments	Description	n z v c	Exceptions[1]
36	CVTPL srclen.rw, srcaddr.ab, dst.wl	Convert packed to long	* * * 0	rsv, iov
08	CVTPS srclen.rw, srcaddr.ab, dstlen.rw, dstaddr.ab	Convert packed to leading separate	* * * 0	rsv, dov
09	CVTSP srclen.rw, srcaddr., dstlen.rw, dstaddr.ab	Convert leading separate to packed	* * * 0	rsv, dov
24	CVTPT srclen.rw, srcaddr.ab, tbladdr.ab, dstlen.rw, dstaddr.ab	Convert packed to trailing	* * * 0	rsv, dov
26	CVTTP srclen.rw, srcaddr.ab, tbladdr.ab, dstlen.rw, dstaddr.ab	Convert packed to trailing	* * * 0	rsv, dov
27	DIVP divrlen.rw, divraddr.ab, divdlen.rw, quolen.rw, quoaddr.ab	Divide packed	* * * 0	rsv, dov, ddvz
38	EDITPC srclen.rw, srcaddr.ab, pattern.ab, dstaddr.ab	Edit packed to character string	* * * *	rsv, dov
39	MATCHC objlen.rw, objaddr.ab, srclen.rw, srcaddr.ab	Match characters	0 * 0 0	
34	MOVP len.rw, srcaddr.ab, dstaddr.ab	Move packed	* * 0 0	
2E	MOVTC srclen.rw, srcaddr.ab, fill.rb, tbladdr.ab, dstlen.rw, dstaddr.ab	Move translated characters	* * 0 *	
2F	MOVTUC srclen.rw, srcaddr.ab, esc.rb, tbladdr.ab, dstlen.rw, dstaddr.ab	Move translated until character	* * * *	
25	MULP mulrlen.rw, mulraddr.ab, muldlen.rw, muldaddr.ab, prodlen.rw, prodaddr.ab	Multiply packed	* * * 0	rsv, dov
22	SUBP4 sublen.rw, subaddr.ab, diflen.rw, difaddr.ab	Subtract packed 4-operand	* * * 0	rsv, dov
23	SUBP6 sublen.rw, subaddr.ab, minlen.rw, minaddr.ab, diflen.rw, difaddr.ab	Subtract packed 6-operand	* * * 0	rsv, dov

[1] **rsv** = reserved operand fault; **iov** = integer overflow trap; **dov** = decimal overflow trap; **ddvz** = decimal divide by zero trap.

3.1.4 Processor State

The processor state is stored in processor registers rather than in memory. The processor state is composed of 16 general-purpose registers (GPRs), the processor status longword (PSL), and the internal processor registers (IPRs).

Nonprivileged software can access the GPRs and the processor status word (bits <15:00> of the PSL). Only privileged software can access the IPRs and bits <31:16> of the PSL. The IPRs are explicitly accessible only by the move to processor register (MTPR) and move from processor register (MFPR) instructions, which can be executed only while running in kernel mode.

3.1.4.1 General-Purpose Registers

The rtVAX 300 implements 16 general-purpose registers as specified in the *VAX Architecture Reference Manual*. These registers are used for temporary storage, as accumulators, and as base and index registers for addressing. These registers are denoted R0 through R15. The bits of a register are numbered from the right <0> through <31>.

Certain of these registers have been assigned special meaning by the VAX architecture.

- R15 is the program counter (PC). The PC contains the address of the next instruction byte of the program.
- R14 is the stack pointer (SP). The SP contains the address of the top of the processor defined stack.
- R13 is the frame pointer (FP). The VAX procedure call convention builds a data structure on the stack called a *stack frame*. The FP contains the address of the base of this data structure.
- R12 is the argument pointer (AP). The VAX procedure call convention uses a data structure called an *argument list*. The AP contains the address of the base of this data structure.

Consult the *VAX Architecture Reference Manual* for more information on the operation and use of these registers.

3.1.4.2 Processor Status Longword

The processor status longword (PSL) is implemented as specified in the *VAX Architecture Reference Manual*, which should be consulted for a detailed description of the operation of this register. The PSL is saved on the stack when an exception or interrupt occurs and is saved in the process control block (PCB) on a process context switch. Nonprivileged software can access bits <15:00>; only privileged software can access bits <31:16>. Processor

initialization sets the PSL to $041F0000_{16}$. Figure 3–1 shows the format of the processor status longword; Table 3–2 describes the fields within the PSL.

Figure 3–1 Processor Status Longword

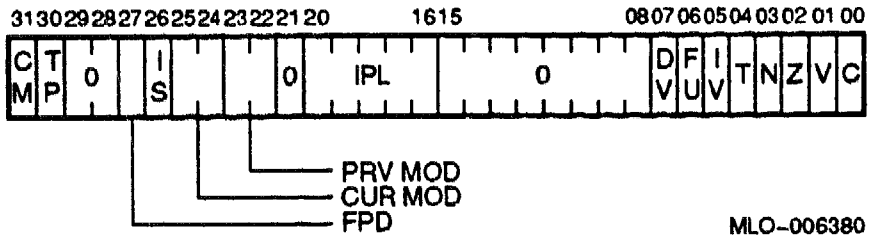


Table 3–2 Processor Status Longword Bit Map

Data Bit	Definition
<31>	Compatibility mode (CM). Reads as zero. The rtVAX 300 does not support compatibility mode.
<30>	Trace pending (TP).
<29:28>	Unused. Must be written as zero.
<27>	First part done (FPD).
<26>	Interrupt stack (IS).
<25:24>	Current mode (CUR MOD).
<23:22>	Previous mode (PRV MOD).
<21>	Unused. Must be written as zero.
<20:16>	Interrupt priority level (IPL).
<15:8>	Unused. Must be written as zero.
<7>	Decimal overflow trap enable (DV). Has no effect on rtVAX 300 hardware. Can be used by macrocode which emulates VAX decimal instructions.
<6>	Floating underflow fault enable (FU).
<5>	Integer overflow trap enable (IV).
<4>	Trace trap enable (T).

(continued on next page)

Table 3–2 (Cont.) Processor Status Longword Bit Map

Data Bit	Definition
<3>	Negative condition code (N).
<2>	Zero condition code (Z).
<1>	Overflow condition code (V).
<0>	Carry condition code (C).

3.1.4.3 Internal Processor Registers

The rtVAX 300 IPRs can be accessed by using the MFPR and MTPR privileged instructions. Each IPR falls into one of the following categories:

1. Implemented by rtVAX 300 (in the CVAX chip).
2. Implemented by rtVAX 300 (and all designs that use the CVAX chip) uniquely.
3. Not implemented, timed out by the DAL bus timer after 32 µs. Read as 0. NOP on write.
4. Access not allowed; accesses result in a reserved operand fault.
5. Accessible, but not fully implemented. Accesses yield unpredictable results.
6. Externally implemented on application module.

Table 3–3 lists each rtVAX 300 IPR, its mnemonic, its access type (read or write), and its category number.

Table 3–3 Internal Processor Registers

Decimal	Hex	Register	Mnemonic	Type	Category[1]
0	0	Kernel stack pointer	KSP	r/w	1
1	1	Executive stack pointer	ESP	r/w	1
2	2	Supervisor stack pointer	SSP	r/w	1
3	3	User stack pointer	USP	r/w	1
4	4	Interrupt stack pointer	ISP	r/w	1
7:5	7:5	Reserved			3

[1]I = register initialized on power-up and by negation of RST when the processor is halted.

(continued on next page)

Table 3–3 (Cont.) Internal Processor Registers

Decimal	Hex	Register	Mnemonic	Type	Category[1]
8	8	P0 base register	P0BR	r/w	1
9	9	P0 length register	P0LR	r/w	1
10	A	P1 base register	P1BR	r/w	1
11	B	P1 length register	P1LR	r/w	1
12	C	System base register	SBR	r/w	1
13	D	System length register	SLR	r/w	1
15:14	F:E	Reserved			3
16	10	Process control block base	PCBB	r/w	1
17	11	System control block base	SCBB	r/w	1
18	12	Interrupt priority level	IPL	r/w	1 I
19	13	AST level	ASTLVL	r/w	1 I
20	14	Software interrupt request	SIRR	w	1
21	15	Software interrupt summary	SISR	r/w	1 I
23:22	17:16	Reserved			3
24	18	Interval clock control/status	ICCS	r/w	2 I
25	19	Next interval count	NICR	w	3
26	1A	Interval count	ICR	r	3
27	1B	Time-of-year clock register	TODR	r/w	3
28	1C	Console storage receiver status	CSRS	r/w	5 I
29	1D	Console storage receiver data	CSRD	r	5 I
30	1E	Console storage transmit status	CSTS	r/w	5 I
31	1F	Console storage transmit data	CSTD	w	5 I
32	20	Console receiver control/status	RXCS	r/w	3
33	21	Console receiver data buffer	RXDB	r	3
34	22	Console transmit control/status	TXCS	r/w	3
35	23	Console transmit data buffer	TXDB	w	3
36	24	Translation buffer disable	TBDR	r/w	3
37	25	Cache disable	CADR	r/w	2 I

[1] I = register initialized on power-up and by negation of RST when the processor is halted.

(continued on next page)

Table 3–3 (Cont.) Internal Processor Registers

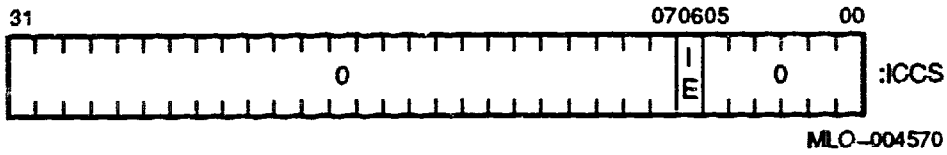
Decimal	Hex	Register	Mnemonic	Type	Category[1]
38	26	Machine check error summary	MCESR	r/w	3
39	27	Memory system error	MSER	r/w	2 I
41:40	29:28	Reserved			3
42	2A	Console saved PC	SAVPC	r	2
43	2B	Console saved PSL	SAVPSL	r	2
47:44	2F:2C	Reserved			3
48	30	SBI Fault/status	SBIFS	r/w	3
49	31	SBI silo	SBIS	r	3
50	32	SBI silo comparator	SBISC	r/w	3
51	33	SBI maintenance	SBIMT	r/w	3
52	34	SBI error	SBIER	r/w	3
53	35	SBI timeout address	SBITA	r	3
54	36	SBI quadword clear	SBIQC	w	3
55	37	I/O bus reset	IORESET	w	6
56	38	Memory management enable	MAPEN	r/w	1
57	39	TB invalidate all	TBIA	w	1
58	3A	TB invalidate single	TBIS	w	1
59	3B	TB data	TBDATA	r/w	3
60	3C	Microprogram break	MBRK	r/w	3
61	3D	Performance monitor enable	PMR	r/w	3
62	3E	System identification	SID	r	1
63	3F	Translation buffer check	TBCHK	w	1
127:64	7F:40	Reserved			4

[1]I = register initialized on power-up and by negation of RST when the processor is halted.

3.1.5 Interval Timer

The rtVAX 300 interval timer, IPR 24, is implemented according to the *VAX Architecture Reference Manual* for subset processors. The interval clock control /status register (ICCS) is implemented as the standard subset of the standard VAX ICCS in the CVAX chip; NICR and ICR are not implemented (Figure 3–2).

Figure 3–2 Interval Timer



Bit	Definition
<31:07>	Unused. Read as zeros, must be written as zeros.
<06>	Interrupt enable (IE). Read/write. This bit enables and disables the interval timer interrupts. When the bit is set, an interval timer interrupt is requested every 10 ms with an error of less than 0.01 percent. When the bit is clear, interval timer interrupts are disabled. This bit is cleared on power-up.
<05:00>	Unused. Read as zeros, must be written as zeros.

Interval timer requests are posted at IPL 16_{16} with a vector of $C0_{16}$. The interval timer is the highest priority device at this IPL.

3.1.6 ROM Address Space

The entire 128K-byte boot and diagnostic ROM may be read from local register I/O space (addresses 20040000 through 2007FFFF). Writes to this space result in a machine check.

3.1.7 Resident Firmware Operation

The rtVAX 300 resident firmware can be entered by transferring program control to location 20040000.

Section 3.1.9 lists the various halt conditions that cause the CVAX processor to transfer program control to location 20040000.

When running, the rtVAX 300-resident firmware provides the services expected of a VAX console system. In particular, the following services are available:

- Bootstrap following processor halts or initial power-up
- An interactive command language allowing the user to examine and alter the state of the processor
- Diagnostic tests executed on power-up that check out the CVAX processor, the memory system, and the Ethernet coprocessor

3.1.8 Memory Management

The rtVAX 300 implements full VAX memory management, as defined in the *VAX Architecture Reference Manual*. System space addresses are virtually mapped through single-level page tables, and process space addresses are virtually mapped through 2-level page tables. Refer to the *VAX Architecture Reference Manual* for descriptions of the virtual to physical address translation process and the format of VAX page table entries (PTEs).

3.1.8.1 Translation Buffer

To reduce overhead associated with translating virtual addresses to physical addresses, the rtVAX 300 processor employs a 28-entry, fully associative translation buffer for caching VAX PTEs in modified form. Each entry can store a modified PTE for translating virtual addresses in either the VAX process space or VAX system space. The translation buffer is flushed whenever memory management is enabled or disabled, for example, by writes to IPR 56, when any page table base or length registers are modified, for example, by writes to IPRs 8 to 13, and by writing to IPR 57 (TBIA) or IPR 58 (TBIS).

Each entry is divided into two parts: a 23-bit tag register and a 31-bit PTE register. The tag register stores the virtual page number (VPN) of the virtual page that the corresponding PTE register maps; the PTE register stores the 21-bit PFN field, the PTE<V> bit, the PTE<M> bit, and an 8-bit partially decoded representation of the 4-bit VAX PTE PROT field, from the corresponding VAX PTE, and a translation buffer valid (TB<V>) bit.

During virtual to physical address translation, the contents of the 28 tag registers are compared with the virtual page number field (bits <31:9>) of the virtual address of the reference. If there is a match with one of the tag registers, a translation buffer hit has occurred, and the contents of the corresponding PTE register are used for the translation.

If there is no match, the translation buffer does not contain the necessary VAX PTE information to translate the address of the reference, and the PTE must be fetched from memory. Upon fetching the PTE, the translation buffer is updated by replacing the entry that is selected by the replacement pointer. Since this pointer is moved to the next sequential translation buffer entry whenever it is pointing to an entry that is accessed, the replacement algorithm is not last used (NLU).

3.1.8.2 Memory Management Control Registers

Four IPRs control the memory management unit (MMU): IPR 56 (MAPEN), IPR 57 (TBIA), IPR 58 (TBIS), and IPR 63 (TBCHK).

Memory management can be enabled/disabled through IPR 56 (MAPEN). Writing 0 to this register with an MTPR instruction disables memory management; writing a 1 enables memory management. Writes to this register flush the translation buffer. To determine whether or not memory management is enabled, IPR 56 is read by the MFPR instruction. Translation buffer entries that map a particular virtual address can be invalidated by using the MTPR instruction to write the virtual address to IPR 58 (TBIS).

Note

Whenever software changes a valid PTE for the system or current process region, or a system PTE that maps any part of the current process page table, all process pages mapped by the PTE must be invalidated in the translation buffer.

The entire translation buffer can be invalidated by using the MTPR instruction to write a 0 to IPR 57 (TBIA).

The translation buffer can be checked to see if it contains a valid translation for a particular virtual page by using the MTPR instruction to write a virtual address within that page to IPR 63 (TBCHK). If the translation buffer contains a valid translation for the page, the condition code V bit (bit <1> of the PSL) is set.

Note

The TBIS, TBIA, and TBCHK IPRs are write only. The operation of an MFPR instruction from any of these registers is undefined.

3.1.9 Exceptions and Interrupts

Both exceptions and interrupts divert execution from the normal flow of control. An exception is caused by the execution of the current instruction and is typically handled by the current process, for example, an arithmetic overflow; an interrupt is caused by some activity outside the current process and typically transfers control outside the process, for example, an interrupt from an external hardware device.

The following events cause interrupts:

- HLT L (nonmaskable)
- PWRFL L (IPL $1E_{16}$)
- Interrupt from a peripheral device received on IRQ<3:0> L (IPL 14_{16} to IPL 17_{16}):

  Interval timer (IPL 16_{16})
  Ethernet coprocessor (IPL 15_{16})
  Console DUART (IPL 14_{16})

- Software interrupt invoked by MTPR src,_#SIRR (IPL 01_{16} to $0F_{16}$)
- AST delivery when REI restores a PSL with a mode $\geq$ ASTLVL (IPL 02_{16})

Each device has a separate interrupt vector location in the system control block (SCB). Thus, interrupt service routines do not need to poll devices in order to determine which device interrupted. The vector address for each device is determined by hardware.

To reduce interrupt overhead, no memory mapping information is changed when an interrupt occurs. Thus, the instructions, data, and contents of the interrupt vector for an interrupt service routine must be in the system address space or present in every process at the same address.

3.1.10 Interrupt Control

The IRQ<3:0> L, HLT L, and PWRFL L inputs to the processor and three registers control the hardware interrupt system. Asserting any of the input pins generates an interrupt at the hardware level given in Table 3–4. The three registers are used to control the software interrupt system.

3.1.11 Internal Hardware Interrupts

The rtVAX 300 10 ms interval timer interrupts at IPL 16_{16}, and the Ethernet coprocessor can interrupt the rtVAX 300 at IPL 15_{16}. These interrupts have higher priority than IRQ<2> L and IRQ<1> L, which also interrupt at IPL 16_{16} and IPL 15_{16}.

3.1.12 Dispatching Interrupts: Vectors

The system control block is a page-aligned table containing the vectors used to dispatch exceptions and interrupts to the appropriate service routines. Only device vectors in the range of 100_{16} to $7FFC_{16}$ should be used, except by devices emulating console storage and terminal hardware. The console reserves vectors 02C0 to 02CC and interrupts at IPL 14_{16} by means of IRQ<0> L.

The rtVAX 300 internal Ethernet coprocessor can interrupt at IPL 15_{16}. This interrupt is daisy-chained to the external interrupt request IRQ<1> L and is serviced before IRQ<1> L. The vector is set by writing to the Ethernet coprocessor CSR0 register at location 20180000.

3.1.12.1 Interrupt Action

Interrupts can be divided into two classes: nonmaskable and maskable.

Nonmaskable interrupts cause a halt through the hardware halt procedure which saves the PC, PSL, MAPEN<0>, and a halt code in IPRs, raises the processor IPL to $1F_{16}$, and then passes control to the resident firmware. The firmware dispatches the interrupt to the appropriate service routine, based on the halt code and hardware event indicators. Nonmaskable interrupts with a halt code of 3 cannot be blocked, because this halt code is generated after a hardware reset.

Maskable interrupts save the PC and PSL, raise the processor IPL to the priority level of the interrupt (except for vectors with DAL<0> H set to 1, where the processor IPL is set to 17_{16}, independent of the level at which the interrupt was received), and dispatch the interrupt to the appropriate service routine through the SCB.

Table 3–4 lists the various interrupt conditions for the rtVAX 300 plus their associated priority levels and SCB offsets.

Note

If the external device sets DAL<00> H of the vector that it places on the bus, the rtVAX 300 processor raises the IPL to 17_{16} after responding to interrupts generated by the assertion of IRQ<3> L, IRQ<2> L, IRQ<1> L, or IRQ<0> L. The rtVAX 300 maintains the IPL at the priority of the interrupt, if DAL<00> H is zero.

Table 3–4 Interrupts

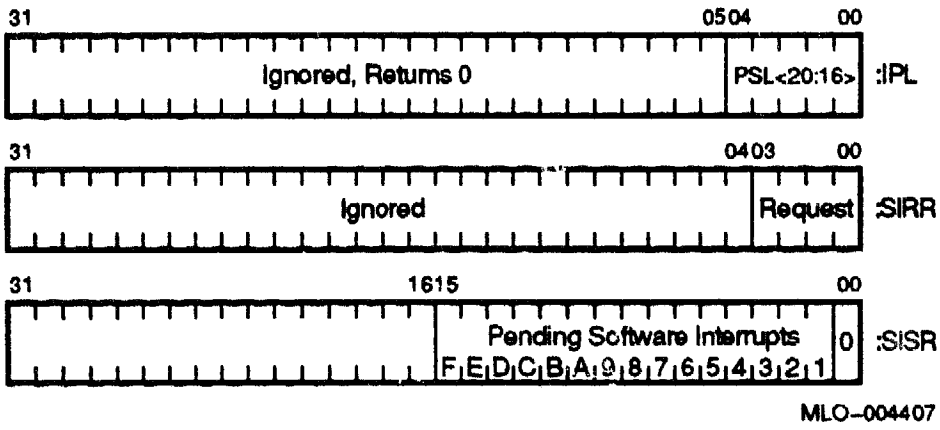
Priority Level$_{16}$	Interrupt Condition	SCB Offset
Nonmaskable	Reset asserted	[1]
	HLT L asserted	[2]
1F	Unused	
1E	PWRFL L asserted	0C
1D–18	Unused	
17	IRQ<3> L asserted	Device vector on DAL<15:02> H
16	Interval timer interrupt	C0
	IRQ<2> L asserted	Device vector on DAL<15:02> H
15	Ethernet coprocessor interrupt	Vector placed in Ethernet coprocessor CSR0
	IRQ<1> L asserted	Device vector on DAL<15:02> H
14	Console terminal	02C0
	IRQ<0> L asserted	Device vector on DAL<15:02> H
13–10	Unused	
0F–01	Software interrupt requests	84–BC

[1]This condition forces execution to the resident firmware's dispatcher with a halt code of 3 (hardware reset).

[2]This condition forces execution to the resident firmware's dispatcher with a halt code of 2 (external halt).

Three IPRs control the interrupt system: IPR 18, the interrupt priority level register (IPL), IPR 20, the software interrupt request register (SIRR), and IPR 21, the software interrupt summary register (SISR). The IPL is used for loading the processor priority. The SIRR is used for generating software interrupt requests. The SISR records pending software interrupt requests at levels 1 through 15. Figure 3–3 shows the format of these registers. Refer to the *VAX Architecture Reference Manual* for more information on these registers.

Figure 3–3 Interrupt Registers



3.1.12.2 Halting the Processor

The rtVAX 300 is a dynamic device and cannot be halted by disabling its clock input (CLKIN). The CPU is halted either by executing the HALT instruction in kernel mode or by asserting the HLT L signal.

Assertion of the HLT L signal results in the execution of a nonmaskable interrupt by the CPU. HLT L is edge-sensitive and must be asserted for at least two microcycles to guarantee its being sensed by the CPU. In order for another HLT L to be recognized, HLT L must be deasserted for at least two microcycles. A break detection circuit may be added to the console receive line to assert the HLT line when the console break key is depressed. (Chapter 6 gives details of and illustrates this circuit.)

Execution of the HALT instruction or assertion of HLT L causes the execution of macro instructions to be suspended and the restart process to be entered. The initiation of the restart process is under control of the processor microcode, which saves the processor state and passes control to the internal boot and diagnostic ROMs beginning at physical address 20040000. These ROMs implement the console emulation program and give control to the console, displaying the >>> prompt when a halt condition is detected.

3.1.12.3 Exceptions

There are three types of exceptions:

- Trap
- Fault
- Abort

A *trap* is an exception that occurs at the end of the instruction that caused the exception. After an instruction traps, the PC saved on the stack is the address of the next instruction that would normally have been executed, and the instruction can be restarted.

A *fault* is an exception that occurs during an instruction and leaves the registers and memory in a consistent state, such that the elimination of the fault condition and restarting the instruction gives correct results. After an instruction faults, the PC saved on the stack points to the instruction that faulted.

An *abort* is an exception that occurs during an instruction and leaves the value of the registers and memory unpredictable, such that the instruction cannot necessarily be correctly restarted, completed, simulated, or undone. After an instruction aborts, the PC saved on the stack points to the instruction that was aborted, which may or may not be the instruction that caused the abort; the instruction may or may not be restarted, depending on the class of the exception and the contents of the parameters that were saved.

Exceptions are grouped into six classes:

- Arithmetic
- Instruction execution
- Memory management
- Operand reference
- System failure
- Tracing

Table 3–5 lists exceptions by class. Exceptions save the PC and PSL, and in some cases, one or more parameters, on the stack. Most exceptions do not change the IPL of the processor (except the exceptions in serious system failures class, which set the processor IPL to $1F_{16}$) and cause the exception to be dispatched to the appropriate service routine through the SCB (except for the interrupt stack not valid exception, and exceptions that occur while an interrupt or another exception are being serviced, which cause the exception to be dispatched to the appropriate service routine by the resident firmware).

The *VAX Architecture Reference Manual* describes the exceptions listed in Table 3–5 (except machine check) in greater detail. Section 3.1.12.4 describes the machine check exception in greater detail. Table 3–8 in Section 3.1.12.7 describes exceptions that can occur while an interrupt or another exception are being serviced.

Table 3–5 Exceptions

SCB Offset$_{16}$	Type	Meaning
Arithmetic Trap and Fault		
34	Trap	Integer overflow
34	Trap	Integer divide-by-zero
34	Trap	Subscript range
34	Fault	Floating overflow
34	Fault	Floating divide-by-zero
34	Fault	Floating underflow
Instruction Execution Exceptions		
10	Fault	Reserved/privileged instruction
2C	Fault	Breakpoint
40–4C	Trap	Change mode (CHMK, CHME, CHMS, CHMU)
C8	Trap	Instruction emulation
CC	Fault	Suspended emulator
Memory Management Exceptions		
20	Fault	Access control violation
24	Fault	Translation not valid
Operand Reference Exceptions		
18	Abort	Reserved operand fault
1C	Fault	Reserved addressing mode
System Failure Exceptions		
[1]	Abort	Interrupt stack not valid
04	Abort	Machine check
04	[2]	DAL bus parity errors

[1]Dispatched by resident firmware rather than through the SCB.

[2]Handled through machine check.

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Table 3–5 (Cont.) Exceptions

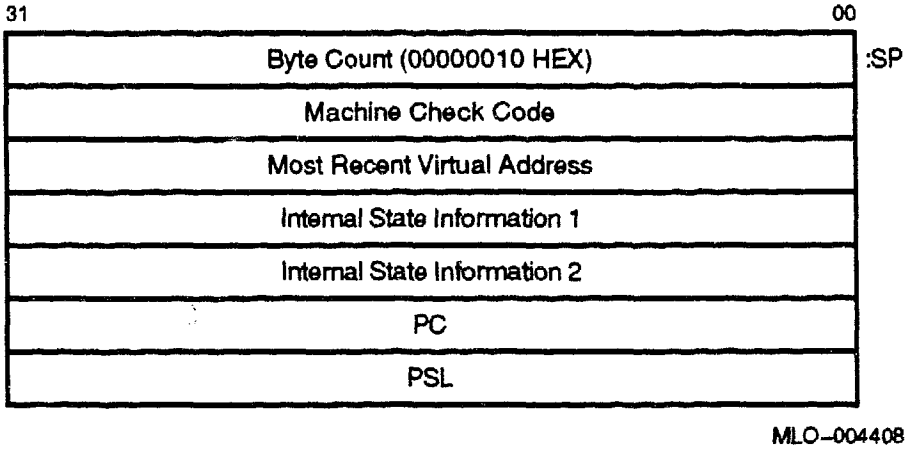
SCB Offset$_{16}$	Type	Meaning
System Failure Exceptions		
04	[2]	Internal cache parity errors
04	[2]	ERR L asserted without RDY L
04	[2]	DAL bus timeout errors
08	Abort	Kernel stack not valid
Tracing Exception		
28	Fault	Trace

[2]Handled through machine check.

3.1.12.4 Information Saved on a Machine Check Exception

In response to a machine check exception, the PSL, PC, four parameters, and a byte count are pushed onto the stack, as shown in Figure 3–4.

Figure 3–4 Information Saved on a Machine Check Exception



Byte Count

Byte count <31:00> indicates the number of bytes of information that follow on the stack (excluding the PC and PSL).

Machine Check Code Parameter

Machine check code <31:00> indicates the type of machine check that occurred. Possible machine check codes and their associated causes follow:

- **Floating-point errors** indicate that the floating-point accelerator (CFPA) chip detected an error while communicating with the CVAX processor chip during the execution of a floating-point instruction. The most likely causes of these types of machine checks are: a problem internal to the CVAX processor chip; a problem internal to the CFPA; or a problem with the interconnect between the two chips. Machine checks due to floating-point errors may be recoverable, depending on the state of the VAX can't restart flag (captured in internal state information 2 <15>) and the first part done flag (captured in PSL <27>). If the first part done flag is set, the error is recoverable. If the first part done flag is cleared, then the VAX can't restart flag must also be cleared for the error to be recoverable; otherwise, the error is unrecoverable, and depending on the current mode, either the current process or the operating system should be terminated. The information pushed onto the stack by this type of machine check is from the instruction that caused the machine check.

$Code_{16}$	Error Description
1	The CFPA chip detected a protocol error while attempting to execute a floating-point instruction.
2	The CFPA chip detected a reserved instruction while attempting to execute a floating-point instruction.
3	The CFPA chip returned an illegal status code while attempting to execute a floating-point instruction.
4	The CFPA chip returned an illegal status code while attempting to execute a floating-point instruction.

- **Memory management errors** indicate that the microcode in the CVAX processor chip detected an impossible situation while performing memory management functions. The most likely cause of this type of a machine check is a problem internal to the CVAX chip. Machine checks due to memory management errors are nonrecoverable. Depending on the current mode, either the current process or the operating system should be terminated. The state of the P0BR, P0LR, P1BR, P1LR, SBR, and SLR should be logged.

$Code_{16}$	Error Description
5	The calculated virtual address for a process PTE was in the P0 space instead of in the system space when the CVAX processor attempted to access a process PTE after a translation buffer miss.
6	The calculated virtual address space for a process PTE was in the P1 space instead of in the system space when the CVAX processor attempted to access a process PTE after a translation buffer miss.
7	The calculated virtual address for a process PTE was in the P0 space instead of in the system space when the CVAX processor attempted to access a process PTE to change the PTE<M> bit before writing to a previously unmodified page.
8	The calculated virtual address for a process PTE was in the P1 space instead of in the system space when the CVAX processor attempted to access a process PTE to change the PTE<M> bit before writing to a previously unmodified page.

- **Interrupt errors** indicate that the interrupt controller in the CVAX processor requested a hardware interrupt at an unused hardware IPL. The most likely cause of this type of a machine check is a problem internal to the CVAX chip. Machine checks due to unused IPL errors are nonrecoverable. A nonvectored interrupt generated by a serious error condition (memory error, power fail, or processor halt) has probably been lost. Execution of the operating system should be terminated.

$Code_{16}$	Error Description
9	A hardware interrupt was requested at an unused IPL.

- **Microcode errors** indicate that the microcode detected an impossible situation during instruction execution. Note that most erroneous branches in the CVAX processor microcode cause random microinstructions to be executed. The most likely cause of this type of machine check is a problem internal to the CVAX chip. Machine checks due to microcode errors are nonrecoverable. Depending on the current mode, either the current process or the operating system should be terminated.

$Code_{16}$	Error Description
A	An impossible state was detected during an MOVC3 or MOVC5 instruction (not move forward, move backward, or fill).

- **Read errors** indicate that an error was detected when the CVAX processor tried to read from the internal cache, main memory, or an external I/O device. The most likely cause of this type of machine check must be

determined from the state of the MSER. Machine checks due to read errors may be recoverable, depending on the state of the VAX can't restart flag (captured in internal state information 2 <15>) and the first part done flag (captured in PSL <27>). If the first part done flag is set, the error is recoverable. If the first part done flag is cleared, then the VAX can't restart flag must also be cleared for the error to be recoverable; otherwise, the error is unrecoverable and depending on the current mode, either the current process or the operating system should be terminated. The information pushed onto the stack by this type of machine check is from the instruction that caused the machine check.

$Code_{16}$	Error Description
80	An error occurred while reading an operand, a process page table entry during address translation, or on any read generated as part of an interlocked instruction.
81	An error occurred while reading a system page table entry during address translation, a process control block entry during a context switch, or a system control block entry while processing an interrupt.

- **Write errors** indicate that an error was detected when the CVAX processor tried to write to either the internal cache, the main memory, or an external I/O device. The most likely cause of this type of machine check must be determined from the state of the MSER. Machine checks due to write errors are nonrecoverable, because the processor can perform many read operations out of the internal cache before a write operation completes. For this reason, the information that is pushed onto the stack by this type of machine check cannot be guaranteed to be from the instruction that caused the machine check.

$Code_{16}$	Error Description
82	An error occurred while writing an operand, or a process page table entry to change the PTE<M> bit before writing a previously unmodified page.
83	An error occurred while writing a system page table entry to change the PTE<M> bit before writing a previously unmodified page, or while writing a process control block (PCB) entry during a context switch or during the execution of instructions that modify any stack pointers stored in the PCB.

Most Recent Virtual Address Parameter

Most recent virtual address <31:00> captures the contents of the virtual address pointer register at the time of the machine check. If a machine check other than machine check 81 occurs on a read operation, this field represents

the virtual address of the location that is being read when the error occurs, plus four. If machine check 81 occurs, this field represents the physical address of the location that is being read when the error occurs, plus four.

If a machine check other than machine check 83 occurs on a write operation, this field represents the virtual address of a location that is being referenced either when the error occurs, or sometime after, plus four. If a machine check 83 occurs, this field represents the physical address of the location that was being referenced either when the error occurs, or sometime after, plus four. In other words, if the machine check occurs on a write operation, the contents of this field cannot be used for error recovery.

Internal State Information 1 Parameter

Internal state information 1 is divided into four fields. The contents of these fields are described as follows:

- <31:24> captures the opcode of the instruction that was being read or executed at the time of the machine check.
- <23:16> captures the internal state of the CVAX processor chip at the time of the machine check. The four most significant bits are equal to <1111>, and the four least significant bits contain highest priority software interrupt <3:0>.
- <15:08> captures the state of CADR<07:00> at the time of the machine check. See Section 3.3.2.5 for an interpretation of the contents of this register.
- <07:00> captures the state of the MSER<07:00> at the time of the machine check. See Section 3.3.2.6 for an interpretation of the contents of this register.

Internal State Information 2

Internal state information 2 is divided into five fields. The contents of these fields are described as follows:

- <31:24> captures the internal state of the CVAX processor chip at the time of the machine check. This field contains SC register <7:0>.
- <23:16> captures the internal state of the CVAX processor chip at the time of the machine check. The two most significant bits are equal to 11 (binary), and the six least significant bits contain state flags <5:0>.
- <15> captures the state of the VAX can't restart flag at the time of the machine check.

- <14:08> captures the internal state of the CVAX processor chip at the time of the machine check. The three most significant bits are equal to 111 (binary), and the four least significant bits contain ALU condition codes.
- <07:00> captures the offset between the virtual address of the start of the instruction being executed at the time of the machine check (saved PC) and the virtual address of the location being accessed (PC) at the time of the machine check.

PC

PC<31:00> captures the virtual address of the start of the instruction being executed at the time of the machine check.

PSL

PSL<31:00> captures the contents of the PSL at the time of the machine check.

3.1.12.5 System Control Block

The system control block (SCB) consists of at least two pages in memory that contain the vectors by which interrupts and exceptions are dispatched to the appropriate service routines. IPR 17, the system control block base register (SCBB), points to the SCB. Figure 3–5 represents the SCB; Table 3–6 describes its format.

Figure 3–5 System Control Block Base Register

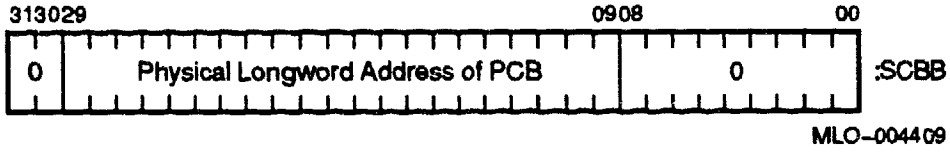


Table 3–6 System Control Block Format

SCB Offset$_{16}$	Interrupt/Exception Name	Type	Parameter	Notes
00	Unused			IRQ passive release on other VAX systems
04	Machine check	Abort	4	Parameters depend on error type

(continued on next page)

Table 3–6 (Cont.) System Control Block Format

SCB Offset$_{16}$	Interrupt/Exception Name	Type	Parameter	Notes
08	Kernel stack not valid	Abort	0	Must be serviced on interrupt stack
0C	Power fail	Interrupt	0	IPL is raised to $1E_{16}$
10	Reserved/privileged instruction	Fault	0	
14	Customer reserved instruction	Fault	0	XFC instruction
18	Reserved operand	Fault/ Abort	0	Not always recoverable
1C	Reserved addressing mode	Fault	0	
20	Access control violation	Fault	2	Parameters are virtual address, status code
24	Translation not valid	Fault	2	Parameters are virtual address, status code
28	Trace pending (TP)	Fault	0	
2C	Breakpoint instruction	Fault	0	
30	Unused			Compatibility mode in other VAX processors
34	Arithmetic	Trap/ Fault	1	Parameter is type code
38:3C	Unused			
40	CHMK	Trap	1	Parameter is sign-extended operand word
44	CHME	Trap	1	Parameter is sign-extended operand word
48	CHMS	Trap	1	Parameter is sign-extended operand word
4C	CHM[illegible]	Trap	1	Parameter is sign-extended operand word
50:80	Unused			
84	Software level 1	Interrupt	0	

(continued on next page)

Table 3–5 (Cont.) System Control Block Format

SCB Offset$_{16}$	Interrupt/Exception Name	Type	Parameter	Notes
88	Software level 2	Interrupt	0	Ordinarily used for AST delivery
8C	Software level 3	Interrupt	0	Ordinarily used for process scheduling
90:BC	Software levels 4–15	Interrupt	0	
C0	Interval timer	Interrupt	0	IPL is 16_{16} (INTIM)
C4	Unused			
C8	Emulation start	Fault	10	Same mode exception, FPD=0; parameters are opcode, PC, specifiers
CC	Emulation continue	Fault	0	Same mode exception, FPD=1: no parameters
D0:DC	Unused			
E0:EC	Reserved for customer or CSS use			
F0:FC	Unused			Reserved to Digital
100:1FC	Adapter vectors	Interrupt	0	Not implemented by the rtVAX 300
200:7FFC	Device vectors	Interrupt	0	Correspond to DAL bus vectors placed on DAL<15:02> H

3.1.12.6 Hardware Detected Errors

The rtVAX 300 can detect three types of error conditions during program execution:

- DAL bus parity errors indicated by MSER<6> (on a read) being set. (This error cannot be distinguished if detected during a read reference.)
- Internal cache tag parity errors indicated by MSER<0> being set.
- Internal cache data parity errors indicated by MSER<1> being set.

3.1.12.7 Hardware Halt Procedure

The hardware halt procedure is the mechanism by which the hardware assists the firmware in emulating a processor halt. The hardware halt procedure saves the current value of the PC in IPR 42 (SAVPC), and the current value of the PSL, MAPEN<0>, and a halt code in IPR 43 (SAVPSL). The current stack pointer is saved in the appropriate internal register. The PSL is set to 041F0000 (IPL=$1F_{16}$, kernel mode, using the interrupt stack), and the current stack pointer is loaded from the interrupt stack pointer. Control then passes to the resident firmware at physical address 20040000 with the state of the processor as follows:

Register	New Contents
SAVPC	Saved PC
SAVPSL<31:16>, <07:00>	Saved PSL<31:16>, <07:00>
SAVPSL<15>	Saved MAPEN<0>
SAVPSL<14>	Valid PSL flag (unknown for halt code of 3)
SAVPSL<13:8>	Saved restart code
SP	Current interrupt stack
PSL	041F0000
PC	20040000
MAPEN	0
ICCS	0 (for a halt code of 3)
MSER	0 (for a halt code of 3)
CADR	0 (for a halt code of 3, internal cache is also flushed)
SISR	0 (for a halt code of 3)
ASTLVL	0 (for a halt code of 3)
All else	Undefined

The firmware uses the halt code in combination with any hardware event indicators to dispatch the execution or interrupt that caused the halt to the appropriate firmware routine (either console emulation, power-up, reboot, or restart). Table 3–7 and Table 3–8 list the interrupts and exceptions that can cause halts along with their corresponding halt codes and event indicators.

Table 3–7 Nonmaskable Interrupts That Can Cause a Halt

Halt Code	Interrupt Condition
2	External halt (CVAX HLT L pin asserted)
3	Hardware reset (CVAX RST L pin asserted)

Table 3–8 Exceptions That Can Cause a Halt

Halt Code	Exception Condition
6	Halt instruction executed in kernel mode.
	Exceptions While Servicing an Interrupt or Exception
4	Interrupt stack not valid during exception.
5	Machine check during normal exception.
7	SCB vector bits<1:0> = 11.
8	SCB vector bits<1:0> = 10.
A	CHMx executed while on interrupt stack.
B	CHMx executed to the interrupt stack.
10	ACV or TNV during machine check exception.
11	ACV or TNV during kernel stack not valid exception.
12	Machine check during machine check exception.
13	Machine check during kernel stack not valid exception.
19	PSL<26:24> = 101 during interrupt or exception.
1A	PSL<26:24> = 110 during interrupt or exception.
1B	PSL<26:24> = 111 during interrupt or exception.
1D	PSL<26:24> = 101 during REI.
1E	PSL<26:24> = 110 during REI.
1F	PSL<26:24> = 111 during REI.

3.1.13 System Identification

The system identification register (SID), IPR 62, is a 32-bit read-only register implemented in the CVAX chip, as specified in the *VAX Architecture Reference Manual*. This register identifies the processor type and its microcode revision level. Figure 3–6 shows the system identification register; Table 3–9 describes its fields.

Figure 3–6 System Identification Register

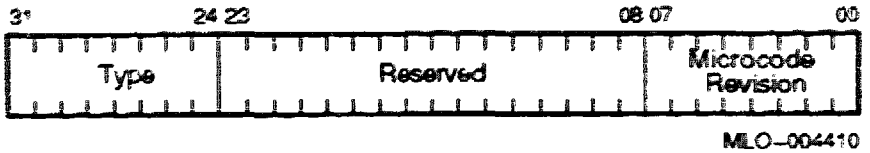


Table 3–9 System Identification Register Fields

Data Bit	Definition
<31:24>	Processor type (TYPE). This field always reads as $0A_{16}$, indicating that the processor is implemented using the CVAX chip.
<23:08>	Reserved for future use.
<07:00>	Microcode revision (MICROCODE REV.). This field reflects the microcode revision level of the CVAX chip.

3.1.14 CPU References

All references by the CVAX processor can be classified into one of three groups:

- Request instruction-stream read references
- Demand data-stream read references
- Write references

3.1.14.1 Instruction-Stream Read References

The CVAX processor has an instruction prefetcher with a 12-byte (3 longword) instruction prefetch queue (IPQ) for prefetching program instructions from either cache or main memory. Whenever there is an empty longword in the IPQ and the prefetcher is not halted due to an error, the instruction prefetcher generates an aligned longword, request instruction-stream (I-stream) read reference.

3.1.14.2 Data-Stream Read References

Whenever data is immediately needed by the CVAX processor to continue processing, a demand data-stream (D-stream) read reference is generated. More specifically, demand D-stream references are generated on operand, page table entry (PTE), system control block (SCB), and process control block (PCB) references.

When interlocked instructions, such as branch on bit set and set interlock (BBSSI) are executed, a demand D-stream read-lock reference is generated. Since the CVAX processor does not impose any restrictions on data alignment (other than the aligned operands of the ADAWI and interlocked queue instructions) and since memory can be accessed only one aligned longword at a time, all data read references are translated into an appropriate combination of masked and nonmasked, aligned longword read references.

If the required data is a byte, a word within a longword, or an aligned longword, then a single, aligned longword, demand D-stream read reference is generated. If the required data is a word that crosses a longword boundary, or an unaligned longword, then two successive aligned longword demand D-stream read references are generated. Data larger than a longword is divided into a number of successive aligned longword demand D-stream reads, with no optimization.

3.1.14.3 Write References

Whenever data is stored or moved, a write reference is generated. Since the CVAX processor does not impose any restrictions on data alignment (other than the aligned operands of the ADAWI and interlocked queue instructions) and since memory can be accessed only one aligned longword at a time, all data write references are translated into an appropriate combination of masked and nonmasked aligned longword write references.

If the required data is a byte, a word within a longword, or an aligned longword, then a single, aligned longword write reference is generated. If the required data is a word that crosses a longword boundary or an unaligned longword, then two successive aligned longword write references are generated. Data larger than a longword is divided into a number of successive aligned longword writes.

3.2 Floating-Point Accelerator

The floating-point accelerator is implemented in a single VLSI chip.

3.2.1 Floating-Point Accelerator Instructions

The floating-point accelerator processes F_floating, D_floating, and G_floating format instructions and accelerates the execution of MULL, DIVL, and EMUL integer instructions.

3.2.2 Floating-Point Accelerator Data Types

The rtVAX 300 floating-point accelerator supports byte, word, longword, quadword, F_floating, D_floating, and G_floating data types. The H_floating data type is not supported, but may be implemented by macrocode emulation.

3.3 Cache Memory

To maximize CVAX processor performance, the rtVAX 300 incorporates a 1K-byte cache implemented within the CVAX chip.

3.3.1 Cacheable References

Any reference that can be stored by the internal cache is called a *cacheable reference*. The internal cache stores CVAX processor read references to the VAX memory space (bit <29> of the physical address equals 0) only. It does not cache I/O space references or DMA references by external devices, including the Ethernet coprocessor. The type(s) of CVAX processor references that can be cached—either request instruction-stream (I-stream) read references, or demand data-stream (D-stream) read references other than read-lock references—is determined by the state of cache disable register CADR<5:4>. The normal operating mode is for both I-stream and D-stream references to be stored.

Whenever the CVAX processor generates a noncacheable reference, a single longword reference of the same type is generated on the DAL bus.

Whenever the CVAX processor generates a cacheable reference stored in the internal cache, no reference is generated on the DAL bus.

Whenever the CVAX processor generates a cacheable reference not stored in the internal cache, a quadword transfer is generated on the DAL bus. If the CVAX processor reference is a request I-stream read, then the quadword transfer consists of two indivisible longword transfers, the first being a request I-stream read (prefetch), and the second being a request I-stream read (fill). If the CVAX processor reference is a demand D-stream read, then the quadword transfer consists of two indivisible longword transfers, the first being a demand D-stream read, and the second being a request D-stream read (fill).

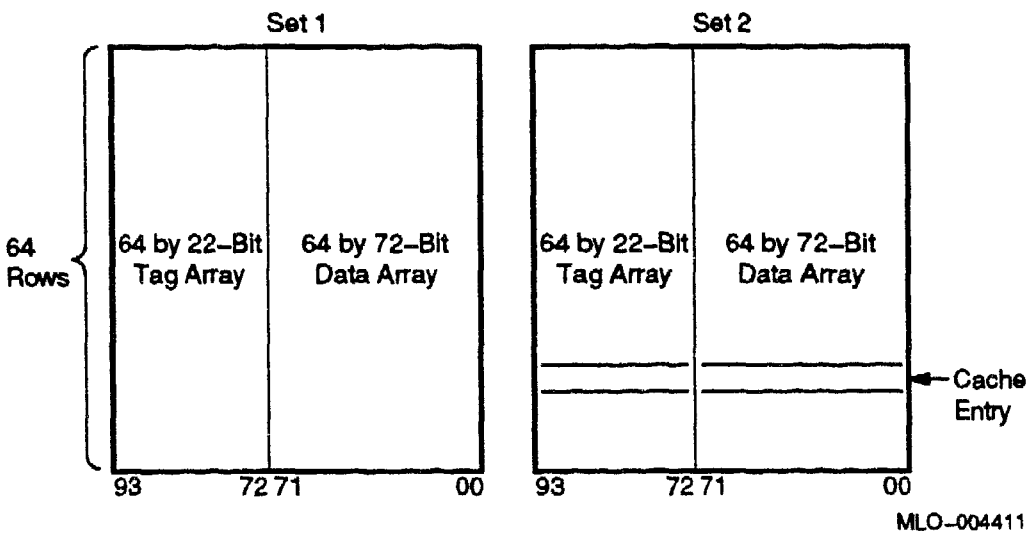
3.3.2 Internal Cache

The rtVAX 300 includes a 1K-byte, 2-way associative, write-through internal cache with a 100-ns cycle time. CVAX processor read references access one longword at a time; CVAX processor writes access one byte at a time. A single parity bit is generated, stored, and checked for each byte of data and each tag. The internal cache can be enabled/disabled by setting/clearing the appropriate bits in the CADR. The internal cache is flushed by any write to the CADR, as long as cache is not in diagnostic mode.

3.3.2.1 Internal Cache Organization

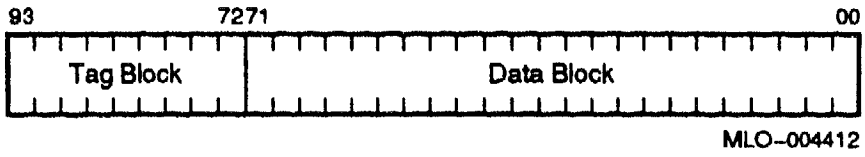
The internal cache is divided into two independent storage arrays called set 1 and set 2. Each set contains a 64-row by 22-bit tag array and a 64-row by 72-bit data array. Figure 3–7 shows the organization of the two sets.

Figure 3–7 Internal Cache Organization



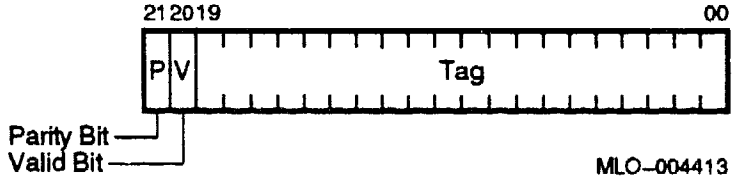
A row within a set corresponds to a cache entry, so there are 64 entries in each set and a total of 128 entries in the entire cache. Each entry contains a 22-bit tag block and a 72-bit (8-byte) data block. Figure 3–8 shows the organization of a cache entry.

Figure 3–8 Internal Cache Entry



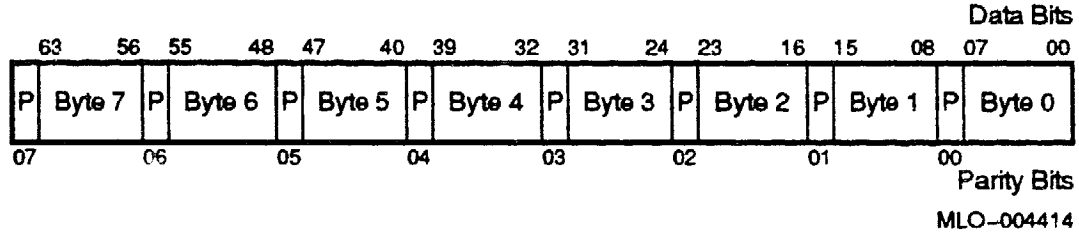
A tag block consists of a parity bit, a valid bit, and a 20-bit tag. Figure 3–9 shows the organization of a tag block.

Figure 3–9 Internal Cache Tag Block



A data block consists of 8 bytes of data, each with an associated parity bit. The total data capacity of the cache is 128 8-byte blocks, or 1024 bytes. Figure 3–10 shows the organization of a data block.

Figure 3–10 Internal Cache Data Block



3.3.2.2 Internal Cache Address Translation

Whenever the CVAX processor requires an instruction or data, the contents of the internal cache are checked to determine if the referenced location is stored there. The cache contents are checked by translating the physical address as follows:

- On noncacheable references, the reference is never stored in the cache, so an internal cache miss occurs and a single longword reference is generated on the DAL bus.

- On cacheable references, the physical address must be translated to determine if the contents of the referenced location resides in the cache. The cache index field, bits <8:3> of the physical address, is used to select one of the 64 rows of the cache, with each row containing a single entry from each set. The cache tag field, bits <28:9> of the physical address, is then compared to the tag block of the entry from both sets in the selected row.

If a match occurs with the tag block of one of the set entries and the valid bit within the entry is set, the cache contains the contents of the referenced location, and a cache hit occurs. On a cache hit, the set match signals generated by the compare operation select the data block from the appropriate set. The cache displacement field, bits <2:0> of the physical address, is used to select the byte(s) within the block. No DAL bus transfers are initiated on CVAX processor references that hit the internal cache.

If no match occurs, the cache does not contain the contents of the referenced location, and a cache miss occurs. In this case, the data must be obtained from either second-level cache or the main memory controller, so a quadword transfer is initiated on the DAL bus (Figure 3–11).

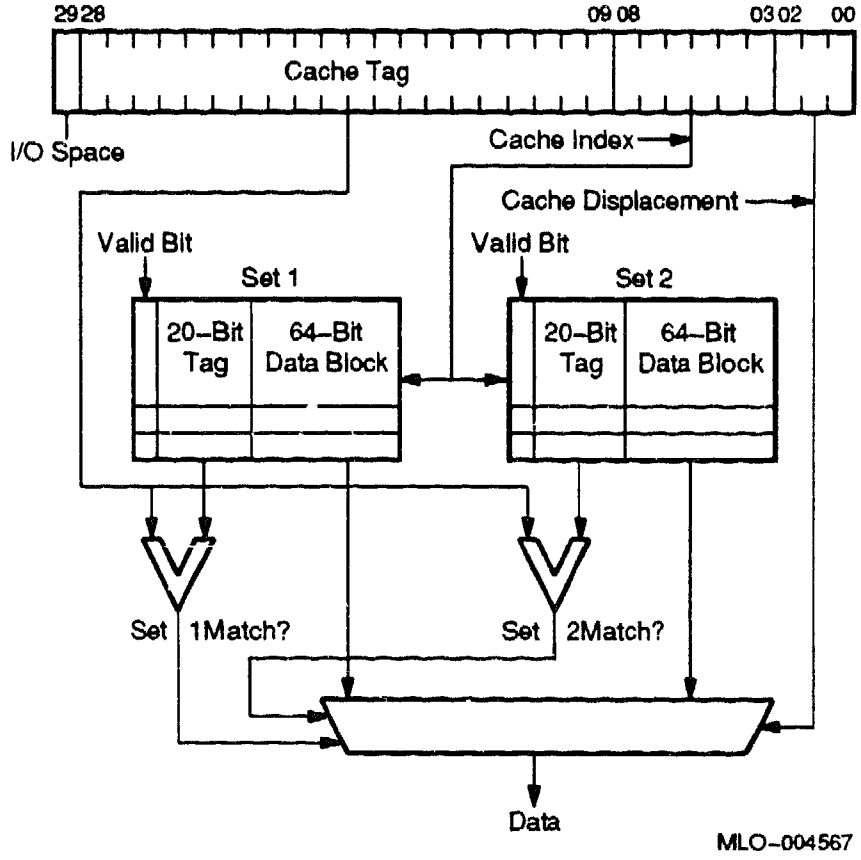
3.3.2.3 Internal Cache Data Block Allocation

Cacheable references that miss the internal cache initiate a quadword read on the DAL bus. When the requested quadword is supplied by either the second-level cache or the main memory controller, the requested longword is passed on to the CVAX processor, and a data block is allocated in the cache to store the entire quadword.

Because the cache is 2-way associative, only two data blocks (one in each set) can be allocated to a given quadword. These two data blocks are determined by the cache index field of the address of the quadword, which selects a unique row within the cache. Selection of a data block within the row (for example, set selection) for storing the new entry is random.

Since the rtVAX 300 supports 256M bytes (32M quadwords) of physical memory, up to 512K quadwords share each row (two data blocks) of the cache. Contiguous programs larger than 512 bytes or any noncontiguous programs separated by 512 bytes have a 50 percent chance of overwriting themselves when cache data blocks are allocated for the first time for data separated by 512 bytes (one page). After six allocations, there is a 97 percent probability that both sets in a row will be filled.

Figure 3–11 Internal Cache Address Translation



3.3.2.4 Internal Cache Behavior on Writes

On CVAX processor-generated write references, the internal cache is write-through. All CVAX processor write references that hit the internal cache cause the contents of the referenced location in main memory to be updated as well as the copy in the cache.

On DMA write references that hit the internal cache, the cache entry containing the copy of the referenced location is invalidated. If the internal cache is configured to store only I-stream references, then the entire internal cache is also flushed whenever an REI instruction is executed. (The VAX architecture requires that an REI instruction be executed before executing instructions out of a page of memory that has been updated.)

3.3.2.5 Cache Disable Register

The cache disable register (CADR), IPR 37, controls the internal cache, and is unique to processor designs that use the CVAX chip. Figure 3–12 shows the cache disable register, and Table 3–10 lists its fields.

Figure 3–12 Cache Disable Register

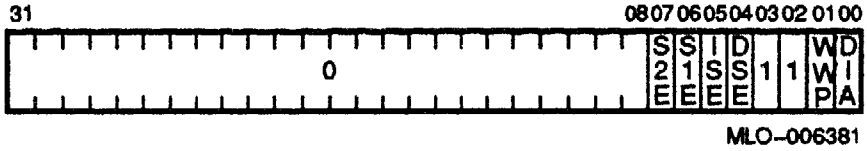


Table 3–10 Cache Disable Register Fields

Data Bit	Definition
<31:08>	Unused. Always read as zeros. Writes have no effect.
<07:06>	Used selectively to enable or disable each set within the cache.
<07>	S2E. Read/write. When set, set 2 of the cache is enabled. When cleared, set 2 of the cache is disabled. Cleared on power-up by the negation of RST L.
<06>	S1E. Read/write. When set, set 1 of the cache is enabled. When cleared, set 1 of the cache is disabled. Cleared on power-up by the negation of RST L.
<05:04>	Used selectively to enable or disable storing I-stream and D-stream references in the cache.
<05>	ISE. Read/write. When set, I-stream memory space references are stored in cache, if it is enabled; when cleared, they are not stored in cache. Cleared on power-up by the negation of RST L.
<04>	DSE. Read/write. When set, D-stream memory space references are stored in cache, if it is enabled; when cleared, they are not stored in cache. Cleared on power-up by the negation of RST L.
<03:02>	Unused. Always read as 1s.
<01>	Write wrong parity (WWP). Read/write. When set, incorrect parity is stored in the internal cache whenever it is written. When cleared, correct parity is stored in the cache whenever the cache is written. Cleared on power-up by the negation of RST L.

(continued on next page)

Table 3–10 (Cont.) Cache Disable Register Fields

Data Bit	Definition
<00>	Diagnostic mode (DIA). Read/write. When set, the internal cache is in diagnostic mode, and writes to the CADR will not cause the internal cache to be flushed. When cleared, the cache is in normal operating mode, writes to the CADR cause the internal cache to be flushed (all valid bits set to the invalid state), and the internal cache is configured for write-through operation.

Note

The internal cache can be disabled either by disabling both set 1 and set 2 (clearing CADR<07:06>) or by not storing either I-stream or D-stream references (clearing CADR<05:04>).

For improved performance, the cache should be configured to store both I- and D-stream references. I-stream only mode suffers from a degradation in performance from what would normally be expected relative to I- and D-stream mode and D-stream only mode, because invalidation of cache entries due to writes to memory by a DMA device are handled less efficiently.

In I-stream only mode, the entire internal cache is flushed whenever an REI instruction is executed. The *VAX Architecture Reference Manual* states that an REI instruction must be executed before executing instructions out of a page of memory that has been updated, whereas in the other two modes of operation, cache entries are invalidated on an individual basis, only if a DMA write operation results in a cache *hit*.

CVAX processor write references with a longword destination (for example, MOVL) write the data into main memory (if it exists), as well as invalidate the corresponding cache entry, irrespective of whether or not a cache hit occurred. CVAX processor write references with a quadword destination (for example, MOVQ) write the data into main memory (if it exists) and cause the second longword of the quadword to be written into the longword of the cache data array that corresponds to the address of the first longword of the destination, irrespective of whether or not a cache hit occurred.

The data in the longword of the cache data array that corresponds to the address of the second longword of the destination remains unaltered. In addition, errors generated during write references, which would normally cause a machine check, are ignored; they do not generate a machine check trap or prevent data from being stored in the cache.

Diagnostic mode is intended to allow the internal cache tag store to be fully tested without requiring 512M bytes of main memory. This mode makes it possible for the tag block in a particular cache entry to be written with any pattern by executing a MOVQ instruction with bits <28:9> of the destination address equal to the desired pattern.

Two MOVQ instructions, one with a quadword aligned destination address and one with the next longword aligned destination address, are required to write to both longwords in the data block of a cache entry. Diagnostic mode does not affect read references.

Note

At least one read reference must occur between all write references made in diagnostic mode. Diagnostic mode should be selected when one and only one of the two sets is enabled. Operation of this mode with both sets enabled or both sets disabled yields unpredictable results.

3.3.2.6 Memory System Error Register

The memory system error register (MSER), IPR 39, records the occurrence of internal cache hits, as well as parity errors on the DAL bus in the cache. This register is unique to CVAX processor designs. MSER<6:4,1:0> are peculiar in the sense that they remain set until explicitly cleared. Each bit is set on the first occurrence of the error it logs and remains set for subsequent occurrences of that error. The MSER is explicitly cleared through the MTPR instruction irrespective of the write data. Figure 3–13 shows the memory system error register; Table 3–11 lists its fields.

Figure 3–13 Memory System Error Register

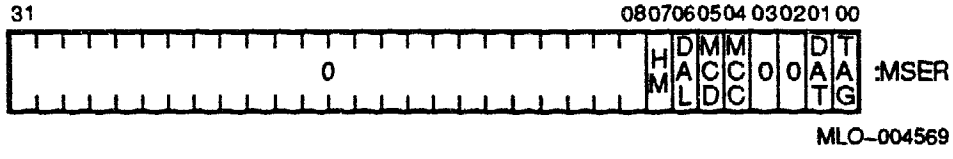


Table 3–11 Memory System Error Register Fields

Data Bit	Definition
<31:08>	Unused. Always read as zero. Writes have no effect.
<07>	Hit/miss (HM). Read only. Writes have no effect. Cleared on all cacheable references that hit the internal cache. Set on all cacheable references that miss the internal cache. Cleared on power-up by the negation of RST L.
<06>	DAL parity error (DAL). Read/write to clear. Set whenever a DAL bus parity error is detected. Cleared on power-up by the negation of RST L.
<05>	Machine check (MCD). DAL parity error. Read/write to clear. Set whenever a DAL bus data parity error causes a machine check. These errors generate machine checks only on demand D-stream read references. Cleared on power-up by the negation of RST L.
<04>	Machine check (MCC). Internal cache parity error. Read/write to clear. Set whenever an internal cache parity error in the tag or data store causes a machine check. These errors generate machine checks only on demand D-stream read references. Cleared on power-up by the negation of RST L.
<03:02>	Unused. Always read as zero. Writes have no effect.
<01>	Data parity error (DAT). Read/write to clear. Set when a parity error is detected in the data store of the internal cache. Cleared on power-up by the negation of RST L.
<00>	Tag parity error (TAG). Read/write to clear. Set when a parity error is detected in the tag store of the internal cache. Cleared on power-up by the negation of RST L.

3.3.2.7 Internal Cache Error Detection

Both the tag and data arrays in the internal cache are protected by parity. Each 8-bit byte of data and the 20-bit tag are stored with an associated parity bit. The valid bit in the tag is not covered by parity. Odd data bytes are stored with odd parity; even data bytes are stored with even parity. The tag is stored with odd parity.

The stored parity is valid only when the valid bit associated with the internal cache entry is set. Tag and data parity (on the entire longword) are checked on read references that hit the internal cache, but only tag parity is checked on CPU and DMA write references that hit the internal cache.

The action taken following the detection of an internal cache parity error depends on the reference type:

- During a demand D-stream read reference, the entire internal cache is flushed, the CADR is cleared (which disables the first level cache and causes the second-level cache to ignore all read operations). The cause of the error is logged in MSER<4:0>, and a machine check abort is initiated.
- During a request I-stream read reference, the entire internal cache is flushed (unless CADR<0> is set), the cause of the error is logged in MSER<1:0>, the prefetch is halted, but no machine check abort occurs, and both caches remain enabled.
- During a masked or nonmasked write reference, the entire internal cache is flushed (unless CADR<0> is set), the cause of the error is logged in MSER<0> (only tag parity is checked on CVAX processor writes that hit the internal cache), there is no effect on CVAX processor execution, and both caches remain enabled.
- During a DMA write reference, the cause of the error is logged in MSER<0> (only tag parity is checked on DMA writes that hit the internal cache), there is no effect on CVAX processor execution, both caches remain enabled, and no invalidate operation occurs.

3.4 Hardware Initialization

The VAX architecture defines three kinds of hardware initialization:

- Power-up
- I/O bus
- Processor

3.4.1 Power-Up Initialization

Power-up initialization occurs when power is restored and includes a hardware reset, an I/O bus initialization, a processor initialization, and initialization of several registers, as defined in the *VAX Architecture Reference Manual*. In addition to initializing these registers, the rtVAX 300 firmware also configures main memory and the local I/O space registers.

An rtVAX 300 hardware reset occurs on power-up and the assertion of RST L. A hardware reset initiates the hardware halt procedure (Section 3.1.12.7) with a halt code of 03. The reset also initializes some IPRs and most I/O space registers to a known state. Those IPRs that are affected by a hardware reset are noted in Section 3.1.4.3. The effect a hardware reset has on I/O space registers is documented in the description of the registers.

3.4.2 I/O Bus Initialization

An I/O bus initialization occurs on power-up, the assertion of RST L when the processor is halted, or as the result of an MTPR to IPR 55 (IORESET) or console UNJAM command.

The I/O bus reset register (IORESET), IPR 55, is implemented externally on the rtVAX 300 application hardware. An MTPR of any value to IORESET causes an I/O bus initialization.

3.4.3 Processor Initialization

A processor initialization occurs on power-up, on the assertion of RST L when the processor is halted, as the result of a console INITIALIZE command, and after a halt caused by an error condition.

3.5 Console Interface Registers

The following tables and figures list and show hardware registers that the rtVAX 300 processor references:

- Boot register (Section 3.5.1)
- Console registers for SCN 2681 DUART (Section 3.5.2)
- Memory system control/status register (Section 3.5.3)
- LED display/status register (Section 3.5.4)

(Appendix C contains tables of rtVAX 300 address assignments.)

3.5.1 Boot Register

The boot register is read once by the firmware when the system is powered on or reset. Bits <3:0> define the initial value of bits <3:0> of the boot action cell. This register is decoded by the rtVAX 300, and BOOT<3:0> L are used for the contents of this register. If the user does not connect these pins, their default value is 1. Figure 3–14 shows the boot register; Table 3–12 lists boot options as they relate to register contents.

Figure 3–14 Boot Register

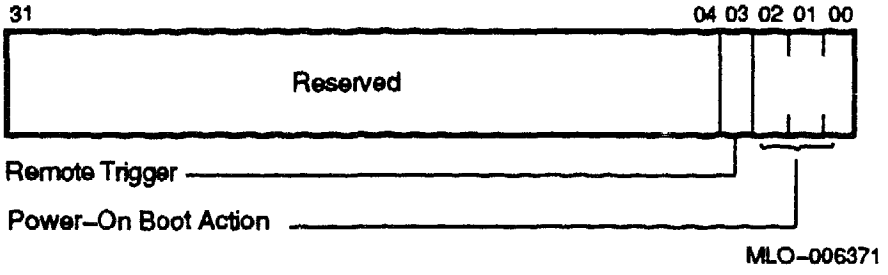


Table 3–12 Boot Options

Register Bit Setting					
<3> L	<2> L	<1> L	<0> L	Device	Action
X	L	L	L	–	No boot performed. rtVAX 300 enters console mode, executing the console emulation program.
X	L	L	H	PRA0	Boot from ROM at location 10000000 in memory space.
X	L	H	L	PRB0	Boot from ROM in I/O space.
X	L	H	H	PRB1	Copy ROM from I/O space to memory space, and then boot.
X	H	L	L	CSB0	DECnet DDCMP boot using Channel B of DUART at 1200 bps.
X	H	L	H	CSB1	DECnet DDCMP boot using Channel B of DUART at 2400 bps.
X	H	H	L	CSB2	DECnet DDCMP boot using Channel B of DUART at 9600 bps.
X	H	H	H	EZA0	Boot from Ethernet using standard MOP protocol.
L	X	X	X	–	Enable remote triggering.

3.5.2 Console DUART Register

Table 3–13 lists the addresses for the console registers and their functions.

Table 3–13 Console Registers SCN 2681 DUART

Address	Read Function	Write Function
20100000	Channel A mode registers (MRA1, MRA2)	Channel A mode registers (MRA1, MRA2)
20100004	Channel A status register (SRA)	Channel A clock select register (CSRA)
20100008	Reserved register	Channel A command register (CRA)
2010000C	Channel A receive holding register (RHRA)	Channel A transmit holding register (THRA)
20100010	Input port change register (IPCR)	Auxiliary control register (ACR)
20100014	Channel A/B interrupt status register (ISR)	Channel A/B interrupt mask register (IMR)
20100018	Counter/timer interval register upper (CTU)	Counter/timer interval register upper (CTUR)
2010001C	Counter/timer interval register lower (CTL)	Counter/timer interval register lower (CTLR)
20100020	Channel B mode register (MRB1, MRB2)	Channel B mode register (MRB1, MRB2)
20100024	Channel B status register (SRB)	Channel B clock select register (CSRB)
20100028	Reserved register	Channel B command register (CRB)
2010002C	Channel B receive holding register (RHRB)	Channel B transmit holding register (THRB)
20100030	Reserved register	Reserved register
20100034	Input port register	Output port configuration register (OPCR)
20100038	Start counter command register	Set output port bits command register
2010003C	Stop counter command register	Reset output port bits command register

3.5.3 Memory System Control/Status Register

To support systems with multiple processors sharing the same memory, the rtVAX 300's automatic memory system testing can be disabled. Digital recommends that the memory testing be enabled, so that the firmware can build a realistic page frame bitmap. Disabling the memory tests has the advantage that self-tests will finish very quickly; however, the disadvantage of doing this is that the page frame bitmap that is built lists all pages as "good." The firmware will not have tested each page, and bad pages will not have been found and might be used by the VAXELN kernel. In addition, if parity or ECC memory has been implemented, read cycles to locations that have not been written to will cause parity error machine checks.

An external memory system control/status (MSCR) register located at physical address 20110000 contains 1 bit; it can optionally be implemented to disable memory tests. If this register is not implemented, the rtVAX 300 uses the default bit value of 1, enabling memory tests. Figure 3–15 shows the layout of this register; Table 3–14 describes its bit structure.

Figure 3–15 Memory System Control/Status Register

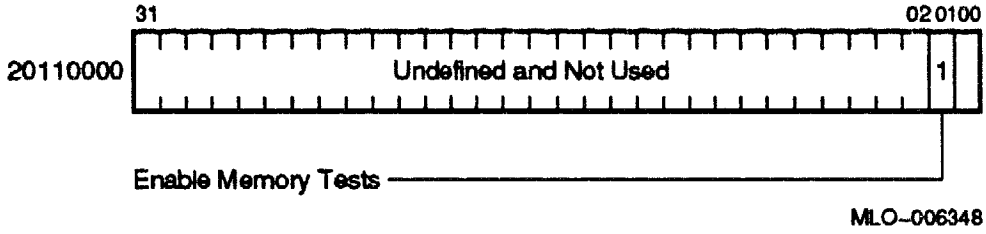


Table 3–14 Memory System Control/Status Register Fields

Bit	Description
<31:02>	Unused.
<01>	Set if memory test is to be performed on power-up; cleared when test is not to be performed. If the register is not implemented, the default is 1.
<00>	Unused.

Note

Digital does not recommend that memory tests be disabled. If they are disabled, parity errors can occur when an uninitialized memory

location is being read, and an untested page frame number bit map will be generated.

3.5.4 Status LED Register

The rtVAX 300 allows you to connect a processor status LED display to display the status of self-test and diagnostic routines. The rtVAX 300 will continue its self-test routines if this optional register does not exist. The first digit indicates the current state of the system; the second digit depends on the status of the first digit. This register is mapped to the word location 201FFFFE.

Figure 3–16 shows the layout of this register; Table 3–15 describes its bit structure. Table 3–16 is a LED display chart.

Figure 3–16 LED Display/Status Register

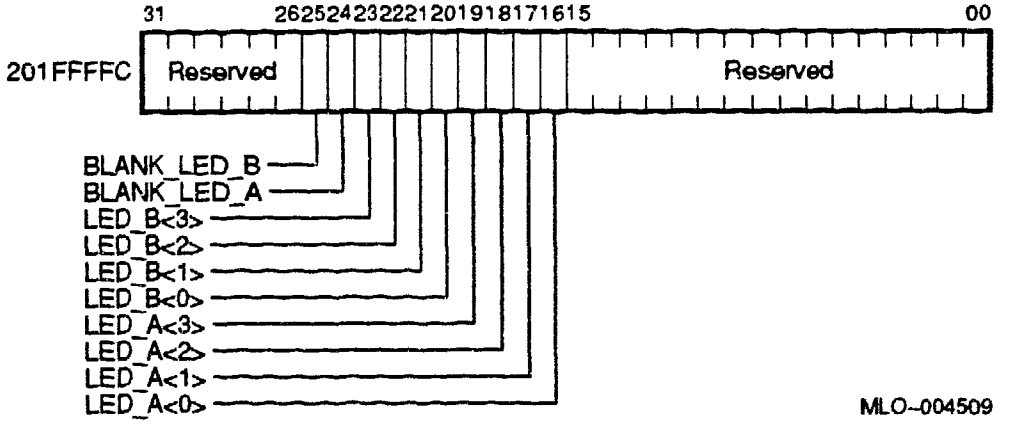


Table 3–15 LED Display/Status Register Fields

Bit	Description
BLANK_LED_B	Blank or turn off the most significant LED display digit: 1 means blank or disable this display digit; 0 means to enable this display digit.
BLANK_LED_A	Blank or turn off the least significant LED display digit: 1 means blank or disable this display digit; 0 means enable this display digit.

(continued on next page)

Table 3–15 (Cont.) LED Display/Status Register Fields

Bit	Description
LED_B<3:0>	The 4-bit binary hexadecimal code to be displayed on the most significant LED display. Note that these signals are inverted.
LED_A<3:0>	The 4-bit binary hexadecimal code to be displayed on the least significant LED display. Note that these signals are inverted.

Table 3–16 LED Display Chart

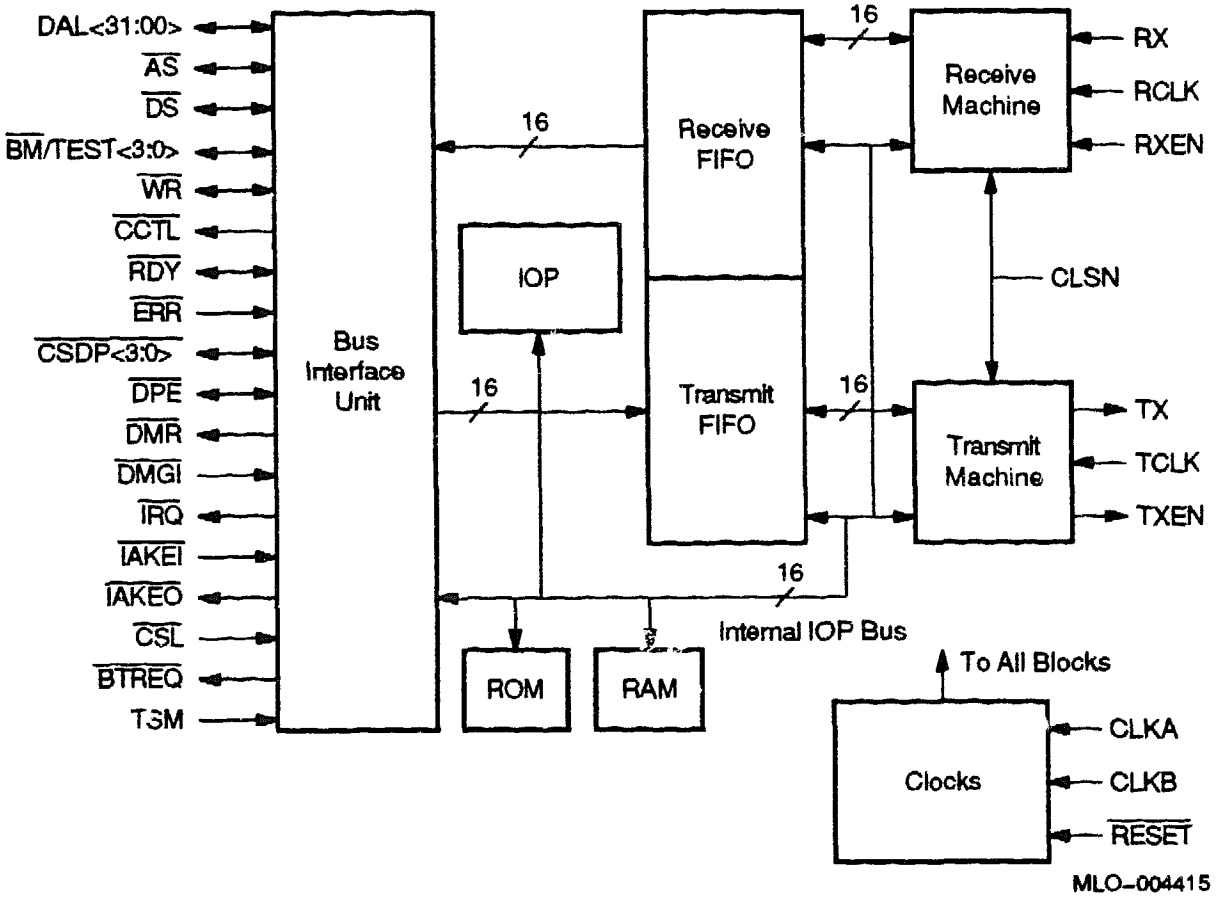
LED<3:0>	BLANK	HEX Code Displayed
0 0 0 0	0	F
0 0 0 1	0	E
0 0 1 0	0	D
0 0 1 1	0	C
0 1 0 0	0	B
0 1 0 1	0	A
0 1 1 0	0	9
0 1 1 1	0	8
1 0 0 0	0	7
1 0 0 1	0	6
1 0 1 0	0	5
1 0 1 1	0	4
1 1 0 0	0	3
1 1 0 1	0	2
1 1 1 0	0	1
1 1 1 1	0	0
X X X X	1	Blanked

3.6 Ethernet Coprocessor

The Ethernet coprocessor supports the Ethernet interface to the rtVAX 300 processor. Figure 3–17 shows a block diagram of this function. This section provides an overview of the following:

- Control/status registers (Section 3.6.1)
- Descriptors and buffers format (Section 3.6.2)
- Operation (Section 3.6.3)
- Serial interface (Section 3.6.4)
- Diagnostics and testing (Section 3.6.5)

Figure 3–17 Ethernet Coprocessor Block Diagram



3.6.1 Control/Status Registers

The Ethernet coprocessor contains 16 CSRs, found at locations 20008000 through 2000803F, that are used to control its operation. The CSRs are located in the I/O address space. The register addresses must be longword-aligned and can be accessed only by using longword instructions. The CSRs are divided into two groups: physical CSRs and virtual CSRs. The assigned locations for the registers are defined in Table 3–17.

You program the Ethernet interface by reading and writing to these registers. The network ID ROM provides the physical network address for the rtVAX 300 at 20008040 to 200080BF.

The physical CSRs are CSR0 through CSR7 and CSR15. These registers are physically present in the Ethernet coprocessor and are directly accessed by the rtVAX 300 processor. The rtVAX 300 processor can access these registers by a single longword instruction. The rtVAX 300 perceives no delay, and the instruction completes immediately. The physical CSRs contain most of the commonly used features of the Ethernet coprocessor.

The virtual CSRs are CSR8 through CSR14. These registers are not directly accessible to the rtVAX 300 processor. When the rtVAX 300 processor accesses one of these registers, the Ethernet coprocessor controls access to these registers by fetching the requested information from on-chip memory and passing it to the rtVAX 300 processor. Table 3–17 lists and describes Ethernet coprocessor registers.

Table 3–17 Ethernet Coprocessor Registers

Address	Register	Name
20008000	CSR0	Vector Address, IPL, Sync/Async (see Section 3.6.1.1)
20008004	CSR1	Transmit Polling Demand (see Section 3.6.1.2)
20008008	CSR2	Receive Polling Demand (see Section 3.6.1.2)
2000800C	CSR3	Receive List Address (see Section 3.6.1.3)
20008010	CSR4	Transmit List Address (see Section 3.6.1.3)
20008014	CSR5	Status Register (see Section 3.6.1.4)
20008018	CSR6	Command and Mode Register (see Section 3.6.1.5)
2000801C	CSR7	System Base Register (see Section 3.6.1.6)
20008020	CSR8	Reserved

(continued on next page)

Table 3–17 (Cont.) Ethernet Coprocessor Registers

Address	Register	Name
20008024	CSR9	Watchdog Timer Register (see Section 3.6.1.7)
20008028	CSR10	Revision Number and Missed Frame Count (see Section 3.6.1.8)
2000802C	CSR11	Boot Message Register (see Section 3.6.1.9)
20008030	CSR12	Boot Message Register (see Section 3.6.1.9)
20008034	CSR13	Boot Message Register (see Section 3.6.1.9)
20008038	CSR14	Breakpoint Address Register (see Section 3.6.1.10)
2000803C	CSR15	Monitor Command Register (see Section 3.6.1.11)

3.6.1.1 Vector Address, IPL, Sync/Asynch (CSR0)

This register must be the first one written by the rtVAX 300, because the Ethernet coprocessor may generate an interrupt on parity errors during rtVAX 300 writes to CSRs.

Caution

A parity error that occurs while the rtVAX 300 is writing to CSR0 may cause an rtVAX 300 failure due to an erroneous interrupt vector. To protect against failure, CSR0 is written as follows while IPL 16_{16} is disabled:

1. Write CSR0.
2. Read CSR0.
3. Compare value read to value written. If values mismatch, repeat step 2.
4. Read CSR5 and examine CSR5<04> for pending parity interrupt. Should an interrupt be pending, write CSR5 to clear it.

Figure 3–18 shows the format of CSR0; Table 3–18 describes its bit structure.

Figure 3–18 CSR0 Format

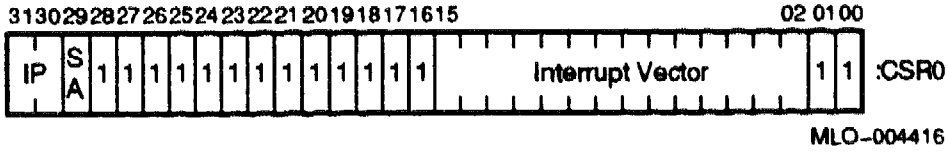


Table 3–18 CSR0 Bits

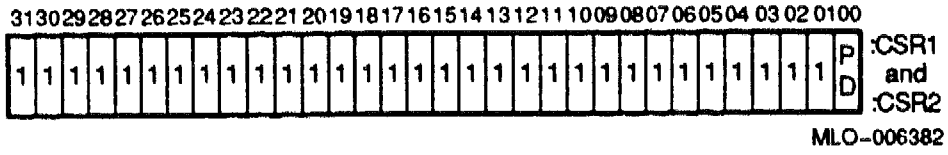
Bit	Name	Access	Description
15:00	IV	R/W	Interrupt Vector—During an interrupt acknowledge cycle for an Ethernet coprocessor interrupt, the Ethernet coprocessor drives this value on the rtVAX 300 bus DAL<31:00> H pins. DAL <31:16> and <01:00> H are set to 0. DAL<01:00> H are ignored when CSR0 is written and set to 1 when read.
29	SA	R/W	Sync/Asynch—Determines the Ethernet coprocessor operating mode when it is the bus master. When this bit is set, the Ethernet coprocessor operates as a synchronous device; when clear, as an asynchronous device.
31:30	IP	R/W	Interrupt Priority—Is the rtVAX 300 interrupt priority level at which the Ethernet coprocessor interrupts.

IP	IPL_{16}
00	14
01	15
10	16
11	17

3.6.1.2 Transmit/Receive Polling Demands (CSR1, CSR2)

Figure 3–19 shows the format of both CSR1 and CSR2. Table 3–19 describes the CSR1 bit structure; Table 3–20 describes the bit structure of CSR2.

Figure 3–19 CSR1/CSR2 Format



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Table 3–19 CSR1 Bits

Bit	Name	Access	Description
00	PD	R/W	Transmit Polling Demand—Checks the transmit list for frames to be transmitted. The PD value is meaningless.

Table 3–20 CSR2 Bits

Bit	Name	Access	Description
00	PD	R/W	Receive Polling Demand—Checks the receive list for receive descriptors to be acquired. The PD value is meaningless.

3.6.1.3 Descriptor List Addresses (CSR3, CSR4)

The two descriptor list heads address registers are identical in function: one is used for the transmit buffer descriptors and one for the receive buffer descriptors. In both cases, the registers point the Ethernet coprocessor to the start of the appropriate buffer descriptor list.

The descriptor lists reside in rtVAX 300 physical memory space and must be longword-aligned.

Note

For best performance, Digital recommends that the descriptor lists be octaword-aligned.

Caution

Initially, these registers must be written before the respective Start command is given (see Section 3.6.1.5); otherwise, the respective process remains in the stopped state. New list head addresses are

acceptable only while the respective process is in the stopped or suspended states. Addresses written while the respective process is in the running state are ignored and discarded.

If the rtVAX 300 attempts to read any of these registers before writing to them, the Ethernet coprocessor responds with unpredictable values. Figure 3–20 shows the format of the descriptor list; Table 3–21 describes its bit structure.

Figure 3–20 CSR3/CSR4 Format

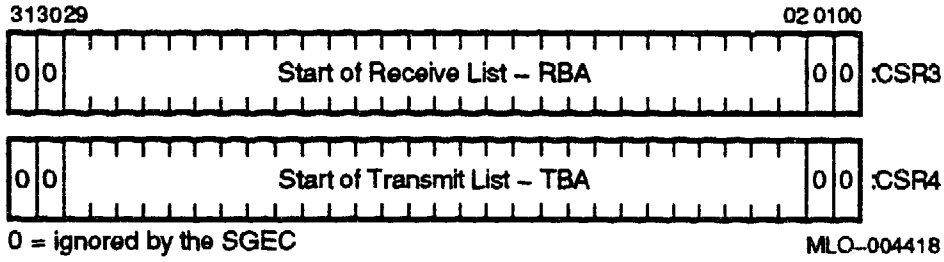


Table 3–21 CSR3/CSR4 Bits

Register	Bit	Name	Access	Description
CSP3	29:00	RBA	R/W	A 30-bit rtVAX 300 physical address of the start of the receive list.
CSR4	29:00	TBA	R/W	A 30-bit rtVAX 300 physical address of the start of the transmit list.

Note

The descriptor lists must be longword-aligned.

3.6.1.4 Status Register (CSR5)

This register contains all the status bits that the Ethernet coprocessor reports to the rtVAX 300. Figure 3–21 shows the format of CSR5; Table 3–22 describes its bit structure.

Figure 3–21 CSR5 Format

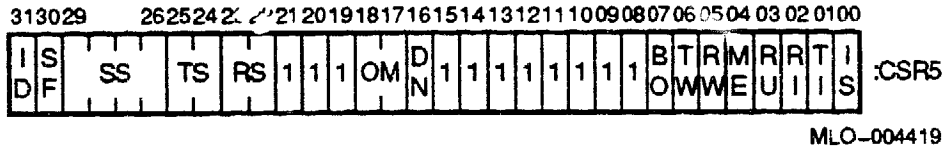


Table 3–22 CSR5 Bits

Bit	Name	Access	Description
00	IS	R/W1	Interrupt Summary—The logical OR of CSR5<06:01>.
01	TI	R/W1	Transmit Interrupt—When set, indicates one of the following: • Either all the frames in the transmit list have been transmitted (next descriptor owned by the rtVAX 300), or a frame transmission was aborted due to a locally induced error. The port driver must scan the list of descriptors to determine the exact cause. The transmission process is placed in the suspended state. Chapter 5 explains the transmission process state transitions. To resume processing transmit descriptors, the port driver must issue the Poll Demand command. • A frame transmission completed, and TDES1<24> was set. The transmission process remains in the running state, unless the next descriptor is owned by the rtVAX 300 or the frame transmission aborted due to an error. In the latter cases, the transmission process is placed in the suspended state.
02	RI	R/W1	Receive Interrupt—When set, indicates that a frame has been placed on the receive list. Frame specific status information was posted in the descriptor. The reception process remains in the running state.

(continued on next page)

Table 3–22 (Cont.) CSR5 Bits

Bit	Name	Access	Description
03	RU	R/W1	Receive Buffer Unavailable—When set, indicates that the rtVAX 300 owns next descriptor on the receive list and could not be acquired by the Ethernet coprocessor. The reception process is placed in the suspended state. Once set by the Ethernet coprocessor, this bit will not be set again until a poll demand is issued and the Ethernet coprocessor encounters a descriptor that it cannot acquire. To resume processing receive descriptors, the rtVAX 300 must issue the poll demand command.
04	ME	R/W1	Memory Error—Is set when any of the following occurs: • Ethernet coprocessor is the DAL bus master, and the ERR L pin is asserted by external logic (generally indicative of a memory problem) • Parity error detected on an rtVAX 300-to-Ethernet coprocessor CSR write or Ethernet coprocessor read from memory When Memory Error is set, reception and transmission processes are aborted and placed in the stopped state. **Note:** This point, port driver must issue a Reset command and rewrite all CSRs.
05	RW	R/W1	Receive Watchdog Timer Interrupt—When set, indicates that the receive watchdog timer has timed out, indicating that some other node is transmitting overlength packets on the network. Current frame reception is aborted, and RDES0<14> and RDES0<08> are set. Bit CSR5<02> is also set. The reception process remains in the running state.
06	TW	R/W1	Transmit Watchdog Timer Interrupt—When set, indicates that the transmit watchdog timer has timed out, indicating that the Ethernet coprocessor transmitter was transmitting overlength packets. The transmission process is aborted and placed in the stopped state. (Also reported into the Tx descriptor status TDES0<14> flag).
07	BO	R/W1	Boot Message—When set, indicates that the Ethernet coprocessor has detected a boot message on the serial line and has set the external pin BOOT L.

(continued on next page)

Table 3–22 (Cont.) CSR5 Bits

Bit	Name	Access	Description
16	DN	R	Done—When set, indicates that the Ethernet coprocessor has completed a requested virtual CSR access. After a reset, this bit is set.
18:17	OM	R	Operating Mode—These bits indicate the current Ethernet coprocessor operating mode, as follows:

Value	Meaning
00	Normal operating mode.
01	Internal Loopback—Indicates that the Ethernet coprocessor is disengaged from the Ethernet wire. Frames from the transmit list are looped back to the receive list, subject to address filtering.
10	External Loopback—Indicates that the Ethernet coprocessor is working in full duplex mode. Frames from the transmit list are transmitted on the Ethernet wire and are looped back to the receive list, subject to address filtering.
11	Diagnostic Mode—Explained in Section 3.6.5.2.

23:22	RS	R	Reception Process State—Indicates the current state of the reception process, as follows:

Value	Meaning
00	Stopped
01	Running
10	Suspended

Section 3.6.4.2 explains the reception process operation and state transitions.

(continued on next page)

Table 3–22 (Cont.) CSR5 Bits

Bit	Name	Access	Description
25:24	TS	R	Transmission Process State—Indicates the current state of the transmission process, as follows:

Value	Meaning
00	Stopped
01	Running
10	Suspended

Section 3.6.4.1 explains the transmission process operation and state transitions.

29:26	SS	R	Self-Test Status—The self-test completion code (valid only if CSR5<30> is set) is as follows:

Value	Meaning
0001	ROM error
0010	RAM error
0011	Address filter RAM error
0100	Transmit FIFO error
0101	Receive FIFO error
0110	Special loopback error

Note: Self-test takes 25 ms to complete.

30	SF	R	Self-Test Failed—When set, indicates that the Ethernet coprocessor self-test has failed. The self-test completion code bits indicate the failure type.
31	ID	R	Initialization Done—When set, indicates that the Ethernet coprocessor has completed the initialization (reset and self-test) sequences and is ready for further commands. When clear, indicates that the Ethernet coprocessor is performing the initialization sequence and ignoring all commands. After the initialization sequence completes, the transmission and reception processes are in the stopped state.

3.6.1.5 Command and Mode Register (CSR6)

This register is used to establish operating modes and for port driver commands. Figure 3–22 shows the format of CSR6; Table 3–23 describes its bit structure.

Figure 3–22 CSR6 Format

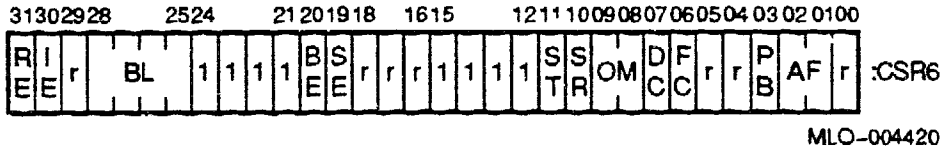


Table 3–23 CSR6 Bits

Bit	Name	Access	Description
2:1	AF	R/W	Address Filtering Mode—Defines the way incoming frames are address filtered:

Value	Meaning
00	Normal—Incoming frames are filtered according to the values of the SDES1<25> and SDES1<26> bits of the setup frame descriptor.
01	Promiscuous—All incoming frames are passed to the rtVAX 300, regardless of the SDES1<25> bit value.
10	All Multicast—All incoming frames with multicast destination addresses are passed to the rtVAX 300. Incoming frames with individual destination addresses are filtered according to the SDES1<25> bit value.
11	Unused—Reserved.

(continued on next page)

Table 3–23 (Cont.) CSR6 Bits

Bit	Name	Access	Description
3	PB	R/W	Pass Bad Frames Mode—When set, the Ethernet coprocessor passes frames that have been damaged by collisions or are too short due to premature reception termination. Both events should have occurred within the collision window (64 bytes), or else other errors are reported. When clear, these frames are discarded and never show up in the rtVAX 300 receive buffers. **Note:** Bad Frames is subject to the address filtering mode; that is, to monitor the network, this mode must be set together with the promiscuous address filtering mode.
6	FC	R/W	Force Collision Mode—Allows the collision logic to be tested. This chip must be in internal loopback mode for FC to be valid. If this bit is set, a collision is forced during the next transmission attempt. This results in 16 transmission attempts with excessive collision reported in the transmit descriptor.
7	DC	R/W	Disable Data Chaining Mode—When set, no data chaining occurs in reception; frames no longer than the current receive buffer are truncated. RDES0<09:08> are always set. The frame length returned in RDES0<30:16> is the true length of the nontruncated frame, while RDES0<10> indicates that the frame has been truncated due to the buffer overflow. When clear, frames too long for the current receive buffer are transferred to the next buffer(s) in the receive list.

(continued on next page)

Table 3–23 (Cont.) CSR6 Bits

Bit	Name	Access	Description
9:8	OM	R/W	Operating Mode—Determine the Ethernet coprocessor main operating mode:

Value	Meaning
00	Normal operating mode.
01	Internal Loopback—The Ethernet coprocessor will loop back buffers from the transmit list. The data is passed from the transmit logic back to the receive logic. The receive logic treats the looped frame as it would any other frame and subjects it to the address filtering and validity check process.
10	External Loopback—The Ethernet coprocessor transmits normally and enables its receive logic to its own transmissions. The receive logic treats the looped frame as it would any other frame and subjects it to the address filtering and validity check process.
11	Reserved for diagnostics.

10	SR	R/W	Start/Stop Reception Command—When set, the reception process is placed in the running state, the Ethernet coprocessor attempts to acquire a descriptor from the receive list and process incoming frames. Descriptor acquisition is attempted from the current position in the list, the address set by CSR3, or the position retained when the Rx process was previously stopped. If no descriptor can be acquired, the reception process enters the suspend state. The Start Reception command is honored only when the Reception process is in the stopped state. The first time this command is issued, an additional requirement is that CSR3 has already written to; otherwise, the reception process remains in the stopped state. When cleared, the reception process is placed in the stopped state after completing reception of the current frame. The next descriptor position in the receive list is saved and becomes the current position after reception is restarted. The Stop Reception command is honored only when the reception process is in the running or suspended state.

(continued on next page)

Table 3–23 (Cont.) CSR6 Bits

Bit	Name	Access	Description
11	ST	R/W	Start/Stop Transmission Command—When set, the transmission process is placed in the running state, and the Ethernet coprocessor checks for a frame to transmit at the transmit list at the current position, the address set by CSR4, or the position retained when the Tx process was previously stopped. If it does not find a frame to transmit, the transmission process enters the suspend state. The Start Transmission command is honored only when the transmission process is in the stopped state. The first time this command is issued, an additional requirement is that CSR4 has already been written to; otherwise, the transmission process remains in the stopped state. When cleared, the transmission process is placed in the stopped state after completing transmission of the current frame. The next descriptor position in the transmit list is saved and becomes the current position after transmission is restarted. The Stop Transmission command is honored only when the transmission process is in the running or suspended states.
19	SE	R/W	Single-Cycle Enable Mode—When set, the Ethernet coprocessor transfers only a single longword or an octaword in a single DMA burst on the rtVAX 300 bus.
20	BE	R/W	Boot Message Enable Mode—When set, enables the boot message recognition. When the Ethernet coprocessor recognizes an incoming boot message on the serial line, CSR5<07> is set, and the external pin BOOT L is asserted for a duration of 6*T cycles (of the rtVAX 300 clock).
28:25	BL	R/W	Burst Limit Mode—Specifies the maximum number of longwords to be transferred in a single DMA burst on the rtVAX 300 bus. When CSR6<19> is cleared, permissible values are 1, 2, 4, and 8; when set, the only permissible values are 1 and 4, and a value of 2 or 8 is respectively forced to 1 or 4. After initialization, the burst limit is set to 1.
30	IE	R/W	Interrupt Enable Mode—When set, setting of CSR5<06:01> generates an interrupt.

(continued on next page)

Table 3–23 (Cont.) CSR6 Bits

Bit	Name	Access	Description
31	RE	R/W	Reset Command—When set, the Ethernet coprocessor aborts all processes and starts the reset sequence. After completing the reset and self-test sequence, the Ethernet coprocessor sets bit CSR5<31>. Clearing this bit has no effect. **Note:** CSR5<05> value is unpredictable on read after hardware reset.

3.6.1.6 System Base Register (CSR7)

This CSR contains the physical starting address of the rtVAX 300 system page table. This register must be loaded by rtVAX 300 software before any address translation occurs so that memory will not be corrupted.

Figure 3–23 shows the format of CSR7; Table 3–24 describes its bit structure.

Figure 3–23 CSR7 Format

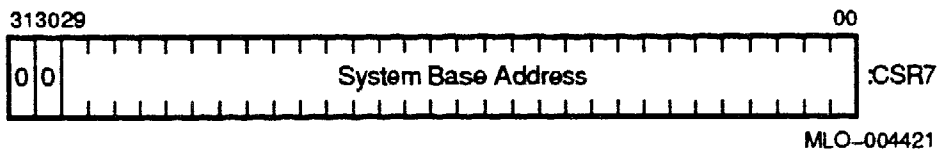


Table 3–24 CSR7 Bits

Bit	Name	Access	Description
29:00	SB	R/W	System Base Address—The physical starting address of the rtVAX 300 System Page Table. Unused if VA (virtual addressing) is cleared in all descriptors. **Caution:** This register should be loaded only once after a reset. Subsequent modifications of this register may cause unpredictable results.

3.6.1.7 Watchdog Timer Register (CSR9)

The Ethernet coprocessor has two timers that restrict the length of time during which the chip can receive or transmit. These watchdog timers are enabled by default and assume the default values after hardware or software resets. Figure 3–24 shows the format of the watchdog timer register; Table 3–25 describes its bit structure.

Figure 3–24 CSR9 Format

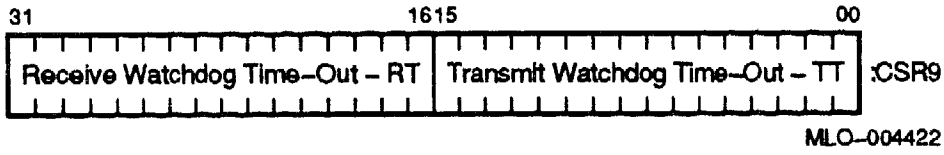


Table 3–25 CSR9 Bits

Bit	Name	Access	Description
15:00	TT	R/W	Transmit Watchdog Time-Out—The transmit watchdog timer protects the network against Ethernet coprocessor transmissions of overlength packets. If the transmitter stays on for *TT* * 16 cycles of the serial clock, the Ethernet coprocessor cuts off the transmitter and sets the CSR5<06> bit. If the timer is set to zero, it never times out. The value of TT is an unsigned integer. With a 10 MHz serial clock, this provides a range of 1.6 µs to 100 ms. The default value is 1250, corresponding to 2 ms.
31:16	RT	R/W	Receive Watchdog Time-Out—The receive watchdog timer protects the rtVAX 300 microprocessor against other transmitters sending overlength packets on the network. If the receiver stays on for *RT* * 16 cycles of the serial clock, the Ethernet coprocessor cuts off reception and sets the CSR5<05> bit. If the timer is set to zero, it will never time out. The value of RT is an unsigned integer. With a 10 MHz serial clock, this provides a range of 1.6 µs to 100 ms. The default value is 1250, corresponding to 2 ms. **Note:** An Rx or Tx watchdog value between 1 and 44 is forced to the minimum time-out value of 45 (72 µs).

3.6.1.8 Revision Number and Missed Frame Count (CSR10)

This register contains a missed frame counter and Ethernet coprocessor identification information. Figure 3–25 shows the format of CSR10; Table 3–26 describes its bit structure.

Figure 3–25 CSR10 Format

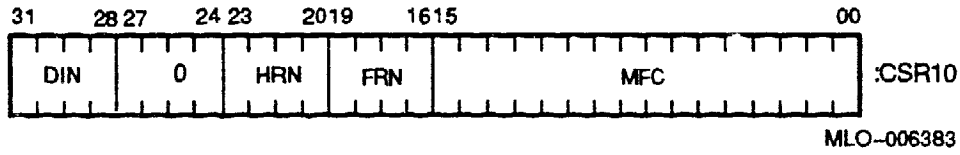


Table 3–26 CSR10 Bits

Bit	Name	Access	Description
15:00	MFC	R	Missed Frame Count—Counter for the number of frames that were discarded and lost because rtVAX 300 receive buffers were unavailable. The counter is cleared when read by the rtVAX 300.
19:16	FRN	R	Firmware Revision Number—Stores the internal firmware revision number for this particular Ethernet coprocessor.
23:20	HRN	R	Hardware Revision Number—Stores the revision number for this particular Ethernet coprocessor.
27:24			Reserved—Read as zeros.
31:28	DIN	R	Chip Identification Number—Determines whether this is an SGEC or an SGEC-compatible device.

3.6.1.9 Boot Message Registers (CSR11, CSR12, CSR13)

These registers contain the boot message verification and processor fields; Table 3–27 describes their bit structure.

Table 3–27 CSR11, CSR12, CSR13 Bits

Register	Bit	Name	Access	Description
CSR11	31:00	VRF<31:00>	R/W	Boot Message Verification field <31:00>
CSR12	31:00	VRF<63:32>	R/W	Boot Message Verification field <63:32>
CSR13	07:00	PRC	R/W	Boot Message Processor field

3.6.1.10 Breakpoint Address Register (CSR14)

This register contains the breakpoint address that causes the internal microprocessor to jump to a patch address. This register, in conjunction with the diagnostic descriptors, allows software patches. Figure 3–26 shows the format of CSR14; Table 3–28 describes its bit structure.

Figure 3–26 CSR14 Format

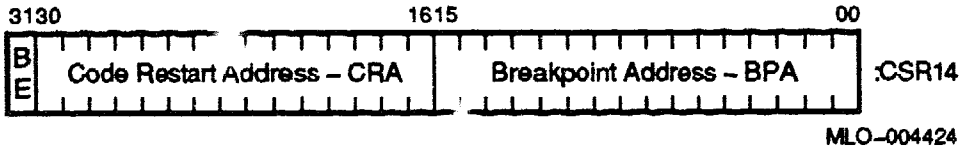


Table 3–28 CSR14 Bits

Bit	Name	Access	Description
15:00	BPA	R/W	Breakpoint Address—The internal processor address at which the program will halt and jump to the RAM-loaded code.

(continued on next page)

Table 3–28 (Cont.) CSR14 Bits

Bit	Name	Access	Description
30:16	CRA	R/W	Code Restart Address—The first address in the internal ROM to which the internal processor jumps after a breakpoint occurs.
31	BE	R/W	When set, breakpoint is enabled.

3.6.1.11 Monitor Command Register (CSR15)

This register is a physical CSR. It contains the bits that select the internal test block operation mode. Figure 3–27 shows the format of CSR15; Table 3–29 describes its bit structure.

Figure 3–27 CSR15 Format

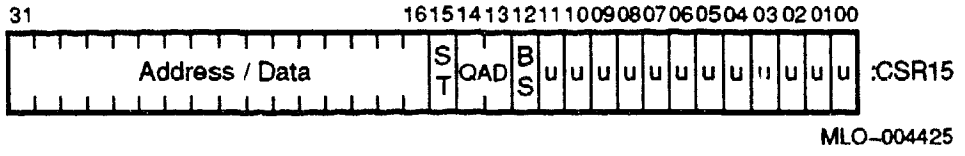


Table 3–29 CSR15 Bits

Bit	Name	Access	Description
12	BS	W	Bus Select—When set, the monitoring is applied on the internal address bus. Meaningful only in test mode (TSM=1). When reset, the internal data bus is monitored on the external test pins BM_L/TEST<03:00>.

(continued on next page)

Table 3–29 (Cont.) CSR15 Bits

Bit	Name	Access	Description
14:13	QAD	W	Quad Select—Meaningful only in test mode (TSM=1). These bits define the specific four bits of the internal data bus or address bus which are monitored on the external test pins BM_L/TEST<03:00>.

QAD	Bits
00	<03:00>
01	<07:04>
10	<11:08>
11	<15:12>

15	ST	W	Start Read—When set, starts the Examine cycle: the data addressed by CSR15<31:16> is fetched and stored into the same register field. Reset by hardware at the end of the operation.
31:16	ADDR/DATA	R/W	Address/Data—Before the Examine cycle starts, it points to the location to be read; three cycles after the assertion of CSR15<15>, it contains the read data.

3.6.2 Descriptor and Buffer Formats

The Ethernet coprocessor transfers frame data to and from receive and transmit buffers in rtVAX 300 memory. These buffers are pointed to by descriptors, also resident in rtVAX 300 memory.

There are two descriptor lists: one for receive and one for transmit. The starting address of each list is written into CSRs 3 and 4, respectively. A descriptor list is a forward-linked (either implicitly or explicitly) list of descriptors, the last of which may point back to the first entry, thus creating a ring structure. Explicit chaining of descriptors, through setting xDES1<31> is called descriptor chaining. The descriptor lists reside in VAX *physical* memory address space.

Note

The Ethernet coprocessor first reads the descriptors, ignoring all unused bits regardless of their state. The only word that the Ethernet coprocessor writes back is the first word (xDES0) of each descriptor.

Unused bits in xDES0 are written as 0. Unused bits in xDES1, xDES2, and xDES3 may be used by the port driver, and the Ethernet coprocessor will never disturb them.

A data buffer can contain an entire frame or part of a frame, but it cannot contain more than a single frame. Buffers contain only data; buffer status is contained in the descriptor. The term data chaining refers to frames spanning multiple data buffers. Data chaining can be enabled or disabled, in reception, through CSR6<07>. Data buffers reside in VAX memory space, either physical or virtual.

Notes

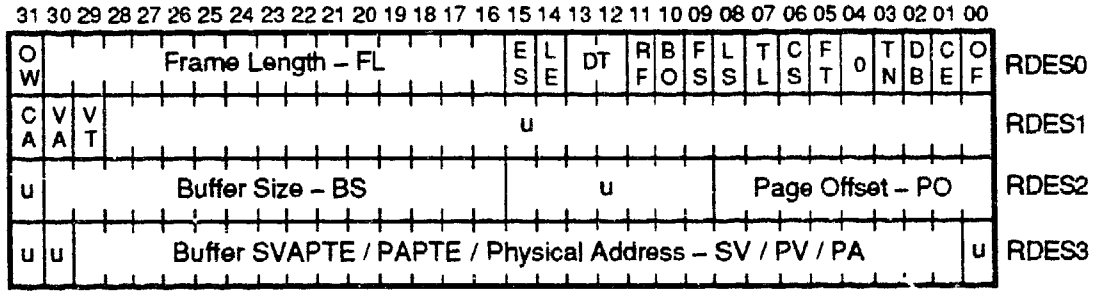
1. The virtual to physical address translation assumes that PTEs are locked in the rtVAX 300 memory while the Ethernet coprocessor owns the related buffer.

2. For best performance in virtual addressing mode, PPTE (Processor Page Table Entry) vectors must not cross a page of the PPTE table.

3.6.2.1 Receive Descriptors

Figure 3–28 shows the format of Receive Descriptors; Table 3–30 through Table 3–33 describe the RDESx bit structures. The RDES0 word contains received frame status, length, and descriptor ownership information.

Figure 3–28 Receive Descriptor Format



0 – SGEC writes as "0"
u – Ignored by the SGEC on read, never written

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Table 3–30 RDES0 Fields

Bits	Name	Description
00	OF	Overflow—When set, indicates received data in this descriptor's buffer was corrupted due to internal FIFO overflow. This will generally occur if Ethernet coprocessor requests are not granted before the internal receive FIFO fills up.
01	CE	CRC Error—When set, indicates that a CRC error has occurred on the received frame.
02	DB	Dribbling Bits—When set, indicates that the frame contained a noninteger multiple of eight bits. This error reported only if the number of dribbling bits in the last byte exceeds two. Meaningless if RDES0<06> or RDES0<11> is set. The CRC check is performed independent of this error; however, only whole bytes are run through the CRC logic. Consequently, received frames with up to six dribbling bits will have this bit set, but if RDES0<01> (or another error indicator) is not set, these frames should be considered valid:

RDES0<01>	RDES0<02>	Error
0	0	None
0	1	None
1	0	CRC error
1	1	Alignment error

03	TN	Translation Not Valid—When set, indicates that a translation error occurred when the Ethernet coprocessor was translating a VAX virtual buffer address. It is set only if RDES1<30> was set. The reception process remains in the running state and attempts to acquire the next descriptor.
05	FT	Frame Type—When set, indicates the frame is an Ethernet type frame (Frame Length Field > 1500). When clear, indicates the frame is an IEEE 802.3 type frame. Meaningless for Runt frames shorter than 14 bytes.
06	CS	Collision Seen—When set, indicates the frame was damaged by a collision that occurred after the 64 bytes following the SFD.

(continued on next page)

Table 3–30 (Cont.) RDES0 Fields

Bits	Name	Description
07	TL	Frame Too Long—When set, indicates the frame length exceeds the maximum Ethernet-specified size of 1518 bytes. **Note:** Frame Too Long is only a frame length indication and does not cause any frame truncation.
08	LS	Last Segment—When set, indicates that this buffer contains the last segment of a frame and status information is valid.
09	FS	First Segment—When set, indicates that this buffer contains the first segment of a frame.
10	BO	Buffer Overflow—When set, indicates that the frame has been truncated due to a buffer too small to fit the frame size. This bit may be set only if data chaining is disabled (CSR6<07> = 1).
11	RF	Runt Frame—When set, indicates that this frame was damaged by a collision or premature termination before the collision window had passed. Runt frames will only be passed on to the rtVAX 300 if CSR6<03> is set. Meaningless if RDES0<00> is set.
13:12	DT	Data Type—Indicates the type of frame the buffer contains, according to the following table:

Value	Meaning
00	Serial received frame.
01	Internally looped back frame.
10	Externally looped back frame or serial received frame. (The Ethernet coprocessor does not differentiate between looped back and serial received frames. Therefore, this information is global and reflects only CSR6<09:08>).

14	LE	Length Error—When set, indicates a frame truncation caused by one of the following: • The frame segment does not fit within the current buffer and the Ethernet coprocessor does not own the next descriptor. The frame is truncated. • The Receive Watchdog timer expired. CSR5<05> is also set.
15	ES	Error Summary—The logical OR of RDES0 bits 00, 01, 03, 06, 07, 11, 14.

(continued on next page)

Table 3–30 (Cont.) RDES0 Fields

Bits	Name	Description
30:16	FL	Frame Length—The length in bytes of the received frame. Meaningless if RDES0<14> is set.
31	OW	Own Bit—When set, indicates that the descriptor is owned by the Ethernet coprocessor. When cleared, indicates that the descriptor is owned by the rtVAX 300. The Ethernet coprocessor clears this bit upon completing processing of the descriptor and its associated buffer.

Table 3–31 RDES1 Fields

Bits	Name	Descriptor
29	VT	Virtual Type—In case of virtual addressing (RDES1<30> = 1), indicates the type of virtual address translation. When clear, the buffer address RDES3 is interpreted as a SVAPTE (System Virtual Address of the Page Table Entry). When set, the buffer address is interpreted as a PAPTE (Physical Address of the Page Table Entry). Meaningful only if RDES1<30> is set.
30	VA	Virtual Addressing—When set, RDES3 is interpreted as a virtual address. The type of virtual address translation is determined by the RDES1<29> bit. The Ethernet coprocessor uses RDES3 and RDES2<08:00> to perform a VAX virtual address translation process to obtain the physical address of the buffer. When clear, RDES3 is interpreted as the actual physical address of the buffer:

RDES1<30>	RDES1<29>	Addressing Mode
0	x	Physical
1	0	Virtual—SVAPTE
1	1	Virtual—PAPTE

(continued on next page)

Table 3–31 (Cont.) RDES1 Fields

Bits	Name	Descriptor
31	CA	Chain Address—When set, RDES3 is interpreted as another descriptor's VAX physical address. This allows the Ethernet coprocessor to process multiple, noncontiguous descriptor lists and explicitly "chain" the lists. Note that contiguous descriptors are implicitly chained. In contrast to what is done for an Rx buffer descriptor, the Ethernet coprocessor clears neither the ownership bit RDES0<31> nor any other bit of RDES0 of the chain descriptor after processing. To protect against infinite loop, a chain descriptor pointing back to itself is considered owned by the rtVAX 300, regardless of the ownership bit (RDES0<31>) state.

Table 3–32 RDES2 Fields

Bits	Name	Descriptor
08:00	PO	Page Offset—The byte offset of the buffer within the page. Meaningful only if RDES1<30> is set. **Note:** Receive buffers must be word-aligned.
30:16	BS	Buffer Size—The size, in bytes, of the data buffer. **Note:** Receive buffers size must be an even number of bytes, not shorter than 16 bytes.

Table 3–33 RDES3 Fields

Bits	Name	Descriptor
31:00	SV/PV/PA	SVAPTE/PAPTE/Physical Address—When RDES1<30> is set, RDES3 is interpreted as the address of the Page Table Entry and used in the virtual address translation process. RDES1<29> determines the type of the address: System Virtual address (SVAPTE) or Physical Address (PAPTE). When RDES1<30> is clear, RDES3 is interpreted as the physical address of the buffer; when RDES1<31> is set, RDES3 is interpreted as the VAX physical address of another descriptor. **Note:** Receive buffers must be word-aligned.

Table 3–34 summarizes the validity of the Receive Descriptor status bits regarding the reception completion status. (V indicates valid; X, meaningless.)

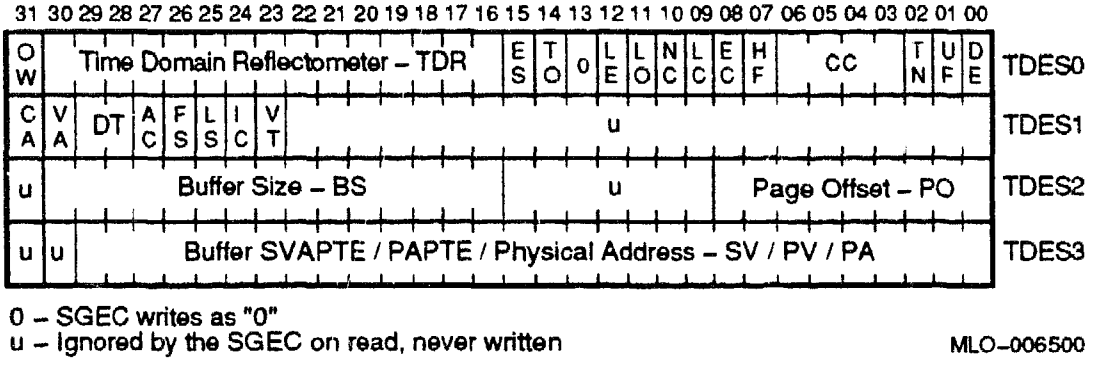
Table 3–34 Receive Descriptor Status Validity

Reception Status	RF	TL	CS	FT	DB	CE	Rx Status Report (ES,LE,BO,DT,FS,LS,FL,TN,OF)
Overflow	X	V	X	V	X	X	V
Collision after 512 bits	V	V	V	V	X	X	V
Runt frame	V	V	V	V	X	X	V
Runt frame < 14 bytes	V	V	V	X	X	X	V
Watchdog time-out	V	V	X	V	X	X	V

3.6.2.2 Transmit Descriptors

Figure 3–29 shows the format of Transmit Descriptors; Table 3–35 through Table 3–38 describe the TDESx bit structures. The TDES0 word contains transmitted frame status and descriptor ownership information.

Figure 3–29 Transmit Descriptor Format



0 – SGEC writes as "0"
u – Ignored by the SGEC on read, never written

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Table 3–35 TDES0 Fields

Bits	Name	Description
00	DE	Deferred—When set, indicates that the Ethernet coprocessor had to defer while trying to transmit a frame. This condition occurs if the channel is busy when the Ethernet coprocessor is ready to transmit.

(continued on next page)

Table 3–35 (Cont.) TDES0 Fields

Bits	Name	Description
01	UF	Underflow Error—When set, indicates that the transmitter has truncated a message due to data late from memory. This bit indicates that the Ethernet coprocessor encountered an empty transmit FIFO while in the midst of transmitting a frame. The transmission process enters the suspended state and sets CSR5<01>.
02	TN	Translation Not Valid—When set, indicates that a translation error occurred when the Ethernet coprocessor was translating a VAX virtual buffer address. It may only set if TDES1<30> was set. The transmission process enters the suspended state and sets CSR5<01>.
06:03	CC	Collision Count—A 4-bit counter indicating the number of collisions that occurred before the transmission attempt succeeded or failed. Meaningless when TDES0<08> is also set.
07	HF	Heartbeat Fail—When set, indicates Heartbeat Collision Check failure. (The transceiver failed to return a collision pulse as a check after the transmission. Some transceivers do not generate heartbeat, and so will always have this bit set. If the transceiver does support Heartbeat Fail, <HF>indicates transceiver failure.) Meaningless if TDES0<01> is set.
08	EC	Excessive Collisions—When set, indicates that the transmission was aborted because 16 successive collisions occurred while attempting to transmit the current frame.
09	LC	Late Collision—When set, indicates frame transmission was aborted due to a late collision. Meaningless if TDES0<01> is set.
10	NC	No Carrier—When set, indicates the carrier signal from the transceiver was not present during transmission (possible problem in the transceiver or transceiver cable). Meaningless in internal loopback mode (CSR5<18:17>=1).
11	LO	Loss of Carrier—When set, indicates loss of carrier during transmission (possible short circuit in the Ethernet cable). Meaningless in internal loopback mode (CSR5<18:17>=1).

(continued on next page)

Table 3–35 (Cont.) TDES0 Fields

Bits	Name	Description
12	LE	Length Error—When set, indicates one of the following: • Descriptor unavailable (owned by the rtVAX 300) in the middle of data-chained descriptors. • Zero length buffer in the middle of data-chained descriptors. • Setup or diagnostic descriptors (data type TDES1<29:28> is not equal to 0) in the middle of data-chained descriptors. • Incorrect order of first_segment TDES1<26> and last_segment TDES1<25> descriptors in the descriptor list. The transmission process enters the suspended state and sets CSR5<01>.
14	TO	Transmit Watchdog Time-Out—When set, indicates that the transmit watchdog timer has timed out, indicating that the Ethernet coprocessor transmitter was babbling. The interrupt CSR5<06> is set and the Transmission process is aborted and placed in the stopped state.
15	ES	Error Summary—The logical OR of bits 01, 02, 08, 09, 10, 11, 12, 14.
29:16	TDR	Time Domain Reflectometer—A count of bit time useful for locating a fault on the cable by using the velocity of propagation on the cable. Valid only if TDES0<08> is also set. Two excessive collisions in a row with the same ±20 TDR values indicate a possible open cable.
31	OW	Own Bit—When set, indicates that the descriptor is owned by the Ethernet coprocessor. When cleared, indicates that the descriptor is owned by the rtVAX 300. The Ethernet coprocessor clears this bit upon completing processing of the descriptor and its associated buffer.

Table 3–36 TDES1 Fields

Bits	Name	Descriptor
23	VT	Virtual Type—In case of virtual addressing (TDES1<30> = 1), indicates the type of virtual address translation. When clear, the buffer address TDES3 is interpreted as a SVAPTE (System Virtual Address of the Page Table Entry). When set, the buffer address is interpreted as a PAPTE (Physical Address of the Page Table Entry). Meaningful only if TDES1<30> is set.

(continued on next page)

Table 3–36 (Cont.) TDES1 Fields

Bits	Name	Descriptor
24	IC	Interrupt on Completion—When set, the Ethernet coprocessor sets CSR5<01> after this frame has been transmitted. To take effect, this bit must be set in the descriptor where bit 25 is set.
25	LS	Last Segment—When set, indicates that the buffer contains the last segment of a frame.
26	FS	First Segment—When set, indicates that the buffer contains the first segment of a frame.
27	AC	Add CRC Disable—When set, the Ethernet coprocessor will not append the CRC to the end of the transmitted frame. To take effect, this bit must be set in the descriptor where bit 26 is set. **Note:** If the transmitted frame is shorter than 64 bytes, the Ethernet coprocessor adds the padding field and the CRC, regardless of the <27> flag.
29:28	DT	Data Type—Indicates the type of data that the buffer contains, according to the following table:

Value	Meaning
00	Normal transmit frame data
10	Setup frame (Refer to Section 3.6.2.3.)
11	Diagnostic frame (Refer to Section 3.6.5.)

(continued on next page)

Table 3–36 (Cont.) TDES1 Fields

Bits	Name	Descriptor
30	VA	Virtual Addressing—When set, TDES3 is interpreted as a virtual address. The type of virtual address translation is determined by the TDES1<23> bit. The Ethernet coprocessor uses TDES3 and TDES2<08:00> to perform a VAX virtual address translation process to obtain the physical address of the buffer. When clear, TDES3 is interpreted as the actual physical address of the buffer:

TDES1<30>	TDES1<23>	Addressing Mode
0	x	Physical
1	0	Virtual—SVAPTE
1	1	Virtual—PAPTE

31	CA	Chain Address—When set, TDES3 is interpreted as another descriptor's VAX physical address. This allows the Ethernet coprocessor to process multiple, noncontiguous descriptor lists and explicitly "chain" the lists. Note that contiguous descriptors are implicitly chained. In contrast to what is done for a Tx buffer descriptor, the Ethernet coprocessor clears neither the ownership bit TDES0<31> nor any other bit of TDES0 of the chain descriptor after processing. To protect against infinite loop, a chain descriptor pointing back to itself is considered owned by rtVAX 300, regardless of the ownership bit state.

Table 3–37 TDES2 Fields

Bits	Name	Descriptor
08:00	PO	Page Offset—The byte offset of the buffer within the page. Meaningful only if TDES1<30> is set. **Note:** Transmit buffers may start on arbitrary byte boundaries.
30:16	BS	Buffer Size—The size, in bytes, of the data buffer. If this field is 0, the Ethernet coprocessor ignores this buffer. The frame size is the sum of all buffer size fields of the frame segments (between and including the descriptors having TDES1<26> and TDES1<25> set).

(continued on next page)

Table 3–37 (Cont.) TDES2 Fields

Bits	Name	Descriptor
		Note: If the port driver wishes to suppress transmission of a frame, this field must be set to 0 in all descriptors comprising the frame and prior to the Ethernet coprocessor acquiring them. If this rule is not adhered to, corrupted frames might be transmitted.

Table 3–38 TDES3 Fields

Bits	Name	Descriptor
31:00	SV/PV/PA	SVAPTE/PAPTE/Physical Address—When TDES1<30> is set, TDES3 is interpreted as the address of the Page Table Entry and used in the virtual address translation process. TDES1<23> determines the type of address: System Virtual Address (SVAPTE) or Physical Address (PAPTE). When TDES1<30> is clear, TDES3 is interpreted as the physical address of the buffer; when TDES1<31> it is set, TDES3 is interpreted as the VAX physical address of another descriptor. **Note:** Transmit buffers may start on arbitrary byte boundaries.

Table 3–39 summarizes the validity of the Transmit Descriptor status bits regarding the transmission completion status. (V indicates valid; M, meaningless.)

Table 3–39 Transmit Descriptor Status Validity

							Tx Status Report
Transmission Status	LO	NC	LC	EC	HF	CC	(ES,TO,LE,TN,UF,DE)
Underflow	X	X	V	V	X	V	V
Excessive collisions	V	V	V	V	V	X	V
Watchdog time-out	X	V	X	X	X	V	V
Internal loopback	X	X	V	V	X	V	V

3.6.2.3 Setup Frame

A setup frame defines the Ethernet coprocessor destination addresses. These addresses filter all incoming frames. The setup frame is *never* transmitted over the Ethernet nor looped back to the receive list. While the setup frame is being processed, the receiver logic temporarily disengages from the Ethernet wire. The setup frame size is *always* 128 bytes and must be wholly contained in a single transmit buffer. There are two types of setup frames:

- Perfect filtering addresses (16) list
- Imperfect filtering hash bucket (512) heads and one physical address

3.6.2.3.1 First Setup Frame A setup frame must be queued, that is, placed in the transmit list with Ethernet coprocessor ownership, to the Ethernet coprocessor before the reception process is started, except when the Ethernet coprocessor is in promiscuous reception mode.

Note

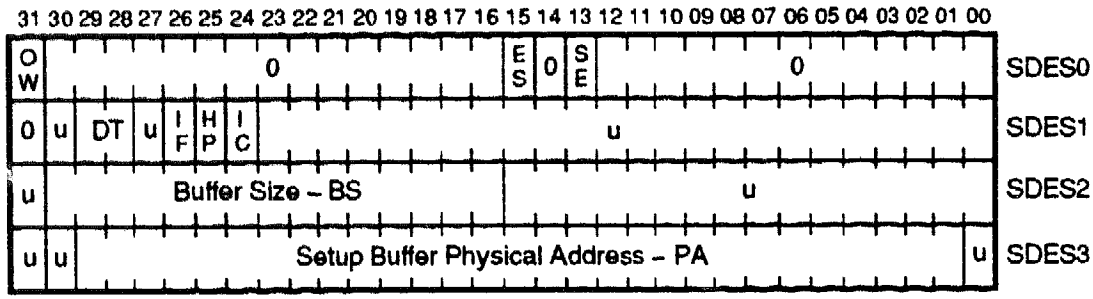
The self-test completes with the Ethernet coprocessor Address filtering table fully set to 0. A reception process started without loading a setup frame rejects all incoming frames except those with a destination physical address of 000000_{16}.

3.6.2.3.2 Subsequent Setup Frame Subsequent setup frames may be queued to the Ethernet coprocessor regardless of the reception process state. The only requirement for the setup frame to be processed, is that the transmission process be in the running state. The setup frame is processed after all preceding frames have been transmitted and after the current frame reception, if any, is completed.

The setup frame does not affect the reception process state, but during the setup frame processing, the Ethernet coprocessor is disengaged from the Ethernet wire.

3.6.2.3.3 Setup Frame Descriptor Figure 3–30 shows the format of the setup frame descriptors; Table 3–40 describes the SDECx bit structure.

Figure 3–30 Setup Frame Descriptor Format



0 – SGEC writes as "0" (SDES0 only)
u – Ignored by the SGEC on read, never written

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Table 3–40 Setup Frame Descriptor Bits

Word	Bits	Name	Description
SDES0	13	SE	Setup Error—When set, indicates that the setup frame buffer size is not 128 bytes.
	15	ES	Error Summary—Set when bit 13 is set.
	31	OW	Own Bit—When set, indicates that the descriptor is owned by the Ethernet coprocessor. When cleared, indicates that the descriptor is owned by the rtVAX 300. The Ethernet coprocessor clears this bit upon completing processing of the descriptor and its associated buffer.
SDES1	24	IC	Interrupt on Completion—When set, the Ethernet coprocessor sets CSR5<01> after this setup frame has been processed.
	25	HP	Hash/Perfect Filtering Mode—When set, the Ethernet coprocessor interprets the setup frame as a hash table and does imperfect address filtering. The imperfect mode is useful when there are more than 16 multicast addresses to listen to. When clear, the Ethernet coprocessor does a perfect address filter of incoming frames according to the addresses specified in the setup frame.

(continued on next page)

Table 3–40 (Cont.) Setup Frame Descriptor Bits

Word	Bits	Name	Description
	26	IF	Inverse Filtering—When set, the Ethernet coprocessor does inverse filtering: the Ethernet coprocessor receives incoming frames with destination address not matching the perfect addresses and rejects frames with destination address matching one of the perfect addresses. Meaningful only for perfect filtering (SDES1<25>=0), while promiscuous and all multicast modes are not selected (CSR6<02:01>=0).
	29:28	DT	Data Type—Must be 2 to indicate setup frame.
SDES2	30:16	BS	Buffer Size—Must be 128.
SDES3	29:1	PA	Physical Address—Physical address of setup buffer. **Note:** Setup buffers must be word-aligned.

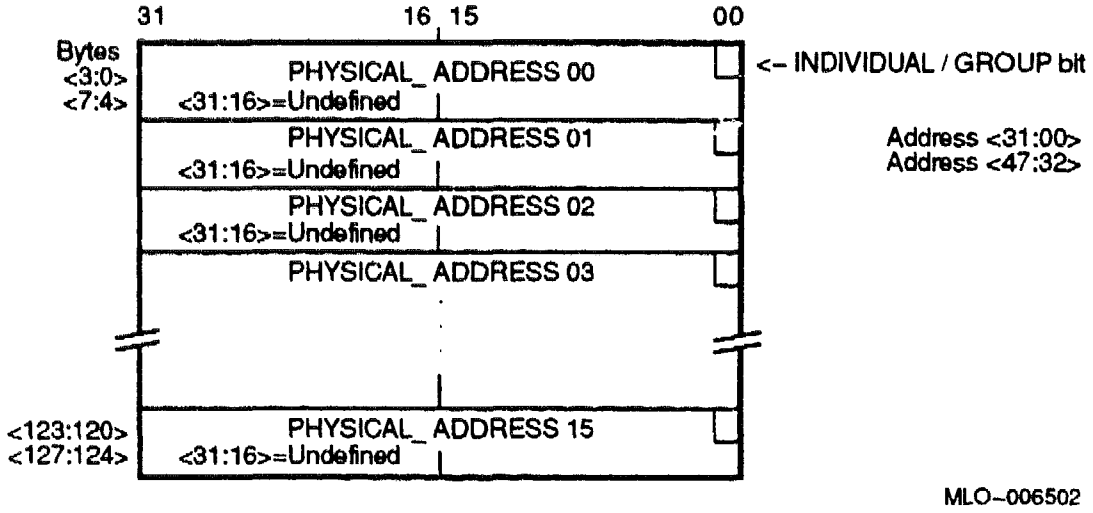
3.6.2.3.4 Perfect Filtering Setup Frame Buffer This section describes how the Ethernet coprocessor interprets a setup frame buffer when SDES1<25> is clear.

The Ethernet coprocessor can store sixteen 48-bit Ethernet destination addresses. It compares the addresses of any incoming frame to these, and based on the status of Inverse_Filtering flag SDES1<26>, rejects those that

- Do not match, if SDES1<26> = 0
- Match, if SDES1<26> = 1

The setup frame *must always* supply all 16 addresses. Any mix of physical and multicast addresses can be used. Unused addresses should be duplicates of one of the valid addresses. Figure 3–31 shows the format of the addresses.

Figure 3–31 Perfect Filtering Setup Frame Buffer Format



The low-order bit of the low-order byte is the address's multicast bit.

Example 3–1 illustrates a perfect filtering setup buffer fragment.

Example 3–1 Perfect Filtering Setup Buffer Fragment

```
Ethernet addresses to be filtered:
❶  A8-09-65-12-34-76
   09-BC-87-DE-03-15
     .
     .
     .

Setup frame buffer fragment:
❷  126509A8
   00007634
   DE87BC09
   00001503
     .
     .
     .
```

❶ Ethernet multicast addresses written according to the IEEE 802 specification for address display

❷ Those two addresses as they would appear in the buffer

3.6.2.3.5 Imperfect Filtering Setup Frame Buffer This section describes how the Ethernet coprocessor interprets a setup frame buffer when SDES1<25> is set.

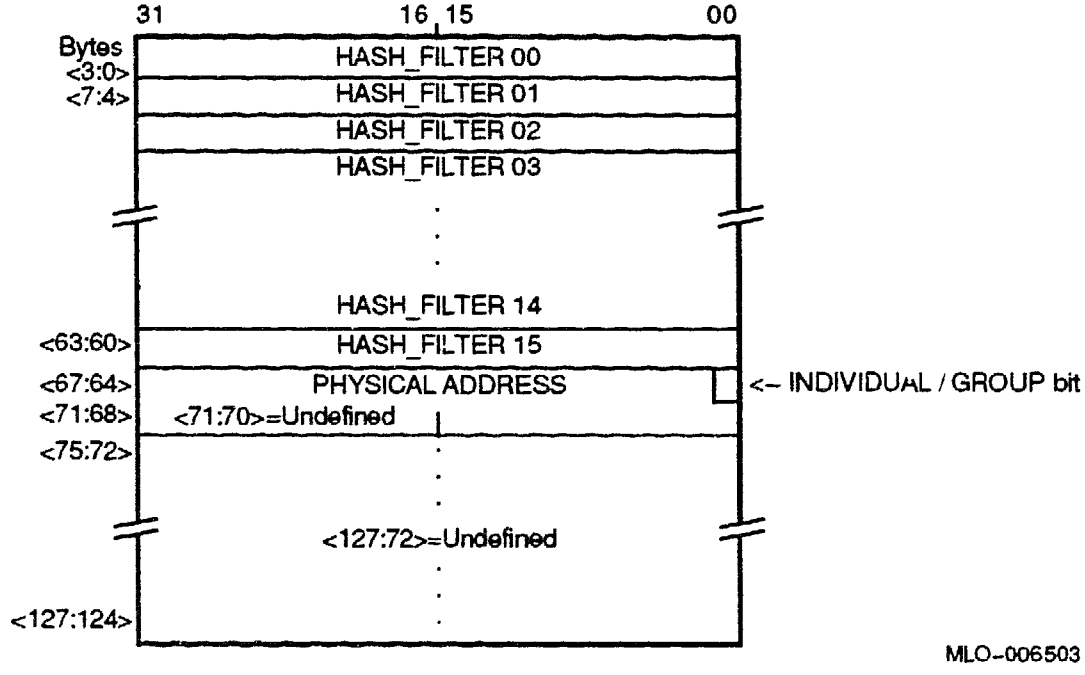
The Ethernet coprocessor can store 512 bits, serving as hash bucket heads, and one *physical* 48-bit Ethernet address. Incoming frames with multicast destination addresses are subjected to the imperfect filtering. Frames with physical destination addresses are checked against the single physical address.

For any incoming frame with a multicast destination address, the Ethernet coprocessor applies the standard Ethernet CRC function to the first six bytes containing the destination address, and then uses the least significant nine bits of the result as a bit index into the table. If the indexed bit is set, the frame is accepted; if it is cleared, the frame is rejected.

This filtering mode is called imperfect, because multicast frames not addressed to this station may slip through, but it still reduces the number of frames that the rtVAX 300 must process.

Figure 3–32 shows the format for the hash table and the physical address.

Figure 3–32 Imperfect Filtering Setup Frame Buffer Format



Bits are sequentially numbered from right to left and down the table. For example, if the destination address CRC<8:0> is 33, the Ethernet coprocessor examines bit 1 in the second longword. Example 3–2 shows an imperfect filtering setup frame buffer. Appendix E shows a C program to compute the setup frame buffer for the hashing filtering mode.

Example 3–2 Imperfect Filtering Setup Frame Buffer

```
Ethernet addresses to be filtered:
❶  25-00-25-00-27-00
   A3-C5-62-3F-25-87
   D9-C2-C0-99-0B-82
   7D-48-4D-FD-CC-0A
   E7-C1-96-36-89-DD
   61-CC-28-55-D3-C7
   6B-46-0A-55-2D-7E
❷  A8-12-34-35-76-08

Setup frame buffer:
❸  00000000
   10000000
   00000000
   00000000
   00000000
   40000000
   00000080
   00100000
   00000000
   10000000
   00000000
   00000000
   00000000
   00010000
   00000000
   00400000
❹  353412A8
   00000876
```

❶ Ethernet multicast addresses written according to the IEEE 802 specification for address display

❷ An Ethernet physical address

❸ The first part of an imperfect filter setup frame buffer with set bits for the multicast addresses

❹ The second part of the buffer with the physical address

3.6.3 Operation

A program in rtVAX 300 memory called the port driver controls the operation of the Ethernet coprocessor. The Ethernet coprocessor and the port driver communicate through two data structures:

- Command and Status Registers (CSRs)—These registers are located in the Ethernet coprocessor and mapped in the rtVAX 300 processor's I/O address space. The CSRs are used for initialization, global pointers, command transfer, and global error reporting.
- Descriptor Lists and Data Buffers—These are collectively called the host communication area and are located in rtVAX 300 memory. These lists and buffers handle the actions and status reporting related to buffer management.

The Ethernet coprocessor can be viewed as two independent, concurrently executing processes: reception and transmission. These processes are started after the Ethernet coprocessor completes its initialization sequence. Once started, these processes alternate between three states: stopped, running, or suspended. State transitions take place as a result of port driver commands or the occurrence of selected external events.

A simple programming sequence of the chip can be summarized as follows:

1. After power-up or reset, verify that self-test completed successfully.
2. Load CSRs with major parameters, such as the system base register, interrupt vector, or address filtering mode.
3. Create transmit and receive lists, and load CSRs to identify them to the Ethernet coprocessor.
4. Place a setup frame in the transmit list to load the internal reception address filtering table.
5. Start receive and transmit processes by placing them in the running state.
6. Wait for Ethernet coprocessor interrupts.
7. Issue a Polling Demand command if either the receive or transmit process enters the suspended state. This is done after correcting the cause of the process suspension.

The following sections describe Ethernet coprocessor operation:

- Hardware and software reset (Section 3.6.3.1)
- Interrupts (Section 3.6.3.2)

3.6.3.1 Hardware and Software Reset

The Ethernet coprocessor responds to two types of reset commands: a hardware reset through the RESET L pin, and a software reset command triggered by setting CSR6<31>. In both cases, the Ethernet coprocessor aborts all ongoing processing and starts the reset sequence. The Ethernet coprocessor restarts and reinitializes all internal states and registers. No internal states are retained, no descriptors are owned, and all rtVAX 300 visible registers are set to 0, except where otherwise noted.

Note

The Ethernet coprocessor does not explicitly disown any owned descriptors; so a descriptor's Own bits might be left in a state indicating Ethernet coprocessor ownership.

Table 3–41 lists the CSR fields that are not set to 0 after reset.

Table 3–41 Ethernet Coprocessor CSR Nonzero Fields After Reset

Field	Value
CSR3	Unpredictable
CSR4	Unpredictable
CSR5<16>	1
CSR6<28:25>	1
CSR6<31>	Unpredictable after hardware reset; 1 after software reset
CSR7	Unpredictable
CSR9	RT = TT = 1250

After the reset sequence completes, the Ethernet coprocessor executes the self-test procedure to do basic sanity checking. After the self-test completes, the Ethernet coprocessor sets the initialization done flag CSR5<31>. The self-test completion status bits CSR5<30> and CSR5<29:26> indicate whether the self-test failed and the reason for the failure.

Note

The self-test takes 25 ms to complete.

If the self-test completes successfully, the Ethernet coprocessor is ready to accept further rtVAX 300 commands. Both the reception and transmission processes are placed in the stopped state.

Successive reset commands (either hardware or software) may be issued. The only restriction is that Ethernet coprocessor CSRs should not be accessed during a 1-μs period following the reset. Access during this period will result in a CP–BUS timeout error. Access to Ethernet coprocessor CSRs during the self-test are permitted; only CSR5 reads should be performed.

3.6.3.2 Interrupts

Various events generate interrupts. CSR5 contains all the status bits that may cause an interrupt, provided that CSR6<30> is set. The port driver must clear the interrupt bits (by writing a 1 to the bit position) to enable further interrupts from the same source.

Interrupts are not queued, and if the interrupting event recurs before the port driver has responded to it, no additional interrupts are generated. For example, CSR5<02> indicates that one or more frames were delivered to rtVAX 300 memory. The port driver should scan all descriptors, from its last recorded position up to the first description owned by the Ethernet coprocessor.

An interrupt is generated only once for simultaneous, multiple interrupting events. The port driver must scan CSR5 for the interrupt cause(s). The interrupt will not be regenerated, unless a new interrupting event occurs after the rtVAX 300 acknowledged the previous one, and provided that the port driver cleared the appropriate CSR5 bit(s).

For example, CSR5<01> and CSR5<02> may both be set, the rtVAX 300 acknowledges the interrupt, and the port driver begins executing by reading CSR5. Now CSR5<03> sets. The port driver writes back its copy of CSR5, clearing CSR5<01> and CSR5<02>. After the rtVAX 300 IPL is lowered below the Ethernet coprocessor level, another interrupt will be delivered with the CSR5<03> bit set.

Should the port driver clear all CSR5 set interrupt bits before the interrupt has been acknowledged, the interrupt will be suppressed.

3.6.4 Serial Interface

The Ethernet coprocessor supports the full IEEE 802.3 frame encapsulation and media access control (MAC). The Ethernet coprocessor functions in a send and receive half-duplex mode and is in either the transmit or receive mode, except when the Ethernet coprocessor is in one of its loopback modes, which operate in full duplex.

3.6.4.1 Transmit Mode

In transmit mode, the Ethernet coprocessor initiates a DMA cycle to access data from the transmit buffer in rtVAX 300 memory to assemble a packet to be transmitted on the network. It then adds a preamble and start frame delimiter (SFD) pattern to the beginning of the data, calculates and appends a cyclic redundancy check (CRC) value, if enabled, to the data to make the packet. After the packet is assembled, the Ethernet coprocessor waits for MAC to allow transmission on the network. When transmission is enabled, the Ethernet coprocessor serializes the data and sends it to the serial interface adapter (SIA).

3.6.4.2 Receive Mode

In receive mode, the decoded serial data and clock are fed to the Ethernet coprocessor from the external SIA. The Ethernet coprocessor uses the decoded clock to read the data into its internal FIFO receive buffer. The data is deserialized, and the destination address is checked. If the message is for the Ethernet coprocessor, a CRC value for the received data is calculated and compared to the CRC checksum at the end of the frame. If there is a CRC error, an error bit is set in the receive descriptor. The Ethernet coprocessor notifies the rtVAX 300 processor of all received frames, including those with CRC errors and framing errors. Frames less than 64 bytes long are not delivered to the rtVAX 300 processor, unless the Ethernet coprocessor is programmed to do so.

3.6.5 Diagnostics and Testing

The Ethernet coprocessor supports three levels of testing and diagnostics:

- First Level—Error reporting during normal operation
- Second Level—In system software controlled diagnostic features
- Third Level—Hardware diagnostic mode, which allows access to the internal data paths of the Ethernet coprocessor

3.6.5.1 Error Reporting

The Ethernet coprocessor reports error conditions that relate to the network as a whole or to individual data frames. Network-related errors are recorded as flags in one or more of the Ethernet coprocessor's CSRs and result in an interrupt being posted to the rtVAX 300 CVAX processor. Frame-related errors are written to the descriptor entries of the corresponding frame. Table 3–42 lists reported errors by class.

Table 3–42 Ethernet Coprocessor Summary of Reported Errors

Classification	Error
System Errors	Memory Error
Serial Interface Errors	Collision Fail Transmit Watchdog Timeout Receive Watchdog Timeout Loss of Carrier
Frame Errors	CRC Error Framing Error Overflow/Underflow Error Translation Error Late Collision Error Frame less than 64 bytes long

3.6.5.2 On-Chip Diagnostics

The Ethernet coprocessor contains extensive on-chip diagnostics. These diagnostics include an internal self-test, loopback modes, and a time domain reflectometer.

3.6.5.2.1 Internal Self-Test The Ethernet coprocessor's self-test is run after a reset of the chip. The internal self-test checks the operation of the following sections of the Ethernet coprocessor:

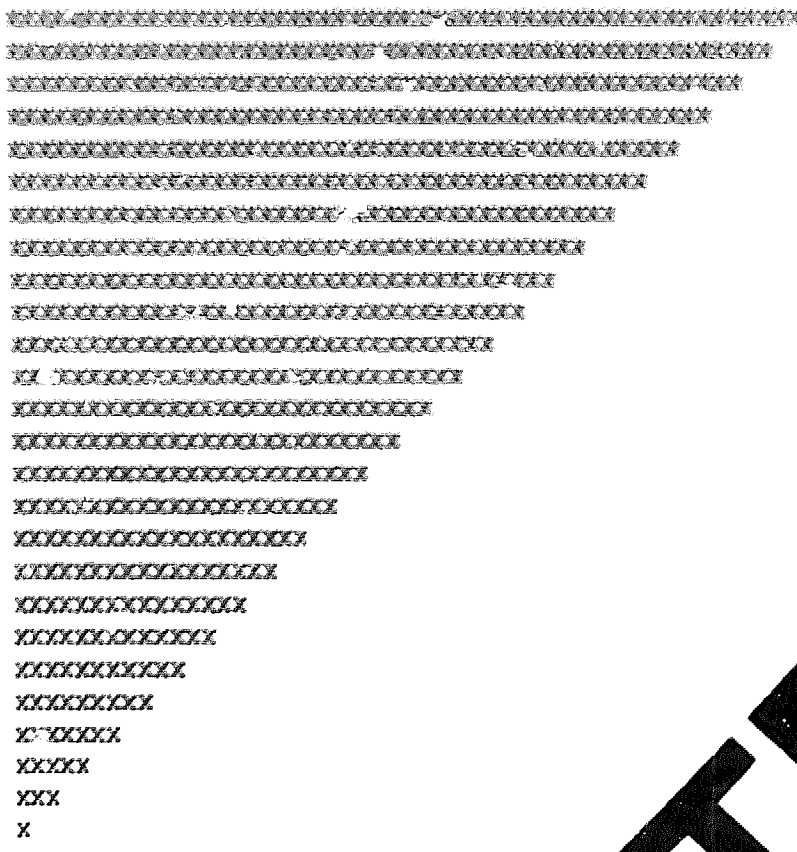
- Internal ROM
- Internal RAM
- Transmit FIFO
- Receive FIFO
- Address Recognition RAM

3.6.5.2.2 Loopback Modes The self-test performs a local loopback test. The Ethernet coprocessor supports these loopback modes: internal loopback and external loopback. Internal loopback mode permits the testing of Ethernet coprocessor logic that includes frame length checking, CRC generation and checking, and descriptor management, for example, chaining and virtual address translation. External loopback mode provides a loopback capability on an active Ethernet or IEEE 802.3 network. This mode places the Ethernet coprocessor in full duplex operation in which it receives its own transmissions. In either loopback mode, the rtVAX 300 software must:

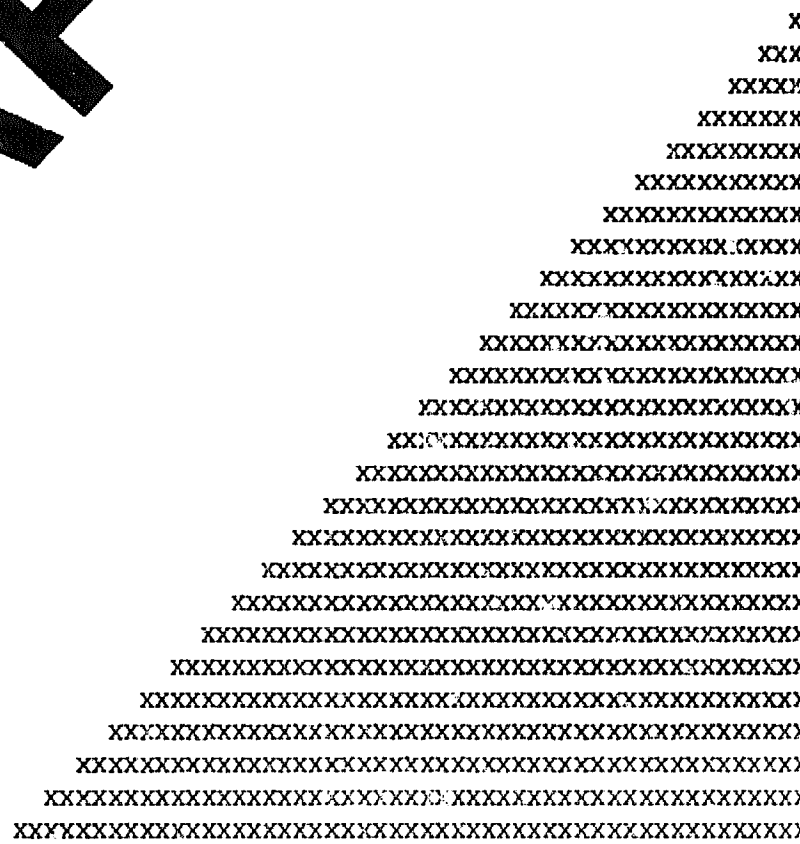
- Build the data frame that is to be transmitted
- Provide a receive buffer for the looped data that is to be returned to the rtVAX 300 processor

Loopback operation is selected by the operating mode bits (CSR6<09:08>).

3.6.5.2.3 Time Domain Reflectometer The Ethernet coprocessor has a time domain reflectometer (TDR) to help find faults on the Ethernet cable. The TDR detects short and open circuits on the cable that result in reflections on the cable.



CHAPTER 4



4

Firmware

The rtVAX 300 processor firmware contains the following components:

- A subset of the VAX console program
- Power-on and Ethernet self-tests
- Bootstrap for booting from Ethernet, serial lines, or PROM

The rtVAX 300 processor uses the clock interrupt for various timers. Portions of the code run at IPL 15_{16} to allow clock interrupts. No other interrupts are used.

The rtVAX 300 system firmware is the software in the system ROM. The corresponding firmware sections provide these functions:

- Power-on self-test—Tests the base system and the optional console at power-on
- System configuration—Handles integration of the optional console and memory with the base system by accessing external devices, sizing memory, and checking for console hardware registers
- Dispatcher—Handles entry to the system ROM by booting or entering the console emulation program
- Bootstrap—Loads the next level of software, that is, the VAXELN system image
- Console emulation program—Emulates a subset of the VAX standard console program

This chapter discusses the following topics:

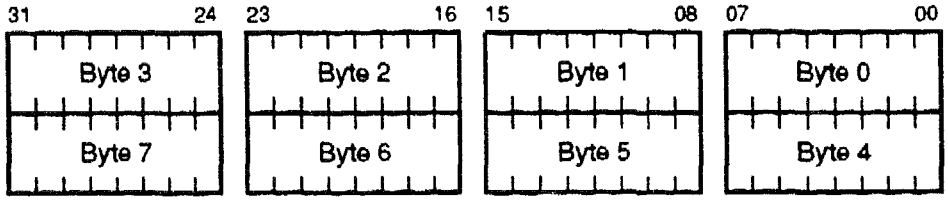
- System firmware ROM format (Section 4.1)
- System firmware entry (Section 4.2)
- Console program (Section 4.3)
- Entity-based module and Ethernet listener (Section 4.4)

- Startup messages (Section 4.5)
- Diagnostic test list (Section 4.6)
- System scratch RAM (Section 4.7)
- User-defined board-level boot and diagnostic ROMs (Section 4.8)
- Creation and down-line loading of test programs (Section 4.9)
- Serial-line boot directions (Section 4.10)
- ROM bootstrap operations (Section 4.11)

4.1 System Firmware ROM Format

The base rtVAX 300 firmware is contained in four 8-bit-wide ROMs; this provides a full 32-bit memory data path. Figure 4–1 shows the system ROM format.

Figure 4–1 System ROM Format

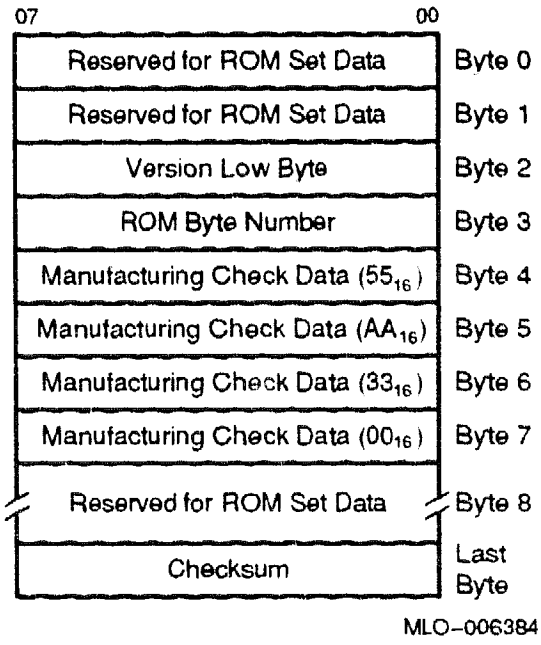


System firmware ROMs require two types of information: some information is required on a per-byte basis for ease of manufacture and development; the bulk of the information (software and tables) is supplied by the set of ROM parts.

4.1.1 System ROM Part Format

The following features are provided for each ROM part, that is, for each of the four ROM chips. These features simplify development and manufacture of ROM parts. The first two bytes (00 and 01) of each chip are reserved for data used within the context of the full set of chips. The ROM set data start on a longword boundary. Byte addressing is the address within the isolated chip, not the address in the system firmware ROM address space nor the address within the ROM set. The information presented in Figure 4–2 represents the data within each byte of the system ROM space. The data are replicated for each byte of the devices associated with the system ROM.

Figure 4–2 System ROM Part



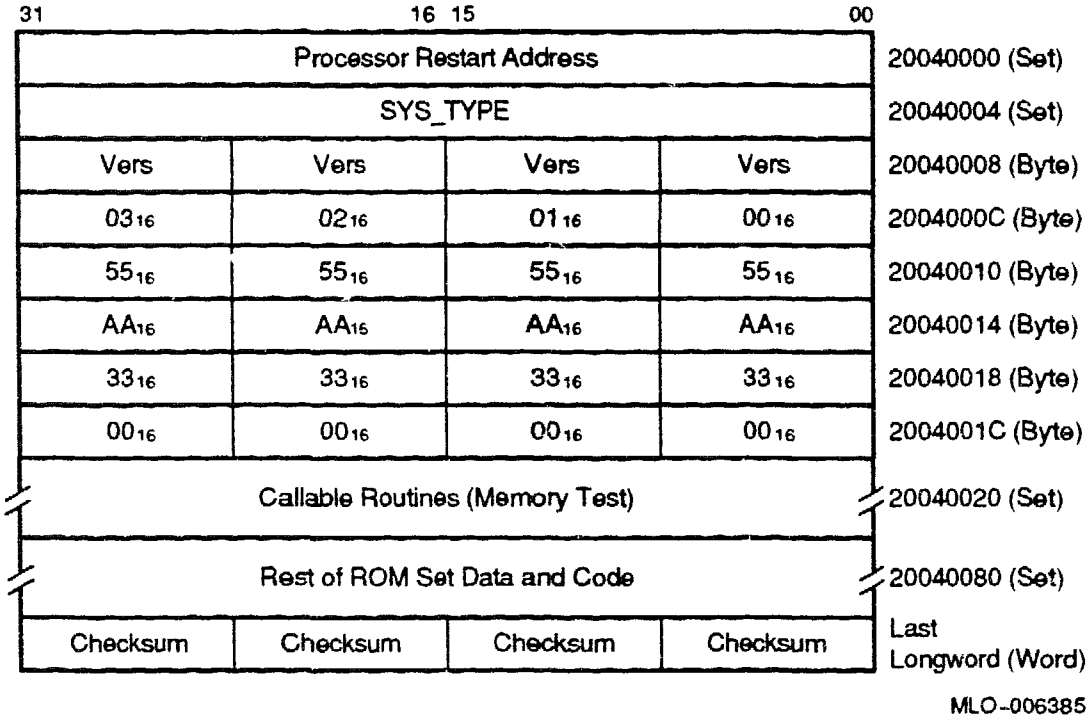
Contents are as follows:

- Version (byte 02)—Contains the version number of the console code for the rtVAX 300 system firmware. The same value appears in each of the four ROM parts, so that a set of chips may be verified to be compatible with a high level of confidence.
- ROM byte number (byte 03)—Indicates the position of the byte among the set of ROMs used to implement the firmware. This is equal to the low two bits of the physical address of the first byte in this ROM part. This value ranges from 0 to 3.
- Manufacturing check data (bytes 04 through 07)—May be used for a quick verification of the ROM. The data are 55_{16}, AA_{16}, 33_{16}, and 00_{16}.
- Checksum (last byte)—Each ROM byte contains a simple additive checksum in its last word. The system adds all bytes, modulus 256, and stores the negative value of the sum for each ROM.

4.1.2 System ROM Set Format

The following data are meaningful only within the context of the collated set of ROMs. All information in the system firmware ROM memory is position-independent. Figure 4–3 shows the ROM set data.

Figure 4–3 System ROM Set Data



These physical addresses in the rtVAX 300 base system ROM set are fixed, as follows:

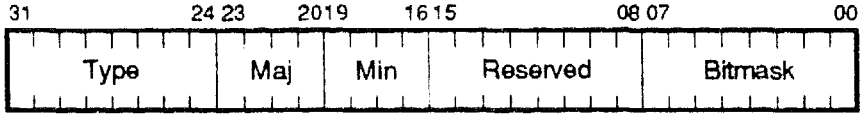
- 20040000 (processor restart address)—The rtVAX 300 hardware begins execution at address 20040000 on one of the following conditions:
  - At power-on.
  - On execution of a HALT instruction.
  - On assertion of the EXT HLT line, for example, when a break signal is received from the user-supplied console device or the HALT button is pressed.

- On processor detection of severe corruption of its operating environment. The processor is forced into kernel mode at IPL $1F_{16}$, and mapping is disabled, so that all addresses are physical.[1]

- 20040004 (SYS_TYPE)—This is the system type register. The value representing the rtVAX 300 is 09*nn*0002, where *nn* is an 8-bit quantity representing the major and minor revisions. The high byte is always 09, representing the rtVAX 300. The next byte contains two 4-bit quantities identifying the major and minor versions of the resident firmware. The lowest byte (2) identifies the rtVAX 300 as a single-user system. Figure 4–4 shows the system type register; Table 4–1 lists its fields.

- 20040008 (reserved for ROM part data)—24 bytes (6 bytes in each of the 4 system ROMs) are reserved for information contained in each ROM byte. Section 4.1.1 lists the information contained in each ROM byte.

Figure 4–4 System Type Register



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Table 4–1 System Type Register Fields

Data Bit	Definition
<31:24>	System processor type of the rtVAX 300. This field is 09_{16}.
<23:20>	Firmware Revision: Version Major ID. This field is 1_{16} for the rtVAX 300 Firmware Version V1.1.
<19:16>	Firmware Revision: Version Minor ID. This field is 1_{16} for the rtVAX 300 Firmware Version V1.1.
<15:08>	Reserved. This field is all zeros.
<07:00>	Licensing bitmask. Unused. The value of this field is 02_{16}, indicating a single-user system.

[1] The actual contents at the location 20040000 is a branch instruction.

4.2 System Firmware Entry

The firmware checks for a power-on entry to see if it should execute the power-on self-test. The firmware then passes control to the dispatch code shown in Example 4–1, which examines, and dispatches according to, the halt code set by the hardware at entry, the halt action fields stored internally, and the restart in progress and bootstrap in progress bits.

Example 4–1 Firmware Dispatch Code

```
if halt code = power on
   then (CPMBX<hlt_act> = 03
        CPMBX<hlt_swx> = 03
        BOOTDEV<2:0> = BOOT<2:0>
        if user_init code present then call user_init code
        if BOOTDEV<2:0> = 0
        then halt
        else boot according to BOOTDEV<2:0>
        endif
        )

elseif halt code = external halt
     then halt

else    (case CPMBX<hlt_act>
          0: (CPMBX<hlt_act>=CPMBX<hlt_swx>
             restart
             )
          1: (CPMBX<hlt_act>=CPMBX<hlt_swx>
             restart
             )
          2: (CPMBX<hlt_act>=CPMBX<hlt_swx>
             boot
             )
          3: (CPMBX<hlt_act>=CPMBX<hlt_swx>
             halt
             )
        )
endif
```

(continued on next page)

Example 4–1 (Cont.) Firmware Dispatch Code

```
restart: if restart in progress
           then (display 'restart error' message
             boot
             )
         else (set restart in progress
             do restart ❶
             )
         endif

boot:    if bootstrap in progress
         then (display 'boot error' message
             halt
             )
         else (set bootstrap in progress
             do boot ❷
             )
         endif

halt: do halt ❸
```

❶ Refer to Section 4.2.1.

❷ Refer to Section 4.2.2.

❸ Refer to Section 4.2.3.

4.2.1 Restart

The restart operation searches system memory for a restart parameter block (RPB). This data structure is previously allocated by the console program and filled in by the VAXELN realtime executive and the console program. If a valid RPB is found, the operating system is restarted at an address specified in the RPB. An internal flag indicating restart in progress is set to prevent repeated attempts to restart a failing operating system. A system restart can occur as the result of a processor halt.

4.2.2 Boot

The system firmware can load and start (bootstrap) an operating system. The firmware searches for a section of correctly functioning system memory large enough to hold a primary bootstrap program. If the firmware finds such a section of memory, it loads and starts the primary bootstrap.

The primary bootstrap then loads and starts the operating system. An internal flag indicating that a bootstrap is in progress is set to prevent repeated attempts to boot the operating system when one attempt has already failed. System bootstrap occurs when the operator enters a BOOT command or when the processor halts.

4.2.3 Halt

The console (Halt) program interprets commands entered on the console terminal and controls the processor operation. The following people may use the console terminal:

- An operator to boot the operating system
- A customer service engineer to maintain the system
- A system user to communicate with running programs

The processor can halt on one of the following conditions:

- An operator command
- A serious system error
- A HALT instruction
- Assertion of the HLT line
- Boot failure

Although users may employ the console program to develop software this is not a goal of its implementation. The operator may put the system in an inconsistent state by using console commands. The operation of the processor in such a state is undefined.

4.3 Console Program

This section discusses the operator interface to the firmware console program. The console program operates an optional user-supplied terminal through the Signetics 2681 Serial-Line Unit (SCN 2681 DUART) chip or its equivalent.

4.3.1 Entering the Console Program

The rtVAX 300 operates normally in program I/O mode. The mode is set to console I/O mode by one of the following methods:

- Kernel HALT occurs: the rtVAX 300 is running in kernel program mode, a program executes the HALT instruction, and the default recovery action is specified to halt.
- Boot operation fails and the default action is set for Boot/Halt.

- The boot operation fails, and the default recovery action is set for Restart/Boot/Halt.
- The operating environment is severely corrupted: the processor forces a processor restart when it detects one of several events indicating severe corruption of its operating environment. The system firmware treats this like a processor restart caused by a kernel mode HALT.
- The system powers on: the boot register bits 2:0 are specified to be Halt, or the boot switch is set for a boot option and the boot operation fails.
- Boot fails for any reason.
- External HALT: the external HLT line to the rtVAX 300 is asserted at any time. This line is typically connected to a user-supplied HALT button.

4.3.2 Compatible Console Interface

The rtVAX 300 ROM code includes console support similar to that supported by the rest of Digital's VAX product line.

4.3.3 Entering and Exiting from Console Mode

Normal operation of the rtVAX 300 is in program I/O mode. The mode is set to console I/O mode by one of the methods described in Section 4.2.

You issue the BOOT, START, or CONTINUE console command to exit from console I/O mode.

Caution

The operator can put the system in an inconsistent state by issuing console commands. Processor operation in such a state is undefined. If power fails, the rtVAX 300 processor enters the power-off state and loses all context, that is, memory and register contents.

4.3.4 Console Keys

The rtVAX 300 console I/O program responds to the following keys and signals:

Note

During execution of the XFER console command, data directed to and from the console are interpreted as binary data and thus may not be interpreted as described below.

- Return ends a command line. No action is taken on a command until after it is terminated by a carriage return. A null line terminated by a carriage return is treated as a valid, null command. No action is taken, and the console reprompts for input. Carriage return is echoed as <CR><LF>.
- Delete deletes the last character that the operator previously typed. The previous character is erased from the screen and the cursor is restored to its previous position.
- Ctrl/C aborts processing of the current command if control has not been passed to another program, such as the system-level diagnostics. The console program echoes this key as ^C.
- Ctrl/O causes the console to ignore transmissions to its terminal until the next Ctrl/O is entered. This key is echoed as ^O when it disables output but is not echoed when it reenables output. Output is reenabled if the console prints an error message or prompts for a command from the terminal. Displaying a REPEAT command does not reenable output. When output is reenabled for reading a command, the console prompt is displayed. Output is also enabled by entering program I/O mode, and then pressing Ctrl/C.
- Ctrl/Q resumes output to the console terminal that has been stopped by Ctrl/S. Additional Ctrl/Qs are ignored. Ctrl/Q and Ctrl/S are not echoed.
- Ctrl/S stops output to the console terminal until Ctrl/Q is pressed. Ctrl/S and Ctrl/Q are not echoed.
- Ctrl/U causes the console to echo ^U<CR> and deletes the entire line. If Ctrl/U is pressed on an empty line, it is echoed, and the console displays (>>>) to prompt for another command.
- Ctrl/R causes the console to echo <CR> <LF> followed by the current command line. This function can be used to improve the readability of a command line that has been heavily edited. When Ctrl/C is pressed as part of a command line, the console deletes the line, as it does with Ctrl/U.
- Break allows the system to enter console I/O mode upon receipt of the BREAK signal; you must supply circuitry to assert the EXT HLT line if the received signal goes into the spacing state for more than 100 ms. The SCN 2681 DUART does not support BREAK processing directly. (Chapter 6 gives a circuit example.)

4.3.5 Console Command Syntax

The console program prompt is three right angles (>>>) on a new line.[1]

The following restrictions apply to console commands:

- They are limited to 80 characters. Characters entered after the 80th character replace the last character in the buffer. Though characters so lost may be displayed on the console display, they will not be included in the actual command line.
- The command interpreter is case-insensitive. The lowercase ASCII characters "a" through "z" are treated as uppercase characters.
- The parser rejects characters with codes greater than $7F_{16}$. These characters are acceptable in comments.
- Type-ahead is not supported. Characters received before the console prompt is displayed are checked for control characters, such as, Ctrl/S, Ctrl/Q, and Ctrl/C, but otherwise discarded.

4.3.6 Console Commands

The rtVAX 300 console program supports the commands described in the following sections.

4.3.6.1 Boot

B[OOT] [/[R5:]<DATUM>] [<device-name>[:]]

The console program loads an operating system. If the load is successful, the operating system is started.

- Qualifier

  The qualifier is of the form /<DATUM>, where <DATUM> is a hexadecimal value passed as a longword in register five (R5) to the bootstrap program. This value is used as boot flags by the loaded code. An equivalent qualifier takes the form /R5:<DATUM> for backward compatibility. Refer to the specification of the loaded operating system for a detailed list of other used flags. The rtVAX 300 system firmware interprets only bit 9 of this longword. If bit 9 is set, the firmware immediately halts before transferring control to the booted code. The rtVAX 300 system firmware uses none of the other bits.

---

[1] The character sequence is $0D_{16}$, $0A_{16}$, $0D_{16}$, $3E_{16}$, $3E_{16}$, $3E_{16}$, 20_{16} (which is <CR>, <LF>, <CR>, '>>>', <SP>); this character string can be used by host software executing a binary load on the special attached terminal port to determine when it may respond.

- Device Name

  The name of the boot device is passed to the bootstrap routine in register zero (R0). The name is of the form *ddcu*, where *dd* is a 2-letter device mnemonic, *c* is an optional 1-letter controller designator, and *u* is a 1-digit decimal unit number. The console program accepts lowercase letters, but converts the name to uppercase. A terminating colon on the device name is acceptable, but not required; this character is not passed to the loaded code.

Section 4.3.7 lists boot devices and their corresponding mnemonics.

4.3.6.2 Continue

C[ONTINUE]

The console I/O mode is exited. Operation returns to (or begins in) program mode at the PC value either saved when console I/O mode was entered or entered by the operator using the DEPOSIT command.

Note

The interrupt stack pointer (ISP) must contain a valid virtual or physical address of RAM memory for this command to work. Two longwords are pushed on the interrupt stack. If the interrupt stack contains an invalid address, the following message is displayed:

```
?04 ISP ERR
```

4.3.6.3 Deposit

D[EPOSIT] [/<QUALIFIER>] <ADDRESS> <DATUM>

The specified datum is written to the specified address.

- Qualifiers
  - Access (size) qualifiers

    /B—byte
    /W—word
    /L—longword

  - Address qualifiers

    /V—virtual memory
    /P—physical memory
    /I—internal register

/G—general-purpose register
/M—machine register

- Miscellaneous qualifiers

  /N:<COUNT>—repeat count
  /U—unprotect

In the absence of an access or address qualifier, the previous qualifier is used. Specification of conflicting qualifiers is an error, and an appropriate error message is displayed; the command is ignored.

The effect of miscellaneous qualifiers /U and /N does not persist beyond the command in which they are typed.

The /U (unprotect) qualifier allows access to almost any address. Without the /U switch, a protected deposit or examine can only access memory that is reflected in the PFN map or physical addresses between 20000000 and 3FFFFFFF.

- Address—The address is specified in hexadecimal. A missing address is treated as a +. Supported symbolic addresses are as follows:
  - * is the location last referenced in an examine or deposit operation.
  - @ is the location addressed by the last location referenced in an examine or deposit operation. This reference cannot be to a general register.
  - + is the location immediately following the last location referenced in an examine or deposit operation. For references to physical or virtual memory spaces, the location referenced is the last address, plus the size of the last reference (1 for byte, 2 for word, 4 for longword).
  - – is the location immediately preceding the last location referenced in an examine or deposit operation. For references to physical or virtual memory spaces, the location referenced is the last address, minus the size of the last reference (1 for byte, 2 for word, 4 for longword).

The following limited set of mnemonic addresses is supported:

ASTLVL	AST level register
CADR	Cache disable register
ESP	Executive mode stack pointer
ICCS	Interval clock control register
IPL	Interrupt priority level register

ISP	Interrupt stack pointer
KSP	Kernel mode stack pointer
MAPEN	Memory management enable register
MSER	Memory system error register
P0BR	P0 base register
P0LR	P0 length register
P1BR	P1 base register
P1LR	P1 length register
PCBB	Process control block base address register
PC	Program counter
PSL	Program status longword
R<n>	General register (n = a decimal number 0 through 15)
SAVPC	Saved PC register—read only, ignored on write
SAVPSL	Saved PSL register—read only, ignored on write
SBR	System base register
SCBB	System control block base register
SID	System identification register
SIRR	Software interrupt request register
SISR	Software interrupt summary register
SLR	System length register
SP	Stack pointer
SSP	Supervisor mode stack pointer
TBCHK	Translation buffer check register
TBIA	Translation invalidate all register
TBIS	Translation invalidate single register
USP	User mode stack pointer

The rtVAX 300 system firmware maintains shadow copies of many processor registers, because reference to the actual registers would interfere with the operation of the rtVAX 300 firmware. Data accessible only through their shadow copies are general registers R0 through R15, the PSL, and internal registers MAPEN, ICCS, SCBB, IPL, MSER, and CADR. Access of any stack pointer may involve the current stack pointer (R14), the shadow copy of the stack pointer, and the internal registers.

Notes

1. The shadow copy replaces the actual copy at console exit.

2. Upon entry of the ROM code, the IPR CADR is not correctly saved; however, if the IPR CADR is changed by a DEPOSIT command, the value added by the DEPOSIT command is restored.

- Datum—The datum is specified as a hexadecimal number. A missing datum is treated as a zero entry.

4.3.6.4 Examine

E[XAMINE] [/<QUALIFIER>] [<ADDRESS>]

The contents of the specified address are displayed in hexadecimal.

- Qualifiers—Supported qualifiers are the same as the DEPOSIT command.
- Address—The address specification is the same as the DEPOSIT command

4.3.6.5 Find

F[IND] [<QUALIFIER LIST>]

The console searches the system memory starting at physical address zero for a page-aligned 128K-byte section of main memory or a restart parameter block (RPB). If the segment or block is found, its address plus 512 is left in the SP; otherwise, an error message is issued, and the contents of the SP are unpredictable. If no qualifier is specified, /MEM is assumed.

Valid qualifiers are:

- /MEM—Search memory for a page-aligned 128K-byte segment of good memory.
- /RPB—Search memory for a restart parameter block. The search leaves memory unchanged. SP contains the address of the RPB+200_{16}.

4.3.6.6 Halt

H[ALT]

A halt message is displayed, followed by the console prompt.

4.3.6.7 Help

HE[LP]

Supported console commands are listed along with supported parameters and available options. Figure 4–5 illustrates the Help screen.

Figure 4–5 Help Display

```
>>> help

  DEPOSIT [{ /B | /W | /L }] [{ /P | /V | /I }] [/U] [/N:<n>]
          [{ <addr> | <sym> | + | - | * | @ } [<datum>]]
  EXAMINE [{ /B | /W | /L }] [{ /P | /V | /I }] [/U] [/N:<n>]
          [{ <addr> | <sym> | + | - | * | @ }]
  SET BOOT <ddcu>
  SET BFLG <bflg>
  SET HALT <0-3>
  SET TRIG <0-1>
  SHOW {BOOT | BFLG | ETHER | HALT | MEM | TRIG}
  INITIALIZE
  UNJAM
  BOOT [/R5:][<bflg>] {EZA0 | PKA0 | PRBx | CSBx}
  CONTINUE
  START <addr>
  REPEAT <cmd>
  TEST <n>
  FIND [{ /MEM | /RPB }]
  XFER <addr> <cnt> ...
  HALT
  HELP

>>>
```

MLO-006357

The Help display is intended to aid the user and does not provide a complete description of the commands.

4.3.6.8 Initialize

I[NITIALIZE]

A processor initialization is performed. The following registers are set (all values in hexadecimal):

PSL	041F0000
ASTLVL	4
SISR	0
ICCS	0
MAPEN	0
CADR	0
PC	200
ISP	200

All other registers are unpredictable.

4.3.6.9 Repeat

R[EPEAT] <COMMAND>

The console program repeatedly executes the specified command. Repeated execution of a command stops when the operator types Ctrl/C or when any abnormal circumstance occurs. Any console command may be specified for the command.

4.3.6.10 Set

SE[T] <PARAMETER-NAME> <VALUE>

Note

All saved values are lost on power failure or reset.

Set the console parameter to the indicated value. The following console parameters and their acceptable values are defined:

- BOOT—Sets the default boot device. The value must be a valid boot device name, as specified in Table 4–9 in the device field.
- BFLG—Sets the default boot flags. The value must be a hexadecimal number of up to eight characters. The value that is entered is not checked for validity.

- HALT—Sets the default halt action and halt switch codes. This code specifies the default action the console should take for all error halts and halt instructions.
- TRIG—Sets remote trigger to be enabled or disabled. This allows a remote system to request a local boot of the system. If the Ethernet self-test has failed, then this command is illegal. The power-on condition for this is determined by BOOT<3>.

4.3.6.11 Show

SH[OW] <PARAMETER-NAME>

The indicated console parameter is displayed.

- BOOT—Displays the default boot device as defined above. If no boot device has been specified, the field appears as four dots (. . . .).
- BFLG—Displays the default boot flags. If no default flags have been specified, then 00000000 is displayed.
- ETHER—Displays the hardware Ethernet address. The Ethernet address ROM is validated and is displayed as ID YY-YY-YY-YY-YY-YY, where YY is a valid 2-digit hexadecimal number. If the Ethernet address ROM is invalid, then ID XX-XX-XX-XX-XX-XX is displayed to indicate that the Ethernet address ROM is invalid.
- HALT—Shows the default halt action code.
- MEM—Displays information concerning the rtVAX 300 system memory. The format of the display is:

```
>>> SHOW MEM

    00400000
    00000000
    003FD400:003FFFFF
```

The first 8-character field displays the total amount of memory in the system, including the console data structures. The second 8-character field shows the first address of 128K bytes of contiguous memory. The final line of the display shows the address range of the area of memory that is not available to the operating system. This includes the area of memory that is reserved for use by the console program. This field will be repeated as many times as needed to display all address ranges that are not available to the operating system.

- TRIG—Shows the state of remote trigger enable. If the returned value is 0, remote triggers are not allowed; if 1, remote triggers are allowed.

Note

The symbols used in the SET and SHOW commands must be entered as shown; however, they can be entered in lowercase and uppercase. The spelling of each symbol is critical.

4.3.6.12 Start

S[TART] <ADDRESS>

The console starts executing instructions at the specified address. The address is treated within the context of the user's memory management mode (physical or virtual).

If no address is given, the current saved PC is used. The START command is equivalent to a DEPOSIT PC followed by a CONTINUE. No initialization is performed.

Note

The interrupt stack pointer (ISP) must contain a valid virtual or physical address of RAM memory for this command to work. Two longwords are pushed on the interrupt stack. If the interrupt stack contains an invalid address, the following message is displayed:

```
?04 ISP ERR
```

Also note that the ISP is undefined after a power-up or reset.

The INITIALIZE command can be used to initialize the ISP and the rest of the processor.

4.3.6.13 Test

T[EST] <PARAMETER1> [<PARAMETER2>]

This command invokes extended diagnostics and utilities. Tests 1_{16} through 7_{16} are onboard power-up tests, tests 8_{16} through E_{16} are user-supplied power-up tests. (Refer to Table 4–5 for a list of test numbers and their meanings.)

4.3.6.14 Unjam

U[NJAM]

This command provides a system reset. The status of all devices returns to a known, initial state—that is, registers are reset to 0, and logic is reset to state 0.

This operation is implemented on the rtVAX 300 by invoking the hardware IORESET, and calling UNJAM routines for the Ethernet interface and the console serial-line unit, if present. The user is responsible for decoding the IORESET processor register to produce a reset signal and for using this signal to reset the user's devices. Any device that may interrupt the rtVAX 300 at IPL 16_{16} or IPL 17_{16} must be reset in this fashion. The user cannot reasonably expect to continue from an UNJAM command.

When you connect the rtVAX 300 to a bus, such as the VME bus, it is useful for the rtVAX 300 to be able to reset that bus and its peripherals under program control. The console UNJAM command provides this facility, because it writes to IPR 37_{16}, the I/O bus reset register. It is not implemented within the rtVAX 300 processor module.

However, if you need an external bus reset signal, external board-level logic should decode the external-internal processor register write cycle to IPR 37_{16} and assert the I/O bus reset line when any write is performed to that register location. Any user devices that may interrupt at IPL 16_{16} or 17_{16} must implement IORESET, and the device must disable all interrupts upon receiving IORESET.

There are no bit assignments for the external bus reset I/O register. The I/O bus reset should be performed after any write to IPR 37_{16}.

4.3.6.15 Transfer

X[FER] <ADDRESS> <COUNT> <CR> <CHECKSUM> <DATA STREAM> <CHECKSUM>

This command transfers binary data to and from physical memory. It is intended for use only by host software through an attached console terminal, serial port Channel A. Do not expect to be able to type this command from a keyboard. Note that XON/XOFF line spacing is disabled during the binary transfer: these characters are treated as binary data when they occur in the binary data stream.

- address—Specifies the physical address that the binary data are transferred to or from. It is specified as a hexadecimal number.
- count—Specifies the number of bytes to be transferred. The count is expressed as an 8-bit hexadecimal number. If the high-order bit of the count longword is 1, the data are transferred (read) from physical memory to the console terminal; if it is 0, the data are transferred (written) from the console terminal to physical memory.
- CR—Carriage return
- checksum—Specifies the two's complement checksum of the command string or data stream. The checksum is one byte of data expressed as a 2-digit hexadecimal number.
- data stream—"Count" bytes of binary data.

4.3.6.16 ! (Comment)

! <COMMENT>

<COMMAND> ! (comment)

The exclamation point prefixes a comment, wherever it appears on the line; the remainder of the line is ignored.

4.3.7 Supported Boot Devices

The boot device names that you can use to boot the rtVAX 300 processor are as follows:

1. EZA0—Ethernet
2. PRA0—ROM in memory space, starting at physical address 10000000
3. PRB0—ROM in I/O space, starting at physical address 20200000
4. PRB1—ROM in I/O space, copied to system memory
5. CSB0—Channel B on SCN 2681 DUART at 1200 bps
6. CSB1—Channel B on SCN 2681 DUART at 2400 bps
7. CSB2—Channel B on SCN 2681 DUART at 9600 bps

If no device name and/or qualifiers are given on the BOOT command, the console uses the value determined by BOOT<2:0>.

4.3.8 Console Program Messages

Error messages consist of a 2-digit hexadecimal number prefaced by a question mark and an abbreviated text message. Error message numbers are in the range 00_{16} through $7F_{16}$.

Section 4.5 discusses and illustrates startup messages that can be displayed during power-on initialization. Table 4–2 lists and describes firmware error messages.

Table 4–2 Firmware Error Messages

$Code_{16}$	Message Text	Description
02	?02 EXT HLT	The external HLT line was asserted.
04	?04 ISP ERR	The interrupt stack was inaccessible or invalid during the processing of an interrupt or exception.
05	?05 DBL ERR1	A machine check occurred while the processor was processing a normal exception.
06	?06 HLT INST	A kernel mode HALT instruction was executed.
07	?07 SCB ERR3	SCB interrupt vector bits <1:0> equaled 3.
08	?08 SCB ERR2	SCB interrupt vector bits <1:0> equaled 2.
0A	?0A CHM FR ISTK	A change mode instruction was executed when PSL<IS> was set.
0B	?0B CHM TO ISTK	The exception vector for the change mode had bit 0 set.
0C	?0C SCB RD ERR	A hard memory error occurred while the processor was trying to read an exception or interrupt vector.
10	?10 MCHK AV	An access violation or invalid translation occurred during the processing of a machine check.
11	?11 KSP AV	An access violation or invalid translation occurred during the processing of an invalid kernel stack pointer exception.
12	?12 DBL ERR2	A machine check occurred while the processor was trying to report a machine check.
13	?13 DBL ERR3	A machine check occurred while the processor was trying to report an invalid kernel stack pointer exception.
19	?19 PSL EXC5	PSL<26:24> = 5 on an interrupt or exception.

(continued on next page)

Table 4–2 (Cont.) Firmware Error Messages

$Code_{16}$	Message Text	Description
1A	?1B PSL EXC6	PSL<26:24> = 6 on an interrupt or exception.
1B	?1B PSL EXC7	PSL<26:24> = 7 on an interrupt or exception.
1D	?1D PSL EXC7	PSL<26:24> = 5 on an REI.
1E	?1E PSL EXC7	PSL<26:24> = 6 on an REI.
1F	?1F PSL EXC7	PSL<26:24> = 7 on an REI.
21	?21 CORRPTN	Console memory corrupted.
22	?22 ILL REF	The requested reference would violate virtual memory protection, the address is not mapped, the reference is invalid in the specified address space, or the value is invalid in the specified destination.
23	?23 ILL CMD	The command string cannot be parsed.
24	?24 INV DGT	The number has an invalid digit.
25	?25 LTL	The command was too large for the console to buffer. The message is issued only after the receipt of the terminating carriage return.
26	?26 ILL ADR	The specified address falls outside the limits of the addressing space.
27	?27 VAL TOO LRG	The specified value does not fit in the destination.
28	?28 SW CONF	Switches conflict.
29	?29 UNK SW	The switch is unrecognized.
2A	?2A UNK SYM	The symbolic address in the EXAMINE or DEPOSIT command is unrecognized.
2B	?2B CHKSM	The command or data checksum on the XFER command is invalid.
2C	?2C HLTED	The operator entered a HALT command.
2D	?2D FND ERR	The FIND command failed to find the RPB or 64K bytes of good memory.
2E	?2E TMOUT	During an XFER command, data failed to arrive in the expected time.
2F	?2F MEM ERR	A parity or other memory error occurred.

(continued on next page)

Table 4–2 (Cont.) Firmware Error Messages

$Code_{16}$	Message Text	Description
30	?30 UNXINT	Unexpected interrupt or exception. For some interrupts, this message is followed by the PC, PSL, and interrupt vector.
83	BOOT SYS	This is the bootstrapping message.
84	FAIL	This is the general failure message.
85	RESTART SYS	This is the restarting system software message.
86	RMT TRGGR	This is the remote trigger request message.

4.3.9 Console Device

The console program operates an optional attached terminal connected through a serial port. The attached terminal may be an ASCII video terminal, for example, a VT220 or VT320, or a host computer running special software.

The existence of a console is determined by the following test performed at power-on:

- Check the physical address 20100000 for a nonexistent memory error (NXM) timeout. If a timeout occurs, no console is available for use.
- The SCN 2681 DUART device is initialized, and the console port (Channel A) is initialized to 9600 bps, no parity, 8 bits/character, and 1 stop bit.
- Channel B is not initialized at this time.
- No check is made to determine whether a device is on the other end of the cable.

4.3.10 Capabilities of Console Terminals

Console terminals for the rtVAX 300 must support at least USASCII graphic character encoding. The terminal may optionally support the DEC Multinational Character Set, which is a superset of USASCII. National replacement character sets are not supported.

Characters normally transmitted by the console program are the USASCII graphic characters 21_{16} (!) through $7E_{16}$ (~), the space character 20_{16}, and control characters $0D_{16}$ (CR), $0A_{16}$ (LF), and 08_{16} (BS, a backspace character).

4.3.11 Console Entry and Exit

The system firmware must do several things when it enters and exits from console mode to ensure that the console window is displayed correctly.

Attached Terminals When present, the attached terminal on serial port Channel A is expected to be operable at all times. Console firmware does not attempt to alter the state of these terminals or the serial port through which they are connected. At entry to the console mode, firmware calls the operating system's SAVE routine (SCR$A_SAVE_CONSOLE), if supplied, and the console prompt is displayed; at exit, firmware calls the operating system's RESTORE routine (SCR$A_RESTORE_CONSOLE), if supplied.

Resident firmware sends several characters to the attached console terminal at entry to console mode. These attempt to place the terminal in a known mode and include:

- XON (11_{16}) enables terminal.
- ESC\ ($1B_{16}$, $5C_{16}$) turns off special text modes (ReGIS, SIXEL, etc).
- ESC\4i ($1B_{16}$, $5C_{16}$, 34_{16}, 69_{16}) directs output to screen.

4.4 Entity-Based Module and Ethernet Listener

The Ethernet maintenance operation protocol (MOP) module supports MOP Version 3 and Version 4 functions. The hardware device type of the rtVAX 300 in the MOP SYSID hardware code field is 105.

The Ethernet listener polls the Ethernet subsystem for receipt of packets. Once a packet has been received, the listener code inspects the packet protocol in order to determine the actions to take. Important protocols are as follows:

- MOP loopback packet (protocol 90–00) for Ethernet connectivity testing. The listener forwards or loops back a MOP loopback packet.
- DECnet SYSID request packet (protocol 60–02, type 5) for sizing the network. The listener generates a DECnet SYSID.
- Ethernet counters request packet (protocol 60–02, type 9) for checking the performance of the system on the Ethernet. The listener generates an Ethernet counters packet.
- DECnet bootstrap trigger packet (protocol 60–01, type 6) for forcing the rtVAX 300 system to enter its bootstrap sequence. Remote trigger must be enabled, in order to initiate the bootstrap process. The listener processes a down-line loaded system image.

- DECnet assistance volunteer packet (protocol 60–01, type 3) for the case where the console program has failed an attempt at booting over the Ethernet.

The listener is established when an initialization routine sets up a pointer in the scratch RAM area to the listener's starting address. The initialization routine is established when the Ethernet subsystem self-test passes and sets up the pointer in scratch RAM to the initialization routine's starting address.

The initialization routine is called by the UNJAM routine, or at power-up time prior to the console program startup, unless the MOP flag is set to 0. This routine establishes the Ethernet controller data structures (transmit and receive descriptor rings, data buffers) and some scratch area for the listener to maintain pointers and counters.

If the protocol is one of those described above, the listener code takes the appropriate action. If the protocol is unsupported, for example, DECnet routing updates, the packet is disregarded.

4.5 Startup Messages

The console displays messages and menus, some during power-up and others when the operator issues commands at the console terminal. The latter depend on entries in the console memory.

4.5.1 Power-On Display

This display is intended to give a complete, but abbreviated, account of the results of the power-on initialization. The display includes the board name and firmware version, a hexadecimal countdown list of test modules (F through 1) with a quick summary of the status of each, and an expanded status report of those test modules for which error or status information is available. The following example shows a sample power-on display:

```
E...D...C...B...A...9...8...

rtVAX 300 Vn.m

>>>
```

where:

n is the major version number
m is the minor version number

In the countdown line, each test number is followed by a status character and two periods. Table 4–3 lists the status codes and their meanings.

Table 4–3 Countdown Status Codes

Code	Meaning
.	Test completed without fatal error
?	Fatal error detected in test
_	Test determined option is missing
*	The return status of a user-supplied test was not 1 (test passes), 0 (test failed), or –1 (option not present)

4.5.2 Boot Countdown Description

When the rtVAX 300 is loading an operating system, the LED display and the console display, if they exist, indicate the progress of the boot. Table 4–4 explains the meanings of the LED displays and console messages.

Table 4–4 Boot Countdown Indications

LED $Display_{16}$	Console Message	Meaning
02	2...	The bootstrap code has started; no valid load host or ROM boot block has been located yet.
01	1...	For ROM boots, the ROM boot block has been located, and if the ROM is to be copied to memory, this procedure has started.
		For Ethernet and serial line boots, a host system has offered to down-line load an operating system to the rtVAX 300 and load of the operating system has started.
00	0...	The load of the operating system from the host or copying and verifying of ROM is complete, and control is being transferred to the loaded operating system.

When the system is booted, a positive indication of boot status is returned in the processor LED display and on the console terminal, as follows:

- The name of the boot device appears on the console terminal.
- The value 2 appears on the console terminal and the processor LEDs to indicate that the bootstrap device is about to be accessed.

- The value 1 appears on the console terminal and the processor LEDs to indicate that the rtVAX 300 firmware has found the secondary bootstrap image on the boot device, and is now reading the image into physical memory
  - For ROM boots, the ROM boot block has been located and copied to memory, if the boot device was PRB1.
  - For Ethernet and serial-line boots, a host system has volunteered and is down-line loading the rtVAX 300 system.
- The value 0 appears on the console terminal and the processor LEDs to indicate that the rtVAX 300 resident firmware is now transferring control to the operating system or secondary bootstrap.

A typical console display during the boot process is:

```
-EZA0
2..1..0..
```

This illustrates a boot from the Ethernet. Other boot devices would be displayed, depending on the setting of the user boot register.

4.5.3 Halt Action

The operator may inspect and possibly modify the console fields used during processor restarts by using the console SET/SHOW HALT command, for example:

```
>>> SET HALT
2 ? >>> 3
>>>
```

See Section 4.2.1 for more information.

4.5.4 Boot Device

The operator may inspect the console field used for the default boot device and modify it by using the console SET/SHOW BOOT command, for example:

```
>>> SET BOOT
EZA0 ? >>>
>>>
```

See Section 4.2.2 for more information. This field is initialized from the boot register upon reset or power-up. When there is no default for the boot device, it is displayed as four periods. To clear the field, enter a period at the prompt.

4.5.5 Boot Flags

The operator may inspect and possibly modify the console field used as default boot flags for system image boot by using the console SET/SHOW BFLG command, for example:

```
>>> SET BFLG
00000000 ? >>> 10
>>>
```

See Section 4.3.6.1 for information on the BOOT command. This field is zeroed upon power-up or reset.

4.6 Diagnostic Test List

Tests are listed in the order they are executed upon restart. Tests are executed implicitly by a power-up/restart condition or explicitly by a console TEST *nn* command, where *nn* is the hexadecimal test number. Table 4–5 lists LED-displayed test numbers and their meanings.

Each test has the following features:

- When called from the console, it supports loop-on-test, loop-on-error, halt-on-error, and continue-on-error.
- It has two levels of subtests:
  - The functional unit of the device under test
  - The particular function of the subunit being tested

Table 4–5 LED Test Number Code List

Test No.	LED $Code_{16}$	Description
0		Initialization test. This test is not user-selectable.
	FF	Power-up value; this value is set on power-up. It indicates that there is power on the module. If the display remains at this value, the rtVAX 300 is unable to execute the first few instructions correctly.
	FE	The first few instructions have completed. The rtVAX 300 can write to the display register.
	FD	Special value u. d for the rtVAX 300 HALT test in the tester box. This value is used only when the rtVAX 300 test box is used.

(continued on next page)

Table 4–5 (Cont.) LED Test Number Code List

Test No.	LED $Code_{16}$	Description
	FC	Special value used for the rtVAX 300 HALT test in the tester box. This value is used only when the rtVAX 300 tester box is used.
	FB	The actual presence of the LED display is verified.
	F8	Value set when user initialization ROM entry point is called.
	F7–F1	Reserved for use by the user's initialization ROM.
	F0	The preliminary initialization is completed. Basic rtVAX 300 instructions work, and it is possible to communicate off the chip.
1		rtVAX 300 ROM verification, LED tests, and checksum. Verify the ROM checksum, that the high and low bytes of ROM are the same version, and that ROM test patterns are correct. The LED registers are verified. This may be the only means to display errors.
	EF	The ROM high and low byte identification words are incorrect.
	EE	ROM version numbers do not match.
	ED	ROM test patterns are incorrect.
	EC	ROM checksum is incorrect.
	E0	ROM tests exited successfully.
2		Memory test codes DF, DE, DD, and D1 are displayed by the scratch memory tests that find and verify RAM used by ROM code and tests that locate, verify, and initialize RAM for use by the console data structures. The RAM is tested with bit pattern test and an address test and cleared to 0.
	DF	No memory present.
	DE	Memory could not be cleared.
	DD	Sizing memory.
	D8	Full memory test—clearing memory.
	D7	Full memory test—memory addressing test.
	D6	Full memory test—test each page of memory.
	D5	Full memory test—test page boundaries.
	D1	Sizing memory completed.
	D0	Scratch memory initialized and is usable.

(continued on next page)

Table 4–5 (Cont.) LED Test Number Code List

Test No.	LED $Code_{16}$	Description
3		Console channel routine, channel existence, and verification. Check to see if a console device responds to the console address. The console will be used after this point if it exists and is functional.
	CF	Console not found. All output directed to the console is discarded (not necessarily a failure).
	CE	Console detected.
	C9	Initialization of Ethernet coprocessor after self-tests.
	C8	UNJAM function after self-tests.
	C7	Performing automatic restart/boot/halt action according to boot register.
4		Not implemented.
5		Floating-Point Accelerator test. The different groups of floating-point instructions, including F-, D-, G-float adds, subtracts, multiplies, comparisons and divides are tested and verified with known results. This verifies the operation of the CFPA.
	AF	MOVF instructions.
	AE	MNEGF instructions.
	AD	ACBF instructions.
	AC	ADDF2/ADDF3 instructions.
	AB	CMPF instructions.
	AA	CVTFD/CVTFG instructions.
	A9	CVTFB/CVTFW/CVTFL/CVTRFL instructions.
	A8	CVTBF/CVTWF/CVTLF instructions.
	A7	DIVF2/DIVF3 instructions.
	A6	EMODF instructions.
	A5	MULF2/MULF3 instructions.
	A4	POLYF instructions.
	A3	SUBF2/SUBF3 instructions.
	A2	TSTF instructions.
	A0	CFPA tests passed.

(continued on next page)

Table 4–5 (Cont.) LED Test Number Code List

Test No.	LED $Code_{16}$	Description
6		Interval timer test. Verify the on-board interval timer interrupt signal exists, does generate interrupts when enabled, and is accurate.
	9F	Interval timer interrupts when disabled via IPL.
	9E	Interval timer does not interrupt.
	9D	Time between interrupts is too short or is not consistent.
	9C	Interval timer interrupts when disabled via ICCS IPR.
	90	Interval timer tests passed.
7		Ethernet test. Tests that the Ethernet interface is functional and that the Ethernet network ID ROM contains a valid network address and correct checksum. Ethernet tests consist of the Ethernet self-test, an Ethernet sanity test, internal and external loopback testing of the Ethernet, address filter testing and several others. This test determines if the Ethernet can be used for booting. This is the final self-test.
	8F	Ethernet sanity test failed.
	8E	ROM network ID address test failed.
	8D	Ethernet internal loopback failed.
	8C	Ethernet collision test failed.
	8B	Multicast addressing test failed.
	8A	CRC test failed.
	89	Frame type test failed.
	88	Virtual mode test failed.
	80	Ethernet tests passed.

The remaining tests are reserved for the user-application-specific test ROMs and are not part of the rtVAX 300.

8	7F–70	User-supplied Test 8.
9	6F–60	User-supplied Test 9.
A	5F–50	User-supplied Test A.

(continued on next page)

Table 4–5 (Cont.) LED Test Number Code List

Test No.	LED $Code_{16}$	Description
B	4F–40	User-supplied Test B.
C	3F–30	User-supplied Test C.
D	2F–20	User-supplied Test D.
E	1F–10	User-supplied Test E.

The following routines are in the rtVAX 300:

–		System boot. This is not a test. If other tests pass, the system either boots or enters console mode, as determined by the boot register setting.
	05	System is awaiting or executing a console command.
	03	Console Restore Procedure, called before control is transferred to user's code, by CONTINUE command.
	02	Attempting boot.
	01	Boot host found, or ROM boot block located.
	00	Control passed to down-line loaded code or external ROM code.

Once control is passed to the loaded code, the state LEDs will have meaning only as defined by that code.

Caution

User code may modify the LED display without affecting the system ROM code; however, such modifications may cause confusion, if the user believes that the system ROM code caused the status.

4.7 System Scratch RAM

The rtVAX 300 system firmware acquires a number of pages of RAM memory at power-on initialization. These pages are marked "bad" in the memory bitmap to prevent higher-level software from modifying their data indiscriminately. Table 4–6 lists the offsets in the scratch RAM to parameters and variables of interest to operating system or option ROM developers.

Table 4–6 Scratch RAM Offset Definitions

$Offset_{16}$	Name
00	Console program mailbox
01	Console program flags
02	Default boot device register
03	Reserved
04	SCR$A_RESTORE_CONSOLE
08	SCR$A_SAVE_CONSOLE

Figure 4–6 shows the layout of the console mailbox register; Table 4–7 describes its fields. Figure 4–7 shows the layout of the console program flags; Table 4–8 describes its fields. Figure 4–8 shows the layout of the default boot device register; Table 4–9 describes its fields.

Figure 4–6 Console Mailbox Register (CPMBX) Offset 00_{16}

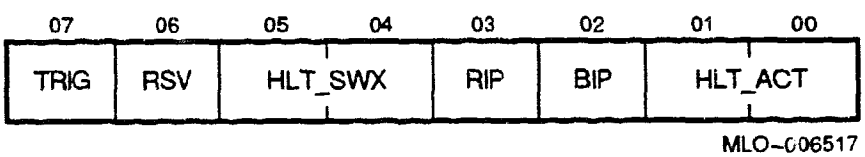


Table 4–7 Console Mailbox Register Fields

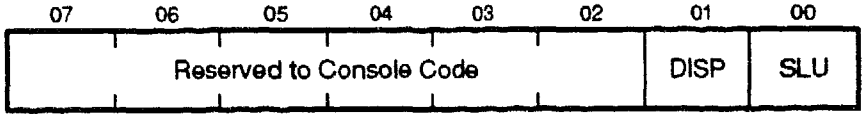
Field	Description
TRIG	A 1-bit field that indicates that remote triggers are allowed. If this bit is set, remote trigger is allowed. This field is initialized upon power-up/reset to the value of the remote trigger bit of the boot flags byte after the user's initialization routine (if any) is called.
RSV	Reserved.
HLT_SWX	A 2-bit halt switch field used to encode permanently the desired console action when a processor halt occurs (except externally generated halts brought about by the assertion of the HLT L line). The action taken is indicated below: 0 — Restart; if that fails, boot; if that fails, halt. 1 — Restart; if that fails, boot; if that fails, halt. 2 — Boot; if that fails, halt. 3 — Halt. This field is initialized upon power-up/reset to the value 2 (BOOT) before the user's initialization routine (if any) is called. This field may be inspected and modified by using the SET/SHOW HALT console commands. At entry to the console, this value is moved to the HLT_ACT field, except for externally generated halts.
RIP	A 1-bit field that serves as the restart in progress flag. The bit is set when the console attempts a restart. If it is already set, the restart attempt is abandoned, an error message is displayed, and a boot is attempted. This field is cleared at power-up. It is also cleared at entry to the console (halt) program, after any attempts at restart and/or boot. The user application must clear this bit when the Ethernet coprocessor's Boot Message Enable mode is to be used.

(continued on next page)

Table 4–7 (Cont.) Console Mailbox Register Fields

Field	Description
BIP	A 1-bit field that serves as the bootstrap in progress flag. The bit is set when the console attempts a cold restart. If the bit is already set, the bootstrap attempt is abandoned, an error message is displayed, and the Console (halt) program is executed. This field is cleared at power-up. It is also cleared at entry to the console (halt) program, after any attempt to boot. The user application must clear this bit when the Ethernet coprocessor's Boot Message Enable mode is to be used.
HLT_ACT	A 2-bit field that temporarily encodes the action that the console is to take when the next processor halt occurs (except for externally generated halts, such as BREAK and assertion of the HLT L signal). The action taken is as described for HLT_SWX above. This field is copied from the HLT_SWX field at power-up, upon execution of the SET/SHOW HALT console commands, and at entry to the console.

Figure 4–7 Console Program Flags



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Table 4–8 Console Program Flags Fields

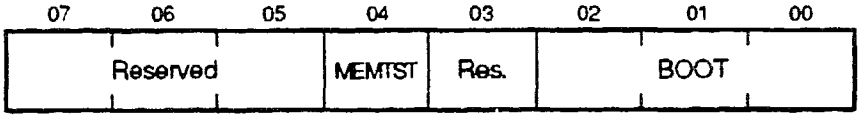
Field	Description
DISP	A 1-bit field used by the console code to determine if the hexadecimal display at address 201FFFFE is present. If the bit is set, that address responded, and the display is assumed to exist. If the bit is clear, there was no hardware response to that address. User-supplied tests and booted images may test this bit to determine if the display register exists. This field is initialized at every entry to the console program.

(continued on next page)

Table 4–8 (Cont.) Console Program Flags Fields

Field	Description
SLU	A 1-bit field used by the console code to determine if the SCN 2681 console DUART at address 20100000 is present. If the bit is set, the address responded and preliminary tests determined that the console DUART was usable. If the bit is clear, there was no hardware response to that address. User-supplied tests and booted images may test this bit to determine if the console DUART is present. This field is initialized at every entry to the console program.

Figure 4–8 Default Boot Device Register (EOOTDEV)



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Table 4–9 Default Boot Device Register Fields

Field	Description
<2:0>	A 3-bit field used to determine the default boot action of the rtVAX 300 when it executes a boot sequence. This field is temporarily overridden by a BOOT command with an explicit device specified. This field is initialized from the boot register at power-up or reset and may be modified by software control. Possible field meanings are as follows:

BOOTDEV	Device	Boot Action
000	....	No boot performed; system enters or remains in HALT mode.
001	PRA0	Boot from ROM in system memory space. The firmware searches for a boot block starting at physical address 10000000 every 16K bytes until it finds the boot block or has reached the address 1FDFC000.
010	PRB0	Boot from ROM in I/O space. The firmware searches for a boot block starting at physical address 20200000 at each 512 byte boundary, until it finds the boot block or has made 256 attempts.
011	PRB1	Boot from ROM in I/O space after copy. The same action as the PRB0 boot is taken, except the contents of ROM are copied into RAM memory address before control is transferred, and then control is transferred to the RAM copy.
100	CSB0	DECnet DDCMP boot. Channel B on the SCN 2681 is initialized to 1200 bps, and a DDCMP MOP load function is executed. See the DDCMP specification for more details. The SCN 2681 console DUART must be supplied by the user.
101	CSB1	DECnet DDCMP boot. Same as CSB0, except that Channel B is initialized to 2400 bps.
110	CSB2	DECnet DDCMP boot. Same as CSB0, except that Channel B is initialized to 9600 bps.
111	EZA0	Boot from Ethernet. The standard MOP protocol for Ethernet loads is used.

<3> Reserved.

(continued on next page)

Table 4–9 (Cont.) Default Boot Device Register Fields

Field	Description
<4>	Set if memory test is to be performed on power-up; cleared when test is not to be performed.
<7:5>	Reserved.

4.7.1 SCR$A_SAVE_CONSOLE

Scratch RAM contains the longword physical address of a save routine supplied by the operating system. This routine is called as the console program enters console mode. The routine gives the operating system the opportunity to save the current state of hardware that may be obliterated by the console device and to ensure that the console device hardware is in an operable state (as discussed in Section 4.3.11 and shown in Table 4–6). This routine is called with a JSB instruction at IPL $1F_{16}$ in kernel mode with memory management disabled. A value of 0 in this field implies that no routine has been provided, and no call is made in this case. The console program does not wait for the hardware that is used by the console device to complete its current operation (become stable) before calling this routine. This field is zeroed at power-up.

4.7.2 SCR$A_RESTORE_CONSOLE

This is the longword physical address of a restore routine supplied by the operating system. This routine is called as the console program exits from console mode. The routine gives the operating system the opportunity to restore the original hardware state when the console program no longer needs to use the console device. This routine is called with a JSB instruction at IPL $1F_{16}$ in kernel mode with memory management disabled. A value of 0 in this field implies that no routine has been provided; no call is made in this case. This field is zeroed at power-up.

4.8 User-Defined Board-Level Boot and Diagnostic ROMs

An optional, user-defined initialization routine and up to seven user-defined self-test routines can be located in user ROM. This 32-bit-wide user ROM is located at a starting address of 20080000 of physical I/O space. This ROM is optional and is not necessary for the normal operation of the firmware initialization and self-test routines.

On power-up, the firmware runs preliminary self-tests and then checks to see if a ROM exists at location 20080000. If a ROM responds to that address, the console program checks for a user-supplied ROM initialization routine in user ROM before executing the full self-tests. If the routine is found, the ROM initialization routine is called.

Once the rtVAX 300 firmware regains control from the user ROM initialization routine, the rtVAX 300 completes its self-test.

If the ROM exists at location 20080000, it is checked again for user-supplied self-test routines; these routines are executed, and the system attempts to boot or to enter console mode, depending on the setting of the BOOT<2:0> lines.

The longword at ROM address 2008001C contains the address of the user's initialization procedure. The seven longwords starting at ROM address 20080020 contain the physical addresses of the seven test routines. The physical address of these routines must be in the range of 20080040 to 200FFFFC, or be 0. A value of 0 for the physical address indicates that this routine does not exist. Figure 4–9 shows the layout of this ROM. Refer to Appendix D for a template of these routines.

The CALLG/CALLS instruction is used to call the initialization and test routines, and the RET instruction to return from them. You must follow the VAX calling standard and therefore save registers R2 to R11. If you use R2 to R11 in the routine, specify them in the procedure entry mask. Registers R12 to R15 are specially handled by CALLx/RET and need not concern users writing code according to the standard. The procedures are called at IPL $1F_{16}$ with memory mapping disabled.

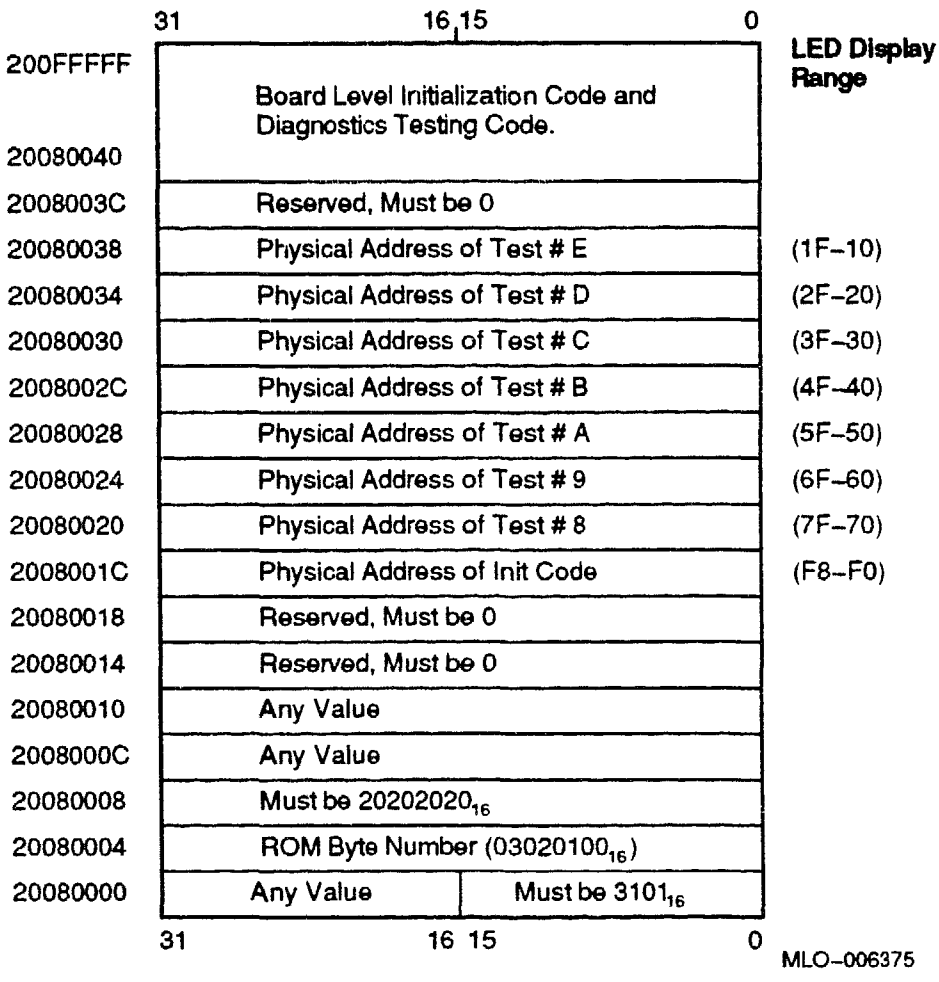
4.8.1 Optional User Initialization Routine

Routines in the initialization ROM can initialize any of the user-supplied devices to a known state and use the interrupt stack for variable storage. The only requirement is that the processor context be restored as described in the VAX calling standard after these routines exit.[1]

- The user's devices are optionally placed in a known state before the self-test is run.
- The console mailbox can optionally be modified.

[1] Registers R2 to R15, the interrupt stack, and all IPRs must be preserved. The *VAX Architecture Reference Manual* describes this standard.

Figure 4–9 User Boot/Diagnostic ROM



4.8.2 Input Parameters

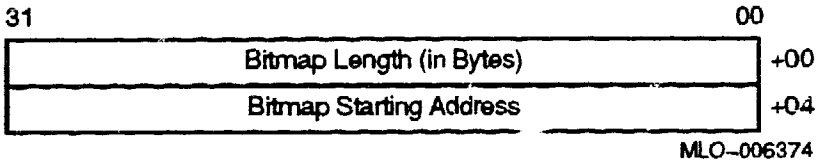
The user-defined initialization routine is called with three parameters:

- Parameter 1 (AP+4) is the address of the console mailbox.
- Parameter 2 (AP+8) is the address of the memory bitmap descriptor. Section 4.8.3 defines this descriptor.
- Parameter 3 (AP+12) is the address of a scratch memory area.

4.8.3 Memory Bitmap Descriptor Format

Figure 4–10 shows the layout of the memory bitmap descriptor.

Figure 4–10 Memory Bitmap Descriptor



Each bit corresponds to a page of memory; bit 0 corresponds to physical page 0, bit 1 corresponds to physical page 1, and so on. If a bit is 1, the corresponding page is considered good and available for use by the operating system. A page whose bit is 0 is considered "bad" or reserved by the console program, and is not to be used as general-purpose memory.

The initialization routine may change any bit from a 1 to a 0 to indicate that a page is reserved for any reason or is not to be passed to the loaded operating system as a normal memory page.

Bits set to 0 when the user initialization routine is called should not be set to 1 by user firmware.

The memory self-test that executes later will change the bit that corresponds to any defective page of memory to a 0. Pages whose bit is 0 when the memory self-test starts will not be tested.

4.8.4 Optional User-Supplied Diagnostic Routines

User-supplied ROM test routines can test any of the user-supplied devices. The seven longwords at 20080020 through 20080038 are checked for addresses of user-supplied tests. If these longwords contain a number in the range 20080040 through 200FFFFC, it is considered the address of a user test, and the test at this location is called with a CALLG/CALLS instruction. Any tests not used should have a 0 as the test address. The processor context must be restored according to the VAX calling standard after these ROMs exit.[1]

The LED status display values between 10_{16} and $7F_{16}$ are reserved for use by these external self-test routines. When control is passed to the test in ROM, the high-order byte of the LED status register is set to a value in the range of 1 through 7 to indicate the test number, and the low-order byte is set to F_{16}. The user's test routine must change the value from the starting value to

[1] Registers R2 to R15, the interrupt stack, and all IPRs must be preserved.

indicate progress through the user's subtests. Normally, the subtests count the lowest digit down from F_{16} to 0_{16}. The high-order byte should always indicate the same value to make failure codes unique.

4.8.4.1 Self-Test Routine Input Parameters

The user-defined initialization routine is called with five parameters:

- Parameter 1 (AP+4) is the address of a scratch memory area. The first 4K bytes may be used as a scratch memory area.
- Parameter 2 (AP+8) is the address of a longword that the test may use to store the PC if the test fails.
- Parameter 3 (AP+12) is the address of a quadword that the test may use to store "expected data" if the test fails.
- Parameter 4 (AP+16) is the address of a quadword that the test may use to store "actual data" if the test fails.
- Parameter 5 (AP+20) is a longword containing flags:
  - Bit 0: 1 if explicitly called with a TEST x command. Informational messages should be suppressed if this bit is 0.
  - Bit 1: 1 if test is called by the power-up sequence.
  - Bit 2: 1 if test should return immediately upon failure; if 0, test may continue to completion and return an error if there is a failure.
  - Bit 3: 1 if console DUART exists; otherwise, 0.
  - Bit 4: 1 if LED test display exists; otherwise, 0.

4.8.4.2 Self-Test Routine Output

The return status of each test is placed in register R0. Return status meanings are as follows:

- 1—Test passed successfully. During self-test, the hexadecimal digit corresponding to the test number followed by 3 periods (...) is displayed to indicate that the test passed.
- 0—Device under test failed the test. During self-test, the hexadecimal digit corresponding to the test number followed by a "?" and 2 periods (?..) is displayed to indicate that the test failed.
- –1—Device being tested is not present. During self-test, the hexadecimal digit corresponding to the test number followed by a "_" and 2 periods (_..) is displayed to indicate that the tested option is not present; however, this is not considered a failure.

4.8.5 Linking User Initialization/User Test ROM

To link the ROM containing the user initialization/user test routines, use the following LINK command to generate a ROM image in file ROM_IMAGE.SYS:

```
$ LINK/SYSTEM=%X20080000/NOHEADER/EXE=ROM_IMAGE.SYS rom1.obj,rom2.obj,...
```

4.9 Creation and Down-Line Loading of Test Programs

You can write simple test routines, down-line load their executable files (.EXE) to the rtVAX 300, and run them.

4.9.1 Writing Test Programs

Test routines can be written in VAX MACRO or in any other programming language that does not call the runtime library (RTL). When compiled and linked with the /SYSTEM and /HEADER qualifiers, they create an executable (.EXE) file, as in the following VAX MACRO code sample:

```
$ MACRO/LIST  TEST.MAR
$ LINK/SYSTEM/HEADER TEST.OBJ
```

The /HEADER information, which contains the starting address of the executable code, is automatically attached to the beginning of the .EXE file. The rtVAX 300's built-in maintenance operation protocol (MOP) loads the executable file into memory and jumps to the starting address.

The program is defined as a load file when the network data base is set up. Do not begin the program's code with the VAX MACRO .ENTRY statement or its equivalent in other languages.

The following example shows a VAX MACRO self-looping test program that allows verification of correct down-line loading:

```
START:      brb START
           .end START
```

When you power up the rtVAX 300, issue the BOOT EZA0 command to boot it; the processor loads the test program into memory and runs it. When the processor halts, it displays the current program counter address, which you can verify. The address should be 00001800, but it can vary according to the firmware revision.

Use the HALT instruction to end a test program. The processor halts and displays the program counter address.

4.9.2 Using MOP to Run Test Programs

To set up your network data base for an rtVAX 300 target node, use the network control program (NCP), defining the target node name, address, hardware address, and load file, as shown in the example below.

The network data base consists of the following:

- A permanent data base, which is stored on the system disk. You need BYPASS privileges to modify the permanent data base; you use the DEFINE command to make modifications.
- A volatile working data base, which is loaded at network startup time from the permanent data base. You need OPER privileges to modify the volatile data base; you use the SET command to make modifications.

```
NCP>  set node rtv300 hard address 08-00-2B-12-BC-36
NCP>  set node rtv300  service circuit qna-0
NCP>  set node rtv300 load file user:[day]test.exe
```

If network service is disabled, you must enable it, for example:

```
NCP>  set circuit qna-0 service enable
```

When you boot from Ethernet, MOP loads and starts the test program.

4.10 Serial-Line Boot Directions

The following directions show how to set up a VMS system for serial down-line loading of VAXELN system images to an rtVAX 300 target through Channel B on the DUART.

1. To load the asynchronous DDCMP driver, execute the following statements each time the system is booted:

   ```
   $  RUN SYS$SYSTEM:SYSGEN
   SYSGEN>  CONNECT NOA0:/NOADAPTOR
   SYSGEN>  ^Z
   ```

2. Configure the asynchronous terminal port as a DDCMP port as follows:

   ```
   $  SET TERM ddcu: /PROTOCOL=DDCMP
   ```

   where *dd* is the device code, *c* is the controller designation, and *u* is the unit number.

   Note

   To ensure that these procedures are performed on each system startup, enter the commands in steps 1 and 2 in the system startup file.

3. Determine the DECnet name for the terminal port used to boot the rtVAX 300. To do so, change the third character of the VMS device name (the *c* in the *ddcu:* format) from a letter to the number that corresponds to the letter's position in the alphabet; then, subtract one from that number.

   For example, if the port you are using is TXB4:, convert the third character (B) to 2 (since B is the second letter of the alphabet), and subtract 1, which leaves 1.

4. Take the following steps to build the new device name:

   a. Append a dash (–) to the first two characters of the VMS device name (the "dd" in the ddcu: format).

   b. Append the digit obtained in step 3 to the resulting string.

   c. Append another dash (–) to the resulting string.

   d. Append the unit number, which is the fourth and following digits of the VMS device name (the u in the ddcu: format).

   For example, the device name TXB4: becomes TX–1–4. The device name TTA1: becomes TT–0–1. Do not append the colon character (:) to the new device name.

5. Run the Network Control Program (NCP), as follows:

```
$ RUN SYS$SYSTEM:NCP
NCP>
```

6. Use the NCP SET command to identify the rtVAX 300 node name and address and to specify the new device name (derived in step 4) and the file that DECnet must down-line load to the rtVAX 300 when it makes a load request.

```
NCP> SET NODE name ADDRESS a.n SERVICE CIRCUIT tt-m-n LOAD FILE file.ext
```

`name`	The DECnet name assigned to the rtVAX 300
`a.n`	The DECnet address of the rtVAX 300
`tt-m-n`	The terminal name derived in step 3
`file.ext`	The name of the system image to be loaded to the rtVAX 300

   For an rtVAX 300 named RTVAX1 connected to TXB4: to which you need to down-line load the file MOM$LOAD:RTVAX300.SYS, you would enter the following NCP SET command:

```
NCP> SET NODE RTVAX1 ADDRESS 1.1 SERVICE CIRCUIT TX-1-4 LOAD -
     FILE MOM$LOAD:RTVAX300.SYS
```

7. Start the DECnet line using the terminal name derived in step 4, as follows:

```
NCP>  SET LINE tt-m-n STATE ON LINE SPEED xxxx
```

tt-m-n	The terminal name derived in step 3
xxxx	The line speed to be used (one of 1200, 2400, or 9600 bps for the rtVAX 300)

For example, you use the following NCP SET LINE command to set the line for device TXB4: at 9600 baud:

```
NCP>  SET LINE TX-1-4 STATE ON LINE SPEED 9600
```

8. Start the DECnet virtual circuit, and instruct DECnet to service load requests, as follows:

```
NCP>  SET CIRC tt-m-n STATE ON SERVICE ENABLED
```

For example, you use the following NCP SET CIRCUIT command to start the virtual circuit for device TXB4: specified in the previous step:

```
NCP>  SET CIRC TX-1-4 STATE ON SERVICE ENABLED
```

Note

Use NCP DEFINE rather than NCP SET commands to save the information in the nonvolatile data base, where it can be automatically used whenever DECnet is started or restarted.

4.11 ROM Bootstrap Operations

The ROM bootstrap allows an rtVAX 300 system to execute either out of ROM or out of RAM, after the system image has been copied from ROM to RAM.

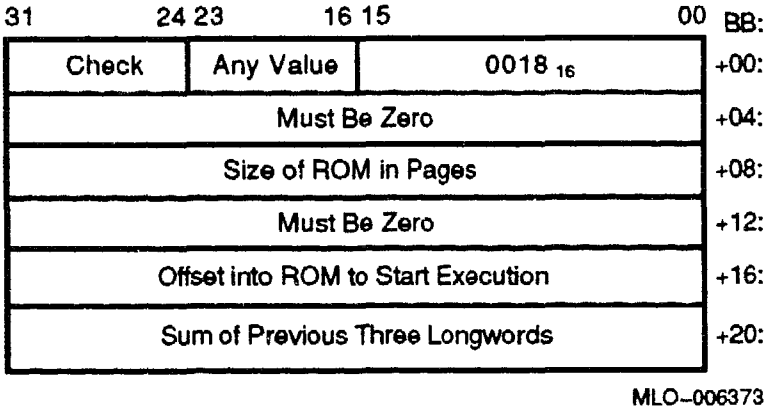
You can specify which RAM bootstrap to use in any of the following ways:

- By selecting a boot action in the boot register at power up
- By using the BOOT command and explicitly specifying any of the ROM boot devices
- By overriding the default boot action in the BOOTDEV register through software

The ROM bootstrap uses a boot block mechanism that allows flexible placement of the ROM in either of the two ROM address spaces. To locate a ROM bootstrap, the rtVAX 300's resident firmware searches a ROM address space, looking for a valid page-aligned ROM boot block. When the first six longwords of any such page contain a valid ROM boot block, the rtVAX 300's firmware copies the ROM contents (if selected) and starts execution. Otherwise, the search continues until the resident firmware has either searched all of the ROM address space or has found a ROM boot block.

Figure 4–11 shows the format of the ROM boot block.

Figure 4–11 ROM Boot Block



BB+0: This word must be 0018_{16}.

BB+2: This byte may be any value.

BB+3: This byte must be the one's complement of the sum of the previous three bytes.

BB+4: This longword must be 0.

BB+8: This longword contains the size (in pages) of the ROM.

BB+12: This longword must be 0.

BB+16: This longword contains the byte offset into the ROM where execution is to begin.

BB+20: This longword contains the sum of the previous three longwords.

The rtVAX 300 supports two ROM address spaces:

- Cached ROM address space
- ROM I/O address space

4.11.1 Booting from Cached ROM Address Space

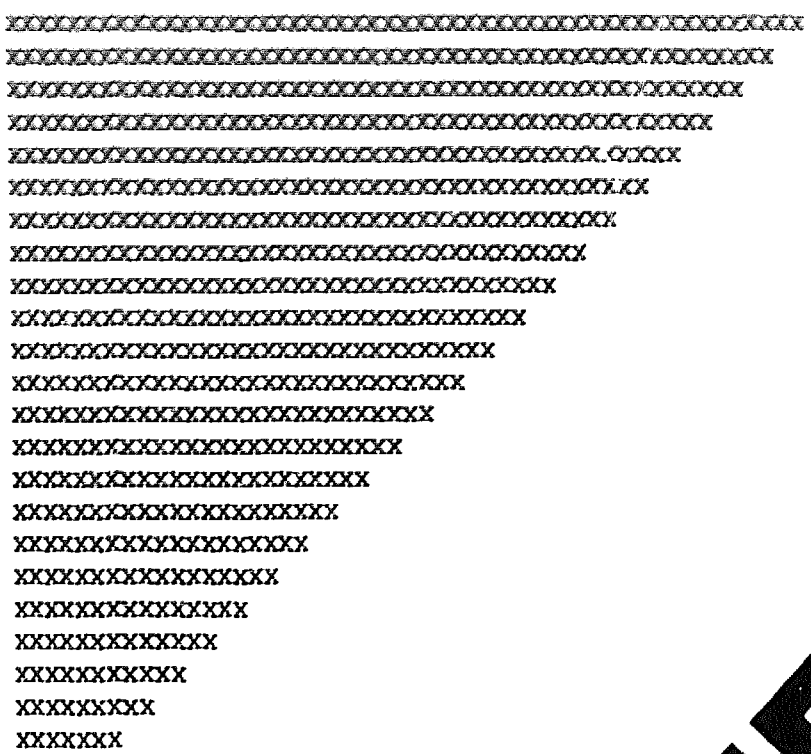
Cached ROM address space is located in memory space to permit the caching of any data and instruction references to it. Cached ROM address space provides 254M bytes of addressing. It begins at address 10000000 and ends at address 1FDFFFFF.

Booting from cached ROM address space is selected by the device PRA0. To speed the search for the ROM boot block, only pages on 16K-byte boundaries are checked for a ROM boot block.

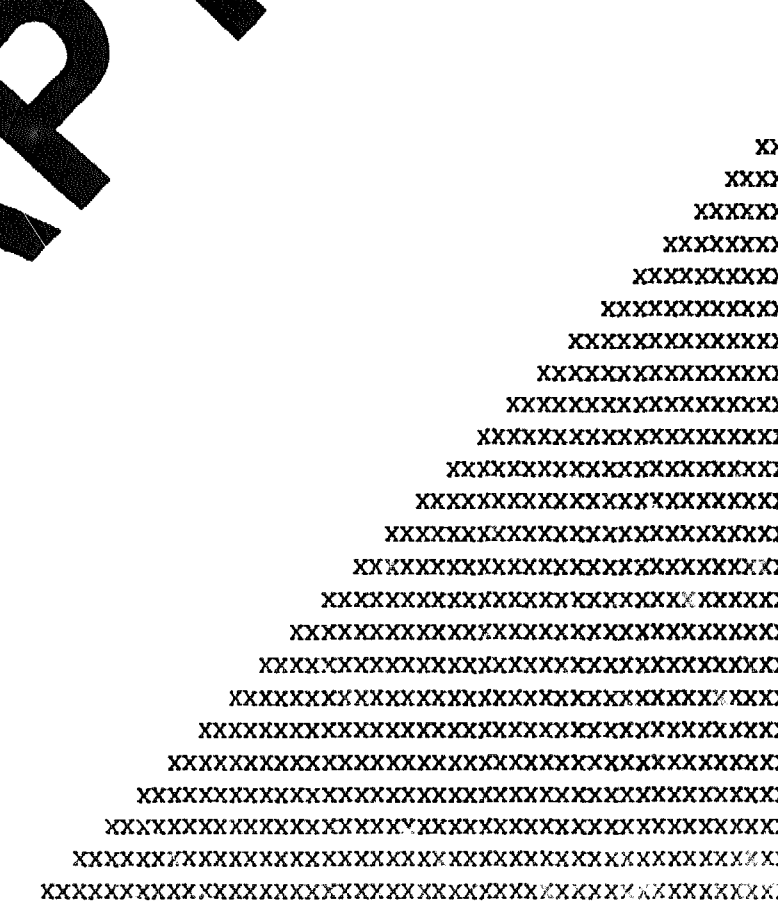
4.11.2 Booting from ROM I/O Address Space

ROM I/O address space is located in user I/O space. Any data and instruction references to ROM located here are not cached.

ROM I/O address space starts at the base of user I/O space starting at address 20200000. Booting from ROM I/O address space is selected by the devices PRB0 or PRB1. There is no restriction on the upper bound of ROM I/O address space; however, the search for a ROM boot block is limited to 255 pages and is done on a page-by-page basis. Bootstrap operations for the two devices PRB0 and PRB1 are identical, except that, for PRB1, the ROM is copied to the first contiguous piece of good RAM in memory space large enough to hold the ROM image.



CHAPTER 5



5

Memory System Interface

This chapter provides the technical information necessary to design a RAM memory system for the rtVAX 300 processor. A 4M-byte DRAM memory array and controller design is presented as an example. Design illustrations are included at the end of this chapter.

This chapter discusses the following topics:

- Memory speed and performance (Section 5.1)
- Static and dynamic RAMs (Section 5.2)
- Basic memory interface (Section 5.3)
- Cycle status codes (Section 5.4)
- Byte mask lines (Section 5.5)
- Data parity checking (Section 5.6)
- Internal cache control (Section 5.7)
- Memory management unit (Section 5.8)
- Memory system design example (Section 5.9)
- Memory timing considerations (Section 5.10)
- Memory system illustrations and programmable array logic (Section 5.11)

5.1 Memory Speed and Performance

The system performance of the rtVAX 300 system is linked to the performance of the memory system. Most bus cycles are used to access memory, because memory contains both the application instructions and data that the rtVAX 300 is processing.

In turn, the rtVAX 300 memory system performance depends on the speed or access time of the RAM memory devices used. In general, the cost of memory devices is directly proportional to their speed and size. Static RAMs generally provide the fastest access time; however, they are more costly and less dense than dynamic RAMs (DRAMs). The memory system speed must be weighed against the cost of the memory elements to determine the type of memory devices which are used.

To improve its performance, the rtVAX 300 processor contains a 1K-byte cache. This cache has a very high hit rate (greater than 70% for some applications) and allows the rtVAX 300 to read a longword in one microcycle. This cache helps to provide very high performance with relatively slow external memory, by satisfying many of the required processor read operations in one microcycle. The best processor performance is still realized with the fastest memory system, so the memory system should be designed to be as fast as practicable.

5.2 Static and Dynamic RAMs

The memory system can be constructed from either static or dynamic RAMs. Dynamic RAMs provide more storage at a lower cost per bit than static RAMs, and they also require less PC board space for the same density. Static RAMs store data more reliably than dynamic RAMs, because the data is stored in a latch and not as a charge on a capacitor. Static RAMs have faster access time than dynamic RAMs. Dynamic RAMs require refresh cycles to retain the stored data and also require address multiplexing and precise strobe timing. These requirements complicate the design of a memory controller for DRAMs.

Once the size of the external memory system has been determined, the type and speed of the memory elements must be defined after weighing all of the factors mentioned above. If performance is the only issue and cost and size are less important, fast static RAMs are the better choice. If cost, size, and power consumption are big concerns, dynamic RAMs are the better choice. For most applications, the slower, less expensive DRAMs are a good choice, because the rtVAX 300 performance is greatly enhanced by its internal cache.

5.3 Basic Memory Interface

The rtVAX 300 can access up to 256M bytes of physical memory and up to 510M bytes of memory-mapped I/O. The physical memory addresses are in the range of 00000000 to 0FFFFFFF. Appendix C lists rtVAX 300 addresses.

The device address is first multiplexed onto the DAL<31:00> bus, and the data is then transferred through that same bus. This reduces the number of external pins on the rtVAX 300 processor module; however, it requires the addition of external latches to store the device address for the duration of the bus cycle. Other bus cycle information must also be latched, such as the WR L, CSDP<4:0> L, and sometimes the BM<3:0> L lines. The latches must hold the bus cycle and address information while AS L is asserted.

When the rtVAX 300 attempts reading from or writing to memory, it first places the memory's physical address on DAL<29:02> H. DAL<01:00> H are unused at this time, and DAL<31:30> H indicate the number of longwords that are to be transferred. Table 5–4 shows the codes for DAL<31:30> H and the number of longwords that are to be transferred.

The 28-bit address provided by the rtVAX 300 on DAL<29:02> H is a longword address that uniquely identifies one of 268,435,456 32-bit-wide memory locations. The rtVAX 300 provides four byte masks, BM<3:0> L, to facilitate byte accesses within 32-bit memory locations. The rtVAX 300 imposes no restrictions on data alignment. Any data item, regardless of size, may start at any memory address, except the aligned operands of ADAWI and interlocked queue instructions.

Any rtVAX 300 read or write falls into one of the following categories: byte access, word access within a longword, word access across longwords, aligned longword access, or unaligned longword access. Quadword and octaword accesses a[illegible]ccur on longword boundaries. Byte accesses, word accesses within a l[illegible]nd aligned longword accesses require one bus cycle. Word accesses th[illegible]ss a longword boundary and unaligned longword accesses require two bus cycles. Table 5–1 lists each transfer and the type and number of bus cycles required for the transfer.

Table 5–1 rtVAX 300 Data Transfer and Bus Cycle Types

Data Transfer Type	Number of Bytes Transferred	Number of Bus Cycles	Bus Cycle Type
Byte	1	1	Longword
Aligned word	2	1	Longword
Unaligned word	2	2	Longword
Aligned longword	4	1	Longword
Unaligned longword	4	2	Longword
Aligned quadword	8	1	Quadword
Aligned octaword	16	1	Octaword

5.4 Cycle Status Codes

The CSDP<4:0> L lines indicate the type of transfer cycle that is taking place. Note that the address decoder for memory must include the CSDP<4:0> L cycle status information to prevent accidental memory access during an interrupt acknowledge cycle, an IPR access cycle, or an rtVAX 300 internal access cycle. Interrupt acknowledge cycles are performed in the same way as a memory read cycle; however, CSDP<4:0> L reads $1X011_2$. In addition, IPR access cycles are performed in the same way as a memory read cycle; however, CSDP<4:0> L reads $1X010_2$. Lastly, during rtVAX 300 internal access cycles, CSDP<4:0> L reads $0XXXX_2$. Thus, if CSDP<4:0> L indicates an interrupt acknowledge cycle, an IPR access cycle, or an rtVAX 300 internal access cycle, do not allow the memory controller to perform a memory access cycle, although the longword address on DAL<29:02> H is within the system RAM space.

The remaining codes are useful for implementing a multiple processor system (to lock and unlock dual-ported memory); however, most simple applications need to decode these lines only to determine when the rtVAX 300 is running an interrupt acknowledge cycle or an IPR access cycle. If an IPR (accessed with MTPR and MFPR instructions) is implemented externally—such as IPR 37_{16}, the I/O reset registers—the IPR read and write codes must be decoded to select the IPR. The read lock code could be used to set a flop that locks the memory subsystem to prevent auxiliary processors from accessing it with interlocked instructions. The write unlock code could then be used to unlock memory by resetting that flop. If the rtVAX 300 is the only device that can access system memory, the lock and unlock cycles can be ignored.

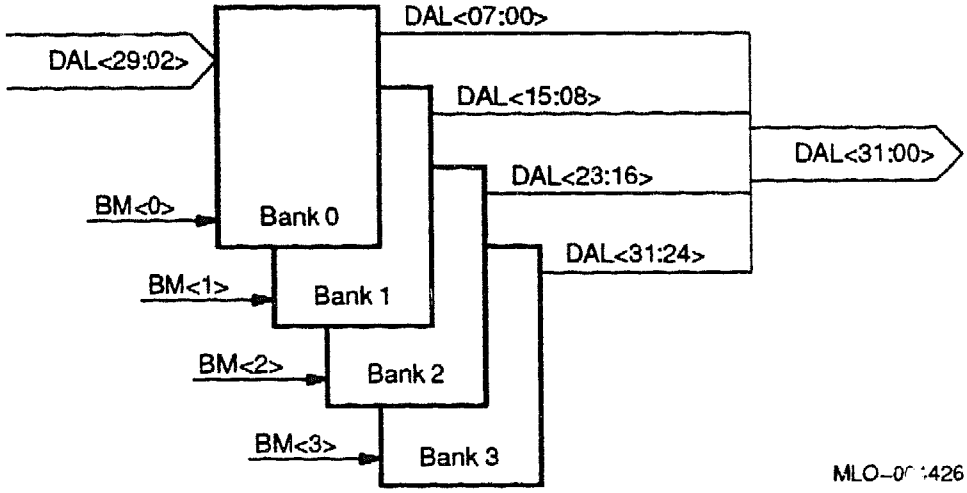
Table 2–5 lists the cycle status symbols.

5.5 Byte Mask Lines

The data path of the rtVAX 300 is 32 bits wide. Byte mask lines indicate which byte(s) the processor is accessing.

Memory is viewed as four parallel 8-bit banks, each of which receives the longword address in parallel on DAL<29:02> H. The address placed on DAL<29:02> H is a longword address, and the byte masks are used to select the bytes within that longword that are being accessed. Each bank reads or writes one byte of the data bus DAL<31:00> H when that byte's byte mask signal is asserted, as shown in Figure 5–1. Byte mask lines BM<3:0> L must be latched on longword and quadword cycles and flow through on octaword cycles; they need be used only during write cycles. During write cycles, the byte masks must be used to select only the byte(s) in memory indicated by asserted byte masks. If a byte with an unasserted byte mask is written to, the data in that location will be corrupted.

Figure 5–1 Memory Organization



Note

Valid parity must be placed on each CSDP<3:0> L line during a read cycle, regardless of the assertion of BM<3:0> L, if DPE L is asserted. Therefore, use the byte masks only for write cycles and select all 4

bytes during read cycles. This parity information is required for proper functioning of the Ethernet controller.

The rtVAX 300's Ethernet controller can use octaword transfer cycles when transferring to nonoctaword-aligned buffers in memory. This forces the byte mask lines to change state during octaword transfers. The Digital-supplied VAXELN device driver always sets up transmit and receive buffers on page boundaries, so that all octaword transfers occur on octaword boundaries. Thus, the byte mask lines will not change during octaword transfers when using the Digital-supplied Ethernet device driver.

Although Digital does not recommend this, users can write their own Ethernet device driver and use nonoctaword-aligned buffers. Digital has tested device drivers that use nonaligned buffers and has found they have poorer performance than those that use aligned buffers. Nonaligned buffers require that memory controllers connected to the rtVAX 300 write only to bytes whose byte mask lines are asserted for each longword that is transferred.

To handle octaword transfers to nonaligned buffers correctly, you must *not* latch the byte mask lines. They must be able to enable CAS line assertion of the DRAMs during each longword that is transferred directly. Longword and quadword transfer cycles require that the byte mask lines be latched during the address transfer portion of the memory access cycle.

The BM<3:0> L lines of the rtVAX 300 must be connected to a separate 74F373 latch. The HOLD L line of this latch cannot be connected directly to the AS L signal of the rtVAX 300. Decoding logic which decodes LADDR<31:30> is used to gate the HOLD L input of the address latches with the AS L line of the rtVAX 300.[1] Figure 5–11 schematically represents this logic.

Note

Modules that have been designed to latch the byte mask lines under all conditions work correctly with current Digital-supplied VAXELN Ethernet device drivers. Digital recommends that all future designs implement the selective byte mask latch, as described above. Selective byte mask latching is required by users who write Ethernet device drivers that place buffers on nonoctaword-aligned boundaries or support continuous address buffer chaining without a 16-byte buffer at the end of each buffer.

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[1] LADDR<31:30> are asserted during octaword transfer cycles.

5.6 Data Parity Checking

To monitor the data integrity of the DAL<31:00> H bus, parity bits are provided with each byte. The parity bits are driven onto CSDP<3:0> L during write cycles while the data is driven onto the DAL<31:00> H bus. During read cycles, the CSDP<3:0> L lines must be driven with valid parity while the DAL<31:00> H bus is driven with the data. The odd bytes (DAL<31:24>, <15:08> H) are driven with odd parity, and the even bytes (DAL<23:16>, <07:00> H) are driven with even parity. If the CSDP<3:0> L lines are not driven with valid parity during a read cycle when DPE L is asserted, the rtVAX 300 performs a DAL parity error machine check, as described in Table 3–11. If the Ethernet controller was bus master at the time of the error, the CPU will be interrupted and will not perform a machine check.

To accommodate peripherals that do not generate or check parity, the DPE L line is provided to cause the rtVAX 300 to ignore DAL parity. DPE L must be driven along with the data during a read cycle; if it is driven low, the rtVAX 300 checks the parity on all 4 bytes, regardless of the assertion of BM<3:0> L; if it is driven high, the rtVAX 300 ignores the data parity information. Table 5–2 lists the parity bits and byte mask lines associated with the 4 bytes of the DAL<31:00> H bus. Proper parity is required only when the DPE line is being asserted. Read cycles from devices residing in the I/O space do not require parity generation.

Table 5–2 rtVAX 300 DAL Parity and Byte Masks

DAL	Byte Mask	CSDP	Parity Type
07:00	0	0	Even
15:08	1	1	Odd
23:16	2	2	Even
31:24	3	3	Odd

Note

The CSDP<4> L signal is used only to indicate an internal cycle and not as a parity bit.

5.7 Internal Cache Control

The rtVAX 300 provides the CCTL L signal to allow external control of the 1K internal cache. If this line is asserted (driven low) during the data transfer of a quadword read cycle, the data read is not stored in the internal cache. In addition, the rtVAX 300 aborts the quadword read cycle after the first longword has been read when the CCTL L line is asserted. If this line is unasserted (driven high) during the data transfer of a quadword read cycle, the data read is stored in the internal cache. To improve processor performance, this line should be driven high during a memory read cycle to allow read references to be internally cached. I/O devices generally drive this line low during read cycles to prevent internal caching of volatile I/O data. Reads from the I/O space (20000000 to 3FFFFFFF) are not cached internally, regardless of the state of CCTL L.

In applications containing multiple processors or a secondary cache, the CCTL L line is manipulated to maintain internal cache consistency. The designer may want to segment system RAM into cacheable and noncacheable address ranges. This can be accomplished through the manipulation of the CCTL L line after the address is decoded.

When external devices perform DMA to the rtVAX 300 private external memory, the internal cache entries corresponding to modified memory locations must be invalidated. This is accomplished by running a conditional cache invalidation DMA cycle. This cycle begins by asserting the CCTL L line before the DMA address during the DMA write cycle. (See Figure 8–19.)

Each conditional invalidate cycle causes the rtVAX 300 to detect a collision on a quadword cache entry. Two consecutive conditional invalidate cycles can be used to detect a collision on a naturally aligned octaword. To maintain cache coherency, a detected collision invalidates that entire quadword within the rtVAX 300 internal cache.

The Ethernet controller can issue longword write cycles. To maintain CPU cache consistency, the Ethernet controller asserts CCTL L at the beginning of the write cycle to start a quadword cache invalidation cycle. Cache invalidation cycles require at least 4 microcycles; therefore, if CCTL L is asserted at the beginning of the write cycle, the memory system must add two wait states (a total cycle time of 400 ns) to the cycle by holding off the assertion of RDY L. If CCTL L is not asserted at the beginning of the write cycle, this is a CPU longword write cycle, and zero or one wait state (200 or 300 ns) memory access can be applied. All DMA devices that use cache invalidation cycles to maintain internal cache consistency must adhere to the cache control timing specifications shown in Figure 2–17.

5.8 Memory Management Unit

To facilitate multitasking and to ease program development, the rtVAX 300 supports virtual memory. The internal memory management unit (MMU) of the rtVAX 300 processor translates virtual addresses to physical addresses. Since the MMU resides within the rtVAX 300, only physical addresses appear on the DAL<29:02> H bus. Thus, the memory system design is simplified, and the memory subsystem is directly addressed by the rtVAX 300 processor.[1] The *VAX Architecture Reference Manual* provides more information on virtual-to-physical address translation of the MMU.

5.9 Memory System Design Example

The remainder of this chapter discusses the design of a 4M-byte DRAM memory system for the rtVAX 300. This memory system consists of the following elements:

- Address and cycle status decoders
- Address latches
- Refresh request timer
- Thirty-six 1M-bit DRAMs (32 for data and 4 for parity bits)
- DRAM row and column address multiplexer
- DRAM data latches
- Memory controller state machine

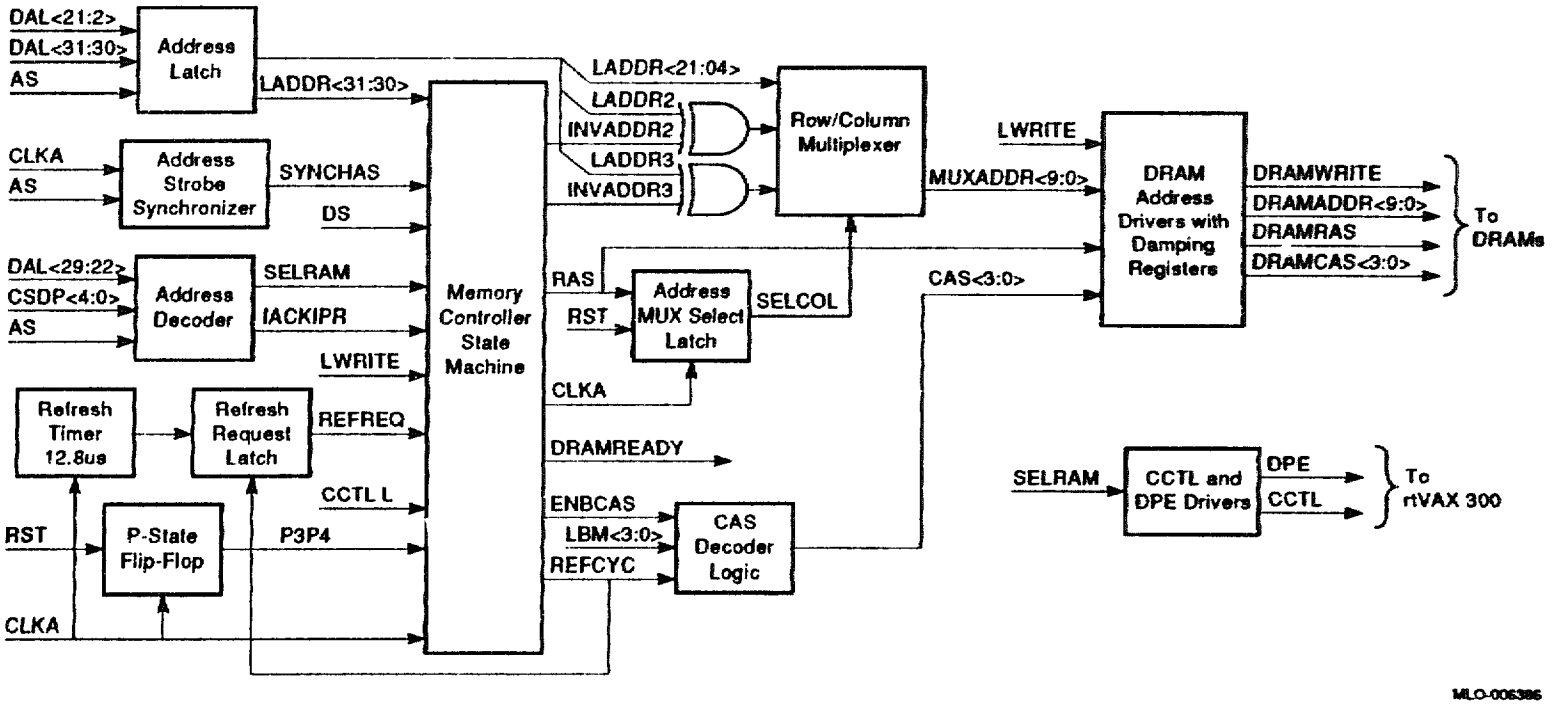
Figure 5–2 shows a simplified diagram of the memory controller logic. Read, write, and refresh memory operations are sequenced by the memory controller.

5.9.1 Address Decoder

The rtVAX 300 places a 28-bit longword address on the DAL<29:02> H bus at the beginning of a memory access cycle. This address must be decoded by an address decoder to provide a select signal for the memory controller. All physical memory must be mapped at the lowest possible memory addresses. Physical memory must also be contiguous and 32 bits wide. Therefore, if a 1M-byte memory array was constructed, it must be mapped to locations 00000000 through 000FFFFF.

[1] Memory system design is similar to that of a nonvirtual-addressed processor.

Figure 5–2 Sample Design: Memory Subsystem Functional Diagram



Full memory address decoding must be implemented to prevent multiple mapping of memory. This is necessary because the firmware begins at location 00000000 and uses a binary search algorithm to ascertain the configuration of memory for sizing and initialization. Nonexistent memory is detected when the memory controller does not assert the RDY L line. The rtVAX 300 internal timer times out, and the memory sizing finishes with the highest responsive location marked as the top of memory. The stacks are set up, and the rtVAX 300 is able to boot.

If full memory address decoding was not implemented, the initialization firmware would find an invalid top of memory. This would cause the stack to write over free process pages and the rtVAX 300 to fail when it tries to boot.

The decoder can be implemented in a registered PAL, as shown in Figure 5–9. In this configuration, DAL<29:22> H are fed into the inputs of the PAL. For memory access, all of these bits must be zero. The PAL's internal flip-flop latches the output of this decoder, SELRAM, at the rising edge of AS H. The SELRAM signal will remain valid throughout the entire bus cycle, until AS H deasserts.

The CSDP<4:0> L bits must be decoded to prevent them from enabling memory when the rtVAX 300 is executing an interrupt acknowledge cycle or an externally implemented internal processor register access cycle. Disable memory during these two cycles; Table 5–3 lists their bit assertions.

Table 5–3 rtVAX 300 CSDP<4:0> IPR and IACK Codes

CSDP<4>	CSDP<2>	CSDP<1>	CSDP<0>	Bus Cycle Type
H	L	H	L	External IPR read or write
H	L	H	H	External interrupt acknowledge
L	X	X	X	rtVAX 300 internal cycle

5.9.2 Address Latches

The rtVAX 300 uses a time-multiplexed data and address (DAL) bus. Address latches, such as the 74F373, must be connected to the DAL lines, and the HOLD line of these latches must be connected to the AS line. This latched address can then be fed into the address inputs of the memory elements. Also, the WR L and BM<3:0> L lines must be latched. (Figure 5–11 shows the connections of these latches.)

5.9.3 DRAM Memory Refresh

Each bit of data stored in a DRAM memory element is stored as a charge in a very small capacitor. Through time, this charge is bled from these capacitors, so each bit must constantly be refreshed to retain the stored data. Special access cycles are defined for the DRAMs that refresh an entire row of data bits. The 1M-bit DRAMs used in this example contain 1,048,576 bits divided into 512 rows, each containing 2048 data bits. Thus, it takes only 512 refresh cycles (one for each row) to refresh every bit within the DRAM.

The specifications for the 80 ns page mode DRAMs require that every row of the entire DRAM array be refreshed every 8.0 ms. The rows can all be refreshed in sequence every 8.0 ms, or one row can be refreshed every 15.6 µs (8.0 ms/512 rows). The 8-bit counter shown in Figure 5–15 sets the refresh request SR latch every 12.8 µs, and the memory controller then refreshes a row of the DRAMs and resets the SR latch. In this scheme, a new row is refreshed every 12.8 µs, so the entire DRAM is refreshed every 6.6 ms (512 x 12.8 µs), and the refresh requirements are met.

Before a refresh cycle can occur, a refresh row address must be generated. This address is latched into the DRAMs, and each bit cell in that row is refreshed during the refresh cycle. The DRAMs that were used generate their own refresh address internally, simplifying the external logic by eliminating the need for a refresh row address counter. DRAMs that support column address strobe (CAS) before row address strobe (RAS) refresh internally generate their own refresh row address. When the DRAM CAS line is asserted before the RAS line, the internal refresh row address counter is incremented, and the next row is selected. When the RAS line is then asserted, the selected row of bit cells are refreshed. RAS and CAS are then deasserted, and the refresh cycle is complete. An external refresh address counter, whose outputs are multiplexed to the DRAMs address lines, must be added if the chosen DRAMs do not support CAS before RAS refresh.

5.9.4 DRAM Row and Column Address Multiplexer

All DRAMs have a multiplexed row and column address bus. This means that half of the address of any bit is driven onto the DRAM address bus at one time. For example, to read one cell within the DRAM, half of the address of that bit is driven onto the DRAM address bus.[1] Next, the RAS is asserted, and the second half of the address (10 bits) is driven onto the DRAM address bus. Next, the CAS is asserted, and the output driver is turned on. After the DRAM access time delay, data that is stored in the addressed cell is driven at the DRAM's data output pin. Once the data has been transferred to the processor,

[1] Half the address equals 10 bits, because the 1M-bit DRAMs require 20 bits of addressing.

the RAS and CAS lines are deasserted, and the DRAM's output is tri-stated. RAS must remain deasserted briefly to allow for internal DRAM precharging.

A multiplexer, such as the 74F711 shown in Figure 5–3, is needed to multiplex the row and column address onto the DRAM address bus. Because the address bus of each DRAM is connected to the output of this multiplexer, high current output drivers are needed to drive the high-capacitive inputs of the DRAMs. This will prevent excessive propagation delay. The 74F711 multiplexers provide sufficient drive current to drive the address bus of the DRAMs directly. If the 74F258 multiplexer is chosen, high current drivers, such as the 74F244, are needed to drive the high capacitance of the DRAM address bus.

The rtVAX 300 supports multiple longword memory access cycles. During quadword and octaword transfer cycles, the rtVAX 300 places only one longword address on the DAL bus at the beginning of the transfer cycle. The memory system must generate the correct number of longwords in the correct order. The subsequent longword addresses are generated by adding the F86 XOR gates between the two lowest order column address inputs of the 74F711 multiplexer. The assertion of the other input of the two F86 gates will cause the associated column address bit to invert.

DAL<31:30> H indicate the number of longwords to be transferred. Table 5–4 lists the codes for DAL<31:30> H and the number of longwords that are to be transferred.

Figure 5–3 Sample Design: DRAM Address Path

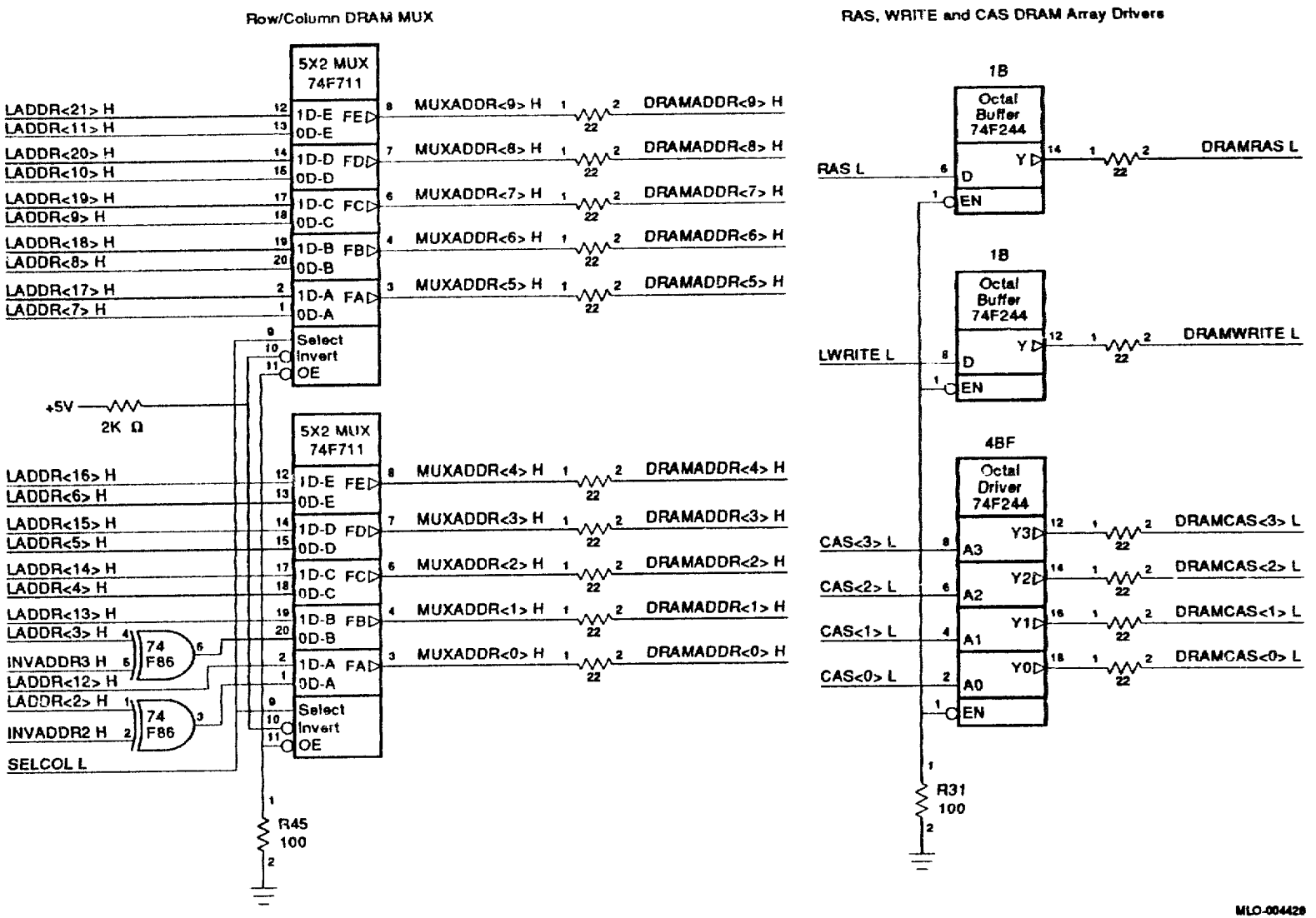


Table 5–4 Memory Read Cycle Selection

DAL 31	DAL 30	Cycle Type	Longwords Transferred
0	1	Longword read or write	1
1	0	Quadword read cycle (CPU)	2
1	1	Octaword read or write cycle (Ethernet)	4

The memory controller looks at LADDR<31:30> to see the transfer cycle type and subsequently asserts INVADDR<3:2> to generate the necessary longword addresses during multiple longword transfer cycles.

5.9.5 4M-Byte DRAM Array

The memory system for the rtVAX 300 must be 32 bits wide. If parity memory is desired, 4 bits must be added, so that each byte has 1 parity bit. Most DRAMs are a single bit wide, so 36 DRAMs are needed to implement parity memory. DRAM packs, which are 8 or 9 bits wide, could also be used.

Note

During Ethernet controller read cycles, proper parity must be generated in CSDP<3:0> L for each longword read, if DPE L is asserted.

The scheme that is used to satisfy multiple word transfers requires that the DRAMs support page mode access. For example, when a quadword read cycle is performed, the address of the preferred longword is first placed on the DAL<29:02> H bus, and DAL<31:30> H read 10_2. The rtVAX 300 then asserts AS, and the address is latched by the address latches. The row address ripples through the F711 MUX and appears on the DRAM address bus. The decoder is asserting the SELRAM and deasserting the IACKIPR signal. The memory controller now asserts RAS, and the row address is latched into the DRAMs. The address MUX select latch then asserts the SELCOL signal, driving the column address onto the DRAM address bus. Now, the memory controller asserts ENBCAS, waits for the access time of the DRAMs, and asserts DRAMREADY. The first longword is now latched into the data latches shown in Figure 5–14, and the ENBCAS line is deasserted. The INVADDR2 line is now asserted, driving the next longword address onto the DRAM address bus. Now, the ENBCAS line of the DRAM is reasserted, and the next longword appears at the data latches. DRAMREADY is reasserted, the second longword is transferred, and the access cycle is complete.

If page mode access is not supported by the DRAMs, the row address would have to be restrobed into the DRAMs for the second longword and the memory performance would suffer.

5.9.6 DRAM Terminating Resistors

The very fast rise and fall times of the DRAM's address, RAS, CAS, and WE lines have some very high frequency components associated with them. When one of these signals changes state, the voltage change has to travel down the PC board trace. The trace acts like a transmission line to very high frequencies, and the impedance of this line may not be uniform. A reflection occurs when a signal encounters a change in impedance. These reflections cause signal overshoot and undershoot, where the line voltage bounces above 5.0V or below 0.0V. Signal reflections deteriorate the signal transition edges; in a clock signal, this could affect which time data is strobed; in the case of data, this could affect when the signal can be sampled.

Most TTL gates can handle a small amount of overshoot and undershoot; DRAMs are easily damaged by excessive overshoot and undershoot. These memory elements have a specification for the amount of undershoot that can safely be tolerated. If this value is exceeded, the DRAM can corrupt its stored data or can be damaged permanently.

Many techniques can be used to reduce the amount of overshoot and undershoot that the DRAM experiences. The RAS, CAS, WE, and address lines connecting to the DRAMs must be made as short as possible to reduce the lines' inductance and capacitance. These lines should be daisy-chained to all of the connection points. Series-dampening resistors should be added to all of these lines as close to the MUX outputs as possible, as shown in Figure 5–3.

The DAL and strobe signal lines of the rtVAX 300 are driven by an ACTQ 244 or ACTQ 245. These CMOS drivers can also generate a fair amount of overshoot and undershoot. Therefore, it is good practice to add series termination resistors for these lines on the application module to improve signal integrity. These resistors slow the rise and fall times of the DRAMs, reducing the reflections. The value of these resistors is determined by measuring the overshoot and rise time of these signal lines on the actual PC board prototype. The resistor value should be the lowest that gives an undershoot voltage below that tolerated by the DRAMs that are used. Shunt resistors can also be used at the end of these lines as terminators.

5.9.7 DRAM Data Latches

The latches shown in Figure 5–14 store data for processor reading, while the next longword is accessed in the DRAMs. This overlapping improves the performance of the memory system for multiple longword transfer cycles.

When the data for the first longword is valid, the memory controller asserts DRAMREADY. This sets the ready hold latch (see Figure 5–15) and asserts the RDY L line of the rtVAX 300. This latch is cleared when the rtVAX 300 deasserts the data strobe (DS) line. When the RDY L line is asserted, the data that was present at the DRAM outputs is latched and driven onto the DAL bus. Once the data has been latched, the CAS hold latch can deassert the CAS<3:0> lines of the DRAMs, and the memory controller can assert the INVADDR2 line to generate the next longword address. The memory controller reasserts the ENBCAS line, asserting the CAS<3:0> lines and driving the next longword data into the inputs of the RAM data latches. When the processor finishes transferring the first longword, the second longword is latched into the data latches.

Caution

The RDY L, ERR L, and CCTL L lines are tri-stateable lines. These lines are pulled up by resistors in the rtVAX 300 and must be driven by a tri-stateable driver, such as the 74F125. If these lines are driven by a standard TTL totem pole output, the rtVAX 300 will not function.

These latches can be eliminated; however, the memory controller state machine must be redesigned and quadword read cycles take one more microcycle, with the consequent reduction of memory system performance. The rtVAX 300 octaword access cycle always requires at least two microcycles for each longword that is transferred; memory performance and longword read cycles are not improved by these latches.

5.9.8 Memory Controller State Machine

The memory controller state machine diagram has the following responsibilities:

- Arbitrate between refresh requests and memory access (refresh requests have priority)
- Execute refresh requests by cycling the REFCYC, ENBCAS, and RAS lines

- Execute memory access cycles by cycling RAS, ENBCAS, DRAMREADY, and INVADDR<3:2>
- Provide the precise timing that is required on the DRAM RAS and CAS lines

Refer to Figure 5–4 for the following discussion.

Every 12.8 µs the refresh counter asserts its TC L output. This sets the refresh request latch shown in Figure 5–15. The latch asserts the REFREQ input of the memory controller. The controller now jumps to the STARTREFRESH state and asserts ENBCAS and REFCYC, asserting every DRAM CAS line. The assertion of REFCYC clears the refresh request latch, deasserting REFREQ. Next, the memory controller asserts RAS, waits one clock tick, and deasserts ENBCAS and REFCYC. The state machine now jumps into the FINISHUP state and deasserts RAS, so the refresh cycle is now finished.

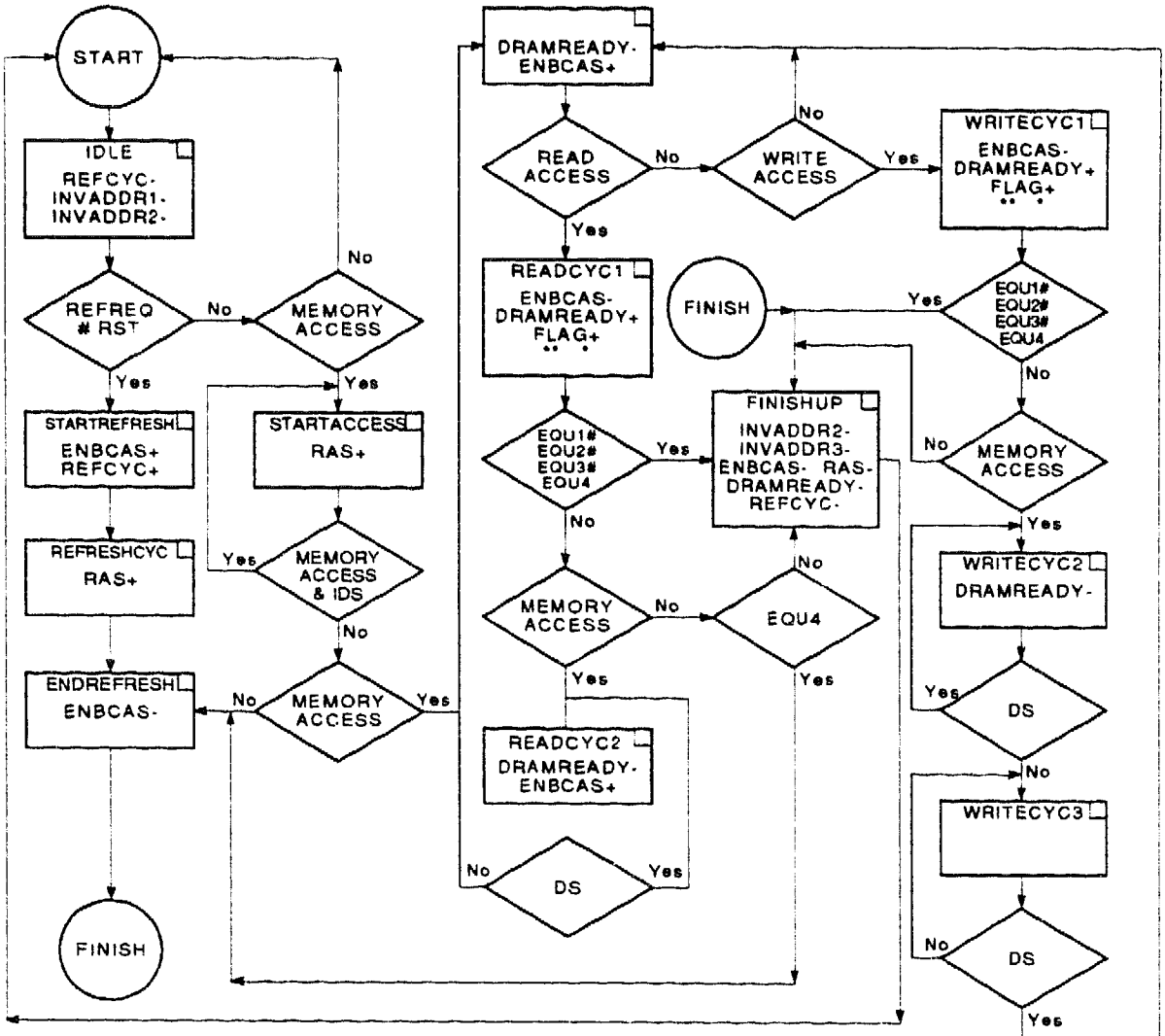
The AS signal of the rtVAX 300 is synchronized by the address strobe synchronizer latch, as shown in Figure 5–15. This is necessary, because AS deasserts just before the rising edge of CLKA, possibly causing the state machine to missequence. By synchronizing AS with CLKB, SYNCHAS deasserts after the rising edge of CLKA.

Note

The setup time of the state machine must be met on all unmasked inputs to prevent missequencing.

During a memory access cycle, SYNCHAS and SELRAM are asserted, while IACKIPR is deasserted. When these conditions are true and REFREQ is unasserted, the memory controller state machine jumps to the STARTACCESS state and asserts RAS. The row address has been latched by the DRAMs, and the SELCOL line is asserted by the address MUX select latch when CLKA deasserts. The column address of the first longword is placed on the DRAM address bus. Next, the controller ensures that the DS line is asserted and then asserts the ENBCAS signal. If this is a write cycle, ENBCAS is then deasserted and DRAMREADY is asserted. The state of INVADDR<3:2> is incremented, creating the DRAM column address for the next longword. Next, the state of INVADDR<3:2> is compared to LADDR<31:30> to determine if the last longword has been transferred. If that was the last longword, the state machine jumps to the FINISHUP state, deasserts all outputs, and waits the RAS precharge time before it allows another memory access.

Figure 5–4 Sample Design: Memory Controller Sequence



MEMORY ACCESS = SYNCHAS & !IACK & SELRAM
WRITE ACCESS = !P4 & LWRITE
READ ACCESS = !P4 & !LWRITE & (!FLAG # !DS)

EQU1 = !INVADDR2 & !INVADDR3 & LADDR<30> & !LADDR<31>
EQU2 = INVADDR2 & !INVADDR3 & !LADDR<30> & LADDR<31>
EQU3 = !INVADDR2 & INVADDR3 & !LADDR<30> & !LADDR<31>
EQU4 = INVADDR2 & INVADDR3 & LADDR<30> & LADDR<31>

* INVADDR2 = !INVADDR2
** INVADDR3 = (!INVADDR2 & INVADDR3) # (INVADDR2 & !INVADDR3)

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If another longword is required and it is a write cycle (LWRITE is asserted), the state machine jumps to WRITECYC2 and deasserts DRAMREADY. The state machine then waits for DS to deassert and jumps to WRITECYC3. Once DS asserts, the state machine jumps to WRITECYC4 and asserts ENBCAS

and DRAMREADY. The machine then increments INVADDR<3:2>, driving the address of the next longword onto the DRAM address bus. The state of INVADDR<3:2> is compared to LADDR<31:30>, and the cycle repeats if another longword is needed.

If another longword is required and it is a read cycle (LWRITE is deasserted), the state machine jumps to READCYC2, deasserts DRAMREADY, and asserts ENBCAS, driving the next longword into the inputs of the RAM latches. When DS deasserts and the rtVAX 300 processor has latched the previous longword, the state machine jumps into the READCYC1 state, and the process repeats itself until the last longword is read.

Table 5–5 lists all transfer cycles along with the order of the longwords that are transferred.

Table 5–5 Quadword and Octaword Read Cycle Transfers

rtVAX 300 Latched Address LADDR 03	02	Memory Address DRAMADDR 03	02	Longword Transferred
Quadword				
X	0	X	0	First
X	0	X	1	Second
X	1	X	1	First
X	1	X	0	Second
Octaword				
0	0	0	0	First
0	0	0	1	Second
0	0	1	0	Third
0	0	1	1	Fourth

After AS and DS have been asserted, the rtVAX 300 processor waits for the assertion of RDY L, indicating that the memory or device has transferred the data. Wait states of one microcycle are added to the I/O or memory access cycle until the memory controller asserts RDY L. If RDY L is not asserted 16 to 32 µs after the assertion of AS, the rtVAX 300 completes the access cycle, indicates an error condition, and transfers operation to an error-handler routine. This action prevents the rtVAX 300 processor from stalling when a read or write request is directed to a nonexistent I/O device or memory location.

5.10 Memory Timing Considerations

The memory subsystem of the rtVAX 300 must satisfy some special timing requirements. (Table A–3 lists these requirements.)

Note

The rtVAX 300 read and write timing specifications must be followed explicitly. Any timing parameter that is not within specification can cause intermittent or complete memory system failure.

The PLUS405–45 logic sequencer controls the timing of all the memory control signals. This sequencer is clocked on the rising edge of CLKA; therefore, all outputs of the state machine will change 12 ns after the rising edge of CLKA.

5.10.1 Calculating Memory Access Time

The rtVAX 300 accommodates slower memory and peripherals by providing the RDY L input. The accessed peripheral can add any number of wait states into the access cycle by holding off the assertion of RDY L. Each wait state is one microcycle long; the processor will wait up to 32 µs until it times out. When calculating the speed of the memory elements, first determine the number of wait states.

If you are operating with one wait state, data must be valid 28 ns before the second rising P1 edge. The access time of the DRAMs is specified from the time that the RAS line is asserted. The sample memory controller will assert the RAS line 12 ns after the rising edge of P3. The RAS driver delay must also be added along with the 74F374 latch delay; thus, the access time from RAS is as follows:

+ 3.0 x CLKA period
– Data setup time
– Memory controller delay
– RAS driver delay
– Latch delay

Access time

In this case, access time = 3 x 50 ns – 28 ns – 12 ns – 5 ns – 7 ns = 98 ns.

Therefore, during a read cycle with one wait state, data must become valid 98 ns after the assertion of RAS. Thus, 98 ns or faster DRAMs, used with this scheme, allow the memory subsystem to operate with one wait state.

5.10.2 State Machine Input Setup Time

In Figure 5–15, the PLUS405–45 state machine used as the memory controller requires 12 ns of setup time at each of its inputs. The actual setup time on any of these inputs is calculated by adding the maximum propagation delay of each gate located between the source and the state machine input. This sum is added to the delay of the source from the rising edge of CLKA. For example, the AS signal is asserted by the rtVAX 300 23 ns after the rising edge of CLKA when the processor is in the P1 state. The delay of the F00 gate in the address strobe synchronizer (5 ns) is added to 23 ns to yield 28 ns total delay from the rising edge of CLKA. Because the cycle time of CLKA is 50 ns, the setup time of SYNCHAS is 22 ns, meeting the 12 ns requirement.

The IACKIPR and SELRAM outputs of the 22V10 PAL in Figure 5–9 are both stable 10 ns after the rising edge of AS H. The 4 ns delay of the AS inverter in Figure 5–15 must be added; therefore, IACK and SELMEM are delayed 14 ns after the falling edge of AS. Since AS falls 23 ns after the CLKA rising edge, IACKIPR and SELMEM assert 37 ns (23 ns + 14 ns) after the CLKA edge. Thus, the setup time for these two signals is 13 ns (50 ns – 37 ns), which is greater than the 12 ns requirement.

Similar analysis was done to the rest of the memory controller sequencer setup times, and Table 5–6 lists the setup times of all the signals.

Table 5–6 Memory Controller Setup Times

Signal Name	Minimum Setup (ns)	Actual Setup (ns)
IACKIPR	12	13
SELRAM	12	13
LWRITE	12	62
P3P4	12	42
DS	12	22
SYNCHAS	12	21
REFREQ	12	30
RST	12	35
LADDR30	12	62
LADDR31	12	62
INVADDR2	12	38
INVADDR3	12	38

5.10.3 Memory Subsystem Longword and Quadword Read Cycle Timing

Section 2.6 specifies the memory system longword, quadword, and octaword read and write cycle timing. The rtVAX 300 bus timing is synchronous with CLKA and CLKB. This timing is used to derive the states required by the memory controller state machine. The state machine, shown in Figure 5–4, illustrates sample operation of the memory controller. Figure 5–5 shows the sample longword and quadword read cycle timing.

The critical timing parameters for the rtVAX 300 memory system must be satisfied along with the timing parameters for the DRAMs. Section 2.6 discusses the values of these parameters. In addition, the DRAMs have some critical timing parameters that must be met. Table 5–7 lists these parameters.

The memory system must be able to transfer four successive longwords at a time during an octaword read cycle. Sample timing for the octaword read cycle is shown in Figure 5–6. The timing relationships are similar to those of the longword read timing.

Figure 5–5 Sample Design: Memory Controller Longword Timing

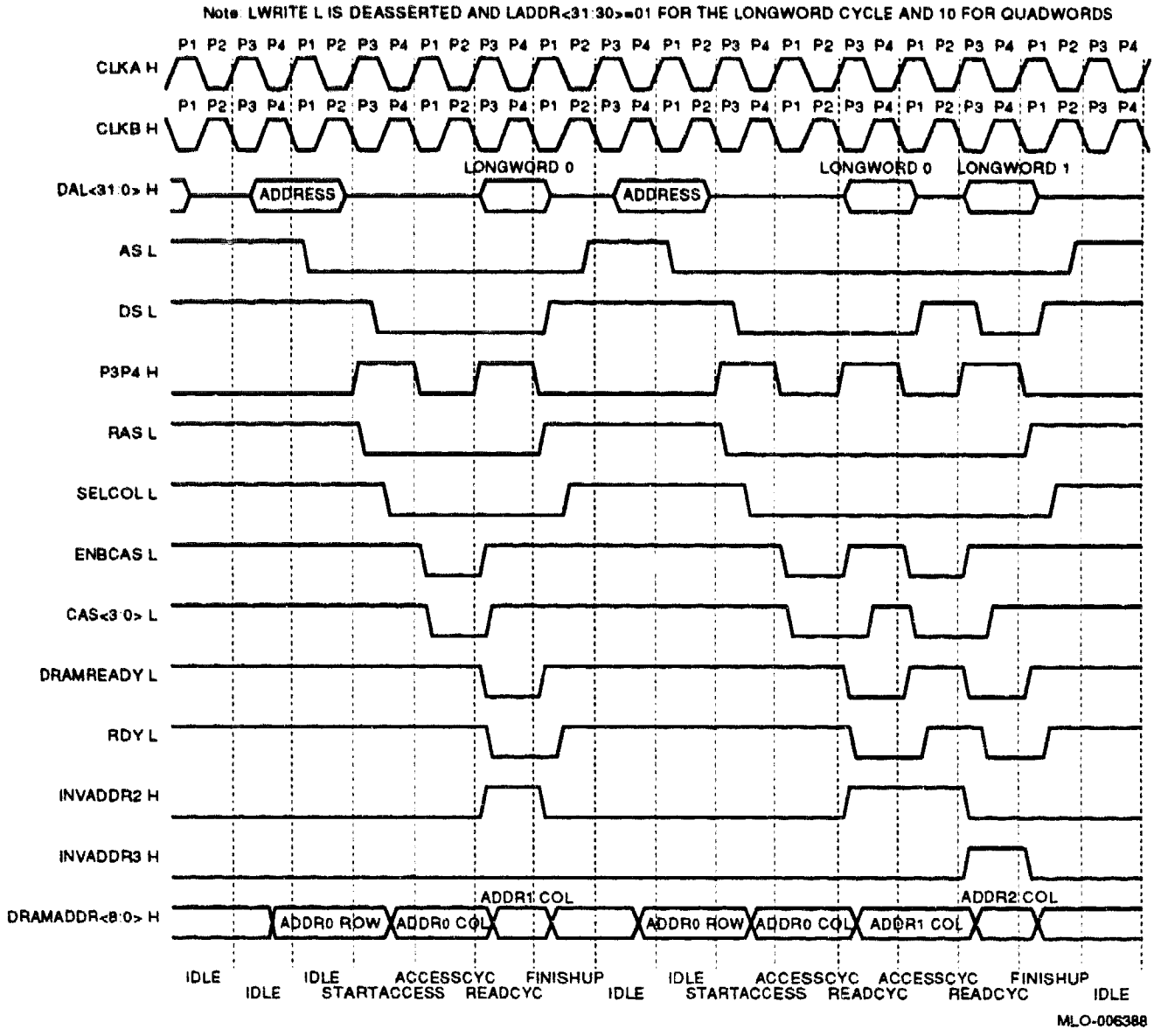


Figure 5–6 Sample Design: Memory Controller Octaword Read Cycle Timing

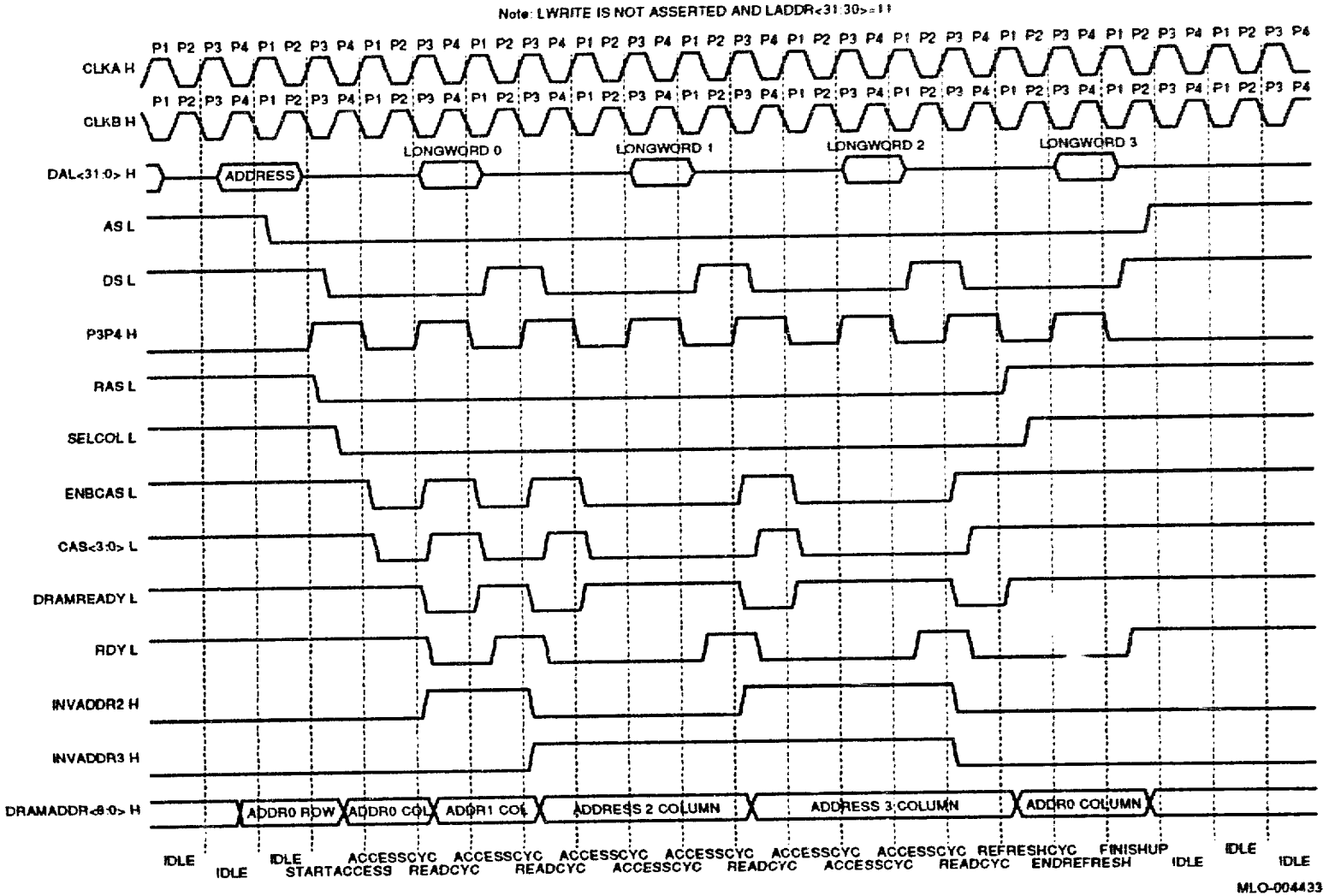


Table 5–7 DRAM Timing Parameters for 80 ns Page Mode 1M Bit x 1

Parameter Name	Minimum Time (ns)	Maximum Time (ns)
Row address setup time	0	–
Row address hold time	15	–
Column address setup time	0	–
Column address hold time	20	–
RAS precharge time	70	–
RAS width	80	10,000
Access time from RAS	–	80
Access time from CAS	–	20
Output disable time after CAS	20	–
RAS to CAS lead time	25	60
Data in setup time before CAS	0	–
Data in hold time after CAS	15	–

5.10.3.1 Calculating DRAM Row Address Setup Time

When the rtVAX 300 is accessing memory, the memory controller asserts RAS on the rising edge of P3. The address is placed on the DAL<29:02> H bus 20 ns before the rising edge of P1. This address has to propagate through the 74F373 latches, the 74F86 XOR gate, and the 74F711 MUX. The total propagation delay is as follows:

+ 1 CLKA period
+ Address to P1 edge
– Propagation of 74F373
– Propagation of 74F86
– Propagation of 74F711
+ Minimum memory controller delay
+ Minimum RAS driver delay

DRAM row address setup time

In this case, DRAM row address setup time = 50 ns + 23 ns – 7 ns – 5 ns – 6 ns + 0 ns + 2 ns = 57 ns.

5.10.3.2 Calculating DRAM Row Address Hold Time

Once RAS has been asserted, the SELCOL input to the 74F711 is asserted on the following CLKA falling edge. When the worst-case row address hold time is calculated, the minimum propagation delay of the two 74F00 gates of the address MUX select flop must be added to the RAS to SELCOL time. The row address hold time is calculated as follows:

+ RAS to CLKA rising edge
– Memory controller output delay
– 2 x minimum propagation of 74F00
+ Minimum 74F711 delay
– Minimum 74F04 delay

DRAM row address hold time

In this case, DRAM row address hold time = 50 ns – 12 ns – (2 x 2) ns + 8 ns – 4 ns = 38 ns.

5.10.3.3 Calculating DRAM Column Address Setup Time

The memory controller asserts ENBCAS on the P1 edge following the assertion of RAS. The CAS lines of the DRAMs assert after two minimum 74F00 delays. The SELCOL line, which drives the column address onto the DRAM address bus, does this two maximum 74F00 gate delays after the falling edge of CLKB. The column address setup time is calculated as follows:

+ SELCOL to CLKA rising edge
– 2 x maximum propagation of 74F00 (address MUX latch)
– Maximum propagation of 74F711
+ 2 x minimum propagation of 74F00 (CAS decode latch)
+ Minimum CAS driver delay

DRAM column address setup time

In this case, DRAM column address setup time = 25 ns – (2 x 5) ns – 15 ns + (2 x 2) ns + 2 ns = 6 ns.

5.10.3.4 Calculating DRAM Column Address Hold Time

The INVADDR<3:2> lines assert on the P3 edge that follows the assertion of ENBCAS. The column address hold time is calculated as follows:

+ CAS assertion to INVADDR<3:2> assertion
– ENBCAS memory controller output propagation delay
– 2 x maximum propagation of 74F00
– CAS driver delay
+ Minimum INVADDR<3:2> memory controller delay
+ Minimum 74F86 delay
+ Minimum 74F711 delay

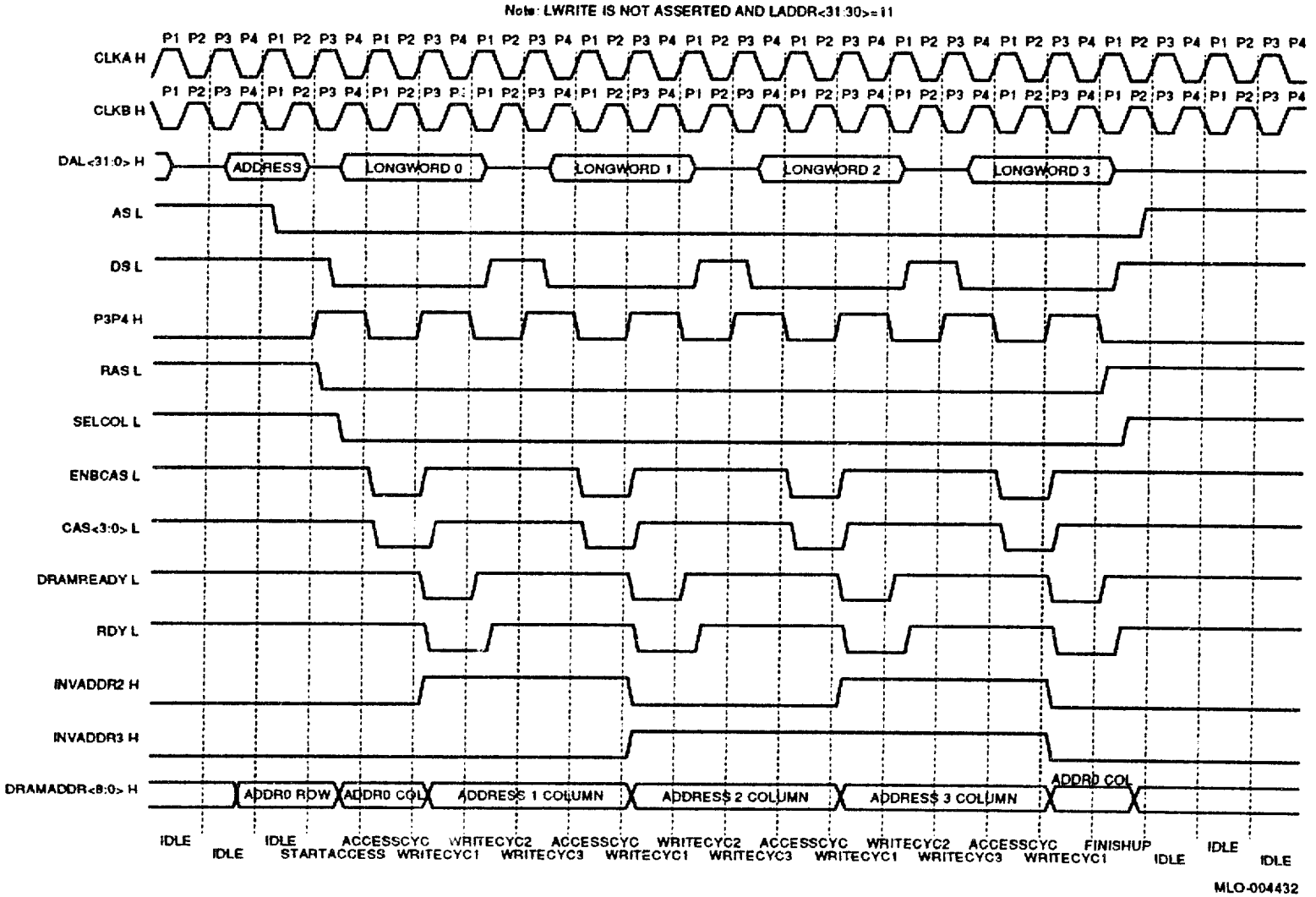
DRAM column address hold time

In this case, DRAM column address hold time = 50 ns – 12 ns – (2 x 5) ns – 5 ns + 0 ns + 2 ns + 5 ns = 30 ns.

5.10.4 Memory Subsystem Octaword Write Cycle Timing

Like the access time for read cycles, DRAMs also have setup and hold times that must be met for write cycles. The data on the DALs is strobed into the DRAMs on the falling edge of CAS. The rtVAX 300 can write up to four longwords in one access cycle. Refer to All multiple word write cycles slip one microcycle for each longword transferred to satisfy the data in setup and hold times. Figure 5–7 for the octaword write cycle sample timing.

Figure 5–7 Sample Design: Memory Controller Octaword Write Cycle Timing



5.10.4.1 Calculating Data In Setup Time

The Data In setup and hold time must be calculated to ensure that valid data is strobed into the DRAMs. The DALs are driven with valid data 23 ns (2P – 27 ns) before the rising edge of P1. The DRAMs CAS line is driven 17 ns after the rising edge of P1; thus, the worst-case DRAM data in setup time is calculated as follows:

+ 2 (74F00 minimum propagation delay)
+ 23 ns
+ 0 ns (state machine minimum propagation delay)

Data in setup time

In this case, data in setup time = 23 ns + 4 ns + 0 ns = 27 ns.

5.10.4.2 Calculating Data In Hold Time

The rtVAX 300 continues to drive the DAL bus with valid data until 31 ns (P + 6 ns) after the rising edge of the following P1. Thus, the minimum data in hold time can be calculated as follows:

– 2 (74F00 maximum propagation delay)
– Memory controller delay
+ 31 ns
+ 100 ns

Data in hold time

In this case, data in hold time = 131 ns – 12 ns – 12 ns = 107 ns.

5.10.5 Memory Subsystem Refresh Timing

Figure 5–8 shows the memory controller refresh timing. The DRAMs that are used support CAS before RAS refresh, page mode, and they have an access time of 80 ns. These DRAMs require that CAS be asserted at least 20 ns before RAS, and RAS must be asserted for at least 80 ns. If CLKA is operating at 20 MHz, the cycle time is 50 ns. The timing diagram also shows that ENBCAS and REFCYC assert 50 ns after REFREQ asserts. REFCYC clears REFREQ, and all of the DRAMs' CAS lines are asserted. RAS asserts 50 ns after ENBCAS asserts, and all three signals remain asserted for 100 ns. Table 5–8 lists all of the timing parameters needed for CAS before RAS refresh.

Figure 5–8 Sample Design: Memory Controller Refresh Timing

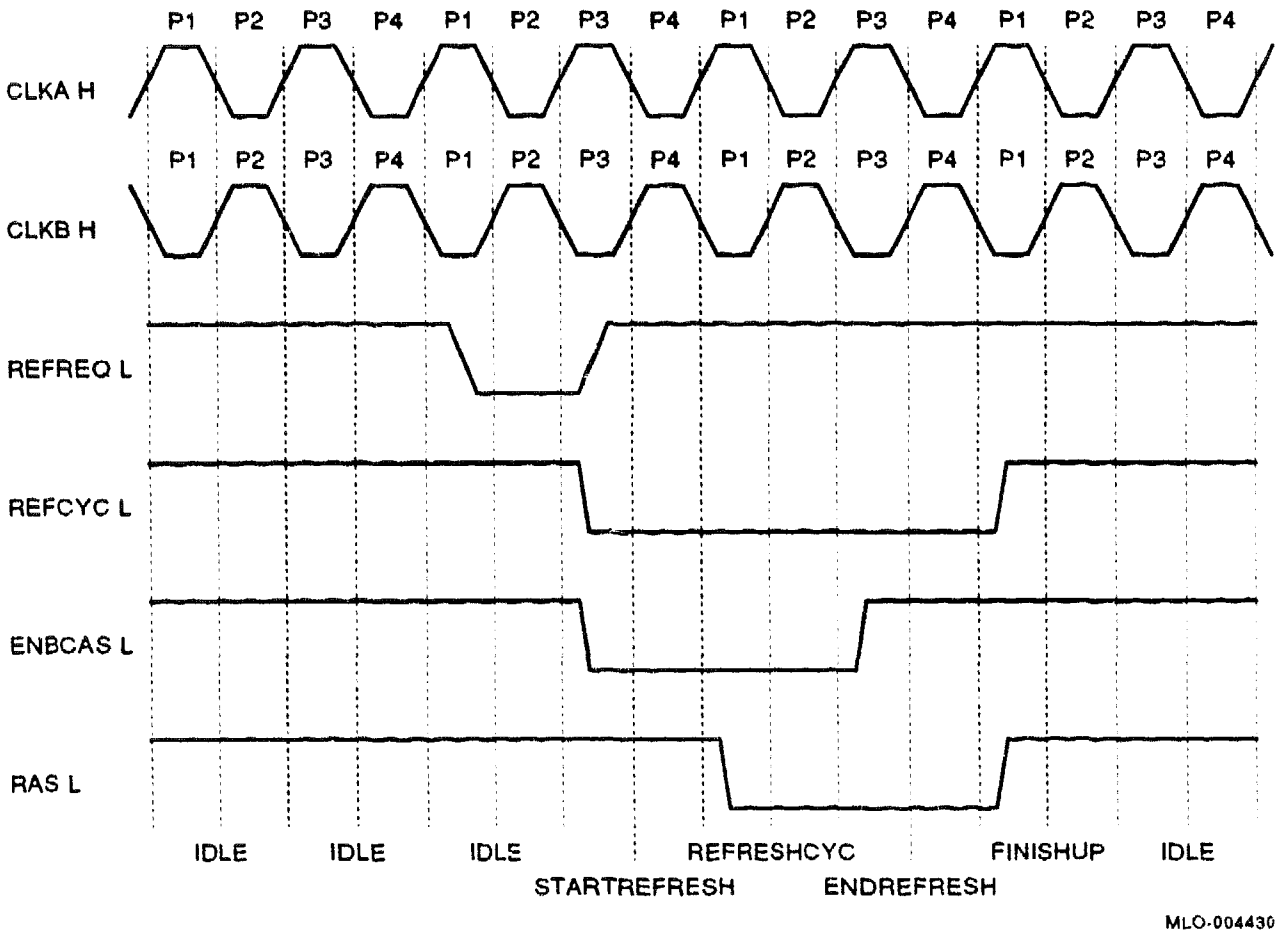


Table 5–8 DRAM CAS Before RAS Refresh Timing Parameters

Parameter Description	Minimum Time (ns)	Maximum Time (ns)	Actual Time (ns)
CAS low while RAS high	20	–	40
RAS low time	80	10,000	100
RAS precharge time	70	–	100

5.10.6 RAS Precharge Time

RAS precharge time is defined as the amount of time that the DRAM needs to be unselected (RAS and CAS are deasserted) after any access cycle. This is needed because internal voltages of the DRAMs must settle after each access. The RAS precharge time for the DRAMs is maintained, because the memory controller enters the FINISHUP state followed by the IDLE state after every memory access or refresh cycle. During these two states, all the memory controller's outputs are unasserted, and the controller stays in each state for 50 ns. This deasserts the RAS and CAS lines for at least 100 ns after each memory access, satisfying the RAS and CAS precharge requirements.

5.10.7 DAL Bus Turnoff Time

The DAL bus turnoff time must also be preserved to prevent bus contention. This time is 35 ns (P + 10) after the P1 edge, when DS has deasserted. After that time, the rtVAX 300 begins to drive the DAL bus with the next address. The DRIVERAM signal, which turns off the DRAM latches, deasserts one 74F20 gate delay after DS. Thus, the turnoff time is as follows:

+ DS deassertion delay
+ 74F20 propagation delay
+ 74F373 turnoff time

Turnoff time

In this case, turnoff time = 25 ns + 5 ns + 7 ns = 37 ns after P1 edge.

Because the memory system is deactivated in 37 ns, transceivers are not required between the rtVAX 300 and the memory system. This time is less than the 53 ns maximum time required by the rtVAX 300. If the turnoff time for any peripheral is greater than 53 ns, transceivers are needed to isolate that peripheral from the DAL bus after the peripheral has been accessed.

5.11 Memory System Illustrations and Programmable Array Logic

The following sections show memory system illustrations and programmable array logic.

- Figure 5–9 shows the sample design for the address decoder and power-up reset.
- Figure 5–10 shows the RAM memory map.
- Figure 5–11 shows the sample design for the address latches.
- Figure 5–12 shows the sample design for DRAM memory array 1.
- Figure 5–13 shows the sample design for DRAM memory array 2.
- Figure 5–14 shows the sample design for the RAM data latches.
- Figure 5–15 shows the sample design for the memory controller.

5.11.1 Application Module Address Decoder PAL

Table 5–9 lists the programmable array logic (PAL) that decodes the rtVAX 300 address and cycle status lines. This PAL does the following:

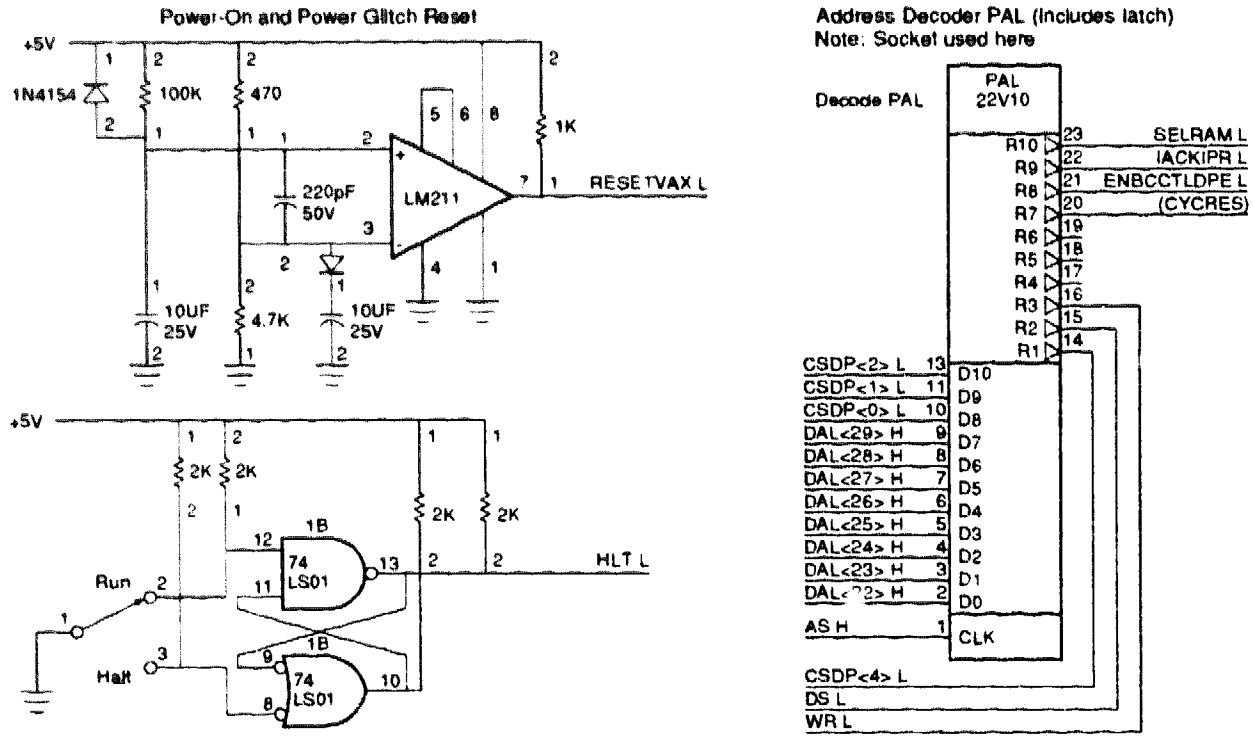
- Selects the memory and decodes rtVAX 300 interrupt acknowledge cycles
- Asserts the SELRAM, IACKIPR, and ENBCCTLDPE lines, which control the data parity enable and cache control drivers, select system RAM, and signal when the rtVAX 300 is running an interrupt acknowledge or IPR cycle

The SELRAM and IACKIPR select lines are internally latched on the rising edge of AS H. This PAL eliminates the need for external device select latches by using the D flip-flops built into the 22V10 PAL.

Table 5–9 Application Module Address Decoder PAL

Pin	Description
Input	
1	AS
2	DAL22
3	DAL23
4	DAL24
5	DAL25
6	DAL26
7	DAL27
8	DAL28
9	DAL29
10	CSDP0
11	CSDP1
13	CSDP2
14	CSDP4
15	!DS
16	!WR
Output	
23	!SELRAM
22	!IACKIPR
21	!ENBCCTLDPE
20	CYCRES

Figure 5–9 Sample Design: Address Decoder and Power-Up Reset



Note: The rtVAX 300 uses CMOS ACTQ245 drivers for the DAL lines and ACTQ244 drivers for the control lines. These drivers have very fast rise and fall times which can generate a fair amount of undershoot and overshoot. Some PAL devices and RAM chips may malfunction when exposed to excessive overshoot and undershoot. It may be necessary to isolate these devices from the rtVAX 300 signal lines with TTL buffers or provide series termination resistors for these lines.

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Figure 5–10 shows the RAM memory map; Table 5–10 lists the corresponding equations.

Figure 5–10 RAM Memory Map

Device	Memory Locations Selected	DAL<29:2> 29 24	23 16	15 08	07 02
RAM	00000000 - 003FFFFF	000000	00XXXXXX	XXXXXXXX	XXXXXX

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Table 5–10 Application Module Address Decoder Equations

Line	Equals
SELRAM.D	!DAL29 & !DAL28 & !DAL27 & !DAL26 & !DAL25 & !DAL24 & !DAL23 & !DAL22
SELRAM.AR	CYCRES
IACKIPR.D	!WR & (!CSDP2 & CSDP1 & CSDP0) # (!CSDP2 & CSDP1 & !CSDP0)
IACKIPR.AR	CYCRES
CYCRES	!AS & (IACKIPR # SELRAM)
ENBCCTLDPE	DS & SELRAM

Figure 5–11 Sample Design: Address Latches

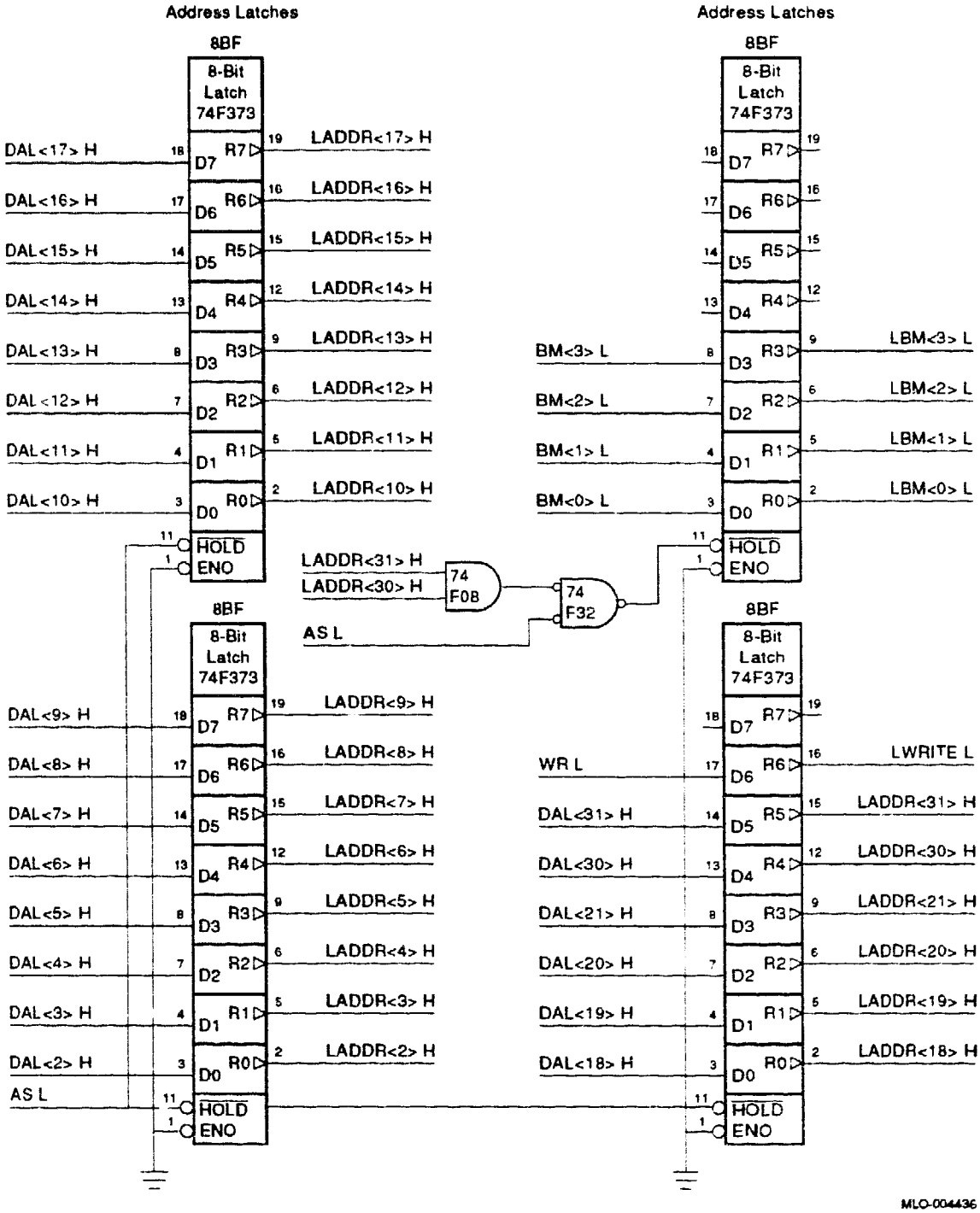


Figure 5–12 Sample Design: DRAM Memory Array (1)

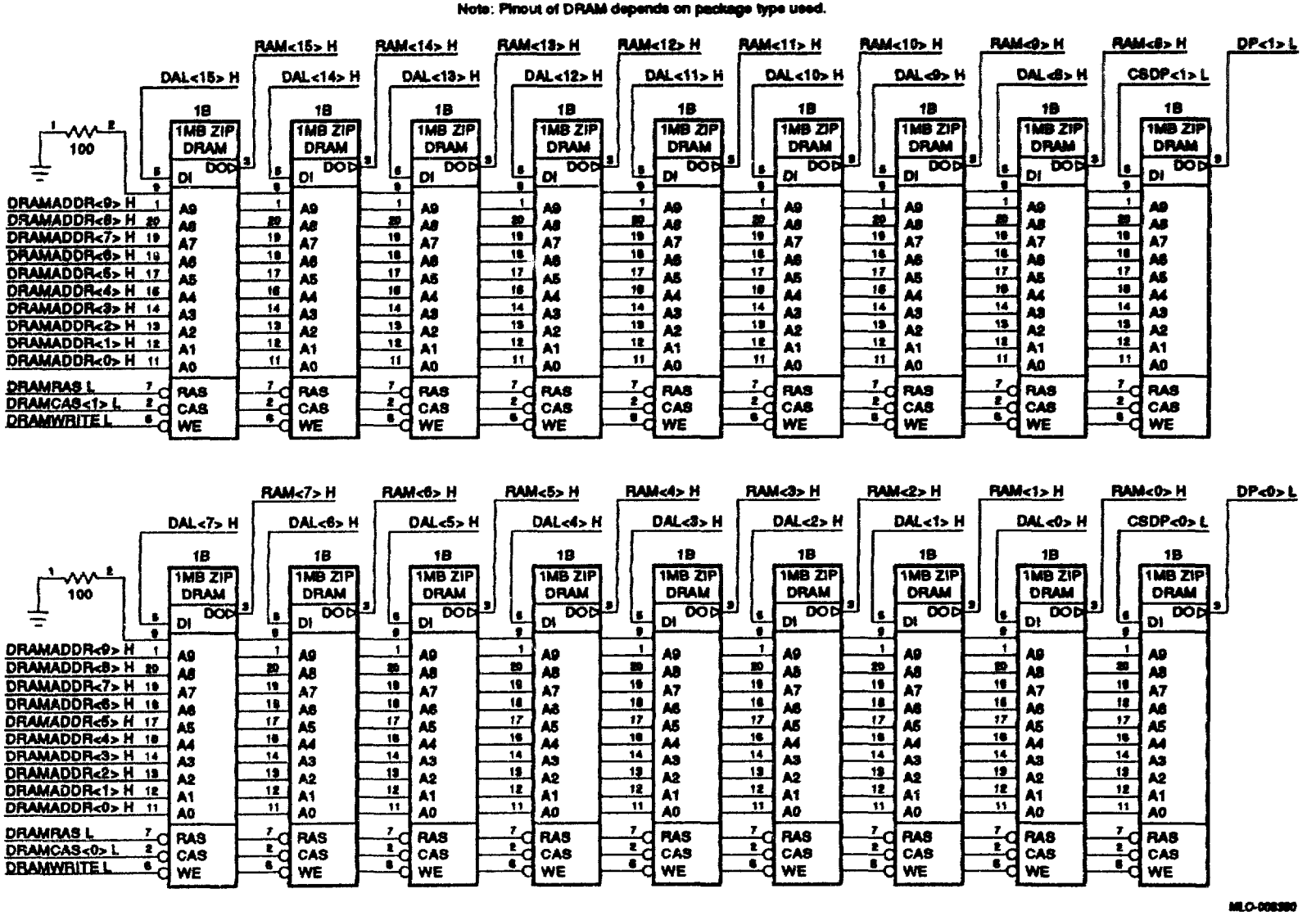


Figure 5–13 Sample Design: DRAM Memory Array (2)

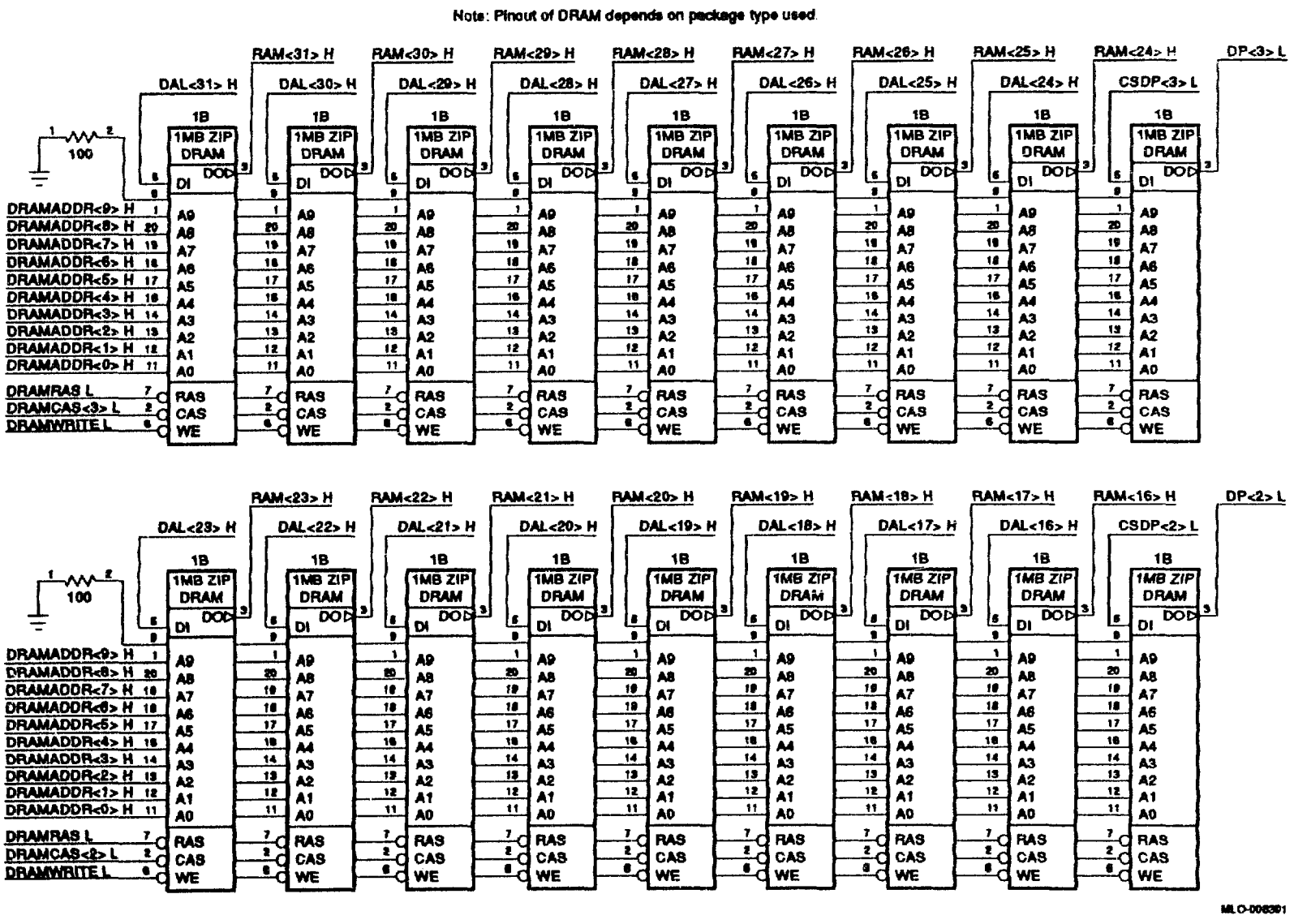


Figure 5–14 Sample Design: RAM Data Latches

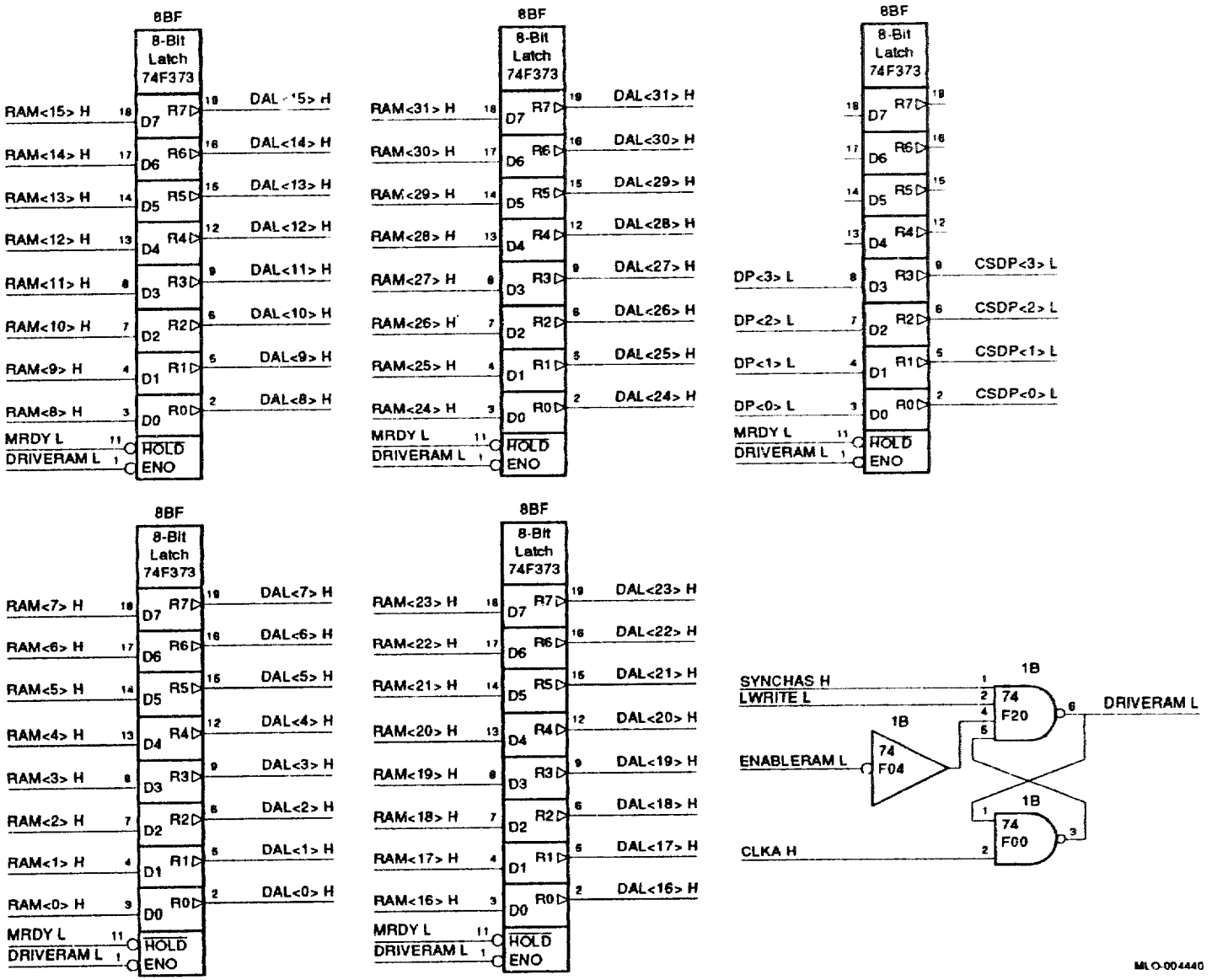
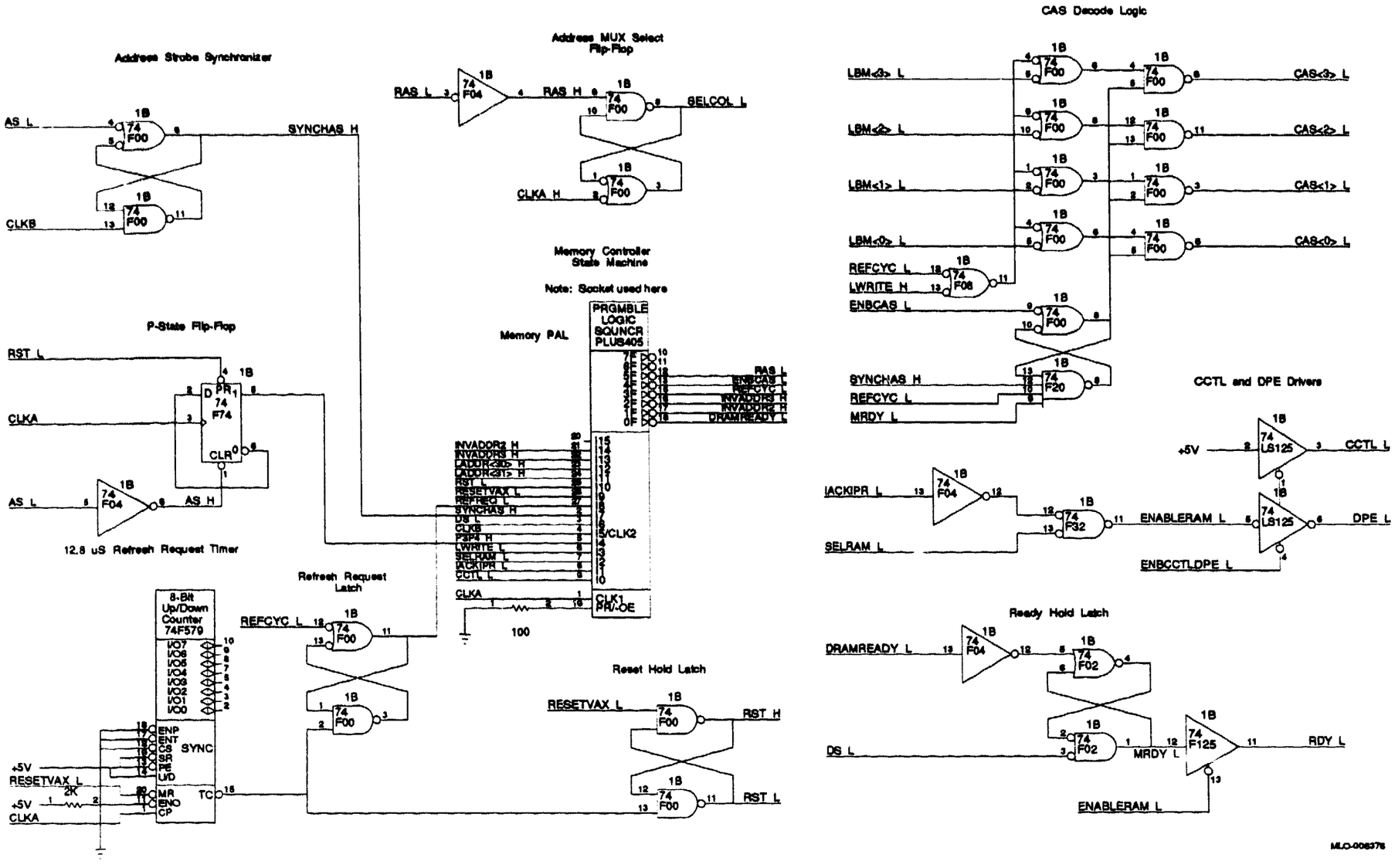


Figure 5–15 Sample Design: Memory Controller



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5.11.2 Memory Subsystem Sequencer State Machine PAL

The memory subsystem sequencer performs the following functions:

- Sequences the RAS, CAS, and address enable control lines for memory access and refresh on the rtVAX 300 application example
- Arbitrates between refresh requests and memory accesses
- Controls the RDY L signal to the rtVAX 300 to mark the end of a memory access cycle

Table 5–11 lists pins, signals, and comments.

Table 5–11 Memory Subsystem Sequencer State Machine PAL

Pins	Signal	Comment
Input Signals		
1	CLKA	The rtVAX 300 A phase of the CVAX clock used to trigger *all* state transitions.
2	SYNCHAS	This synchronized version of AS L from the rtVAX 300 indicates that the address cycle status information is valid and that the rtVAX 300 is starting a memory access. The signal remains asserted until the end of the memory access cycle and is synchronized to deassert on the CLKA positive edge.
3	!DS	This rtVAX 300 data strobe signal output is asserted when the DAL bus is ready to transfer data.
4	CLKB	This rtVAX 300 B phase of the processor clock is added here in case extra states need to be clocked off its edge.
5	P3P4	This signal is asserted when the rtVAX 300 is in the P3 or P4 state and deasserted when the rtVAX 300 is in the P1 or P2 state. This state machine uses the signal to determine when to assert the DRAMREADY line.
6	!LWRITE	This latched write signal output from the rtVAX 300 is asserted during a write cycle and unasserted for reads. It affects the operation of this state machine.
7	SELRAM	This signal is asserted by decode logic when the rtVAX 300 is trying to access the DRAM.

(continued on next page)

Table 5–11 (Cont.) Memory Subsystem Sequencer State Machine PAL

Pins	Signal	Comment
Input Signals		
8	!IACKIPR	This pin is controlled by external decode logic connected to the CSDP lines of the rtVAX 300. The signal asserts when the rtVAX 300 is running an interrupt acknowledge cycle but is *not* asserted for a memory read cycle and must be checked to prevent this state machine from starting a memory access cycle when the rtVAX 300 is running an IACK cycle.
19	OE	This is the output enable of the sequencer.
21	FINVADDR2	This is tied to the INVADDR2 output of this state machine and used as an input for determining the address of the last longword transferred during multiple-longword transfer cycles.
22	FINVADDR3	This is connected to the INVADDR3 output of this state machine and used as an input for determining the address of the last longword transferred during multiple-longword transfer cycles.
23	LADDR30	This signal is the second most significant bit of the latched address of the rtVAX 300. When it is deasserted and LADDR<31> is asserted, a quadword read cycle is taking place.
24	LADDR31	This signal is the most significant bit of the latched address of the rtVAX 300. When it is asserted and LADDR<30> is deasserted, a quadword read cycle is taking place.
25	!RST	This signal asserts during power-up and system reset. It causes the state machine to run refresh cycles continually to warm up the DRAM upon power-up.
26	!RESETVAX	This signal is asserted to start a system reset; its assertion forces the IDLE state and deasserts all outputs.
27	!REFREQ	This signal is asserted by an external refresh request counter every 3.28 ms. This request is reset when this state machine asserts the ENBREFRESH signal.

(continued on next page)

Table 5–11 (Cont.) Memory Subsystem Sequencer State Machine PAL

Pins	Signal	Comment
Output Signals		
12	!RAS	The assertion of this signal strobes the row address into the selected DRAMs for refresh or memory access.
13	!ENBCAS	The assertion of this signal strobes the column address into the selected DRAMs, writes data into them during a write cycle, and turns on the output drivers during a read cycle to drive output data.
15	!REFCYC	The assertion of this signal turns on the refresh address counter output drivers, driving the next refresh address onto the address lines of the DRAMs. This line clears the refresh request latch, and its deassertion increments the refresh address counter.
16	INVADDR3	The assertion of this signal inverts the LADDR<3> bit of the column address, which is then driven onto the address lines of the DRAM. This line is asserted only during the quadword, hexword, and octaword read cycles.
17	INVADDR2	The assertion of this signal inverts the LADDR<2> bit of the column address, which is then driven onto the address lines of the DRAM. This line is asserted only during the quadword, hexword, and octaword read cycles.
18	!DRAMREADY	This output controls assertion of the RDY L line to signal that valid data is on the DAL lines and that the cycle should end.

You define the internal state bits and assign a state name for each bit pattern as follows. In addition, all illegal states are defined to prevent the machine from accidentally hanging. All illegal states next-state to the idle state.

```
NODE [STATE0,STATE1,STATE2,STATE3,FLAG];

STATE0.CKMUX      = CLKA;
STATE1.CKMUX      = CLKA;
STATE2.CKMUX      = CLKA;
STATE3.CKMUX      = CLKA;
FLAG.CKMUX        = CLKA;
/* REFCYC.CKMUX   = CLKA;
DRAMREADY.CKMUX   = CLKA;
INVADDR2_.CKMUX   = CLKA;
INVADDR3_.CKMUX   = CLKA;
RAS.CKMUX_  = CLKA;
ENBCAS.CKMUX   = CLKA;
```

```
FIELD MEMORY = [STATE3,STATE2,STATE1,STATE0];

$DEFINE IDLE          'B'0000
$DEFINE STARTACCESS   'B'0100
$DEFINE ACCESSCYC     'B'0110
$DEFINE READCYC       'B'0010
$DEFINE WRITECYC1_    'B'1110
$DEFINE WRITECYC2_    'B'1100
$DEFINE WRITECYC3_    'B'0111
$DEFINE STARTREFRESH  'B'1000

$DEFINE REFRESHCYC    'B'1001
$DEFINE ENDREFRESH    'B'1011
$DEFINE FINISHUP      'B'0001
$DEFINE POWERUP       'B'1111
$DEFINE ILLEGAL1_     'B'0011
$DEFINE ILLEGAL2_     'B'0101
$DEFINE ILLEGAL3_     'B'1010
$DEFINE ILLEGAL4_     'B'1101
```

You now define equations to ease the state transition conditions. Memory access can start only if SYNCHAS and SELRAM are asserted and if IACK and REFREQ are not asserted to give refresh priority over memory access and to prevent memory access during an rtVAX 300 interrupt acknowledge cycle. EQU 1 through 4 determine when multiple longword transfer cycles are complete by looking at the cycle type LADDR<31:30> and the address of the last longword INVADDR<3:2> that was transferred.

```
MEMACCESS = SYNCHAS & SELRAM & !IACKIPR;
EQU1 = !LADDR31_ &  LADDR30_ &  FINVADDR2_ & !FINVADDR3_;
       /* END LONGWORD XFR */
EQU2 =  LADDR31_ & !LADDR30_ & !FINVADDR2_ &  FINVADDR3_;
       /* END QUADWORD XFR */
EQU3 = !LADDR31_ & !LADDR30_ &  FINVADDR2_ &  FINVADDR3_;
       /* END  HEXWORD XFR */
EQU4 =  LADDR31_ &  LADDR30_ & !FINVADDR2_ & !FINVADDR3_;
       /* END OCTAWORD XFR */
```

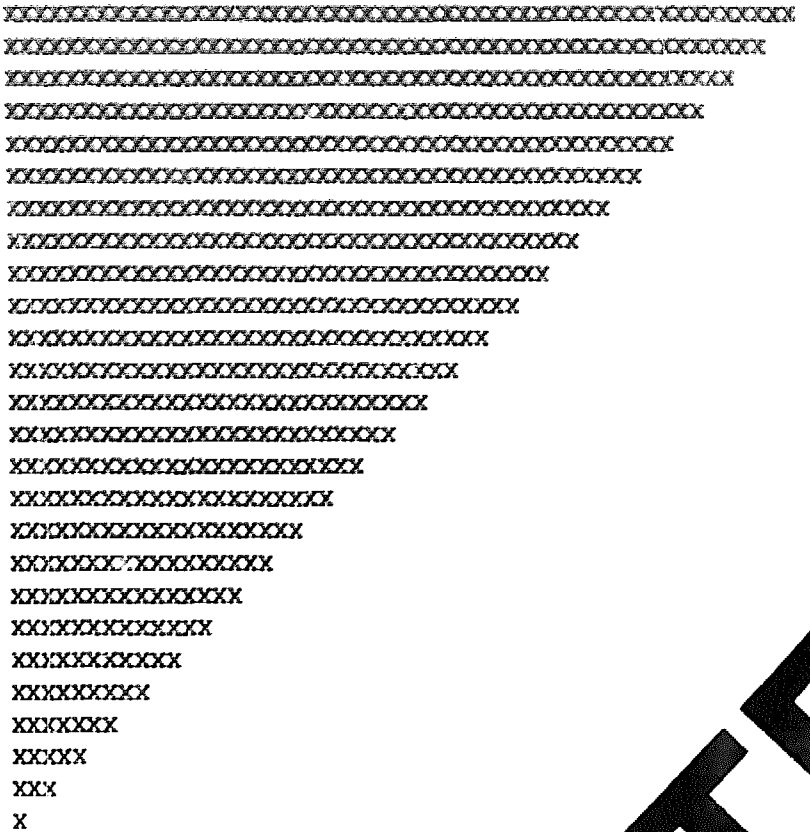
The state machine listing is as follows:

```
SEQUENCE MEMORY {
 PRESENT IDLE
  IF (REFREQ # RST) NEXT STARTREFRESH OUT REFCYC OUT ENBCAS;
  IF MEMACCESS & !(REFREQ # RST) NEXT STARTACCESS OUT RAS;
  DEFAULT NEXT IDLE OUT !REFCYC
      OUT !RAS
      OUT !ENBCAS
      OUT !INVADDR2_
      OUT !INVADDR3_
      OUT !DRAMREADY
      OUT !FLAG;
```

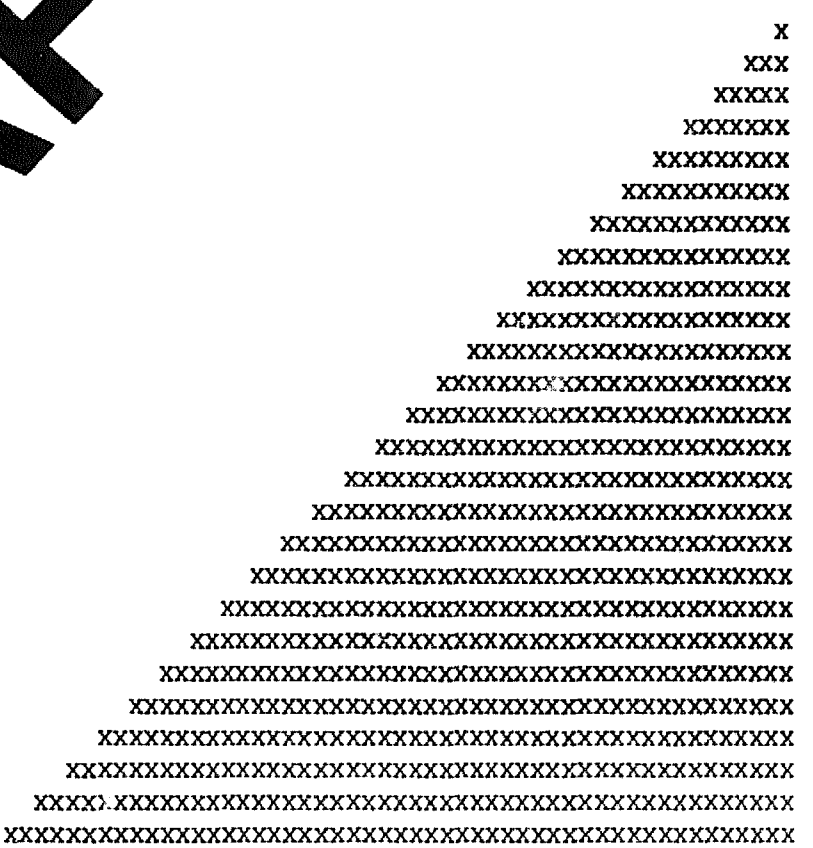
```
PRESENT STARTACCESS
 IF MEMACCESS & DS NEXT ACCESSCYC OUT ENBCAS;
 IF !MEMACCESS NEXT ENDREFRESH;
 DEFAULT NEXT STARTACCESS;

PRESENT ACCESSCYC
 IF !P4_ & !LWRITE & !FINVADDR2_ & !FINVADDR3_ & (!FLAG # !DS)
              NEXT READCYC  OUT DRAMREADY
                        OUT !ENBCAS
        OUT INVADDR2_;
 IF !P4_ & !LWRITE &  FINVADDR2_ & !FINVADDR3_ & (!FLAG # !DS)
              NEXT READCYC  OUT DRAMREADY
                        OUT !ENBCAS
        OUT !INVADDR2_
        OUT INVADDR3_;
 IF !P4_ & !LWRITE & !FINVADDR2_ & FINVADDR3_ & (!FLAG # !DS)
              NEXT READCYC  OUT DRAMREADY
                        OUT !ENBCAS
        OUT INVADDR2_;
 IF !P4_ & !LWRITE & FINVADDR2_ & FINVADDR3_ & (!FLAG # !DS)
              NEXT READCYC  OUT DRAMREADY
                        OUT !ENBCAS
        OUT !INVADDR2_
        OUT !INVADDR3_;
 IF !P4_ &  LWRITE & !FINVADDR2_ & !FINVADDR3_
              NEXT WRITECYC1  OUT DRAMREADY
                        OUT !ENBCAS
         OUT INVADDR2_;
 IF !P4_ &  LWRITE &  FINVADDR2_ & !FINVADDR3_
              NEXT WRITECYC1  OUT DRAMREADY
                        OUT !ENBCAS
         OUT !INVADDR2_
         OUT INVADDR3_;
 IF !P4_ &  LWRITE & !FINVADDR2_ & FINVADDR3_
              NEXT WRITECYC1  OUT DRAMREADY
                        OUT !ENBCAS
         OUT INVADDR2_;
 IF !P4_ &  LWRITE & FINVADDR2_ & FINVADDR3_
              NEXT WRITECYC1  OUT DRAMREADY
                        OUT !ENBCAS
         OUT !INVADDR2_
         OUT !INVADDR3_;
 DEFAULT NEXT ACCESSCYC;
PRESENT READCYC
 IF MEMACCESS & !(EQU1 # EQU2 # EQU3 # EQU4)
       NEXT ACCESSCYC  OUT ENBCAS
          OUT !DRAMREADY
          OUT FLAG;
 IF EQU4 NEXT REFRESHCYC OUT !RAS
           OUT !ENBCAS
           OUT !INVADDR2_
           OUT !INVADDR3_
```

```
            OUT !DRAMREADY
            OUT !FLAG;
 DEFAULT NEXT FINISHUP OUT !RAS
          OUT !ENBCAS
          OUT !INVADDR2_
          OUT !INVADDR3_
          OUT !DRAMREADY
          OUT !FLAG;
PRESENT WRITECYC1_
 IF MEMACCESS & !(EQU1 # EQU2 # EQU3 # EQU4)
          NEXT WRITECYC2_ OUT !DRAMREADY;
 DEFAULT NEXT FINISHUP OUT !RAS
          OUT !ENBCAS
          OUT !INVADDR2_
          OUT !INVADDR3_
          OUT !DRAMREADY;
PRESENT WRITECYC2_
 IF !DS NEXT WRITECYC3_;
 IF DS NEXT WRITECYC2_;
PRESENT WRITECYC3_
 IF DS NEXT ACCESSCYC  OUT ENBCAS
                  OUT FLAG;
 IF !DS NEXT WRITECYC3_;
PRESENT STARTREFRESH
 NEXT REFRESHCYC OUT RAS;
PRESENT REFRESHCYC
 NEXT ENDREFRESH OUT !ENBCAS;
PRESENT ENDREFRESH
 NEXT FINISHUP OUT !REFCYC
        OUT !RAS;
PRESENT FINISHUP
 NEXT IDLE OUT !RAS
    OUT !ENBCAS
    OUT !INVADDR2_
    OUT !INVADDR3_
    OUT !REFCYC
    OUT !DRAMREADY
    OUT !FLAG;
PRESENT POWERUP
 NEXT FINISHUP;
PRESENT ILLEGAL1_
 NEXT FINISHUP;
PRESENT ILLEGAL2_
 NEXT FINISHUP;
PRESENT ILLEGAL3_
 NEXT FINISHUP;
PRESENT ILLEGAL4_
 NEXT FINISHUP;
 }
```



CHAPTER 6



6

Console and Boot ROM Interface

This chapter provides information and examples for interfacing a processor status LED register and an external boot ROM to the rtVAX 300 processor. The console is used for hardware and software debugging, and the optional boot ROM is used to store the VAXELN image and user application permanently, so that the rtVAX 300 processor can boot without an operational network or host system. This ROM could also be used for board-level testing and initialization. The processor status LEDs are used to indicate the progress of rtVAX 300 self-test and processor operating mode.

This chapter discusses the following topics:

- Console system interface (Section 6.1)
- Booting from external ROM (Section 6.2)
- rtVAX 300 processor status LED register (Section 6.3)
- Console and boot ROM illustrations and programmable array logic (Section 6.4)

6.1 Console System Interface

The rtVAX 300 processor module does not contain an internal console serial-line unit (SLU); however, 16 console registers are reserved in the rtVAX 300 processor reserved space to select and program an external Signetics 2681 console dual universal asynchronous receiver/transmitter (SCN 2681 DUART). These registers occupy physical locations 20100000 to 2010003F. The built-in firmware of the rtVAX 300 programs and communicates with the external SCN 2681 DUART, which implements these console registers. The firmware detects the absence of an external console DUART and will stop communication with the console and continue to boot if the console is inoperable or nonexistent. (Table 3–13 lists console register addresses and their read and write functions.)

Note

Digital recommends that the console DUART be implemented in every application module that uses the rtVAX 300 processor. The console provides a tool for debugging the application hardware and software. Without the console terminal, you cannot use the console emulation program and the local debugger.

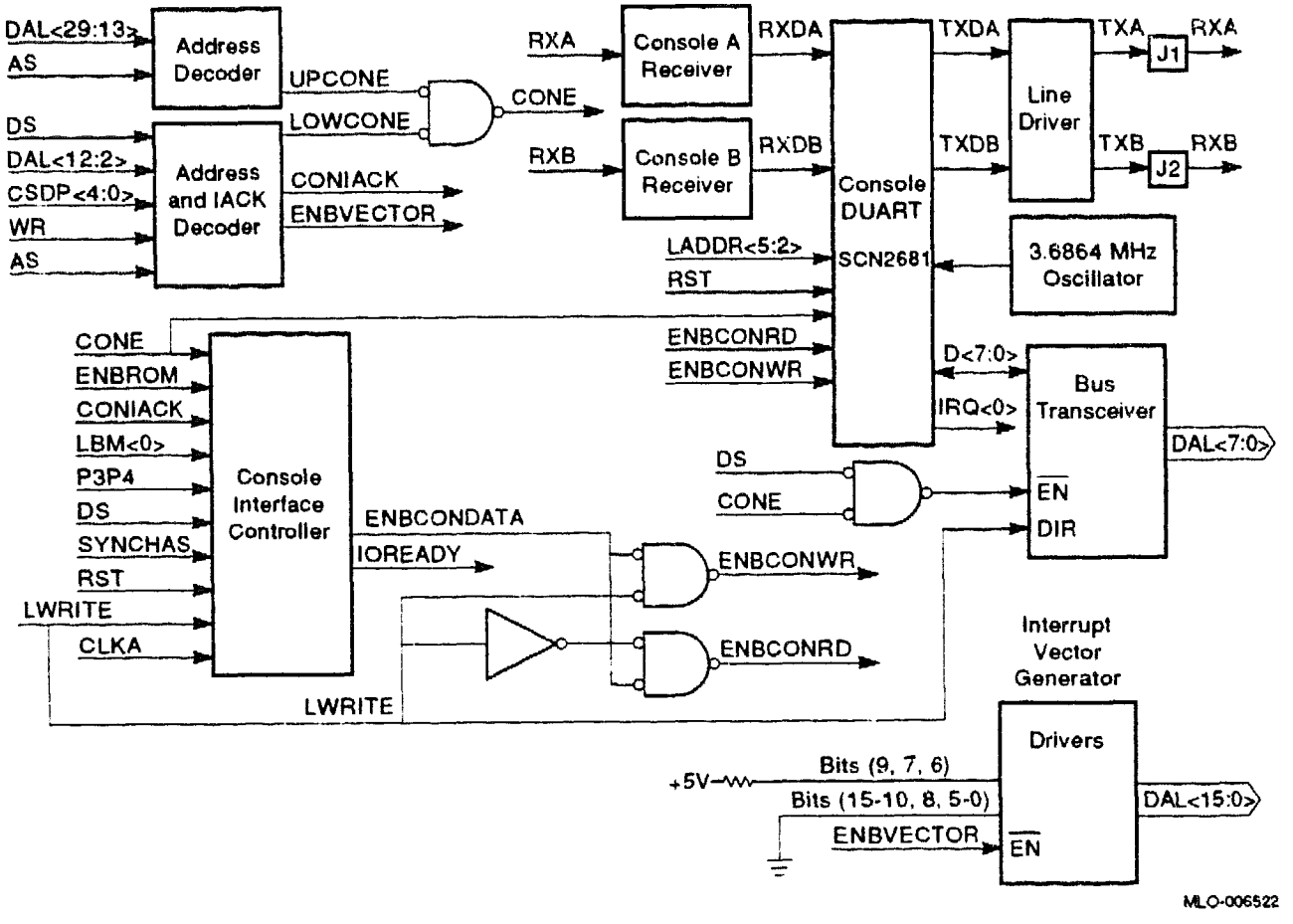
I/O registers implemented in the application hardware can be debugged by using the EXAMINE and DEPOSIT commands of the console emulation program through the console terminal. The built-in console emulation routines provide other commands for performing self-test and external memory testing. The VAXELN kernel also provides a local debugger that is used through the console. User-written VAX assembly language programs for debugging hardware and VAXELN system images can easily be loaded through Channel B of the DUART.

A console terminal interface for the rtVAX 300 processor must contain the following elements:

- Full address decoder to select the console DUART
- Cycle status decoder to detect console interrupt acknowledge cycles
- Address latches to hold the console register address
- SCN 2681 DUART to implement the console registers and interface
- Line receivers and drivers
- DAL transceiver to prevent bus contention
- Interrupt vector generator
- Optional 160 ms break detector
- Console state machine

Figure 6–1 shows the console terminal interface block diagram. The interface contains the address and cycle status decoder, the DUART, DAL bus transceivers, address latches, an interrupt vector generator, and a console state machine. The console terminal connects to Channel A of the DUART; a serial-line output of a VMS host can be connected to Channel B to down-line load hardware debugging assembly language programs and VAXELN system images. Other general-purpose RS–232 peripheral devices can also connect to Channel B.

Figure 6–1 Sample Design: Console Terminal Interface Block Diagram



6.1.1 Console Access

When the rtVAX 300 processor accesses any of the 16 console registers, the rtVAX 300 first places the register address on the DAL<29:02> H bus. This address is in the range of 20100000 through 2010003F. The address decoder (see Figure 6–6) asserts the console enable (CONE L) signal when a valid console address is latched. CONE L asserts on the rising edge of AS H and remains asserted throughout the entire console access cycle. The 4 low-order address bits DAL<05:02> H are latched (see Figure 6–7) and fed into A<3:0> of the DUART to select one of the 16 internal registers. The DUART is only 8 bits wide; therefore, DAL<31:08> H are ignored when accessing the console.

6.1.2 Console State Machine

When the address decoder has asserted CONE L, the DUART is selected, and the console state machine jumps to the WRITECYC1 state, if it is a console write cycle, or to the READCYC1 state, if it is a read cycle. ENBCONDATA and either the DUART RD or the WR input are asserted. The state machine waits the appropriate number of wait states for the console read or write cycle, synchronizes with the P3P4 signal, and asserts IOREADY. This sets the ready hold latch (see Figure 6–11), and the RDY L input to the rtVAX 300 is asserted until the end of the access cycle. The state machine then jumps to the FINISHUP1 to FINISHUP3 states. These states are necessary to satisfy the 200 ns of deselect time required by the SCN 2681 DUART. Refer to Figure 6–2 to see the console state machine sequences.

Caution

The RDY L, ERR L, and CCTL L lines are tri-stateable, bidirectional lines. These lines are pulled up by resistors inside the rtVAX 300 processor and must be driven by a tri-stateable driver, such as the 74F125. If these lines are driven by a standard TTL totem pole output, the rtVAX 300 processor will not function.

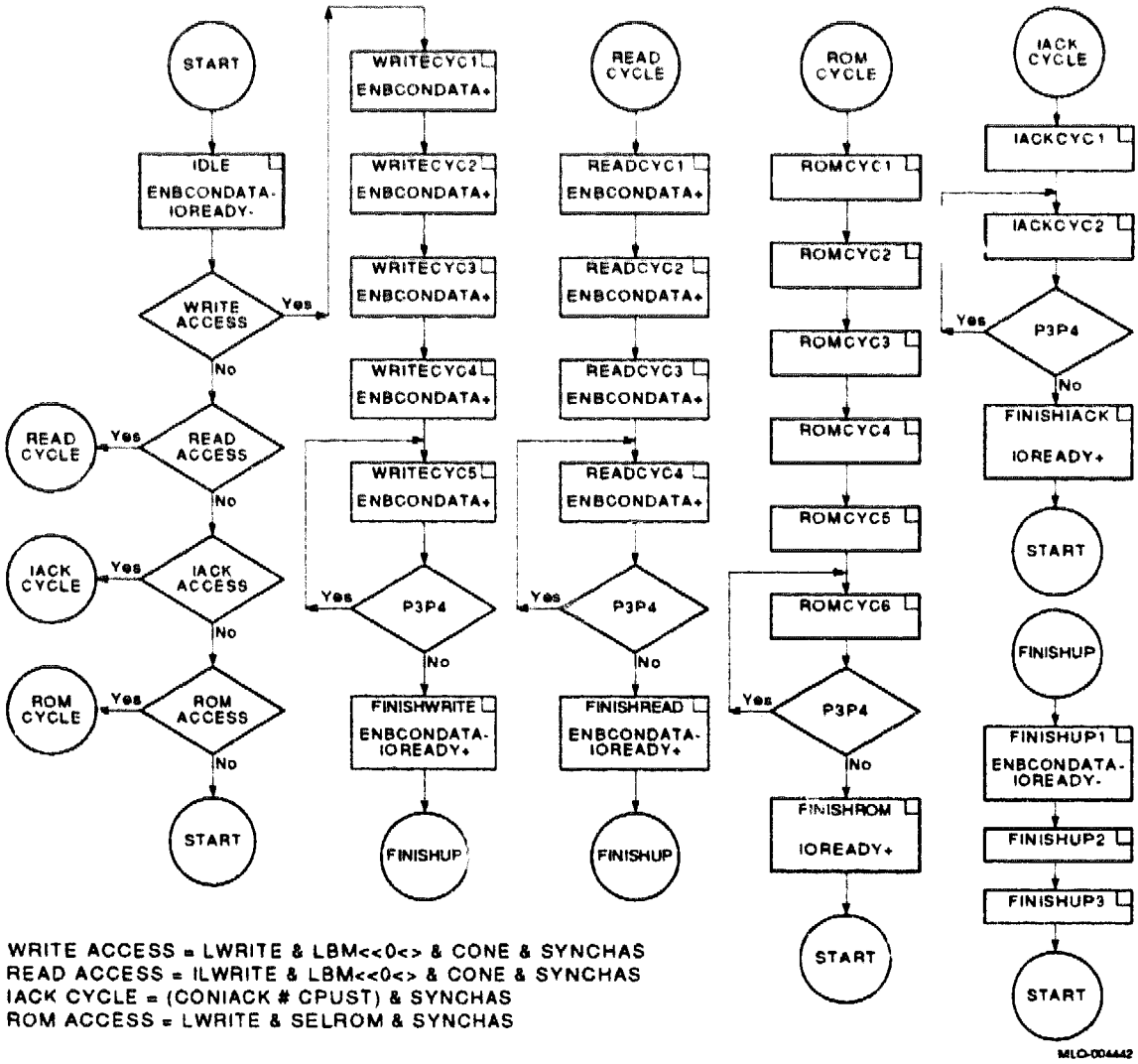
6.1.3 Console Interrupt Acknowledge Cycles

Interrupt requests to the rtVAX 300 processor from the DUART are generated on the IRQ<0> L line when the receive buffer is full or the transmitter buffer is empty. The rtVAX 300 processor responds to interrupt requests by initiating an interrupt acknowledge cycle, shown in Figure 6–3; the sequence is shown in Figure 6–2.

The INT output of the DUART asserts the IRQ<0> L input of the rtVAX 300 processor. The rtVAX 300 processor executes an interrupt acknowledge cycle, during which it expects to read a vector from the interrupting device. The interrupt vector generator (see Figure 6–11) drives a vector of $02C0_{16}$ onto the DAL bus when the ENBVECTOR signal is asserted.

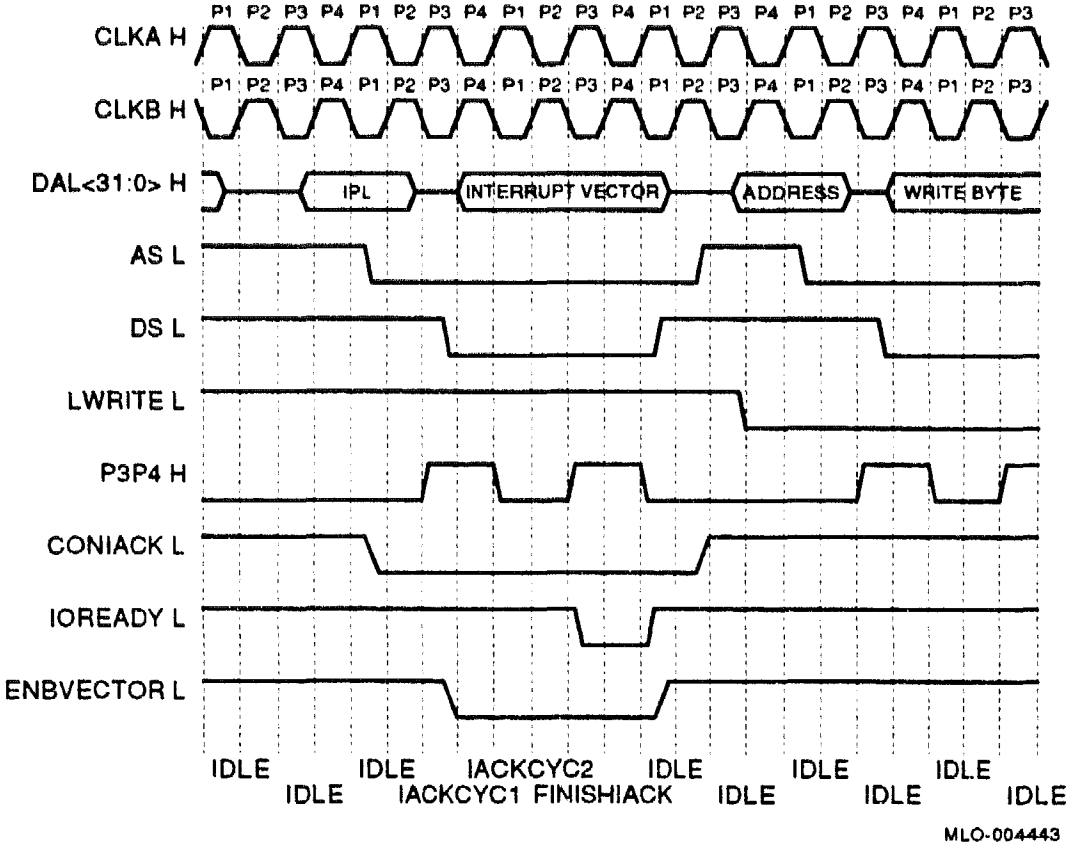
The cycle status decoder (see Figure 6–6) monitors the CSDP<4:0> L and DAL<06:02> H lines to determine if the rtVAX 300 processor is performing an interrupt acknowledge cycle. The interrupt priority level (IPL) is detected when DAL<06:02> H is read. If the IPL correlates to an interrupt generated by the console, the cycle status decoder asserts the CONIACK signal.

Figure 6–2 Sample Design: Console Cycle Sequence



The ENBVECTOR signal is asserted when DS asserts, driving the vector onto the DAL bus. When in the IDLE state and CONIACK is asserted, the console state machine jumps to the IACKCYC1 state and to IACKCYC2. The state machine checks the state of P3P4 to synchronize with the rtVAX 300 and asserts IOREADY, ending the cycle. The rtVAX 300 reads the vector that was driven onto the DAL bus and uses it as an offset into the system control block (SCB) to determine the location of the interrupt service routine for the console.

Figure 6–3 Sample Design: Interrupt Acknowledge Cycle Timing



6.1.4 Console Timing Parameters

To ensure reliable console operation, all timing parameters of the SCN 2681 DUART and the rtVAX 300 must be satisfied. Table 6–1 lists important timing parameters of the SCN 2681 DUART.

Table 6–1 SCN 2681 DUART Timing Parameters

Parameter Name	Minimum Time (ns)	Maximum Time (ns)
Address setup time to RD, WR assertion	10	–
Address hold time to RD,WR assertion	0	–
WR,RD pulse width	225	–
Data valid after RD low	–	175
Data float after RD high	–	100
Data in setup before WR deasserts	100	–
Data in hold after WR deasserts	20	–
High time between WR and RD	200	–

Figure 6–4 shows a timing diagram of the console read and write cycle. This state machine is clocked on CLKA; therefore, all state transitions occur on the positive edge of CLKA. The setup times for each of these inputs were calculated like those of the memory controller and meet the requirements of the 15 ns 22V10 PAL that was used.

6.1.4.1 Console Address Setup and Hold Times

When the rtVAX 300 is accessing the console, the address is placed on the DAL<29:02> H bus 23 ns before the rising edge of P1. ENBCONDATA is asserted on the rising edge of P3. The address information has to propagate through the 74F373 latches (see Figure 6–7).

The calculation for the address setup time is as follows:

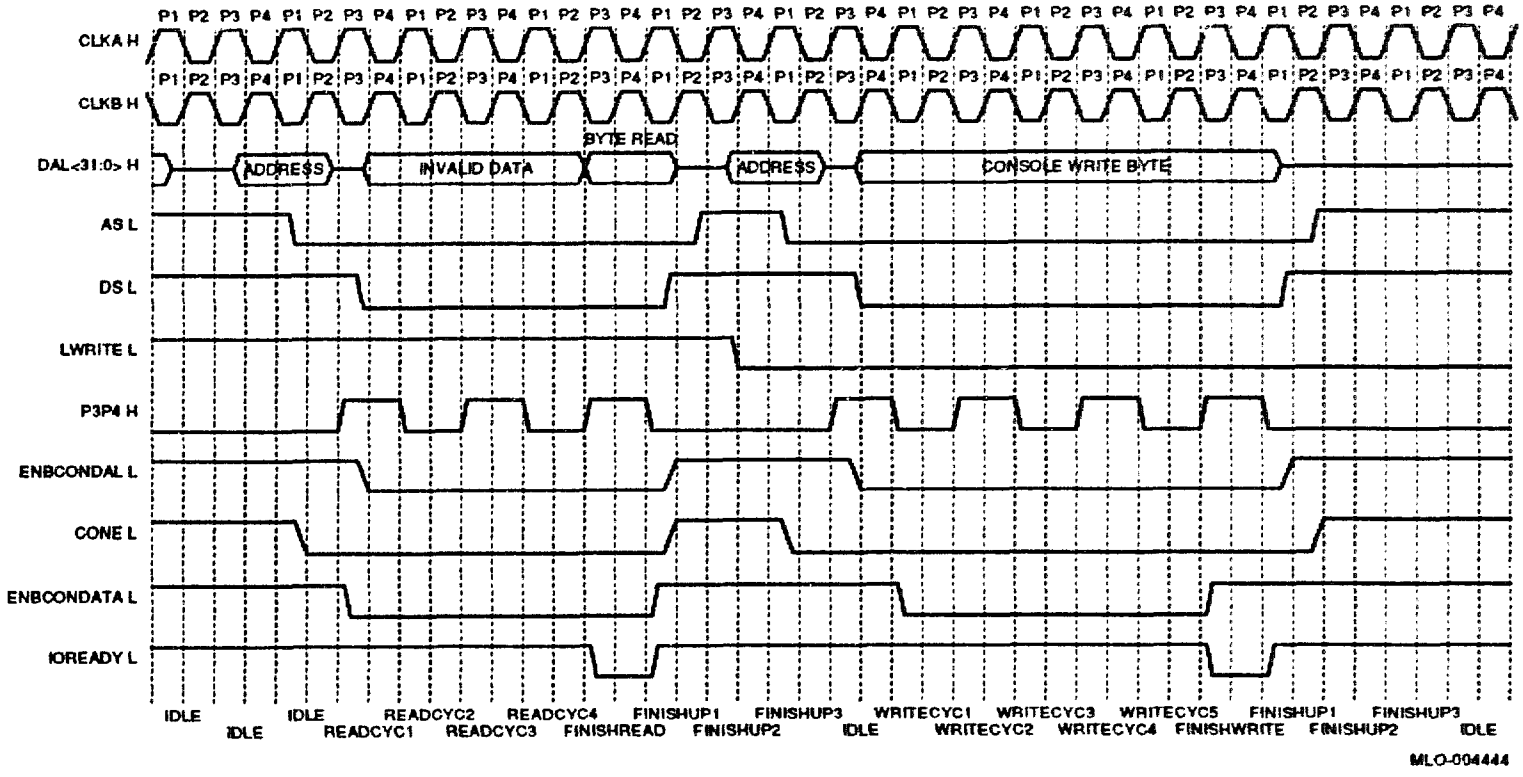
+ 74F244 turn-off time (5 ns)
+ 50 ns
+ 23 ns
– Propagation of F373

DUART address setup time

In this case, the DUART address setup time = 5 ns + 50 ns + 23 ns – 7 ns = 71 ns.

The address on A<3:0> of the DUART will be valid during the entire console access cycle, so the DUART address hold time is easily satisfied.

Figure 6–4 Sample Design: Console Read and Write Cycle Timing



6.1.4.2 Console Data Turn-Off Time

The turn-off time of any device connected to the rtVAX 300 DAL bus must be less than 35 ns after the rising edge of CLKA during the last P1 cycle. Since the turn-off time of the DUART is 100 ns, a transceiver is needed between the DUART data bus and the DAL<07:00> H bus. This 74F245 transceiver (see Figure 6–11) turns off with the deassertion of DS, satisfying the required bus turn-off time. The transceiver also adds delay to the read access time and the write setup time.

The calculation for the timing analysis for the console turn-off time is as follows:

+ DS deassertion delay
+ 74F32 propagation delay
+ 74F245 turn-off time

Turn-off time

In this case, turn-off time = 25 ns + 5 ns + 5 ns = 35 ns after P1 edge.

Note

The time required to deactivate memory and peripheral devices must be considered in the application design to prevent bus contention conflicts.

6.1.4.3 Console Read Cycle Timing Analysis

Since the read access time of the DUART is 175 ns, two wait states are needed to satisfy the rtVAX 300 read-timing. These wait states are added by delaying the assertion of the rtVAX 300 RDY L signal.

During a console read cycle, the console state machine asserts the ENBCONDATA signal, which enables the ENBCONRD, to the DUART, and the ENBCONDAL signal is asserted when DS asserts. The assertion of ENBCONDAL and ENBCONRD turns on the bus transceivers and asserts the RD input of the DUART. The console controller state machine waits 200 ns and then asserts the IOREADY signal within the rtVAX 300 RDY L window, adding two wait states. The console controller completes the console read cycle by deasserting ENBCONDATA and IOREADY for 150 ns and then waits for another console access cycle to begin.

Console read cycle access time is calculated as follows:

+ 5 x CLKA period
– rtVAX 300 data setup time
– CLKA edge to ENBCONDATA assertion
– 74F00 propagation delay
– 74F245 propagation delay

Access time from RD

In this case, access time from RD = (5 x 50) ns – 28 ns – 12 ns – 5 ns – 6 ns = 199 ns.

The FINISHUP1 to FINISHUP3 and IDLE states deassert the ENBCONDATA signal for at least 200 ns after each console read or write cycle. This satisfies the 200 ns RD and WR deassertion time after each console read or write cycle.

6.1.4.4 Console Write Cycle and Data In Setup and Hold Timing Analysis

During console write cycles, the WR line of the DUART must be asserted for at least 225 ns. The data is latched in the DUART internal register upon the deassertion of this line. Figure 6–4 shows the console write cycle timing. The ENBCONWR line is deasserted when the console state machine deasserts the ENBCONDATA line. The console state machine asserts the ENBCONDATA line on the P3 edge after AS asserts. ENBCONDATA remains asserted for five CLKA cycles and deasserts on the P3 edge of CLKA before the cycle ends. At this time, the console state machine asserts IOREADY, asserting the rtVAX 300 RDY L line and ending the console write cycle.

Memory system write cycle data in setup time is calculated as follows:

+ 5 x 50 ns
+ DAL write data setup
+ 74F00 minimum propagation delay
– 74F245 propagation delay

Memory system write cycle data in setup time

In this case, data in setup time = 250 ns + 23 ns + 2 ns – 6 ns = 269 ns.

The input data is valid on the DALs until after the P1 edge of CLKA. The ENBCONDATA line deasserts on the P3 edge of CLKA. Thus, the data in hold time is calculated as follows:

+ 1 CLKA period
– State machine output delay
– 74F00 propagation delay

Data in hold time

In this case, data in hold time = 50 ns – 12 ns – 5 ns = 33 ns.

6.1.5 Console Oscillator

A 3.6864 MHz crystal oscillator provides the clock signals and internal timing to the DUART. The baud rate and other serial line configuration information is software-programmable by writing to the appropriate console register. The built-in firmware of the rtVAX 300 sets the baud rate to 9600 with 8 data bits and 1 stop bit.

6.1.6 Line Drivers and Receivers

The voltages of RS–232 and DEC–423 are not directly TTL-compatible. Line drivers and receivers must convert the TTL voltages of the DUART to the standard voltage levels that are used for RS–232 and DEC–423 applications. The 9636 and 9639 line drivers and receivers (see Figure 6–11) serve as the DEC–423 interface drivers.

6.1.7 Console Break Key Support

You can set up the console terminal break key to halt the rtVAX 300 program execution. This is accomplished by adding a break detection circuit connected to the HLT L line of the rtVAX 300. When the break key of the console terminal is depressed, the RXD line receiver output is asserted low for more than 160 ms. The counter (see Figure 6–11) begins counting as soon as the RXD line is low; it will reset as soon as the RXD line returns to the high state. This counter is clocked by the 10 ms interval timer, and once it counts to 16 (after 160 ms), it asserts the HLT L line of the rtVAX 300 processor and stops counting. The assertion of the HLT L line on the rtVAX 300 processor breaks the program execution and drops the program into console emulation. This break detection circuit can be eliminated if a separate halt switch is implemented or if the console break key is not needed.

6.2 Booting from External ROM

The default booting device for the rtVAX 300 is the network. In this configuration, the BOOT<3:0> L pins are tied to Vcc or left unconnected. (The BOOT<3:0> L pins are tied high through pull-up resistors.) When the rtVAX 300 initializes after a power-on reset, it sends the maintenance operation protocol (MOP) message over the network. The host system responsible for booting the rtVAX 300 receives these MOP requests and begins to down-line load the ELN system file to the rtVAX 300. Once this file is loaded into the rtVAX 300's memory, the rtVAX 300 begins executing the application software from its RAM.

Many applications require the rtVAX 300 to boot internally, independently of the state of the network or host. This is accomplished by connecting a ROM in the rtVAX 300's I/O space or memory space and fixing the VAXELN system image in this ROM. The rtVAX 300 can now boot the intended application if the host node is not available or the network segment fails. This feature is important if controller down time is unacceptable.

6.2.1 Base Address of External ROM

The external user ROM's base address (first and lowest physical location) may be at 20200000 or 10000000. To boot from this ROM, you must connect the BOOT<3:0> L pins, as shown in Table 3–12. When the rtVAX 300 finishes initializing after a reset operation, it begins to copy the VAXELN system image from the ROMs to its external system RAM or runs from the ROMs. The rtVAX 300 does not send the MOP requests over the network; instead, the rtVAX 300 boots from the ROMs. Table 3–12 lists boot options.

6.2.2 Programming the Boot ROMs

The system file generated by EBUILD must first be down-line loaded to the rtVAX 300 target by means of the network as the booting device. You can then use the remote and local debuggers to debug the application software. Once the application software is running correctly, EBUILD should be used to generate a new system file, selecting the ROM as the boot method. The resulting .SYS file should then be run through the PROMLINK program, for example, which creates a loadable file for the EPROM programmer. The programmed ROMs are then inserted into the EPROM programmer, programmed, and then inserted into their correct sockets on the user's application module.

You can now connect the BOOT<3:0> L pins, as shown in Figure 2–7; the rtVAX 300 boots from these ROMs.

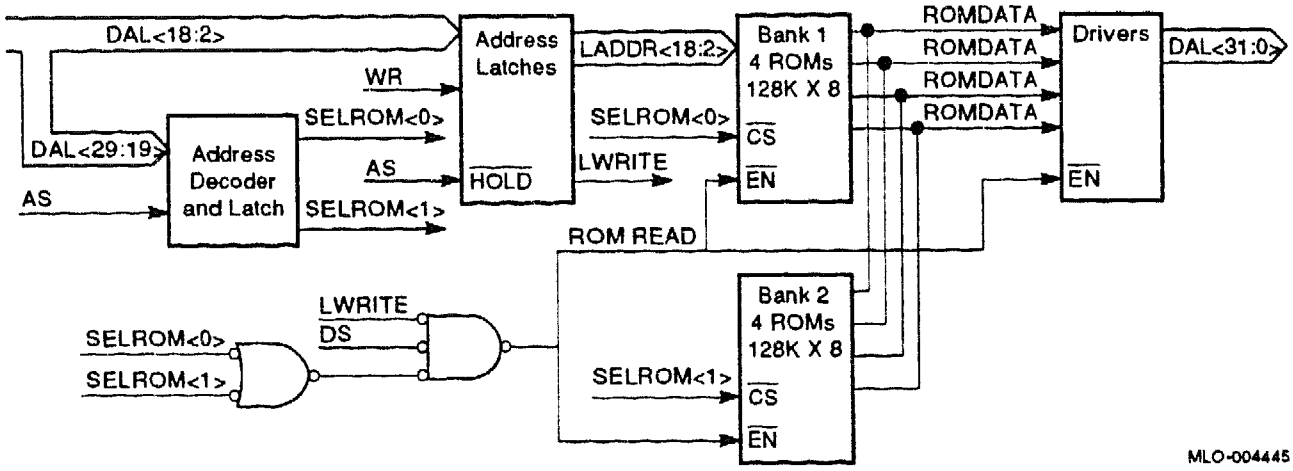
Note

The ROMs must be plugged into their correct sockets; otherwise, the rtVAX 300 will not boot.

6.2.3 Boot ROM Interface Design

Figure 6–5 shows the design of a 1M-byte boot ROM connected to the rtVAX 300's DAL lines. This ROM is constructed from eight 128K x 8 bit 27010 1M-bit ROMs. Eight ROMs are needed to construct a memory size of 1M bytes and each ROM is connected to one of the four bytes of the rtVAX 300 DAL lines by means of F244 drivers. During a read cycle, it is not necessary to qualify each byte with the BM<3:0> L lines. The rtVAX 300 reads only the byte(s) in the longword that correlate to an asserted BM<3:0> L and ignores the other bytes. However, during write cycles you must write only to the byte(s) selected by an asserted BM<3:0> L line. Since ROMs are read-only and cannot be written to, the select logic need not include the BM<3:0> L signals.

Figure 6–5 Sample Design: Boot ROM Functional Block Diagram



6.2.4 Boot ROM Address Decoder

The address decoder, shown in Figure 6–6, decodes the address placed on the DALs by the rtVAX 300. When a valid address for ROM bank 0 (between 20200000 and 2027FFFF) is placed on the DAL bus, the address decoder asserts the SELROM0 signal. In addition, when a valid address for ROM bank 1 (between 20280000 and 202FFFFF) is placed on the DAL bus, the address decoder asserts the SELROM1 signal. These two signals are latched by the assertion of AS H and select the appropriate ROM bank; when the DS L output signal of the rtVAX 300 is asserted, the ROM outputs and drivers are enabled.

6.2.5 ROM Address Latch

Since the address is valid on the DAL<29:02> H bus only at the beginning of any rtVAX 300 access cycle, latches are needed to preserve this address for the duration of the access cycle. The 74F373 latches shown in Figure 6–7 serve to latch the ROM longword address upon the assertion of AS L. This latched address, LADDR<18:02>, is fed directly into the address inputs of the ROMs.

6.2.6 ROM Read Cycle Timing

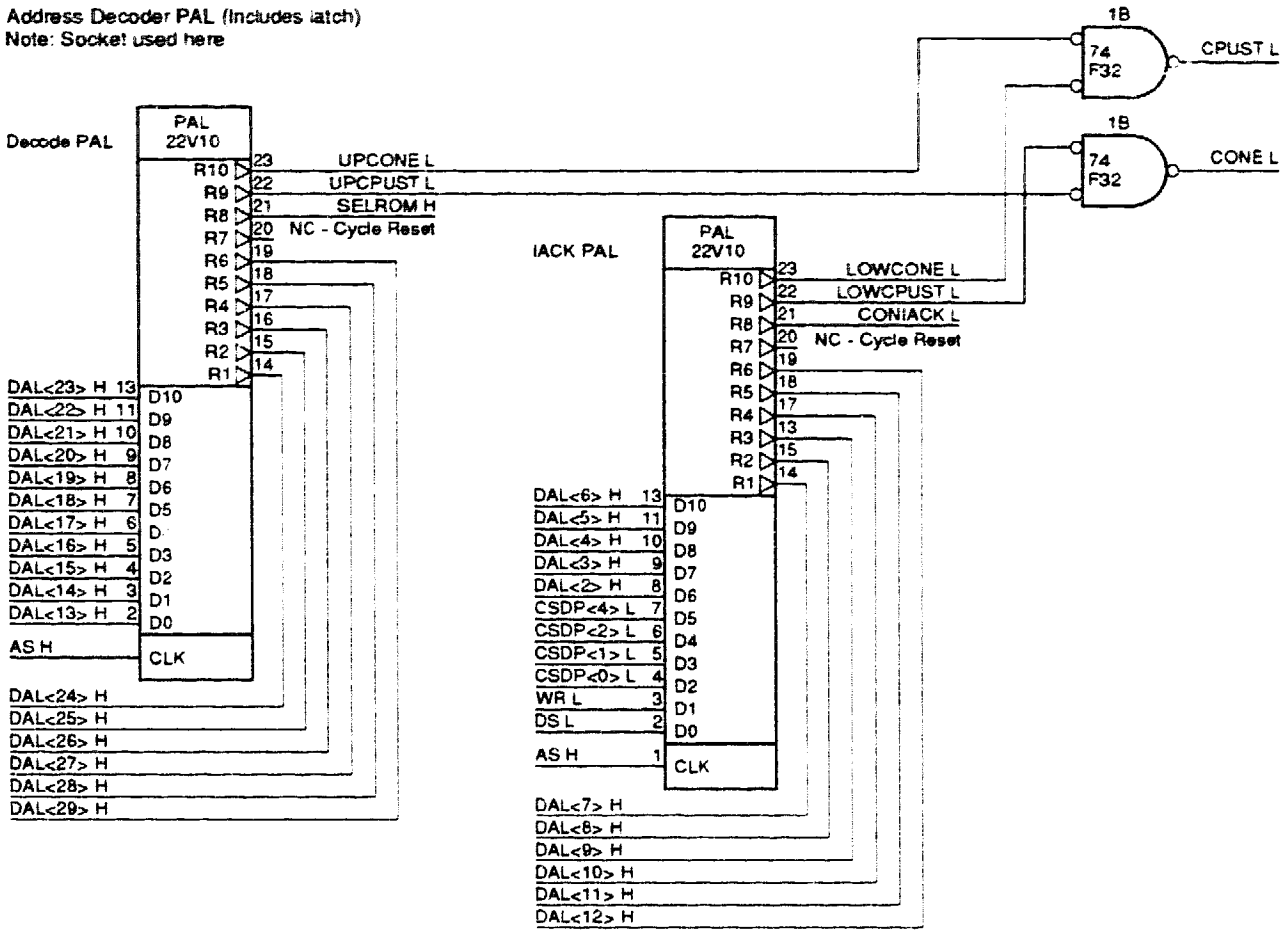
Figure 6–8 shows the read cycle timing for the ROM system. Valid data must be placed on the DALs 28 ns before the rising edge of P1; DS L asserts 27 ns after the rising edge of P3. To operate without any wait states, data must be available at the same time as the assertion of DS L.[1] Access time of the ROMs used is 250 ns; therefore, you must insert three wait states. ROMREAD asserts 5 ns after DS; thus, ROM read cycle access time is calculated as follows:

+ (number of wait states x 100)
+ P3 to P1 time
– DS assertion delay
– Data in setup time
– 74F244 propagation delay
– 74F20 propagation delay

ROM read cycle access time

[1] 100—72—28 = 0 ns, according to the rtVAX 300 specifications.

Figure 6–6 Sample Design: Address Decoder



Note: The rtVAX 300 uses CMOS ACTQ245 drivers for the DAL lines and ACTQ244 drivers for the control lines. These drivers have very fast rise and fall times which can generate a fair amount of undershoot and overshoot. Some PAL devices and RAM chips may malfunction when exposed to excessive overshoot and undershoot. It may be necessary to isolate these devices from the rtVAX 300 signal lines with TTL buffers or provide series termination resistors for these lines.

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In this case, ROM access time = 300 ns + 50 ns – 27 ns – 28 ns – 6 ns – 5 ns = 284 ns.

Table 6–2 shows a list of ROM access times and the number of required wait states. The delay of the drivers, if placed between the ROM outputs and the DAL lines, must be added to the ROM access time.

Figure 6–7 Sample Design: Address Latches

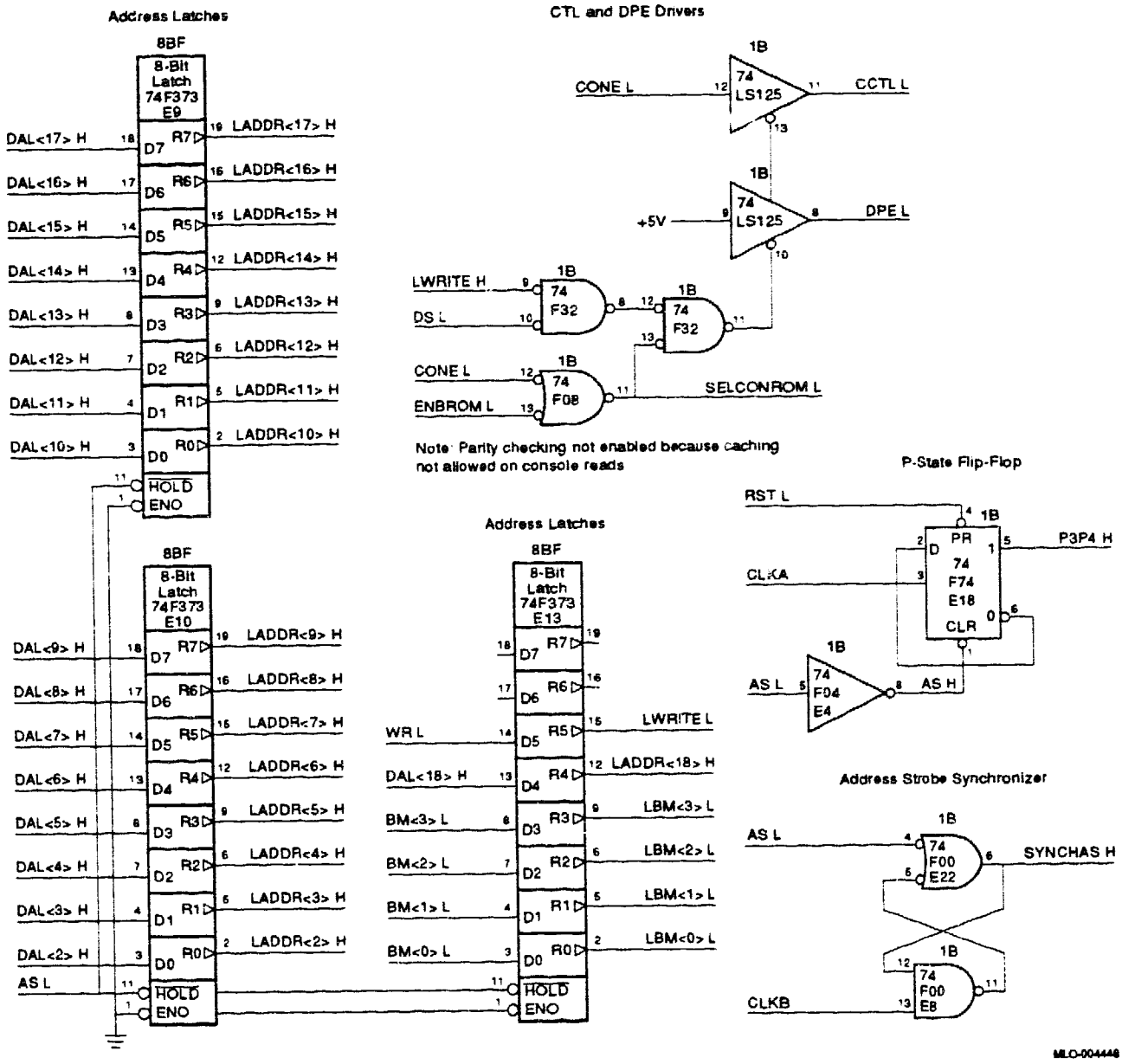


Figure 6–8 Sample Design: ROM Read Cycle Timing

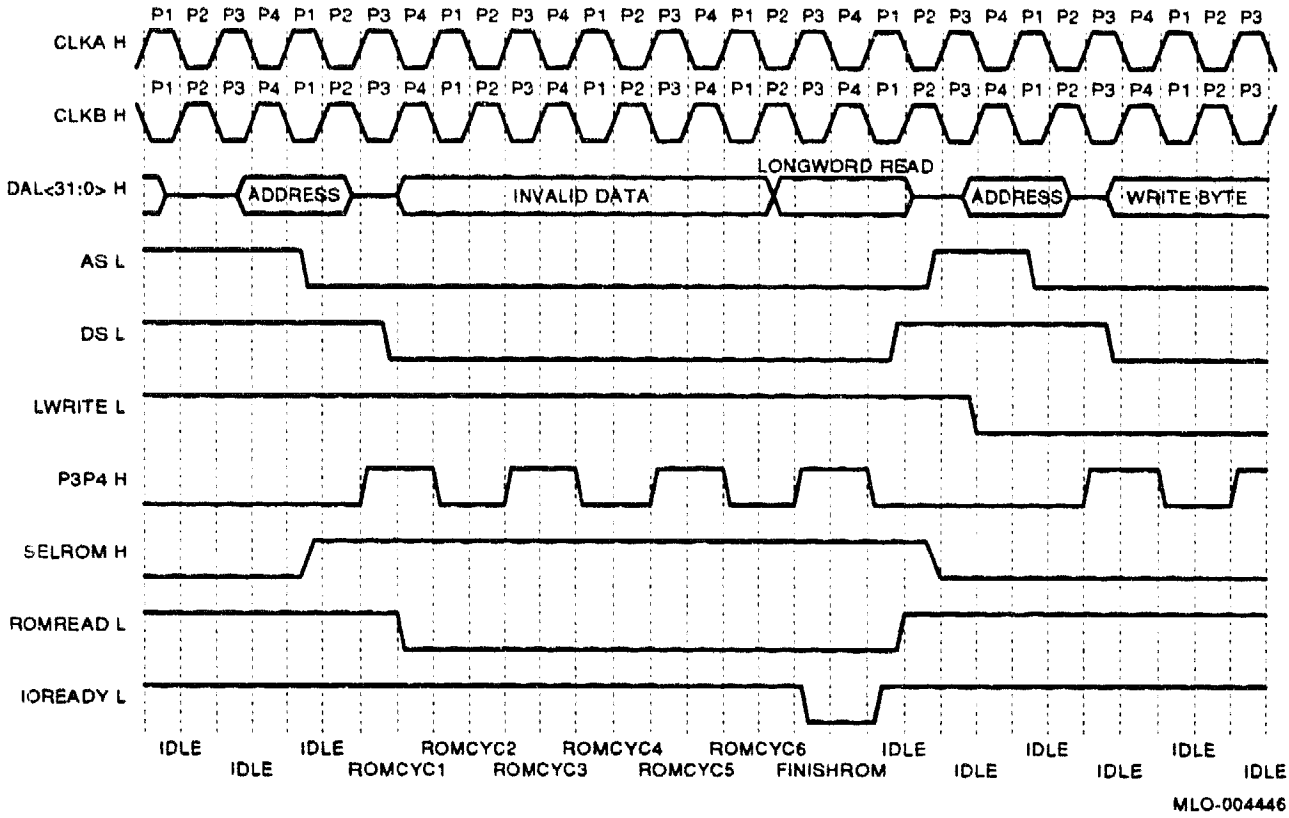


Table 6–2 Typical ROM Access Time

Maximum ROM Access Time (ns)	Wait States Needed	Total Read Cycle Time (ns)
84	1	300
184	2	400
284	3	500
384	4	600

These wait states are inserted by holding off the assertion of the RDY L signal input of the rtVAX 300. This RDY L signal is controlled by the console state machine. The machine jumps to the ROMCYC state when the ENBROM and AS signals are asserted. The state machine then counts seven CLKA ticks and asserts the IOREADY signal, which in turn asserts the RDY L line of the rtVAX 300. Additional wait states can easily be added for slower ROMs by increasing the number of CLKA counts (ROMCYC states) needed before the assertion of the RDY L line.

6.2.7 ROM Turn-Off Time

The rtVAX 300 uses ROMs that have a data turn-off time of 60 ns. This time exceeds the 35 ns specified by the rtVAX 300 processor. Data drivers are added between the ROM data outputs and the DAL bus to stop driving the DAL bus after DS L deasserts to prevent bus contention. The calculation of ROM turn-off time is as follows:

+ DS deassertion delay
+ 74F20 propagation delay
+ 74F244 turn-off time

ROM turn-off time from CLKA to P1 edge

In this case, ROM turn-off time from CLKA to P1 edge = 27 ns + 5 ns + 6 ns = 38 ns.

To determine if drivers are needed, add the DS assertion delay to the ROM CS select delay and subtract the total from 35 ns. The resulting value is the maximum turn-off delay that can be tolerated without the addition of drivers. In this example, the maximum turn-off delay of the ROMs was as follows:

Sample maximum turn-off delay = 35 ns − 28 ns − 5 ns = 12 ns.

If the ROMs take longer than 12 ns from CS deassertion to HI–Z, a set of drivers must be added between the ROMs' data bus and the DAL bus to prevent bus contention;[1] they are enabled by the ROMREAD L signal.

6.2.8 ROM Speed Versus rtVAX 300 Performance

If the ROMs are copied to RAM, the speed of these ROMs affects only the time required to boot the VAXELN system on the rtVAX 300. Once the rtVAX 300 has finished booting, it runs out of system RAM and no longer accesses the ROMs: The entire system image has been copied from the ROMs to system RAM before the VAXELN kernel begins executing. If a longer boot period can be tolerated, slower ROMs can be used. If the rtVAX 300 is designed to run out of the ROMs, the access time of the ROMs directly affects the runtime performance.

6.3 rtVAX 300 Processor Status LED Register

Many applications must have a visual indication of the rtVAX 300 processor status. Two 7-segment LED displays and a status register can be implemented on the user's application module to use as a processor status display. When the rtVAX 300 firmware is performing its self-test, it writes to that register to show the progress of the self-test. This register is at physical address 201FFFFE and is implemented as shown in Figure 6–9. The implementation of this register is optional; if it is deleted, the rtVAX 300 continues to perform its self-tests correctly.

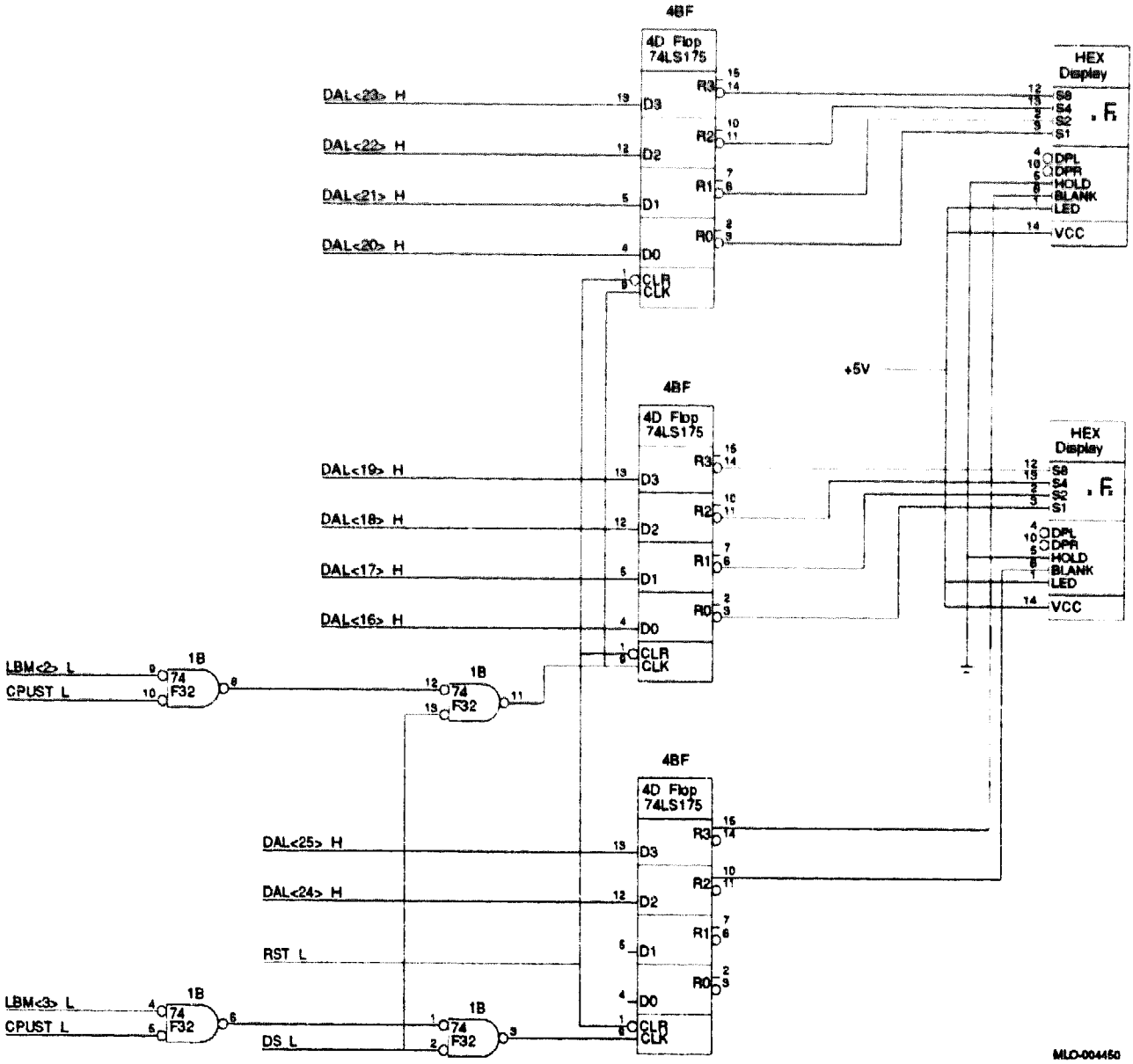
6.4 Console Interface and Boot ROM Illustrations and Programmable Array Logic

This section shows console interface and boot ROM illustrations and describes the programmable array logic (PALs) used.

- Figure 6–10 shows the memory map for all the RAM and ROM registers; Table 6–3 lists the corresponding equations.
- Figure 6–11 illustrates a sample design of a console interface.
- Figure 6–12 and Figure 6–13 illustrate sample designs of user boot ROM banks 1 and 2, respectively.

[1] The ROMs used in the example were specified at 60 ns from CS deassertion to HI–Z.

Figure 6–9 Sample Design: Processor Status Display



6.4.1 Application Module Address Decoder PAL

The application module address decoder PAL selects the memory and I/O devices. It asserts the UPCPUST, SELROM, and CONE signals for the system console and the external boot ROM. The ROM and console select lines are internally latched on the rising edge of AS H. This eliminates the need for external device select latches by using the D flip-flops that are built into the 22V10 PAL. Table 6–4 lists pin settings.

Figure 6–10 Application Module Address Decoder Memory Map

Device	Memory Locations Selected	DAL<29:2> 29 24	23 16	15 08	07 02
CONE	20100000 - 2010003F	100000	00010000	00000000	00XXXX
ROM	20200000 - 202FFFFF	100000	0010XXXX	XXXXXXXX	XXXXXX
CPUST	201FFFFE - 201FFFFF	100000	00011111	11111111	111111

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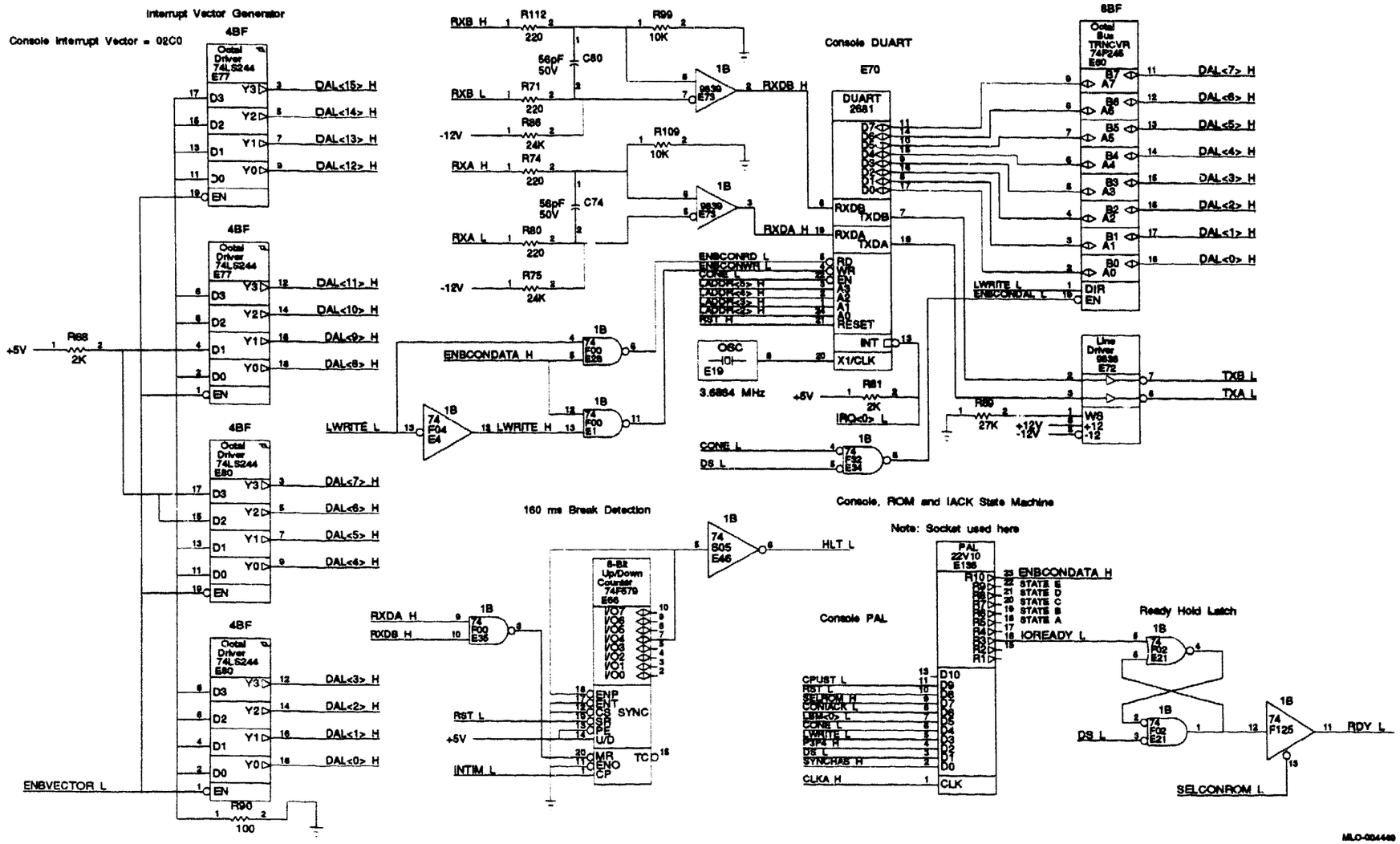
Table 6–3 Decoder Equations

Line	Equals
UPCONE.D	DAL29 & !DAL28 & !DAL27 & !DAL26 & !DAL25 & !DAL24 & !DAL23 & !DAL22 & !DAL21 & DAL20 & !DAL19 & !DAL18 & !DAL17 & !DAL16 & !DAL15 & !DAL14 & !DAL13
UPCONE.AR	CYCRES
SELROM.D	DAL29 & !DAL28 & !DAL27 & !DAL26 & !DAL25 & !DAL24 & !DAL23 & !DAL22 & DAL21 & !DAL20
SELROM.AR	CYCRES
UPCPUST.D	DAL29 & !DAL28 & !DAL27 & !DAL26 & !DAL25 & !DAL24 & !DAL23 & !DAL22 & !DAL21 & DAL20 & DAL19 & DAL18 & DAL17 & DAL16 & DAL15 & DAL14 & DAL13
UPCPUST.AR	CYCRES
CYCRES	AS & (UPCPUST # SELROM # UPCONE)

Table 6–4 Application Module Address Decoder

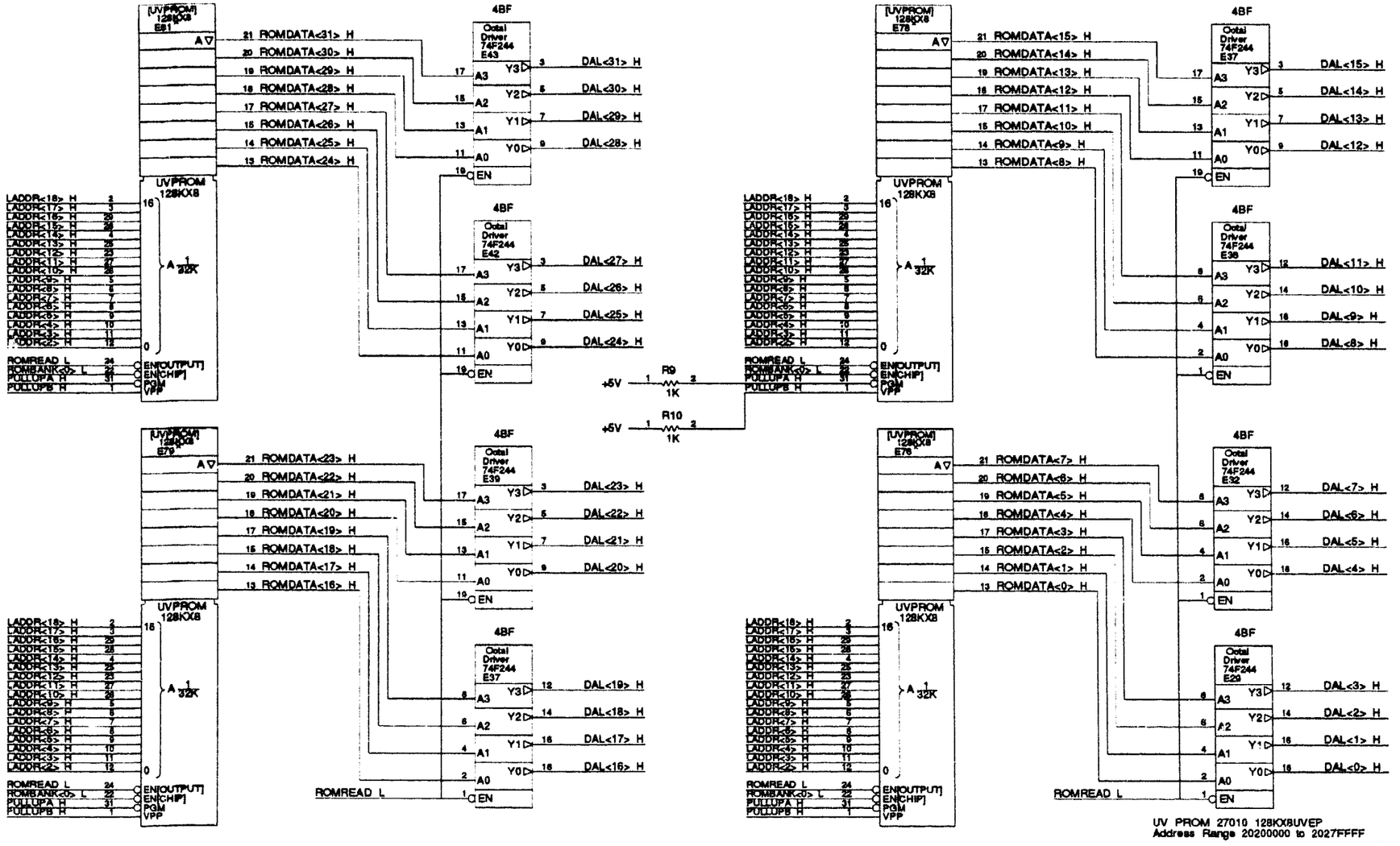
Pin	Setting
Input Signals	
1	AS
2	DAL13
3	DAL14
4	DAL15
5	DAL16
6	DAL17
7	DAL18
8	DAL19
9	DAL20
10	DAL21
11	DAL22
13	DAL23
14	DAL24
15	DAL25
16	DAL26
17	DAL27
18	DAL28
19	DAL29
Output Signals	
23	!UPCONE
22	!UPCPUST
21	SELROM
20	CYCRES

Figure 6–11 Sample Design: Console Interface



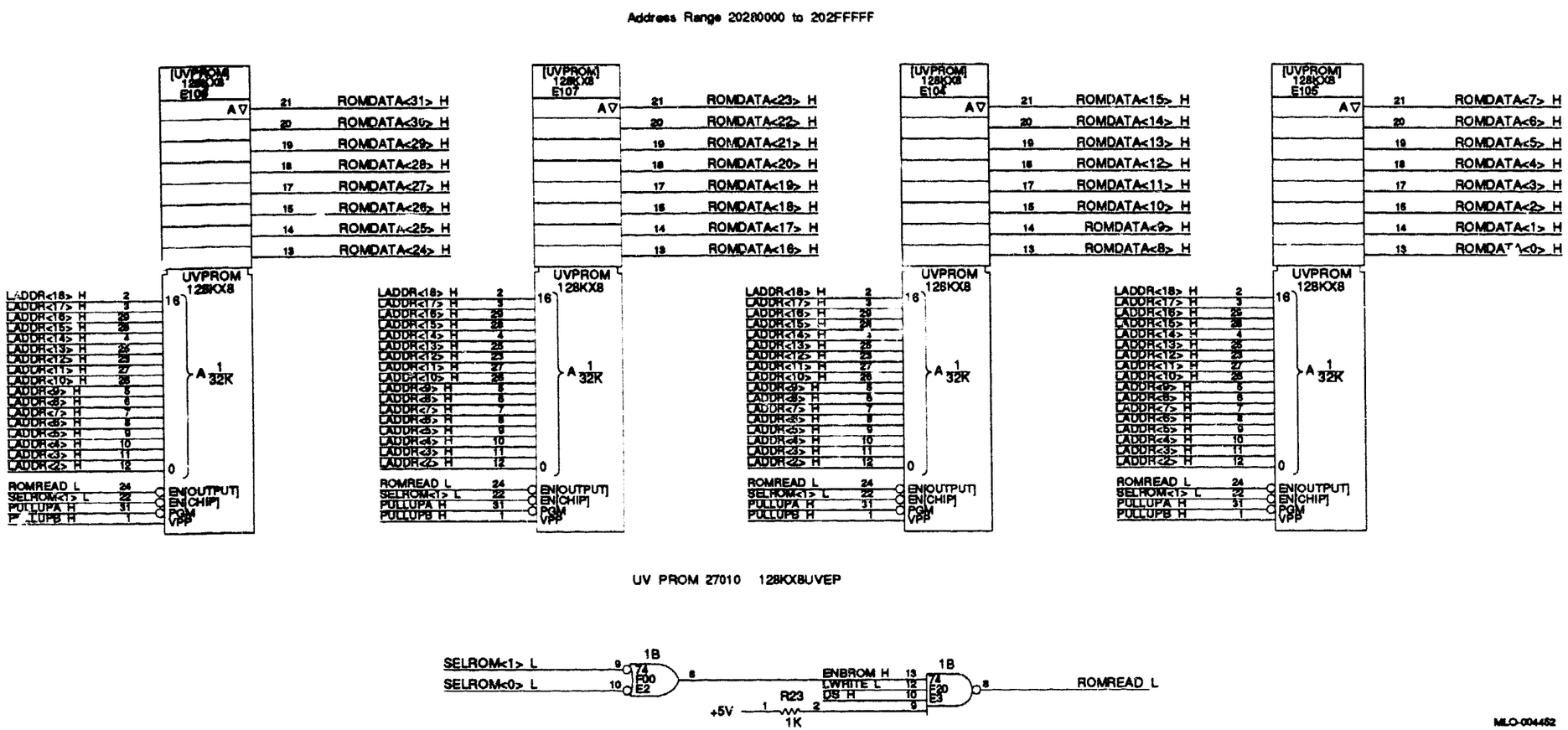
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Figure 6–12 Sample Design: User Boot ROM Bank 1 with Drivers



PAGE 6-26 INTENTIONALLY LEFT BLANK

Figure 6–13 Sample Design: User Boot ROM Bank 2



UV PROM 27010 128KX8UVEP

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Table 6–5 (Cont.) Console Sequencer State Machine PAL

Pin	Signal	Comment
Output Signals		
16	!IOREADY	This output asserts the rtVAX 300 READY line to signal that valid data is on the DAL lines and the cycle should end.
18	STATEA	This output correlates to a state bit for this machine.
19	STATEB	This output correlates to a state bit for this machine.
20	STATEC	This output correlates to a state bit for this machine.
21	STATED	This output correlates to a state bit for this machine.
22	STATEE	This output correlates to a state bit for this machine.
23	ENBCONDATA	The assertion of this signal enables a DUART read or write cycle.

You define a state name for each bit pattern as follows:

```
FIELD CONSOLE = [STATEE,STATED,STATEC,STATEB,STATEA];

$DEFINE IDLE  'B'00000
$DEFINE WRITECYC1 'B'00001
$DEFINE WRITECYC2 'B'00010
$DEFINE WRITECYC3 'B'00011
$DEFINE WRITECYC4 'B'00100
$DEFINE WRITECYC5 'B'00101
$DEFINE FINISHWRITE 'B'00110
$DEFINE READCYC1 'B'10001
$DEFINE READCYC2 'B'10010
$DEFINE READCYC3 'B'10011
$DEFINE READCYC4 'B'10100
$DEFINE FINISHREAD 'B'10101
$DEFINE FINISHUP1 'B'10110
$DEFINE FINISHUP2 'B'10111
$DEFINE FINISHUP3 'B'11000
$DEFINE IOCYC1  'B'00111
$DEFINE IOCYC2  'B'01000
$DEFINE FINISHIO 'B'01001
$DEFINE ROMCYC1  'B'01010
$DEFINE ROMCYC2  'B'01011
$DEFINE ROMCYC3  'B'01100
$DEFINE ROMCYC4  'B'01101
$DEFINE ROMCYC5  'B'01110
```

```
$DEFINE ROMCYC6  'B'01111
$DEFINE FINISHROM 'B'11001
$DEFINE ILLEGAL1 'B'11010
$DEFINE ILLEGAL2 'B'11011
$DEFINE ILLEGAL3 'B'11100
$DEFINE ILLEGAL4 'B'11101
$DEFINE ILLEGAL5 'B'11110
$DEFINE ILLEGAL6 'B'11111
$DEFINE ILLEGAL7 'B'10000
```

You set access and cycle information as follows:

```
WRITEACCESS  = LWRITE & LBM0 & CONE & SYNCHAS;
READACCESS   = !LWRITE & LBM0 & CONE & SYNCHAS;
ROMACCESS    = LWRITE & ENBROM & SYNCHAS;
IACKCYCLE    = (CONIACK # CPUST) & SYNCHAS;
```

You force the idle state during power-up and reset assertion, as follows:

```
ENBCONDATA.AR = RST;
ENBCONDATA.SP = 'B'0;
IOREADY.AR = RST;
IOREADY.SP = 'B'0;
STATEA.AR = RST;
STATEA.SP = 'B'0;
STATEB.AR = RST;
STATEB.SP = 'B'0;
STATEC.AR = RST;
STATEC.SP = 'B'0;
STATED.AR = RST;
STATED.SP = 'B'0;
STATEE.AR = RST;
STATEE.SP = 'B'0;
```

The state machine listing is as follows:

```
SEQUENCE CONSOLE {
 PRESENT IDLE
  IF WRITEACCESS NEXT WRITECYC1 OUT ENBCONDATA;
  IF READACCESS NEXT READCYC1 OUT ENBCONDATA;
  IF IACKCYCLE NEXT IOCYC1;
  IF ROMACCESS NEXT ROMCYC1;
  DEFAULT NEXT IDLE;
 PRESENT WRITECYC1
  NEXT WRITECYC2 OUT ENBCONDATA;
 PRESENT WRITECYC2
  NEXT WRITECYC3 OUT ENBCONDATA;
 PRESENT WRITECYC3
  NEXT WRITECYC4 OUT ENBCONDATA;
```

```
PRESENT WRITECYC4
 NEXT WRITECYC5 OUT ENBCONDATA;
PRESENT WRITECYC5
 IF !P4 NEXT FINISHWRITE OUT ENBCONDATA
    OUT IOREADY;
 DEFAULT NEXT WRITECYC5 OUT ENBCONDATA;
PRESENT FINISHWRITE
 NEXT FINISHUP1;
PRESENT READCYC1
 NEXT READCYC2 OUT ENBCONDATA;
PRESENT READCYC2
 NEXT READCYC3 OUT ENBCONDATA;
PRESENT READCYC3
 NEXT READCYC4 OUT ENBCONDATA;
PRESENT READCYC4
 IF !P4 NEXT FINISHREAD OUT ENBCONDATA
         OUT IOREADY;
 DEFAULT NEXT READCYC4 OUT ENBCONDATA;
PRESENT FINISHREAD
 NEXT FINISHUP1;
PRESENT FINISHUP1
 NEXT FINISHUP2;
PRESENT FINISHUP2
 NEXT FINISHUP3;
PRESENT FINISHUP3
 NEXT IDLE;
PRESENT IOCYC1
 NEXT IOCYC2;
PRESENT IOCYC2
 IF !P4 NEXT FINISHIO OUT IOREADY;
 DEFAULT NEXT IOCYC2;
PRESENT FINISHIO
 NEXT IDLE;
PRESENT ROMCYC1
 NEXT ROMCYC2;
PRESENT ROMCYC2
 NEXT ROMCYC3;
PRESENT ROMCYC3
 NEXT ROMCYC4;
PRESENT ROMCYC4
 NEXT ROMCYC5;
PRESENT ROMCYC5
 NEXT ROMCYC6;
PRESENT ROMCYC6
 IF !P4 NEXT FINISHROM OUT IOREADY;
 DEFAULT NEXT ROMCYC6;
PRESENT FINISHROM
 NEXT IDLE;
PRESENT ILLEGAL1
 NEXT IDLE;
PRESENT ILLEGAL2
 NEXT IDLE;
```

```
PRESENT ILLEGAL3
 NEXT IDLE;
PRESENT ILLEGAL4
 NEXT IDLE;
PRESENT ILLEGAL5
 NEXT IDLE;
PRESENT ILLEGAL6
 NEXT IDLE;
PRESENT ILLEGAL7
 NEXT IDLE;
 }
```

6.4.3 Interrupt Decoder PAL

The interrupt decoder PAL decodes the CSDP<2:0> L, CSDP<4> L, and DAL<06:02> H lines to determine when the rtVAX 300 is running an interrupt acknowledge cycle. The CONIACK signal is asserted when the rtVAX 300 is running a console interrupt acknowledge cycle for a console interrupt (IPL 14_{16}). The console is connected to the rtVAX 300 IRQ<0> L line. DAL<12:06> H lines are decoded to produce the LOWCONE signal to enable the console. The CONIACK and LOWCONE outputs are internally latched by the rising edge of AS. This is accomplished by using the internal D flops to store the output information. The ENBVECTOR output asserts to drive the interrupt vector onto the DAL bus during an interrupt acknowledge cycle.

Table 6–6 lists the pins, signals, and comments; Table 6–7 lists the corresponding equations.

Table 6–6 Interrupt Decoder

Pin	Signal	Comment
Input Signals		
1	AS	This is the active high (inverted) rtVAX 300 address strobe signal, AS L. It is used to clock the internal latches on the rising edge while WR L, DAL, and CSDP L information is valid.
2	!DS	This data strobe line, DS L, of the rtVAX 300 is asserted when the processor is expecting to receive the interrupt acknowledge vector from the DALs.
3	!WR	WR L signal from the rtVAX 300 is high during an interrupt acknowledge cycle.
4	CSDP0	The cycle status bit 0 is asserted during an rtVAX 300 external interrupt acknowledge cycle.

(continued on next page)

Table 6–6 (Cont.) Interrupt Decoder

Pin	Signal	Comment
Input Signals		
5	CSDP1	The cycle status bit 1 is asserted during an rtVAX 300 external interrupt acknowledge cycle.
6	CSDP2	The cycle status bit 0 is deasserted during an rtVAX 300 external interrupt acknowledge cycle.
7	CSDP4	The cycle status bit 4 is deasserted during an rtVAX 300 external interrupt acknowledge cycle.
8	DAL2	DAL line 2 from the rtVAX 300 contains information about the IPL of the rtVAX 300. By decoding the DAL and CSDP lines, this PAL can determine when the rtVAX 300 is running a console interrupt acknowledge cycle.
9	DAL3	DAL line 3 from the rtVAX 300 contains information about the IPL of the rtVAX 300. By decoding the DAL and CSDP lines, this PAL can determine when the rtVAX 300 is running a console interrupt acknowledge cycle.
10	DAL4	DAL line 4 contains information about the IPL of the rtVAX 300. By decoding the DAL and CSDP lines, this PAL determines when the rtVAX 300 is running a console interrupt acknowledge cycle.
11	DAL5	DAL line 5 contains information about the IPL of the rtVAX 300. By decoding the DAL and CSDP lines, this PAL can determine when the rtVAX 300 is running a console interrupt acknowledge cycle.
13	DAL6	DAL line 6 contains information about the IPL of the rtVAX 300. By decoding the DAL and CSDP lines, this PAL determines when the rtVAX 300 is running a console interrupt acknowledge cycle.
14	DAL7	DAL line 7 is used as one of the console address decoder inputs.
15	DAL8	DAL line 8 is used as one of the console address decoder inputs.
16	DAL9	DAL line 9 is used as one of the console address decoder inputs.
17	DAL10	DAL line 10 is used as one of the console address decoder inputs.
18	DAL11	DAL line 11 is used as one of the console address decoder inputs.
19	DAL12	DAL line 12 is used as one of the console address decoder inputs.

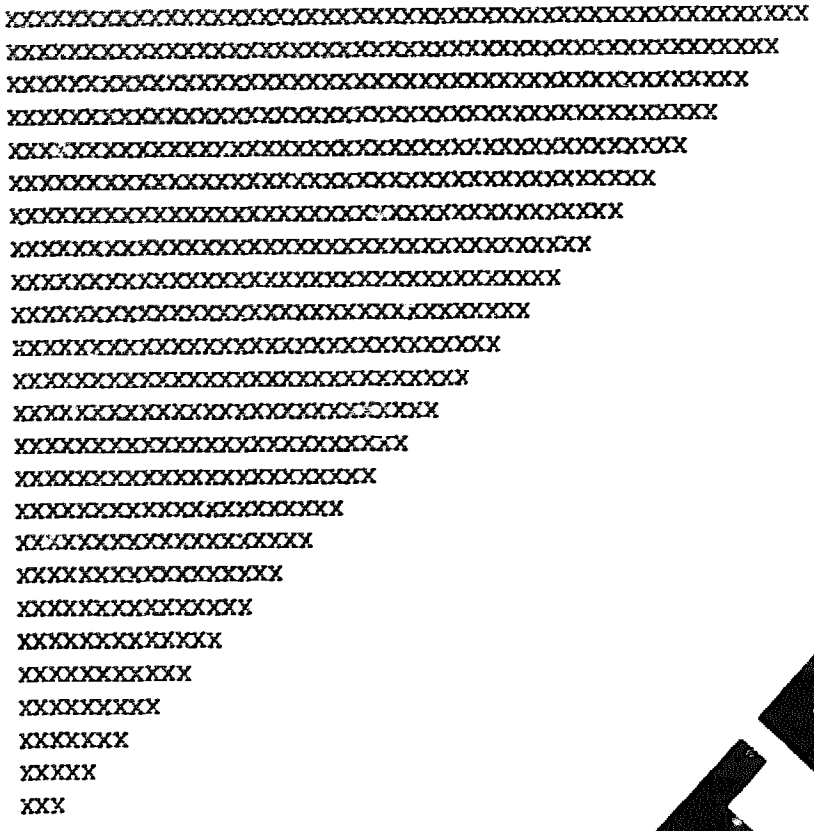
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Table 6–6 (Cont.) Interrupt Decoder

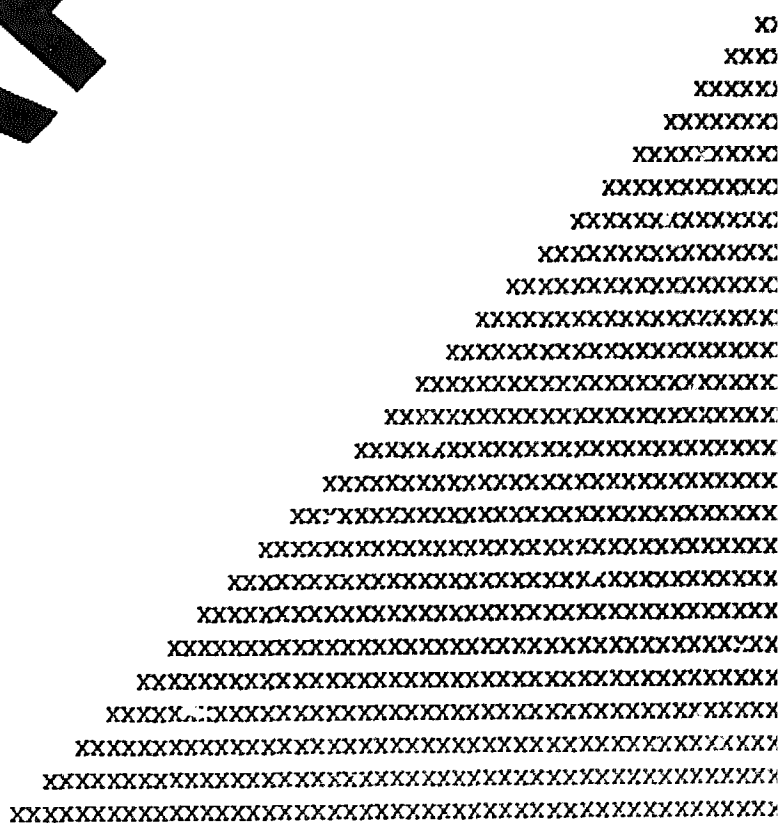
Pin	Signal	Comment
Output Signals		
23	!LOWCONE	This signal and the UPCONE of the address decoder select the console.
22	!LOWCPUST	This signal selects the processor status LED register and the UPCPUST of the address decoder.
21	!CONIACK	This signal is asserted when the rtVAX 300 is running an interrupt cycle for the console.
20	!CYCRES	This signal resets all the select outputs asynchronously once AS deasserts.

Table 6–7 Interrupt Decoder PAL Equations

Line	Equals
CONIACK.D	!WR & CSDP4 & !CSDP2 & CSDP1 & CSDP0 & DAL6 & !DAL5 & DAL4 & !DAL3 & !DAL2
CONIACK.AR	CYCRES
LOWCONE.D	!DAL12 & !DAL11 & !DAL10 & !DAL9 & !DAL8 & !DAL7 & !DAL6
LOWCONE.AR	CYCRES
LOWCPUST.D	DAL12 & DAL11 & DAL10 & DAL9 & DAL8 & DAL7 & DAL6 & DAL5 & DAL4 & DAL3 & DAL2
LOWCPUST.AR	CYCRES
CYCRES	!AS & (CONIACK # LOWCONE # LOWCPUST)



CHAPTER 7



7

Network Interconnect Interface

The rtVAX 300 processor connects easily to Digital's Ethernet network. The VAXELN kernel can include DECnet communication through the built-in Ethernet interface.

This chapter discusses the following topics:

- DECnet communications (Section 7.1)
- Ethernet interface (Section 7.2)
- Thickwire network interconnect (Section 7.3)
- ThinWire support (Section 7.4)
- Ethernet coprocessor registers (Section 7.5)
- Hardware implementation example (Section 7.6)

7.1 DECnet Communications

The rtVAX 300 processor allows the transfer of information and programs among Digital's systems, and among Digital's and other manufacturer's systems. Network communications between Digital's systems is facilitated by DECnet hardware and software.

VAXELN programs developed on a host VAX processor can be loaded into the target rtVAX 300 based application through the network. The rtVAX 300 communicates with other VAX processors through the Ethernet local area network. Systems and devices can easily be connected to the network; network expansion is possible without interrupting network operations. Programs and data can be transferred between realtime applications and VAX processors in the network.

Ethernet provides the following features:

- Simplified network design allows installation of new devices without interrupting communication.
- Cable segments can be added to expand networks.
- Remote locations have fast access to data.
- High-speed communication can take place between nodes.

7.2 Ethernet Interface

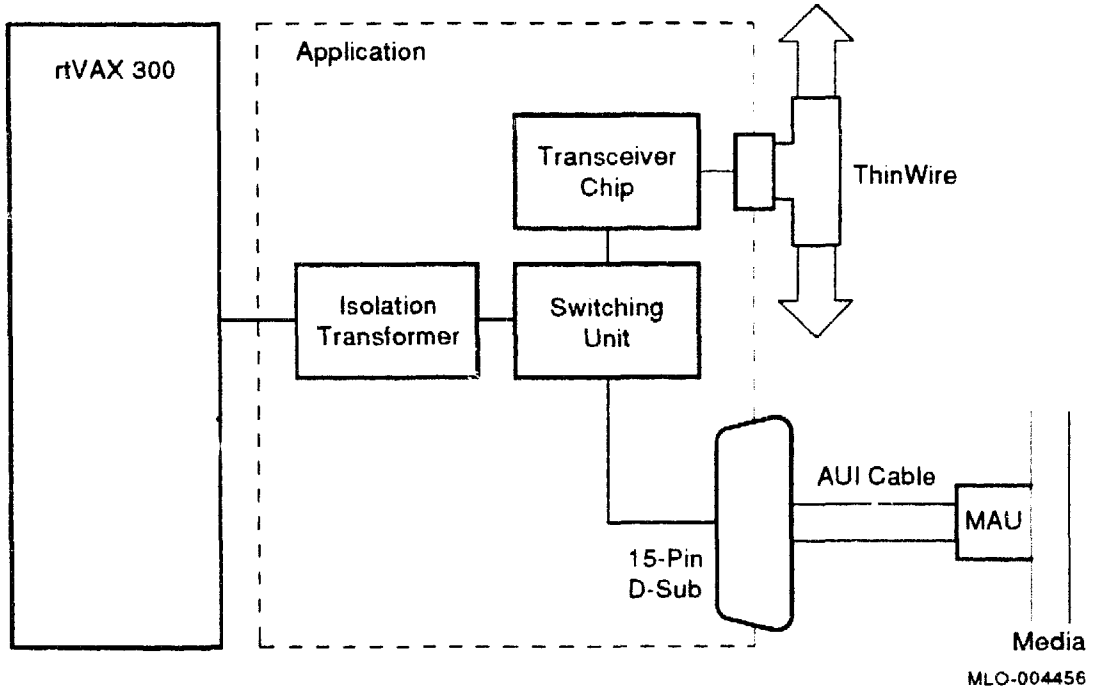
The Ethernet coprocessor and serial-interface adapter (SIA) built into the rtVAX 300 provide the basis of an interface to an Ethernet network. The coprocessor has these features:

- It supports virtual DMA and buffer management.
- It contains one 120-byte FIFO queue for data reception, and another for data transmission, with loopback capability.
- It complies with IEEE Standard 802.3.
- It provides collision handling, transmission deferral and retransmission, and automatic jam and backoff.
- It has a continuous packet rate of up to 14,000 frames per second.

The Ethernet interface can perform DMA transfers directly to the 256M bytes of system RAM. The coprocessor is programmed by reading from and writing to a set of registers on the rtVAX 300. Figure 7–1 shows a block diagram of an interface which supports AUI connection to thickwire and ThinWire or direct connection to ThinWire.

Proper operation of an Ethernet/IEEE 802.3 interface requires precise and specific physical design of the power and ground arrangements. Briefly, components connected to the trunk network cable must be dc and low frequency-isolated from system ground. This isolation is provided by the isolation transformer and dc-to-dc converter. Figure 7–3 illustrates this isolation.

Figure 7–1 Network Interconnect: Controller Block Diagram



7.3 Thickwire Network Interconnect

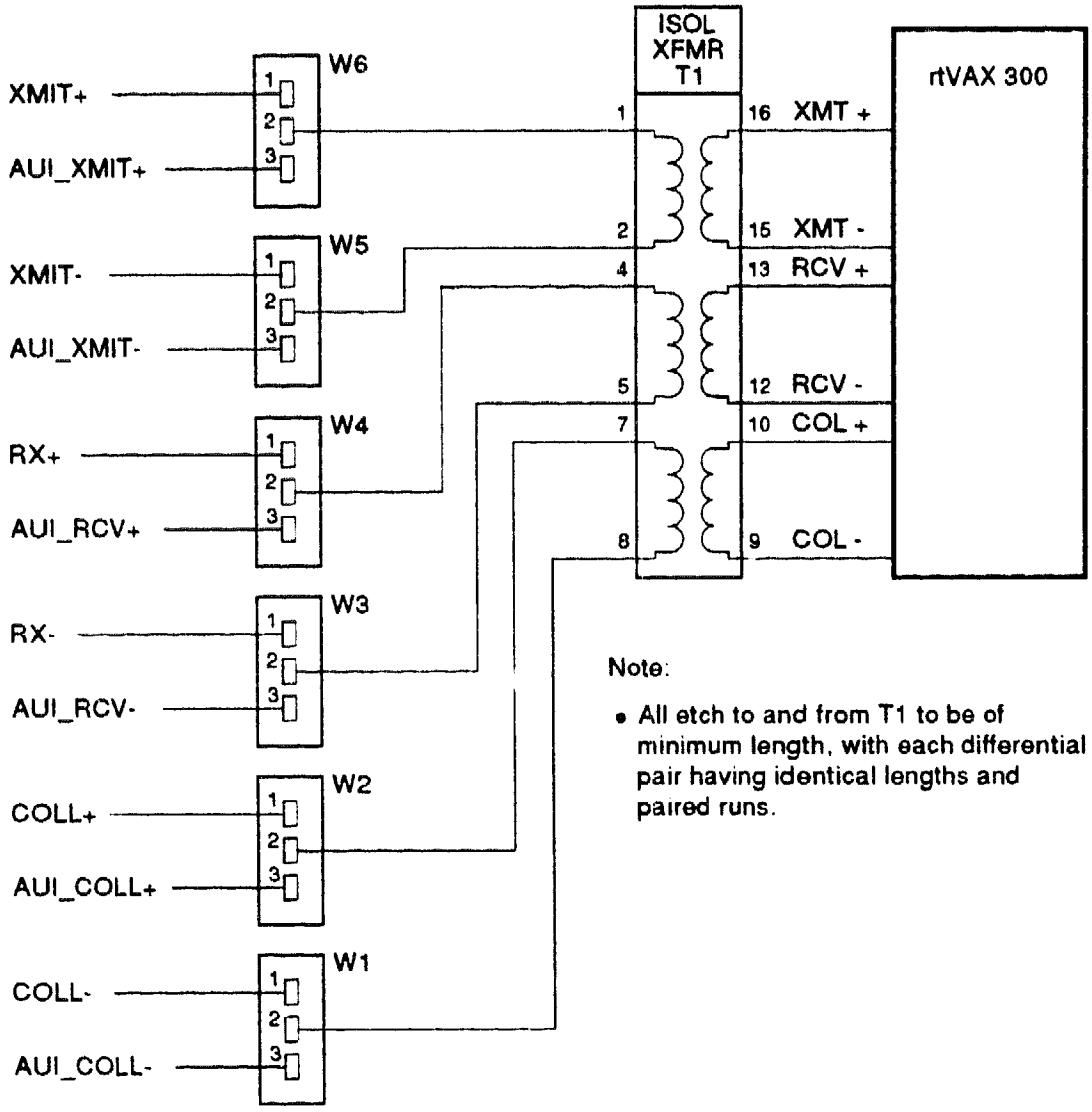
Thickwire Ethernet interconnect requires addition of an external isolation transformer and a 15-pin D-sub connector to the rtVAX 300. Figure 7–2 shows the wiring requirements for the collision detect, receive, and transmit signals for this connector. (Figure 7–2 shows a jumper array, to allow alternate support of a ThinWire interconnect. Figure 7–5 shows the AUI connector and pinning.)

7.4 ThinWire Support

The rtVAX 300 connects to a ThinWire Ethernet network through the DP8392 transceiver and a few other components. An isolated –9V power source is needed to support the ThinWire connection.

The user's application can incorporate the design shown in Figure 7–5, which allows selection of either the thickwire or the ThinWire configurations.

Figure 7–2 Network Interconnect: Isolation Transformer and Jumpers



7.5 Ethernet Coprocessor Registers

The rtVAX 300 Ethernet coprocessor is programmed by reading from and writing to a set of 16 registers at locations 20008000 through 2000803F. Refer to Section 3.6.1 and Table 3–17 for a full description.

The Network ID ROM provides a unique physical network address for the rtVAX 300, readable at locations 20008040 through 200080BF. This address is predetermined by Digital and cannot be changed. This network address is marked on the rtVAX 300 body.

7.6 Hardware Implementation Example

A dual-purpose ThinWire/Attachment Unit Interface (AUI) design was chosen as the sample design, because many designs now incorporate IEEE 802.3 network interfaces through either ThinWire or AUI. The terms *ThinWire* and *AUI* should be understood.

Many aspects of these two interfaces are similar; however, detailed implementation of the two differs significantly. The main difference lies in the connection of the network controller to the media: ThinWire adapters are designed specifically to attach directly to the ThinWire (RG58-like) cable, that is, they employ an internal MAU.

In contrast, AUI interconnects *never* attach directly to the media. Instead, they employ an IEEE 802.3 standard interface to a Media Attachment Unit (MAU), which *will* attach to the media. Figure 7–1 shows a block diagram of the sample design. The broken lines indicate the design's functional boundaries.

7.6.1 Overview of Ethernet Interface

Figure 7–3 shows an Ethernet interface block diagram. This interface supports both direct ThinWire and AUI interfaces.

7.6.1.1 Ethernet Interface Functions

At the heart of all Ethernet interconnect systems are three basic components:

- The MAU
- The Manchester data encoder-decoder, sometimes called an *EnDec*)
- The local area network controller

The MAU is incorporated in the user module if direct media attachment to ThinWire is required; the other two components are implemented within the rtVAX 300.

The MAU allows access to the medium and handles certain critical timing and amplitude level conversions. The DP8392 CTI chip performs the MAU functions for the ThinWire medium.

Figure 7–3 Network Interconnect: Ethernet Interface Block Diagram

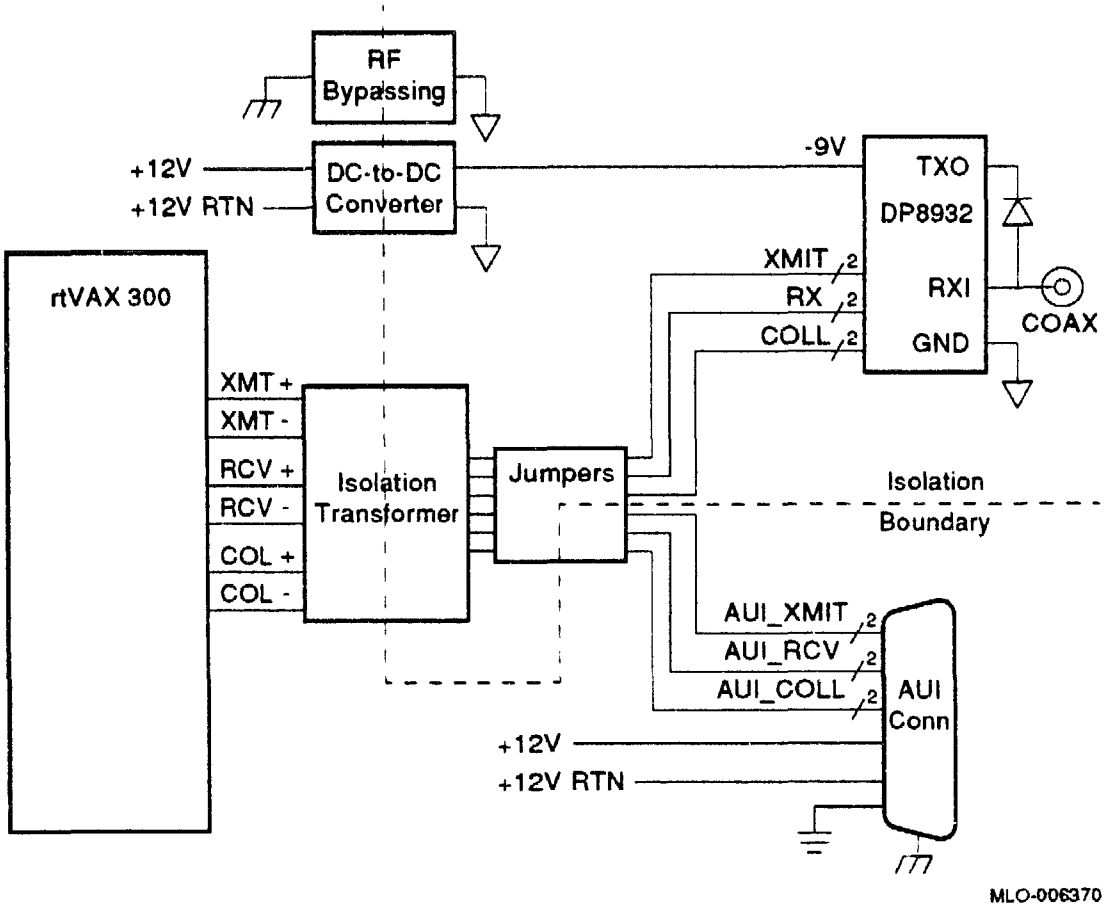


Table 7–1 MAU Signals Description

Signal	Description
Inputs from MAU Interface	
Collision+, Collision–	These are signals of ± 1V on a 78 Ω differential pair.
Receive+, Receive–	These are signals of ± 1V on a 78 Ω differential pair.
Outputs to MAU Interface	
Transmit+, Transmit–	Differential Manchester-encoded, drive 78 Ω differential. No pulldown resistors.

7.6.1.2 DP8392 Transceiver Chip

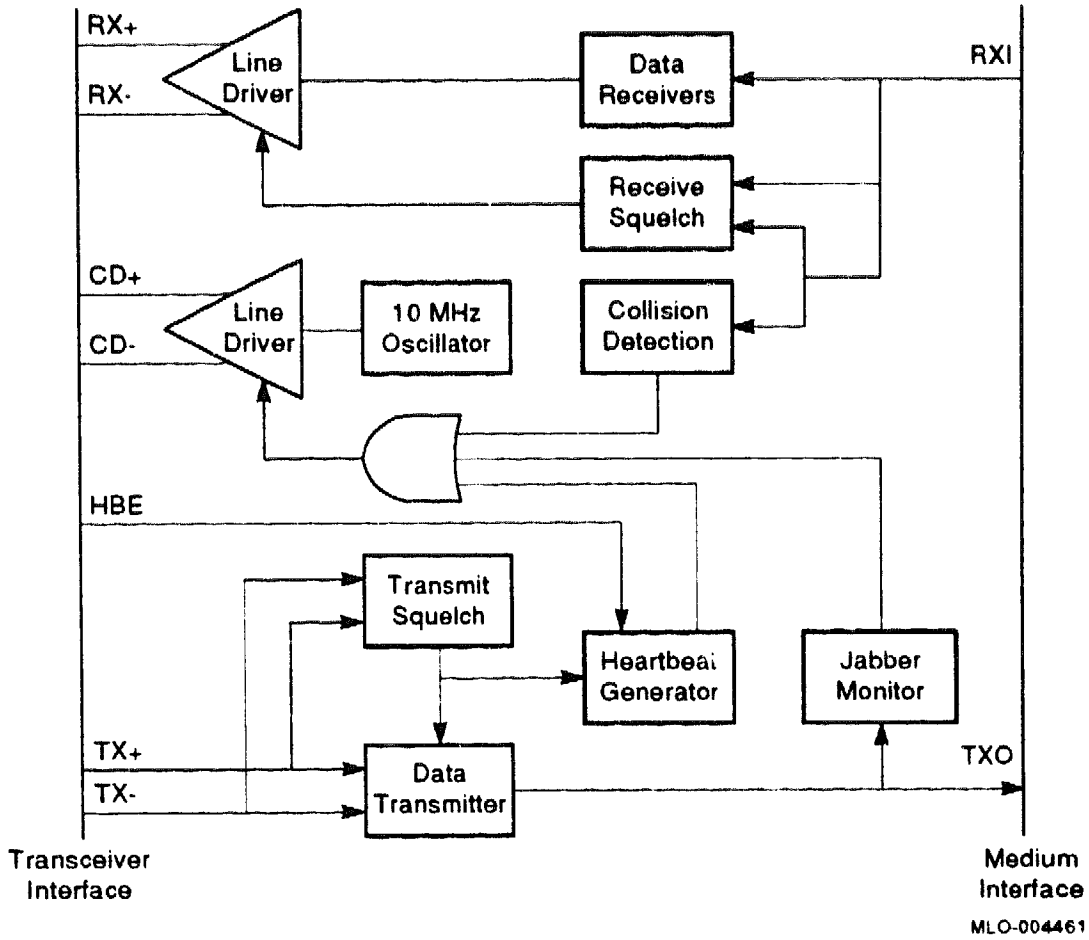
This section describes the transceiver chip and its interface functions. Figure 7–2 shows the rtVAX 300 isolation transformer and jumpers.

The major transceiver functions are as follows:

- **Transmit**—The DP8392 chip takes a differential input (output of the rtVAX 300) and drives a single-ended ac signal onto the ThinWire Ethernet coaxial cable.
- **Receive**—A signal is received from the coaxial cable, corrected for frequency distortion, and driven to the rtVAX 300 on the receive differential pair. The receiver has high input impedance, and low input capacitance, to minimize reflections and loading of the ThinWire coaxial cable. The receiver squelch prevents noise on the coaxial cable from triggering the receiver. At the end of reception, the squelch also serves to prevent dribble bits.
- **Collision Detect**—A low-pass filter extracts the average dc level on the coaxial cable and compares it to the collision threshold. The collision threshold is met if more than one transmitter is simultaneously active on the coaxial cable. The DP8392 chip signals the collision to the rtVAX 300 by a 10 MHz signal on the collision differential pair.
- **Heartbeat Generator**—After each transmission, the DP8392 chip sends a 10 MHz signal to the rtVAX 300 on the collision differential pair. This tests the collision detection circuitry. The heartbeat (also called the SQE test) may be disabled with the HE pin.
- **Jabber Monitor**—The DP8392 chip monitors each transmission with a watchdog timer. If the transmitter is active for an illegal length of time, the transmitter is disabled. Thus, jabbering (broken) nodes are not allowed to interfere with the operation of the network.

Figure 7–4 shows an DP8392 chip block diagram. On the coaxial cable side, the DP8392 chip connects to the 50 Ω Ethernet coaxial cable by a BNC connector. On the rtVAX 300 side, the DP8392 chip differential signals connect to the rtVAX 300 differential signals through isolation transformers.

Figure 7–4 Network Interconnect: DP8392 Chip Block Diagram



7.6.2 Implementation of Design

The following sections discuss implementation considerations:

- Section 7.6.2.1 discusses the transceiver.
- Section 7.6.2.2 discusses layout requirements.
- Section 7.6.2.3 lists Ethernet board parts.
- Section 7.6.2.4 discusses the dc-to-dc converter.

7.6.2.1 ThinWire Transceiver

Figure 7–5 shows the ThinWire interface (BNC connector) and the AUI connector (15-pin D-sub). Included in this figure are the BNC connector for direct ThinWire connection and the required capacitive bypassing between reference planes. The DP8392 transceiver chip must be connected directly to the coaxial BNC connector by an etch run of less than 4 cm.

The 15-pin D-sub connector is the AUI interface to an external MAU, if one is employed. Note that either the direct ThinWire connect or the external MAU can be employed, never both. W8 is the Heartbeat enable jumper for the DP8392 chip; W9 is the Ethernet/IEEE 802.3 isolation jumper. W9 should be installed for standard product shipment.

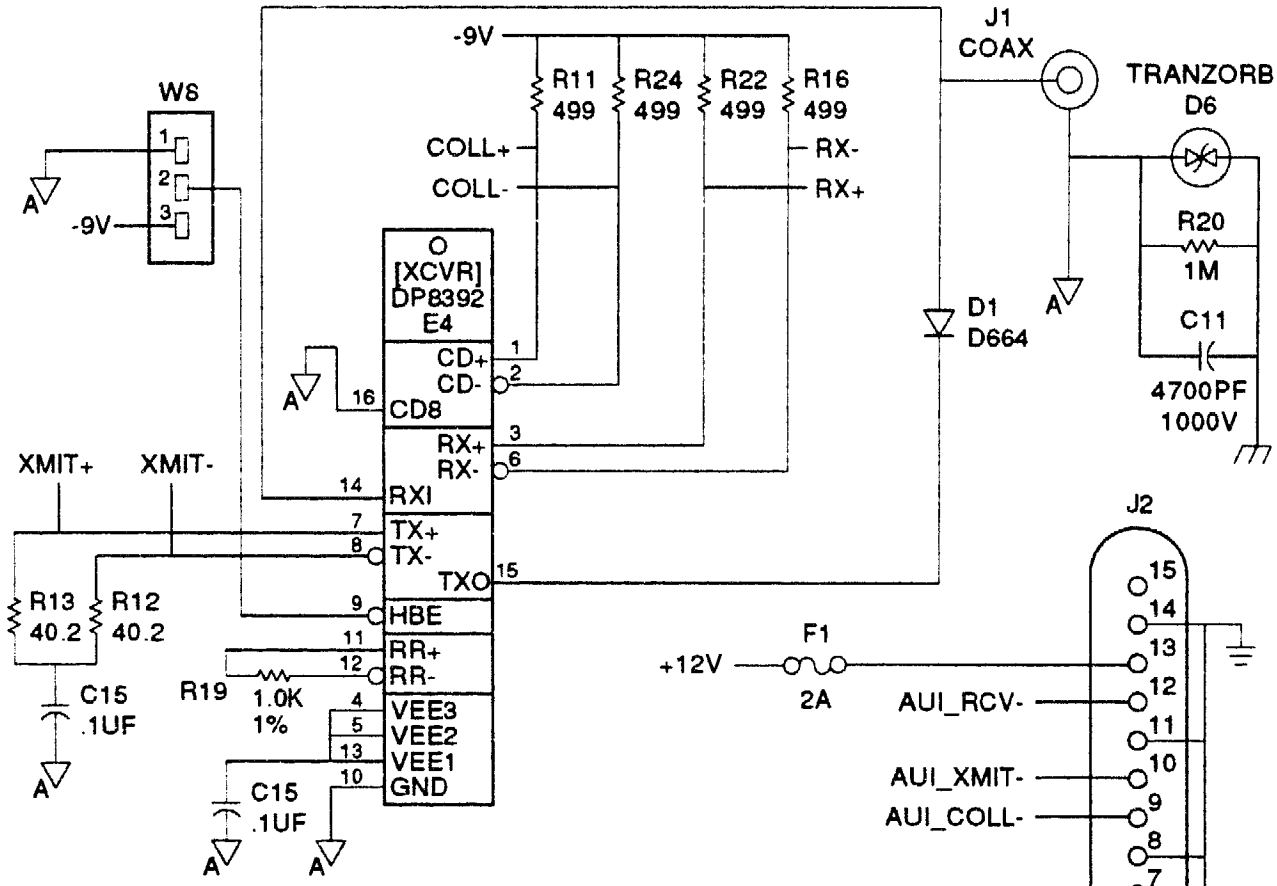
Note

The isolation transformer is not shown in Figure 7–5.

7.6.2.2 Layout Requirements

- The shell of the AUI connector must be attached to the chassis ground.
- Etch running from pin 6 of the AUI connector to the 12V return, and from pin 13 of the AUI connector to the 12V source, must be capable of maintaining a steady-state current of 5 A.
- It is recommended that the 12V return line (pin 6) be taken from the AUI connector and returned to the power supply directly. The return for the 12V supply should not be connected through logic ground due to possible noise problems caused by ground loops.
- Pins 4, 5, and 13 of the DP8392 chip require thermal relief. This can be accomplished by connecting these pins to the –9V plane by an etch pad with a surface area greater than 6.45 cm^2 (1 $inch^2$).
- Placement of the BNC connector is critical. In order to reduce stray capacitance, place the BNC connector as close as possible to the DP8392 chip, no farther than 4 cm etch length away, and void all planes beneath the connecting etch.

Figure 7–5 Network Interconnect: Transceiver, BNC Connector, and AUI Connector



Notes:

- The shell of the D-Sub connector J2 to be attached to chassis ground.
- The etch for ground B and +12V to J2 must be capable of handling a current of 5A.
- Ground B to be connected to logic ground at the power supply only.
- Pins 4, 5, and 13 of E4 to be connected to the VEE plane with a surface area >1 sq in for heat dissipation purposes.
- Place E4 within 2 cm of J1. Void all planes as near to J1 as possible.
- A indicates the -9V return.
- B indicates the 12V return.

MLO-006393

7.6.2.3 Typical Ethernet Board Parts List

Table 7–2 shows a list of parts used in this design example.

Table 7–2 Ethernet Board Parts List

Generic Name	Discrete Value	Total in Design
RES	40.2	2
CAP	.1 μF	1
RES	100	1
JUMPER		8
ENETXFMR	75 μH	1
DP8392	COAXXCVR	1
BIZENER	400V	1
FUSE	2A	1
CONN15	15 P D-SUB	1
JUMPER		1
CAP	4700 pF	1
RES	1K 1%	1
RES	1M	1
RES	499	4
DIODE	D664	2
CAP	.01 μF	1
CAP	820 pF	1
CAP	47 μF	1
CAP	150 pF	1
CAP	68 μF	1
ZENER	8.2V 1%	1
TRANSISTOR,NPN	SWITCHING	1
DIODE	UES1302	1
DIODE	1N4004	1
TRANS	POWER XFORM	1
INDUCTOR	2.2 μH	1

(continued on next page)

Table 7–2 (Cont.) Ethernet Board Parts List

Generic Name	Discrete Value	Total In Design
4N38	OPTO ISOLATOR	1
555	TIMER	1
NMOS	NMOS POWER FET	1
RES	1K	1
RES	75	1
RES	39.2	2
RES	14.7K 1%	1
RES	16.5K 1%	1

7.6.2.4 DC/DC Converter

Figure 7–6 shows a discrete dc-to-dc converter that produces the voltage required by the DP8392 chip while maintaining the isolation requirements of Ethernet. Note that some modular dc-to-dc converters perform the same functions as the discrete converter.

7.6.3 Detailed Design Considerations

This section presents detailed information regarding use of the standard Ethernet devices. The data presented here are more detailed than those found in the device specifications and form the basis for the layout requirements presented in Section 7.6.

7.6.3.1 Differential Signals

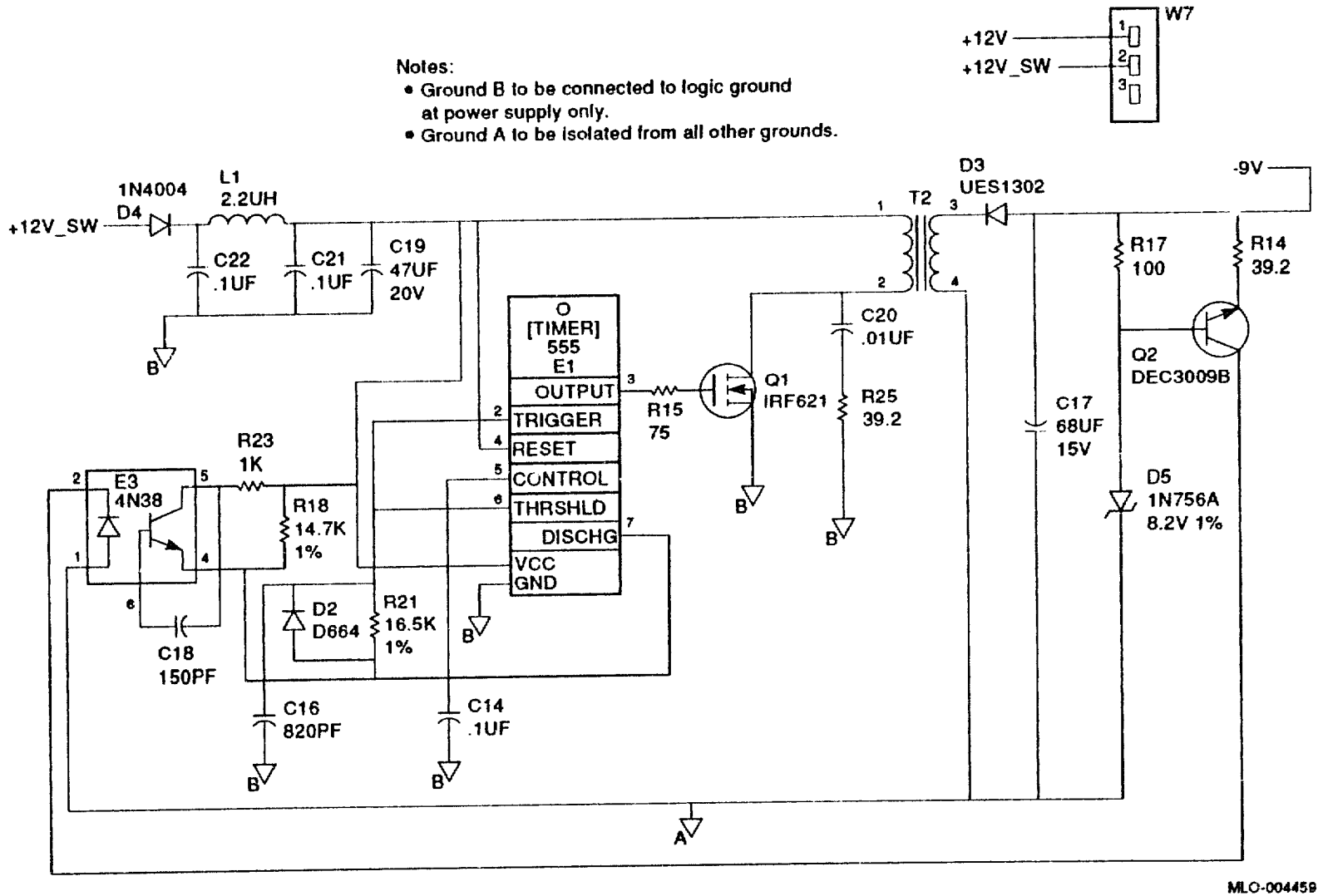
The transmit (XMIT±), receive (RX±), and collision (COL±) signals are differential pairs. Run etch to these pins as parallel pairs, maintaining equal etch length.

7.6.3.2 DP8392 Transceiver

This section discusses:

- External components (Section 7.6.3.2.1)
- Layout considerations (Section 7.6.3.2.2)

Figure 7–6 Network Interconnect: dc-to-dc Converter



7.6.3.2.1 External Components The following paragraphs list and discuss external components.

- **Pull-Down Resistors**—The ThinWire receive and collision balanced differential line drivers from the transceiver chip need four pull-down resistors to VEE. Being external to the chip, they allow setting of the voltage swings required to drive the differential lines and dissipate power outside the chip, which adds to long-term reliability. In addition, they are used with the transformer to control the differential undershoot which occurs when the drivers reset.

  In ThinWire designs with integrated transceivers, the transceiver is directly connected to isolation transformers. In this case, higher value pull-down resistances (up to 1.5K Ω) may be used to save power and still provide the necessary ac voltage swing. The use of resistances greater than 1.5K Ω is not justified by the amount of power saved and results in too low a signal for proper operation of the SIA receiver squelch.

- **Diode**—The requirements for the capacitance added by the transceiver chip to the ThinWire coaxial cable are strict. The transceiver along with the media-dependent interface is allotted 10 pF in a ThinWire network. The DP8392 transceiver chip introduces about 4.5 pF when it is not transmitting. To decrease this capacitance, the "off" state capacitance of a diode is placed in s with the transmitter output (TXO) pin of the chip.

  A general-purpose diode, like the D664 of 25V and 135 mA, provides a maximum 2 pF of capacitance when it is reverse-biased and has a reverse recovery time of a maximum 10 ns. This means that the capacitance introduced by the DP8392 is reduced from 4.5 pF to 1.4 pF (maximum) and that 10 ns are added to the transmitter startup delay (the time required for transmitted data to validly appear on the coaxial medium).

- **Precision Resistor**—The transceiver chip uses a 1K, 1% resistor between pins 11 (RR+) and 12 (RR–) to set ThinWire coaxial drive levels, output rise and fall times, 10 MHz collision oscillator frequency, jabber timing and receiver ac squelch timing. A 1K, 0.25 W, 1% resistor is recommended.

- **Decoupling Capacitor**—A 0.1 to 0.47 μF capacitor is needed between the GND and VEE pins (10 and 4, 5, 13). This decoupling capacitor helps reduce impulse and ripple noise on the transceiver chip power supply below limits of ±75 mV and ±100 mV peak-to-peak, respectively. A ceramic capacitor should be used for its good high-frequency characteristics. A 0.47 μF, 25V capacitor is recommended. If impulse noise and ripple limits are exceeded, packet loss results.

- **Pulse Transformer**—MAUs, either internal or external, need three isolation pulse transformers to isolate the differential signals (COL ±, RX ±, and XMIT ±) of the transceiver chip from the SIA. ThinWire products with integrated transceivers use 75 μH pulse transformers.
- **Power Supply**—The DP8932 transceiver chip operates over a supply voltage range of –8.46V to –9.54V. The chip draws from 50 to 200 mA. The transceiver chip has a power supply noise immunity of 100 mV peak-to-peak.

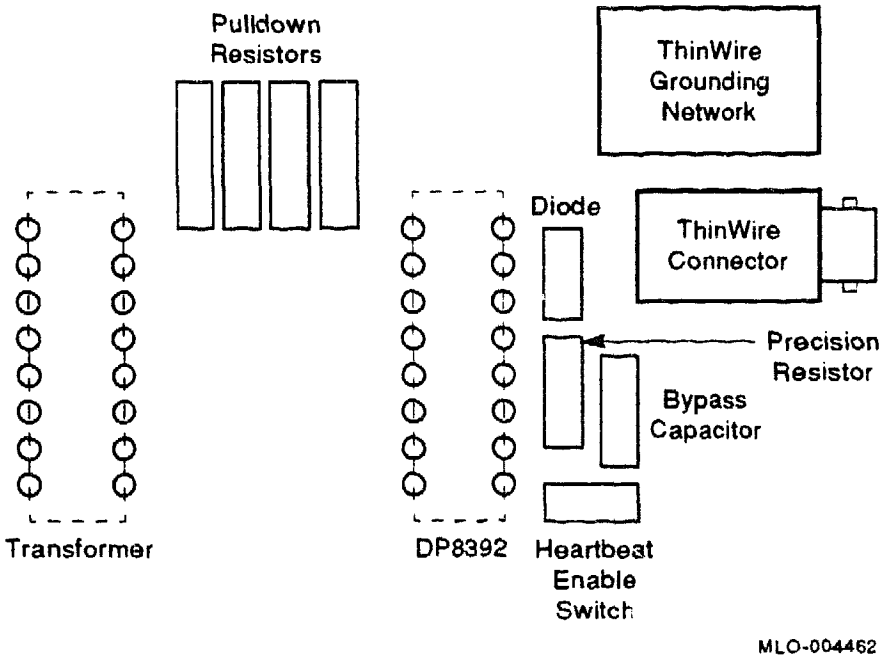
7.6.3.2.2 Layout Considerations

- To minimize the capacitance introduced to the ThinWire coaxial cable by the transceiver chip, follow these guidelines:
  - Mount the transceiver chip as close to the center pin of the BNC connector as possible, no more than 4 cm away.
  - Align the RXI pin, 14, and the anode of the isolation diode with the center pin of the BNC connector.
  - Keep the length of traces from the RXI and TXO pins (14 and 15) to the BNC connector to a minimum, not greater than 4 cm.
  - Keep all metal traces, especially GND and VEE traces and planes, as far as possible from the RXI and TXO traces.
  - In a multilayered PC board, void the area of GND and VEE planes beneath the RXI and TXO lines.
  - Solder the DP8392 chip directly onto the PC board. Do not use a socket; the DP8392 has a special lead frame designed to conduct heat out of the chip.
- Connect VEE pins (4, 5, and 13) to large metal traces or planes. Good heat conduction is required for long-term reliability. A minimum total trace or plane area of 6.45 cm^2 (1 $inch^2$) is recommended to take advantage of the 3.5 W power dissipation rating of the chip package at 25°C. Do not use heat-relieved mounting holes for these pins.
- Connect the collision detect sense (CDS) pin independently to the coaxial shield. The CDS pin is provided for accurate detection of collision levels on the coaxial cable. To avoid altering the collision threshold due to intermediate ground drops from pin 16 to the coaxial shield, attach pin 16 independently to the coaxial shield by a short, heavy conductor. During ESD testing, any potential differences between power ground (pin 10) and the CDS pin (pin 16) can cause some internal functions to latch up.

- Place the decoupling capacitor, connected across GND and VEE, as close to the transceiver chip as possible to minimize the trace inductance.
- Etch runs from the pins of the differential pairs (COL ±, pins 1 and 2; RX ±, pins 3 and 6; and XMIT ±, pins 7 and 8) must be parallel pairs of minimum, equal lengths. The possibility of one side of the differential pair picking up more noise than the other is minimized when the lines are balanced.
- For ThinWire designs maintain a voltage isolation barrier of 500V RMS between input and output circuits

Figure 7–7 shows the typical layout of a ThinWire interface.

Figure 7–7 Network Interconnect: Layout of ThinWire Medium Interface



7.6.3.3 ThinWire Application Hints

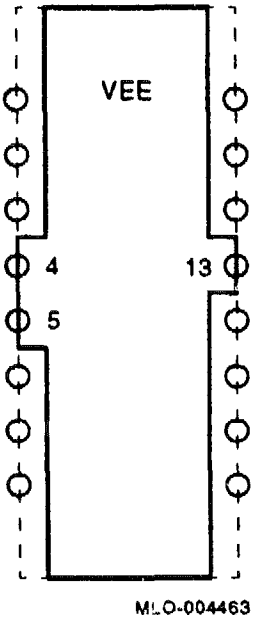
The following application hints may be useful:

- PCB layout considerations

  Figure 7–8 shows a heat spreader, implemented in side one (component side) PCB etch, connected to pins 4, 5, and 13 of the transceiver chip. This heat spreader works in conjunction with the special copper leadframe used in the DP8392 chip to conduct heat out of the VEE pins. Since this large area of side one etch is under the chip, it does not require extra PCB space

to implement. You need not route signals under the chip on side one, if the layout is done as indicated above.

Figure 7–8 Network Interconnect: Heat Spreader



- EMC compliance

  ThinWire Ethernet interfaces can be difficult to certify for FCC Class B; Class A requirements are less difficult. The best approach is to use very low ESR capacitors between the isolated ThinWire cable shield and the system chassis earth ground. The best type of device is a multilayered ceramic-surface mount capacitor. These devices have very low ESR, insignificant lead length, and are available in a 1000 VDC rating that meets the 500 VAC (RMS) isolation requirement of Standards IEEE 802.3 and ECMA 97.

  In general, more than one value may be required, and two to six parts may have to be connected in parallel to achieve a low enough impedance at all frequencies of interest. The total capacitance must not exceed the limit imposed by IEEE 802.3, 0.01 μF. This requires some experimentation and testing at the EMC test sites. The etch used to connect the BNC shield contact and the chassis ground to these capacitors must be very thick and very short for the capacitors to be effective.

The 1M Ω resistor required by the IEEE 802.3 10Base–2 (ThinWire) Standard between isolated ground and chassis earth ground removes static electricity buildup, but does not protect from ESD effects. The best solution for ESD protection is two 400 VDC bidirectional transorbs (similar to back-to-back zener diodes) in series. This retains the required 500 VAC (RMS) isolation, but protects against ESD voltages above 800 VDC. The connection requirements for the transorbs are similar to those for the capacitors, that is, very short and very thick etch.

7.6.3.4 Power

The Ethernet interface requires two supply voltages, +12V and –9V. The following are the specific requirements for each supply.

- **+12V**

  The +12V supply must be between 11.28V and 15.75V. This supply is referenced to AUI voltage return. This +12V is used to supply power to the MAU. The MAU may be the DP8392 chip (and associated circuitry) or may be an external MAU connected to the station by an AUI cable. It is not permissible to supply power to both MAU's simultaneously to prevent transmission on two networks.

  When the MAU is the on-board DP8392 chip, the current drawn from the +12V supply is approximately 220 mA. When power is supplied to an external MAU through the AUI connector, the current draw can be as much as 0.5 A steady state. The voltage that appears at the AUI connector must be at least 11.28V (12V—6%) when the external MAU is drawing the maximum current of 0.5 A. It is therefore important to minimize the dc resistance of the path between the power supply of the station and the AUI connector.

  In addition to the steady-state current requirements, there are considerations for surge current. The +12V supply must be able to handle the surge current drawn by an external MAU, when it is hot-swapped. The connection of an external MAU should not crash the station, or otherwise affect normal operation of the station. The +12V supply (as seen at the AUI connector) is allowed to go out of tolerance during MAU hot-swap. Transceivers draw currents of up to 25 A lasting 500 μs.

  A significant amount of noise can be coupled into the voltage return line for the +12V supply. Most of this is switching noise from the dc-to-dc converter (either on-board or in the external MAU). It is recommended that a dedicated path be used for voltage return between the AUI connector and the power supply. Avoid coupling this noise into the logic ground of the board.

- **–9V**

  A dc-to-dc converter is used to create a –9V supply that is necessary to run the DP8392 chip, when used. The ground reference for the –9V supply is the ThinWire coaxial cable ground. This supply and its ground must be dc-isolated from the other grounds in the design.

7.6.3.5 Grounding

Four different ground references must be considered in the Ethernet interface:

- Logic ground

  This is the reference for the system +5V supply.

- Chassis ground

  This is the lowest available impedance path to earth, usually provided by the ac power line.

- Voltage return

  This is the reference for the +12V supply. Keep the voltage drop over the path to the power supply small to ensure that a minimum requirement of 11.28V is delivered to the AUI connector when 0.5 A are being drawn from the +12V supply.

  Ultimately, the logic, chassis, and voltage return grounds may all be common. However, it is recommended that these three grounds be tied together only at one location: at the power supply.

- Connector grounding

  – ThinWire BNC connector grounding requirements (if used):

    The shell of the BNC connector must be common with the ground of the DP8392 chip and the return of the –9V supply. This ground must be dc-isolated from the remaining three grounds.

  – AUI connector grounding requirements:

    Two variants of the AUI cable exist: old, Ethernet-compliant cables and IEEE 802.3-compliant cables.

    The old Ethernet cable has a protective outer shield which is connected to the connector shell *and* pin 1 of the cable. It may have shields on the individual twisted pairs, which are also connected to pin 1.

    The IEEE 802.3 cable has a protective outer shield which is connected to the connector shell *only*. It also has inner shields on the twisted pairs. If the shields have a common drain wire, the cable is connected to pin 4. If the shields have individual drain wires they are connected to pins 1, 4, 8, 11, and 14.

It is the goal of the sample design to meet the functional requirements of both cable types. This is accomplished by connecting the connector shell to the chassis ground with a dc resistance not to exceed 20 mΩ and connecting pins 4, 8, 11, and 14 to logic ground at the station's AUI connector. A jumper is used to configure the connection of pin 1 in the station. When the jumper is installed, pin 1 is connected to logic ground. When the jumper is removed, pin 1 is left floating. The jumper must be installed when IEEE 802.3 AUI cables are used with the station. The jumper must be removed if the station has an old Ethernet cable.

Stations should ship with the jumper installed. This ensures that the implementation of the interface complies with the IEEE 802.3 grounding specification. All cables shipped by Digital Equipment Corporation comply with the IEEE 802.3 ground design requirements.

7.6.3.6 Isolation Boundary

An isolation boundary must exist between the coaxial cable medium and the circuitry within the station. This boundary has two characteristics:

- It presents a high impedance to low frequency signals.

  This is required in order to limit currents in ground loops. These ground loops are set up by multiple stations connecting to their local earth grounds and to the coaxial cable ground that is the network media. The impedance between either coaxial cable conductor (center conductor or shield) and any of the conductors in the AUI must be at least 250 kΩ at 60 Hz.

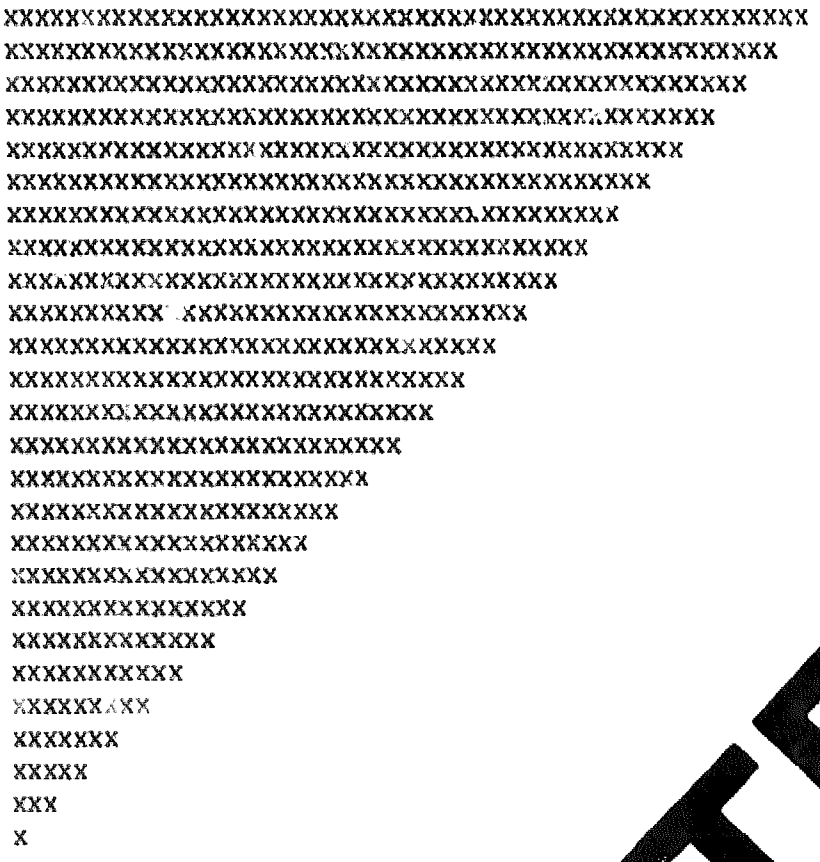
- It presents a low impedance to high frequency signals.

  This creates a low impedance path for noise to be shunted to earth ground. The magnitude of the impedance between the shield of the coaxial cable and the protective ground of the AUI must be at most 15 Ω in the frequency range of 3 MHz to 30 MHz.

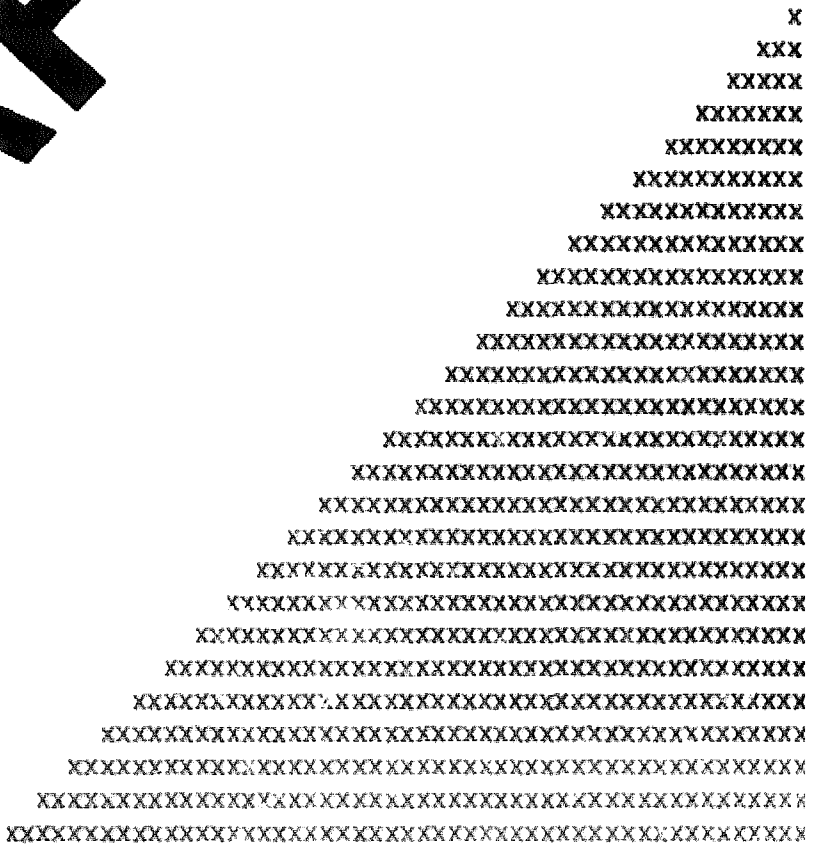
This isolation boundary is implemented within the MAU. When a station has only an AUI connector, the design need not implement these isolation requirements, because they are implemented in the external MAU.

The isolation boundary must be implemented in internal MAUs and is provided by the isolation transformer between the SIA and the MAU. The requirement for a high impedance at 60 Hz is met by the use of two blocks: a dc-to-dc converter and a signal isolation transformer. The layout must maintain a sufficient spacing between any two conductors on opposite sides of the boundary.

The requirement for a low impedance at 3 MHz is met by the use of the bypassing block. Note that the design uses a capacitance of 4700 pF to provide the RF shunt. At 3 MHz, this capacitance has an impedance of 11.3 Ω. This leaves a budget of 3.7 Ω (15—11.3) for connection between the chassis ground on the PC board and the earth ground of the station.



CHAPTER 8



8

I/O Device Interfacing

This chapter discusses the following topics:

- I/O device mapping (Section 8.1)
- Interrupt structure (Section 8.2)
- Bus interfacing techniques (Section 8.3)
- DMA device mapping registers (Section 8.4)
- rtVAX 300 to digital signal processor application example (Section 8.5)
- Reset/power-up (Section 8.6)
- Halting the processor (Section 8.7)
- I/O system illustrations (Section 8.8)

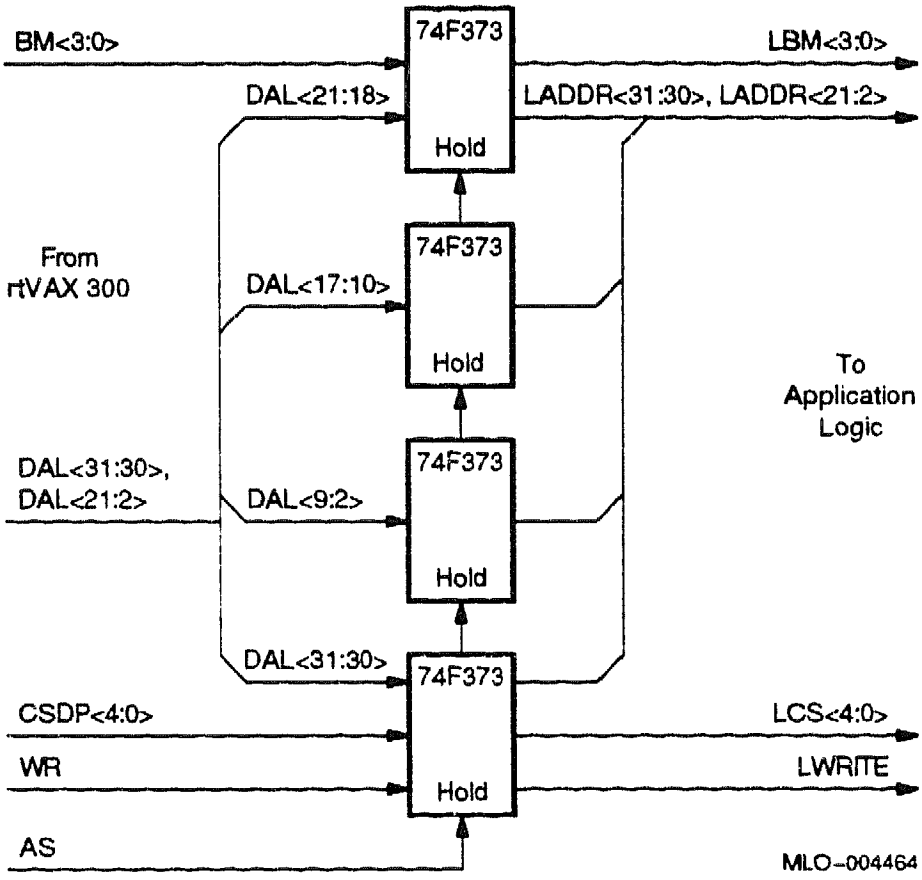
8.1 I/O Device Mapping

The rtVAX 300 processor supports 8-bit, 16-bit, and 32-bit I/O devices that are located in the rtVAX 300 processor's 510M bytes of I/O space. This space is accessed with the same read and write cycles used for memory access; however, address bit 29 is set for I/O access and cleared for memory access. The I/O space of the rtVAX 300 is at physical locations 20000000 to 3FFFFFFF.

8.1.1 Address Latch

The rtVAX 300 uses time-multiplexed data and address lines to transfer memory and device addresses and data. Since the address is valid only on this bus at the beginning of a device read or write cycle, address latches are needed to latch the address. These latches can be connected, as shown in Figure 8–1, by using the AS signal to latch the address. In addition, the byte mask signals BM<3:0>, write line WR L, and cycle status signals CSDP<4:0> L must all be latched along with the address. The outputs of these latches are used as inputs to address decoders and other application-specific logic. The outputs of these latches maintain valid address and cycle status information throughout the access cycle.

Figure 8–1 I/O Device Interfacing: Address Latches

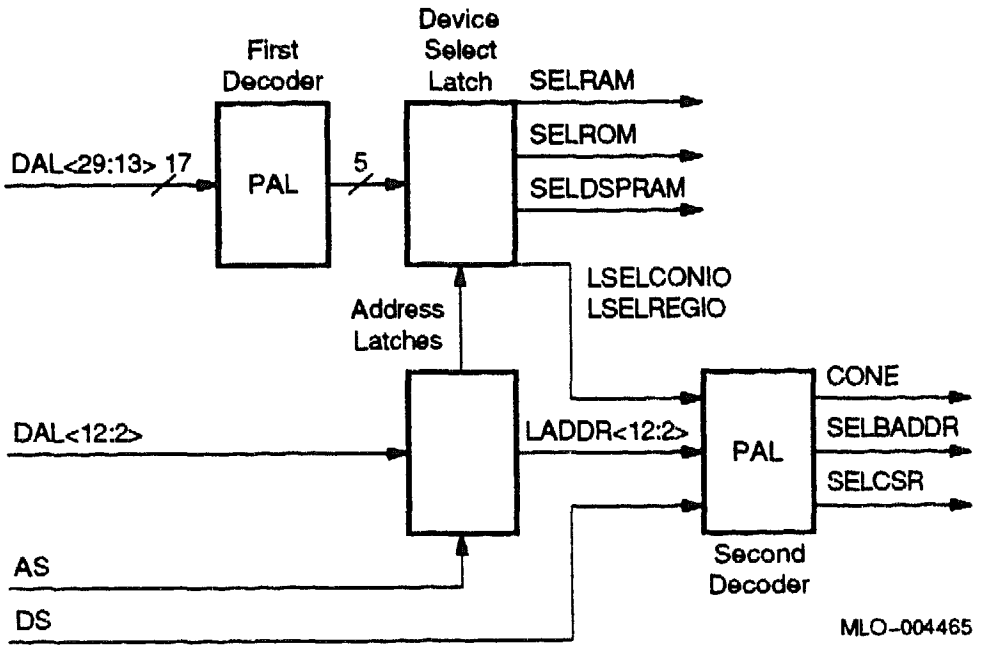


8.1.2 Address Decoding

Address decoding to generate chip select signals must be performed for each memory-mapped I/O peripheral. Programmable logic, such as the PAL 22V10, can be used to decode the rtVAX 300 addresses and generate the chip select signals for the memory subsystem and I/O peripherals. To implement full address decoding for a byte-, word-, or longword-wide peripheral, 28 address bits must be decoded. However, most PAL programmable devices do not offer enough input pins, and you can cascade two PAL devices to decode the memory address, as shown in Figure 8–2.

The first PAL decodes the upper address bits DAL<29:13>, and the outputs of this PAL are all latched by the device select latch. ROM and RAM are selected by the first PAL. Two other outputs of this PAL are latched and fed into a second PAL with the low-order latched address bits LADDR<12:02>. The output of this PAL asserts the CONE (console enable), SELBADDR (DMA base address register), and SELCSR (I/O CSR register). The data strobe (DS) line enables these three select signals.

Figure 8–2 I/O Device Interfacing: Address Decoding Block Diagram



8.1.3 I/O Access: Cache Control, Data Parity, and I/O Cycle Types

The rtVAX 300 performs only longword transfers from I/O space; it does not cache any data read from there. This allows for a simple design of I/O peripherals, because they need not respond to quadword or octaword access cycles.

I/O devices can be constructed to generate and check DAL bus parity, although proper parity is not required for I/O space reads if the DPE L line is deasserted.

If DAL parity generation and detection are not needed for the I/O device, drive the DPE L line high during that device's read cycle. A 74F657 parity transceiver can be used to generate and detect parity for an I/O device. Note that the odd bytes (DAL<15:08> and DAL<31:24>) have odd parity and that the even bytes (DAL<07:00> and DAL<23:16>) have even parity. If the I/O device is capable of DMA operations to the rtVAX 300 processor's external RAM memory, the DMA I/O device must generate the correct parity when writing to memory; otherwise, the rtVAX 300 detects a DAL parity error when reading those modified memory locations.

8.2 rtVAX 300 Interrupt Structure

Most simple peripherals, such as A/D, D/A, parallel, and serial I/O devices, can be directly mapped to a valid location of the rtVAX 300 processor's I/O space. When the device requests service, it asserts one of the four IRQ<3:0> L lines and waits for the rtVAX 300 to run an interrupt acknowledge cycle. This interrupt acknowledge cycle looks like a normal memory read cycle; however, the CSDP<4:0> L reads 1X011, indicating an external interrupt acknowledge cycle.

The IPL of the device interrupt being serviced is placed on DAL<06:02>, and AS L is asserted. This IPL must then be decoded, and the interrupting device must place a vector on DAL<15:02> and assert RDY L. DAL<31:16> and DAL<01> are ignored; however, DAL<0>L can be used to force the processor IPL to 17_{16} when asserted. Thus, if a device interrupts the rtVAX 300 by asserting IRQ<0> L, the processor raises its IPL to 14_{16}. If the vector that is driven onto DAL<15:00> is odd (DAL<00> is set to 1), the rtVAX 300 raises its priority level to IPL 17_{16} when executing the interrupt service routine. It is now up to the interrupt service routine to lower the IPL of the rtVAX 300 so that other interrupt requests are not blocked.

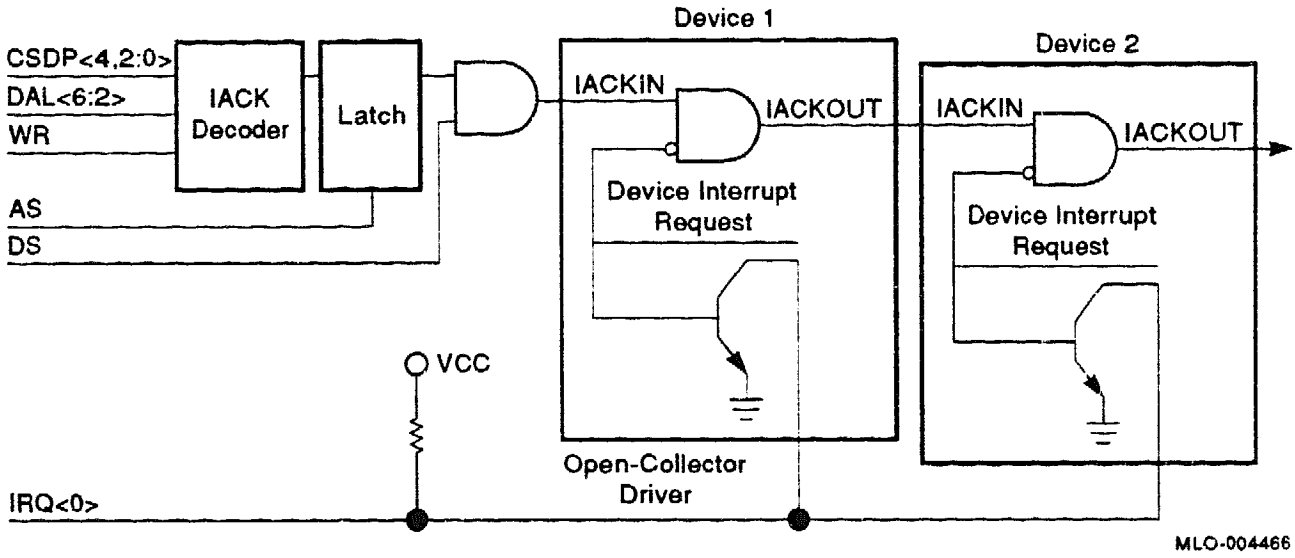
Lines IRQ<3:0> L are level-sensitive, and the interrupting device can continue to assert the IRQ<0> L line until the interrupt service routine lowers the rtVAX 300 IPL level below the interrupt request IPL. The rtVAX 300 does not service interrupt requests of the same or lower IPL than the IPL at which the processor is now operating. Therefore, if a device requests an interrupt by asserting IRQ<1> L and the processor runs an interrupt acknowledge cycle for that device, the processor's IPL is raised to 15_{16}. If the device continues to assert the IRQ<1> L line, the processor does not acknowledge the second interrupt until the interrupt service routine lowers the processor's IPL below 15_{16}; this prevents interrupt stacking and allows multiple devices to interrupt the processor by using the same interrupt request line. It is good practice to have the I/O device clear the interrupt request after the rtVAX 300 runs an interrupt acknowledge cycle for that device.

Typically, a CSR register associated with the I/O device contains the interrupt control bit(s). When a device has requested an interrupt, a bit is set in that register. This bit can automatically reset after the CSR is read, or the ISR can clear this bit by writing back to the CSR. The ISR branches to the correct servicing code, which depends on the nature of the interrupt, after reading this CSR. The ISR executes the service code, which cannot be preempted. After executing the code, the ISR lowers the processor's IPL, and other interrupts can be serviced. See the *rtVAX 300 Programmer's Guide* for a discussion of ISRs.

8.2.1 Interrupt Daisy-Chaining

In many applications, more than four devices need to request interrupts from the rtVAX 300. To accommodate multiple devices, the interrupt requests are logically ORed, and the interrupt acknowledge is daisy-chained between the devices, as shown in Figure 8–3.

Figure 8–3 I/O Device Interfacing: Interrupt Daisy-Chain Block Diagram



For example, if two devices need to interrupt at IPL 14_{16}, the interrupt request line of both devices can connect to IRQ<0> through open-collector drivers. A decoder that decodes interrupt acknowledgments at IPL 14_{16} asserts the device interrupt acknowledge signal. After being latched, this signal is then ANDed with DS and fed into the interrupt acknowledge input of the first device. This device drives a vector onto the DAL bus and drives RDY L, if it was the device that was asserting IRQ<0> L. However, if the first device did not assert the IRQ<0> L signal, it passes the interrupt acknowledge to the second device by asserting an interrupt acknowledge output signal. This IACKOUT signal is then fed into the interrupt acknowledge input of the second device. The second device can now drive the vector onto the DAL bus and assert RDY L. If the second device did not assert the IRQ<0> L signal and it receives the interrupt acknowledge input, it should not drive the vector onto DAL<15:00> or assert RDY L. The rtVAX 300 times out after 32 μs and aborts the interrupt acknowledge cycle. Aborted interrupt acknowledge cycles result in a passive release without a machine check.

8.2.2 Interrupt Vector

The interrupt vector generated by the interrupting device is used as an offset to locate an entry in the system control block (SCB). This entry is then read from the SCB to determine the virtual starting address of the interrupt service routine for that interrupting device. Each interrupting device must generate a unique vector, so that a different ISR is invoked for each device. (Table 3–4 lists the relationship between interrupts and the SCB.)

8.3 General Bus Interfacing Techniques

In some applications, the rtVAX 300 interfaces with a general-purpose I/O bus, such as the VME bus or the IBM PC/AT bus. The design of this interface can vary. The rtVAX 300 application module can function either as a bus master or a slave processor. Communication between the rtVAX 300 application module and other modules on the bus is carried out through either shared memory or dual-ported data registers.

8.3.1 Bus Errors

When a bus error occurs, external logic notifies the CPU by asserting ERR L during a bus cycle. The CPU responds, as shown in Table 8–1. External logic can assert both ERR L and RDY L to request a retry of bus cycles.

Caution

The RDY L, ERR L , and CCTL L lines are tri-stateable bidirectional lines. These lines are also internally pulled up by a resistor, and they must be driven by tristateable drivers. If these lines are driven by a standard TTL totem pole output, the rtVAX 300 does not function.

8.3.2 Using the rtVAX 300 as a Bus Master

In most bus interfacing applications, the rtVAX 300 functions as a bus master. The address space of the bus should be mapped to the rtVAX 300's I/O space. An interrupt controller is needed to handle and control interrupts that are generated on the bus; this controller must interrupt the rtVAX 300 and provide an interrupt vector when the rtVAX 300 acknowledges the interrupt. A bus cycle controller is also needed to control the bus protocol of the I/O bus and correctly service bus access cycles from the rtVAX 300. This controller becomes fairly complex if multiple bus masters are allowed on the I/O bus.

Table 8–1 Response to Bus Errors and DAL Parity Errors

Cycle Type	Prefetch	Cache[1]	Error Status[2]	Machine Flows
Demand D-stream (read)	–	Entry invalidated	Logged in MSER bits 06:05	Machine check abort
Write	–	–	–	Machine check abort
Request D-stream (read)	–	Entry invalidated	Logged in MSER bit 06	–
Request I-stream (read)	Halted	Entry invalidated	Logged in MSER bit 06	–

[1]The entire row in cache memory selected by the faulting address is invalidated whether or not the reference is cacheable. The entries from both sets are invalidated.

[2]Only DAL parity errors log status.

8.3.3 Using the rtVAX 300 as a Bus Slave

In certain applications, rtVAX 300 functions as a slave processor on a system bus. To do this, a bus interface must be designed to interface the bus to dual-ported memory on the rtVAX 300. This memory must map to the rtVAX 300's I/O space and to some address space of the system bus. It is useful to construct a few CSRs that allow the master processor on the system bus to interrupt the rtVAX 300 and give status information. In addition, the rtVAX 300 should be able to interrupt the master processor.

8.3.4 Building a DMA Engine for the rtVAX 300

The rtVAX 300 allows the peripherals to request the DAL bus and become DAL bus master. When the rtVAX 300 has given bus mastership to the external DMA device, the rtVAX 300 tri-states its DAL<31:00>, AS L, DS L, WR L, BM<3:0>, and CSDP<4:0> L lines. The DMA peripheral must now drive each of these lines with the same protocol as the rtVAX 300. All control signals must be pulled up to prevent accidental assertion when their lines are first tri-stated. It is also good practice to pull up the DAL<31:00>, BM<3:0>, and CSDP<4:0> L lines to prevent oscillation when these lines are not driven.

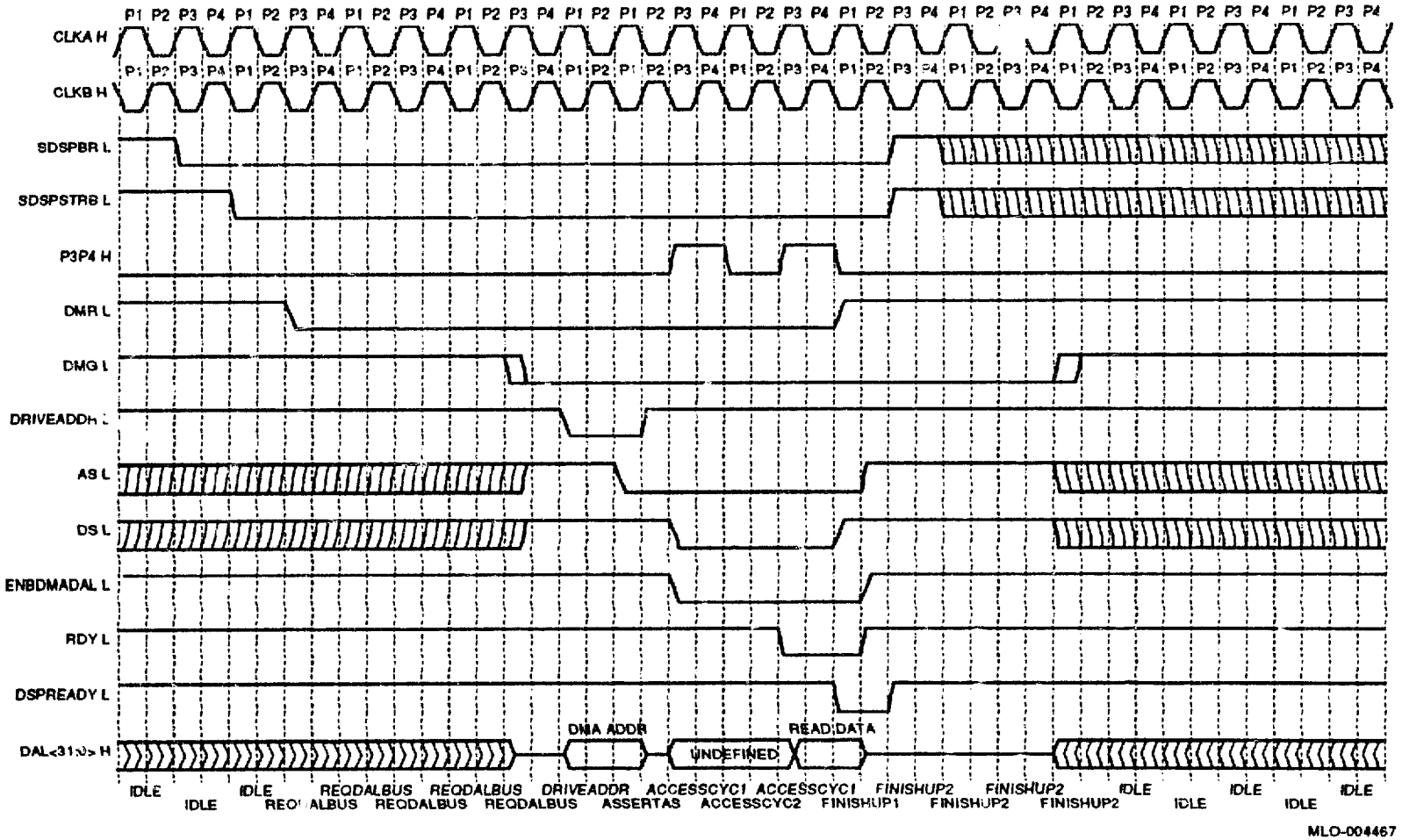
The DMA peripheral transfers information in the following sequence:

1. The DMA device asserts the DMR L signal, requesting to become DAL bus master, and waits for the assertion of DMG L.
2. The rtVAX 300 finishes the present transfer cycle, tri-states all signal lines, and asserts DMG L.

3. The DMA device drives the DMA address on the DAL bus, the cycle status onto CSDP<4:0> L, and the BM<3:0> lines, which are the byte access information, along with the WR L and DPE L lines.
4. The DMA device asserts AS L. This is the P1 clock phase.
5. The DAL<31:00>, CSDP<4:0> L, DPE L, and WR L lines are tri-stated by the DMA device. This is the P2 phase.
6. During a DMA write cycle, the DAL bus is driven with the data and CSDP <3:0> L is driven with the byte parity by the bus master. During a read cycle, the DMA peripheral listens to the DAL and CSDP lines to read the data. During either cycle, the DS L line is asserted. This is the P3 phase. DMA write cycles must maintain rtVAX 300 internal cache coherency; therefore, a DMA write to an address whose data has been previously cached invalidates that cache entry. The DMA bus master accomplishes this by first asserting the CCTL L line and then driving the DMA addresses onto the DAL bus and asserting AS L. This cache invalidation cycle prevents stale data from existing in the rtVAX 300 internal cache.
7. The DMA device waits for the assertion of RDY L during the P1 phase. Until RDY L is asserted, all signals stay in the same state.
8. During a read cycle, the memory subsystem asserts RDY L, and the DMA device must latch the data; during a write cycle, the DMA device must tri-state the DAL<31:00> and CSDP<4:0> L lines during the P2 phase.
9. If another DMA transfer is required, the DMA device goes to step 3. Only eight successive DMA transfers are allowed; the DMA device must relinquish the bus to the rtVAX 300 by deasserting DMR L. In addition, DMA devices cannot remain bus master for longer than 6 μs. If more DMA transfers are required, the DMA device can reassert DMR L and go back to step 1. The deassertion of DMR L allows the rtVAX 300 to access memory between DMA requests.
10. The DMA device deasserts the DMR L signal, the rtVAX 300 deasserts the DMG L signal, and the DMA transfer is complete.

The DMA timing diagrams, Figure 8–4 and Figure 8–19, show more details of the read and write cycles. In Figure 8–4, all data and strobe signals are controlled on rising edges of both CLKA and CLKB. For example, the AS L signal asserts on the rising edge of CLKA (P1 state) and deasserts on the rising edge of CLKB (P2 state). To emulate the proper timing of these strobe signals, a state machine must be clocked on CLKA, and some output latches must be clocked on CLKB. (See Figure 8–29 for an example of this.)

Figure 8–4 I/O Device Interfacing: DMA Read Cycle Timing



8.4 DMA Device Mapping Registers

When I/O devices or a bus interface must support DMA to the rtVAX 300 system memory, a scatter/gather (S/G) map is useful. This map translates the DMA addresses generated by the I/O device into the physical addresses of the rtVAX 300 system memory.

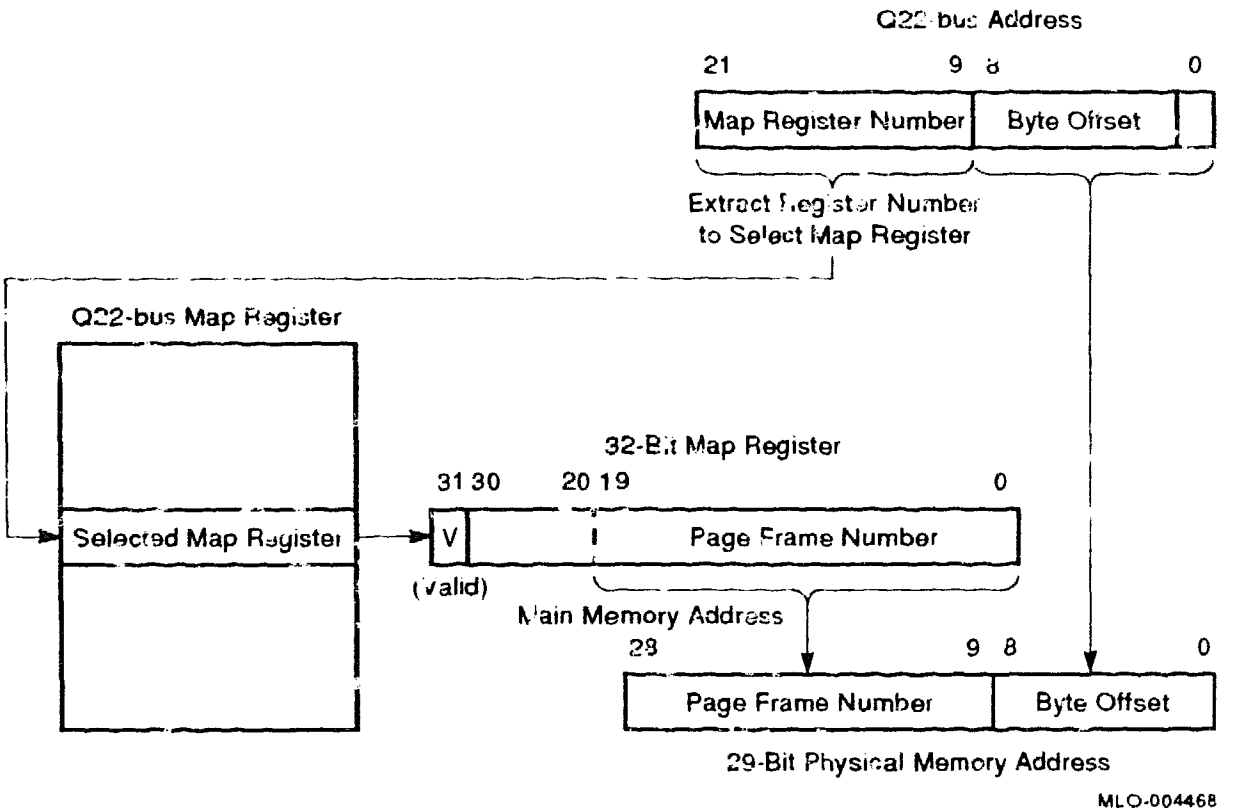
The VAX architecture defines a page to contain 512 bytes. To access any byte within any page, 9 bits of addressing are required for the byte offset within a page, and 21 bits are needed (the page frame number) to locate the page within the 30 bits of addressing accommodated by the VAX. To map the I/O device DMA address to the rtVAX 300 system memory correctly, the S/G map provides the page frame number (PFN) for the address that the I/O device generates.

For example, the Q22-bus supports 22 bits of addressing and multiple bus masters. The bottom 9 bits of the Q22-bus are directly multiplexed onto the rtVAX 300 system memory address. Bus address bits <08:02> are multiplexed onto DAL<08:02>, and bus address bits <01:00> control BM<3:0> to access the correct byte of VAX memory. The upper 13 bits of the Q22-bus address are used to select one entry in the S/G map. That entry in the S/G map then contains the 20 bits of possible pages in memory space to define the PFN. In addition, a Valid bit (bit 31) for each entry ensures that the operating system has correctly updated each map entry. Thus, the S/G map consists of 8192 Q22-bus mapping registers (QMRs), each being 21 bits wide.

The operating system dynamically updates each entry in the S/G map as pages of the I/O bus are mapped into physical pages of the rtVAX 300 system RAM. The rtVAX 300 views the S/G map as 8192 longword registers; each register maps one page of Q22-bus memory to a page in the rtVAX 300 system RAM. Figure 8–5 shows the translation from Q22-bus addresses to physical memory addresses.

Implementing these mapping registers allows Q22-bus DMA devices to perform DMA to and from contiguous Q22-bus addresses; the S/G map maps each page of Q22-bus memory to a page in system RAM if the Valid bit is set. These mapping registers must be readable and writable only from the rtVAX 300 and directly mapped to I/O space locations. When the rtVAX 300 is writing to or reading from the Q22-bus, the mapping registers are not used to address the Q22-bus. The Q22-bus address space is directly mapped to locations in the rtVAX 300 I/O space. The S/G map is used only when Q22-bus devices are performing DMA to the rtVAX 300 system memory. The rtVAX 300 can access its memory space through the Q22-bus interface by accessing a Q22-bus address that is validly mapped to its own system RAM.

Figure 8–5 Q22-bus to Main Memory Address Translation



These mapping registers are not a requirement, and some low-cost rtVAX 300 bus interfaces may not implement them. In addition, larger buffer areas that span many Kbytes can be used to reduce the number of mapping registers. In these applications, sections of the rtVAX 300 system RAM are directly mapped to an address space within the bus. This method requires contiguous allocation of DMA data buffers and reduces the flexibility of the VAXELN device drivers. Refer to the *rtVAX 300 Programmer's Guide* for information on rtVAX 300 device drivers.

Digital recommends implementing error registers for bus interfaces. These registers log events, such as DMA timeout and bus protocol and parity errors. Error conditions should interrupt the processor or assert the ERR L line. The ERR L line is asserted only if the present processor bus cycle caused the error condition. The system software can access these error registers to acknowledge the error condition and take the appropriate action.

8.4.1 Q22-bus to Main Memory Address Translation

On DMA references to main memory, the 22-bit Q22-bus address must be translated into a 29-bit physical memory address. This translation process is performed by the Q22-bus interface by using the Q22-bus map. This map contains 8192 mapping registers (one for each page in the Q22-bus memory space), each of which can map a page (512 bytes) of the Q22-bus memory address space into any of the 1M pages in main memory. Figure 8–5 shows how Q22-bus addresses are translated to main memory addresses. At system power-up, the Q22-bus map registers, including the Valid bits, are undefined. The system software must initialize these registers and enable the S/G map.

8.4.2 Q22-bus Map Registers

The Q22-bus map contains 8192 registers that control the mapping of Q22-bus addresses into main memory. Each register maps a page of the Q22-bus memory space into a page of main memory. These registers are implemented in a 32K-byte block of I/O space.

The local I/O space address of each register was chosen so that register address bits <14:02> are identical to Q22-bus address bits <21:09> of the Q22-bus page that the register maps.

Figure 8–6 shows the format of the Q22-bus map registers (QMRs); Table 8–2 lists the register bits and their meanings.

Figure 8–6 Q22-bus Map Register

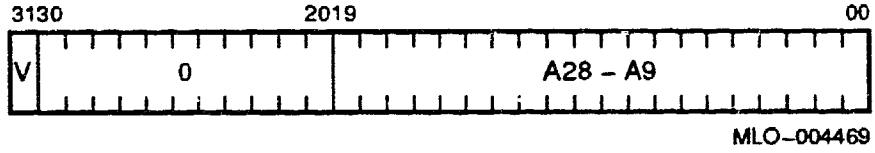


Table 8–2 Q22-bus Map Register Bits

Data Bit	Meaning
31	Valid bit (V). Read/write. When a Q22-bus map register is selected by bits <21:09> of the Q22-bus address, the Valid bit determines whether mapping is valid for that Q22-bus page. If the Valid bit is set, Q22-bus addresses within the page controlled by the register are mapped into the main memory page determined by bits <28:09>. If the Valid bit is clear, the Q22-bus interface does not respond to addresses within that page.
30:20	Unused. These bits must always read and be written as zero.
19:00	Address bits <28:09>. Read/write. When a Q22-bus map register is selected by a Q22-bus address, and if that register's Valid bit is set, then these 20 bits are used as main memory address bits <28:09>. Q22-bus address bits <08:00> are used as main memory address bits <08:00>. These bits are undefined on power-up and the negation of DCOK when the processor is halted.

8.4.3 Dual-Ported Memory

Another communication method that can be used is the design of dual-ported memory. Either the system RAM can be dual-ported or some dual-ported RAM can be placed in the I/O space. In addition, dual-ported RAM in the I/O space does not require the implementation of cache invalidation cycles, because I/O references are not stored in the cache. Dual-ported RAM in the I/O space has the advantage that the processor can still read from and write to system RAM while the I/O device is reading from and writing to the dual-ported I/O RAM. This method does not require the design of a DMA engine; therefore, the logic may be simpler.

8.5 rtVAX 300 to Digital Signal Processor (DSP) Application Example

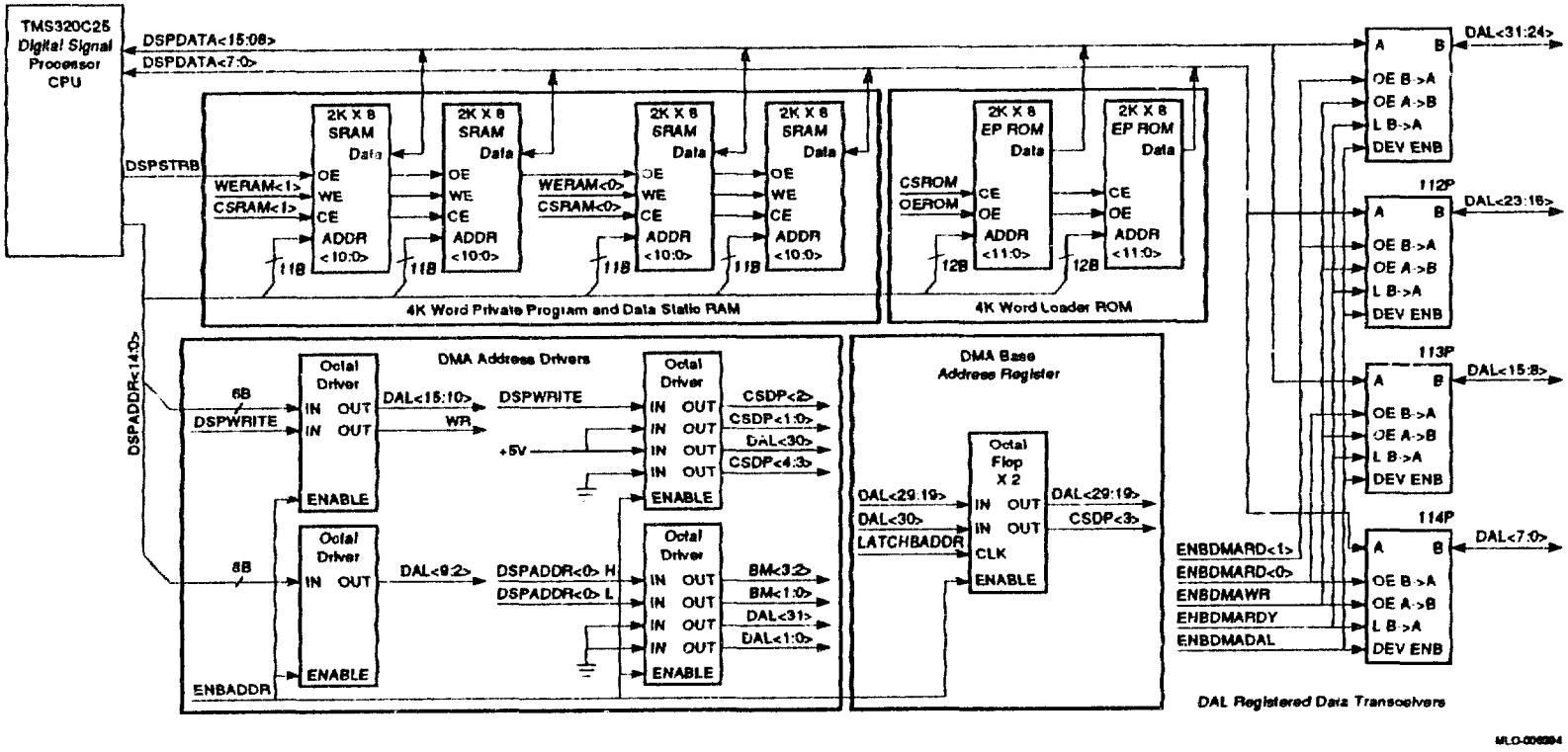
A 2-processor system was designed and constructed as an application example for the rtVAX 300. This application module has the following features:

- 4M bytes of parity DRAM system memory that operates with one wait state
- A 1M-byte user boot ROM for permanent storage of application software
- Two DEC–423 serial lines for the console and down-line loading
- DECnet Ethernet network interface for both ThinWire and thickwire
- A Texas Instrument TMS320C25 DSP with 4K words of private memory

- 4K words of initialization and loader ROM for the DSP
- A D/A and A/D converter that is privately coupled to the DSP
- A DMA engine that allows the DSP to write to and read from rtVAX 300 system memory
- An interprocessor communication CSR

Figure 8–7 shows the rtVAX 300 and DSP processor interface.

Figure 8–7 I/O Device Interfacing: DSP and rtVAX 300 Processor Interface Block Diagram



8.5.1 DSP Private Memory

The DSP executes programs in 4K words of private RAM memory; 4K words of ROM for initialization and program loading are privately coupled to the DSP. Table 8–3 shows the memory map of the DSP.

Table 8–3 TMS320C25 Digital Signal Processor Memory Map

Physical Location	Program Space Device	Data Space Device	Global Memory Space Device
0000—0FFF	ROM	RAM	None
1000—1FFF	ROM	RAM	None
2000—2FFF	ROM	RAM	None
3000—3FFF	ROM	RAM	None
4000—4FFF	RAM	RAM	None
5000—5FFF	RAM	RAM	None
6000—6FFF	RAM	RAM	None
7000—7FFF	RAM	RAM	None
8000—FFFF	None	None	rtVAX 300 memory accessed by DMA cycles

The DSP is a word-oriented device, expecting to transfer 16 bits of data at a time. The rtVAX 300 can transfer either bytes, words, or longwords during each bus cycle. When the DSP is reset, it begins to execute code from program space location 0000. The loader ROM is at that location. The code in that ROM first initializes some registers and vectors of the DSP; then, the code causes the DSP to load a program from the rtVAX 300 memory by using DMA cycles. Once the program has been loaded into the DSP's RAM, the DSP executes the loaded program from this program RAM at location 4000_{16}. Since full address decoding was not implemented, the ROM maps four times in the program space, and the RAM maps eight times in the data space and four times in the program space.

8.5.2 4K Words of DSP Private RAM

When the DSP reads data from external memory, it first places the address on the DSPADDR address bus. Either the program strobe (PS) signal for access to program memory or the data strobe (DS) signal for access to data memory is asserted. The DSPWRITE signal is not asserted (read cycle). The DSP_MEMORY PAL (see Figure 8–29) looks at the SRAMADDR<0> line to determine if bank 0 or bank 1 is selected. If bank 0 is selected, the CSRAM0 line is asserted and the two SRAMs in bank 0 are selected.

Both WRITERAM<1:0> signals remain unasserted. Next, the DSP asserts the DSPSTRB signal, enabling all SRAM outputs. The DSPREADY signal is asserted by the DSP_MEMORY PAL, and the DSP reads the data and ends the cycle. Write cycles operate in the same manner; however, the WRITERAM<1:0> signals assert with DSPSTRB for the selected bank.

The DSP requires the use of 40 ns static RAMs to operate without any wait states. The propagation delay of the DSP_MEMORY PAL must be added to the access time; therefore, 25 ns SRAMs were used.

8.5.3 DSP 4K-Word Private Initialization ROM

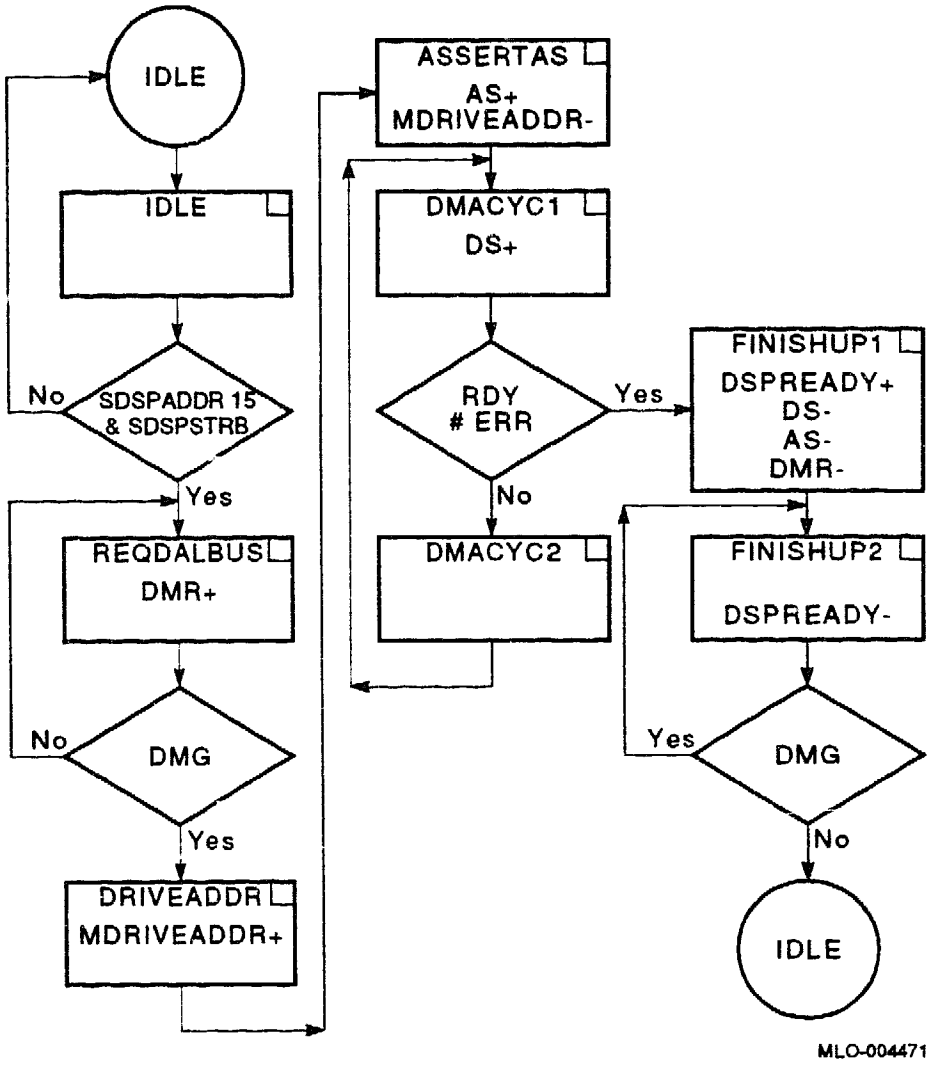
The DSP can read from only the initialization ROM. The DSP_MEMORY PAL asserts the CSROM output when a valid ROM program space address is placed on the DSPADDR bus. The OEROM signal is later asserted, and the DSP asserts the DSPSTRB line with DSPWRITE unasserted. Since the ROMs are very slow, the DMA_ CONTROL PAL adds three wait states to the access cycle. After those wait states have occurred, the DMA_CONTROL PAL asserts the DMAREADY line, which in turn asserts the DSPREADY line, ending the cycle.

8.5.4 DSP DMA Cycles

Certain portions of the DSP's memory can be mapped globally. This global memory is mapped between locations 8000 and FFFF. Access to these locations causes the DSP DMA controller to assert the rtVAX 300's DMR L line. Then the rtVAX 300 tri-states the DAL bus and all of the control signals and asserts the DMG L line; now, the DMA controller must start a DMA access cycle.

Once the DMA controller state machine receives the DMG L signal from the rtVAX 300, the DRIVEADDR signal is asserted to drive the DSP's DMA address onto the rtVAX 300's DAL bus through the 74F244 drivers, shown in Figure 8–26. The assertion of DRIVEADDR asserts the ENBADDR signal through the CSR_REG PAL, driving DAL<31:02> H, CSDP<4,2:0> L, and BM<3:0> L with the appropriate address and control information. Next, the AS L signal is asserted and later, the DRIVEADDR signal deasserts. Now, the DS signal and the ENBDMADAL are asserted; the DMA controller waits for the assertion of RDY L in the RDY/ERR window. The assertion of ENBDMADAL turns on the 74F543 transceivers (see Figure 8–25). Once RDY L is received, the DMAREADY signal is asserted, asserting the DSPREADY signal through the DSP_MEMORY PAL. If this is a DMA read cycle, the DSPDMARDY signal causes the 74F543 transceivers to latch the data on the DAL bus and continue to drive the DSP data bus with that data until the DSP finishes the read cycle. The DSP global memory access cycle now completes, and the DMA controller deasserts AS L, DS L, DMR L, and ENBDMADAL. See the state machine diagram described by Figure 8–8 and the timing diagram in Figure 8–4 for details.

Figure 8–8 I/O Device Interfacing: DMA State Machine Sequence



8.5.5 Control and Status Register

A control and status register (CSR) is implemented between the rtVAX 300 and the DSP. This register has an 8-bit 1-way mirror for interprocessor communication. It also contains interrupt, reset, and hold bits for each processor.

8.5.5.1 1-Way Mirror Register

The bottom 8 bits of the CSR register form a 1-way mirror register (see Figure 8–27). When the DSP reads from I/O space, the DSPIS signal is asserted, indicating that the DSP is accessing the CSR. The DSR_BADDR PAL then asserts the ENBDSPCSR line once DSPSTRB asserts, driving the contents of the mailbox onto the DSPDATA bus. These contents are the value that was last written to by the rtVAX 300 and *not* the contents last written to by the DSP.

When the DSP writes to I/O space, the DSPIS signal is also asserted. The DSR_BADDR PAL then asserts the LATCHDSPCSR line when DSPSTRB asserts. When LATCHDSPCSR deasserts, the data on the DSP data bus is latched into the DSP mirror register. The data on DSP data bit <08> is used to set the VAX interrupt request flop, as shown in Figure 8–28. When this bit is set, an interrupt at IPL 16_{16} is posted by asserting the IRQ<2> L line of the rtVAX 300.

When the rtVAX 300 reads this mirror register, it reads the most recent value written to it by the DSP. When the rtVAX 300 writes to this register, the DSP reads that value the next time it reads from that register.

8.5.5.2 Interrupt, Reset, and Hold Bits

When the system is first reset, the CSR register clears all of its bits except the HOLD DSP and RESET DSP bits. Once the rtVAX 300 boots, it writes the DSP program into a reserved block of rtVAX 300 system memory and sets the DMA base address register. The rtVAX 300 can now reset these 2 bits, and the DSP copies the program to its own private memory and begins to execute it. The base address register (see Figure 8–28) drives through the bus drivers (see Figure 8–27) to the rtVAX 300 DAL bus. The DSP cannot read any of these bits; however, it can write to the interrupt VAX bit, as described above.

When set, the interrupt bit for the rtVAX 300 requests an interrupt by asserting IRQ<2> L. When the rtVAX 300 runs an interrupt acknowledge cycle, this request is cleared; however, the bit in the CSR remains set. When this register is read, this bit is cleared at the end of the read cycle. The interrupt bit for the DSP operates in the same manner; however, it asserts the DSPIR<0> bit. This bit is cleared when the DSP runs an interrupt acknowledge cycle.

8.5.6 DMA Base Address Register

The rtVAX 300 can perform DMA to up to 64K bytes of memory. The DMA base address register selects the 64K-byte block of memory which can be seen by the DSP. The DSP CSR, whose implementation is shown in Figure 8–26, is readable and writable only from the rtVAX 300 and cannot be accessed by the DSP.

8.6 Reset/Power-Up

The rtVAX 300 processor must have its RST L line asserted for at least 750 ns when it is first powered up to ensure the stability of all on-chip voltages before beginning operation. Assertion of this line resets all rtVAX 300 internal registers and sets the program counter to 20040000. Once the RST L line is deasserted, the rtVAX 300 begins booting by fetching instructions that start at physical location 20040000, the starting location of the rtVAX 300 internal boot and diagnostics ROMs.

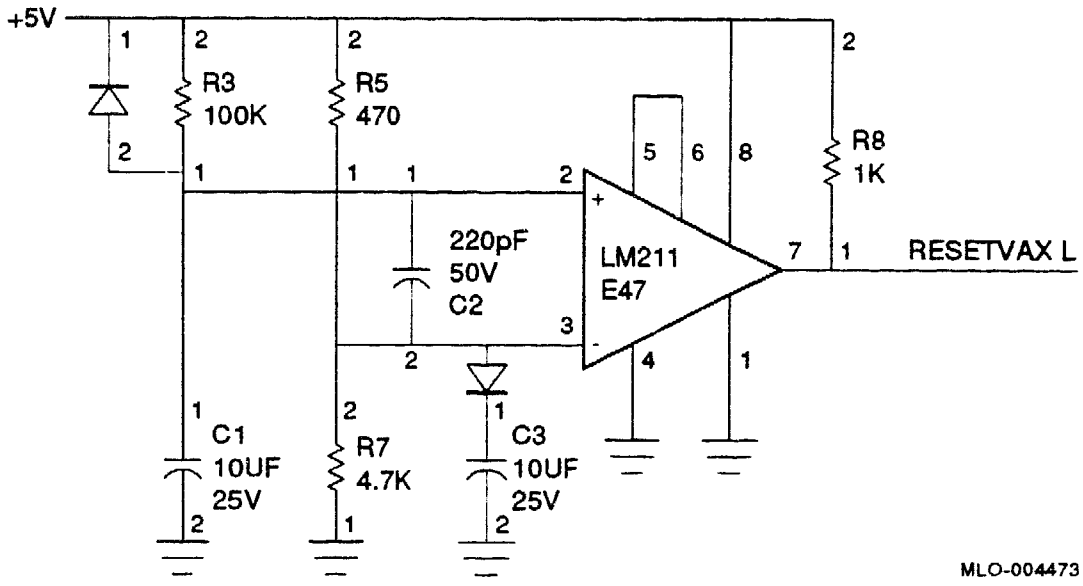
The power-on reset circuit, shown in Figure 8–9, asserts the RESETVAX line when power is first applied to the board. The 4.7 kΩ and 470 Ω resistors on the (–) input of the LM211 comparator set that input voltage to 4.5V. The 10 µF capacitor on this input charges more quickly than the 10 µF capacitor, which is charged to 5V through a 100K resistor to Vcc. Thus, when power is first applied, the (–) input of the LM211 comparator quickly reaches 4.5V. The (+) input of the comparator is at a lower voltage than the (–) input until the 10 µF capacitor charges over 4.5V. This takes slightly longer than the RC time constant of 100,000 x 0.00001 = 1 second. While the (+) input is at a lower potential than the (–) input, the open-collector output of the LM211 comparator is turned on, and the RESETVAX signal is asserted.

When the reset switch is pressed, the BUTTRST signal also asserts through the 74F32 gate of the ENBRST switch, shown in Figure 8–31. When either BUTTRST or RESETVAX is asserted, the 74F579 counter is reset, and the reset hold latch is cleared. After 12.8 µs, the counter overflows, and the TC output toggles. The reset hold flop stores a 1, and the RST L line is deasserted by the reset latch.

Caution

The reset assertion time and deassertion timing in the specifications must be followed exactly. RST L can deassert only 10 ns after or 20 ns before any CLKA edge. If this timing is violated, the rtVAX 300 does not initialize properly. The RST L line can be asserted at any time.

Figure 8–9 I/O Device Interfacing: Reset Timer Logic

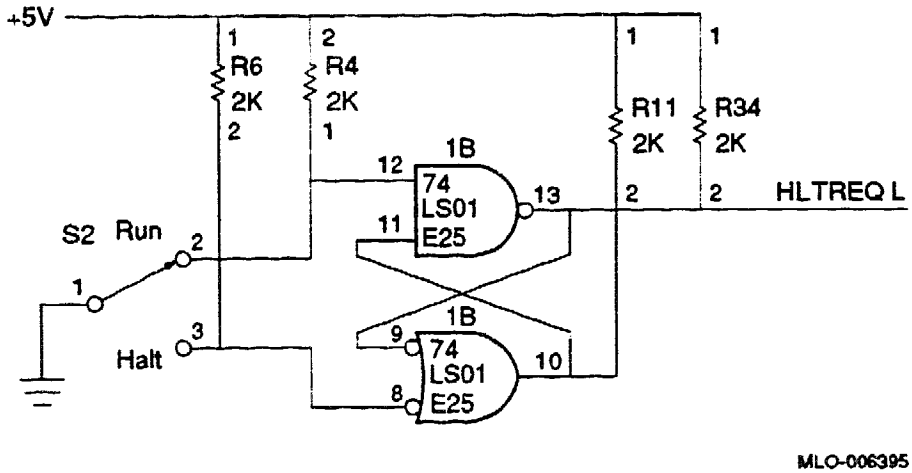


8.7 Halting the Processor

The rtVAX 300 is a dynamic device and cannot be halted by disabling its clock input (CLKIN). The CPU is halted either by executing the HALT instruction in kernel mode or by asserting the HLT L signal.

When in the HALT position, the RUN/HALT switch (S1) sets a flip-flop which asserts the HLT L output to the rtVAX 300 processor, as shown in Figure 8–10. This causes the rtVAX 300 to enter a halt routine and to store the content of certain rtVAX 300 registers. This is a momentary contact switch that is normally in the RUN position.

Figure 8–10 I/O Device Interfacing: HALT Logic

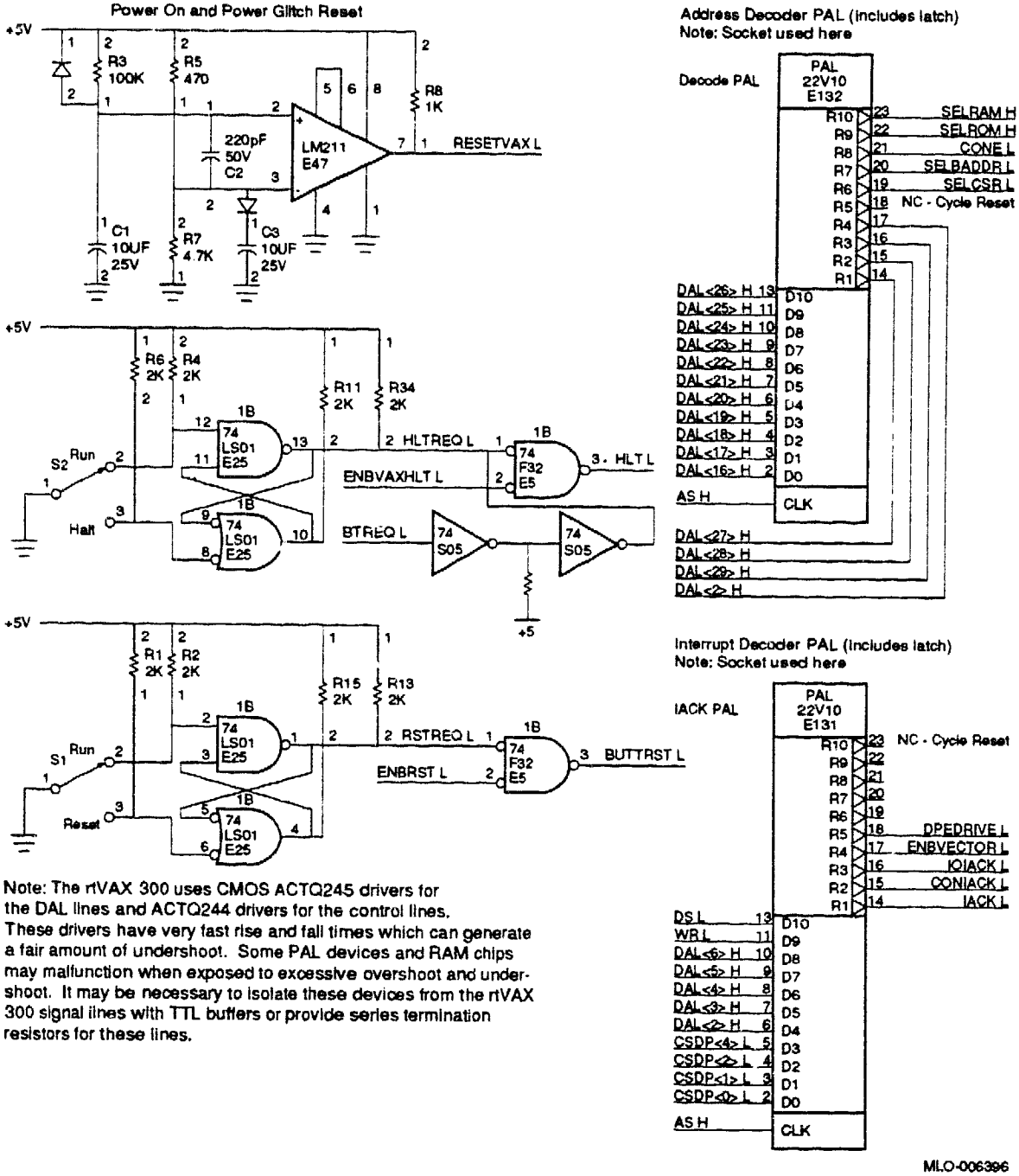


8.8 I/O System Illustrations

The following pages show I/O system illustrations and programmable array logic.

- Figure 8–11 shows the address decoder and power-on reset.
- Figure 8–12 shows the address latches.
- Figure 8–13 shows the DRAM address path.
- Figure 8–14 shows DRAM memory array (1).
- Figure 8–15 shows DRAM memory array (2).
- Figure 8–16 shows the RAM data latches.
- Figure 8–17 shows the DSP PGM loader ROM.
- Figure 8–18 shows rtVAX 300 ThinWire/thickwire network connections.
- Figure 8–20 shows the memory controller.
- Figure 8–21 shows the console interface.
- Figure 8–22 shows the user boot ROM bank 1 with drivers.
- Figure 8–23 shows the user boot ROM bank 2.
- Figure 8–24 shows the DSP and private RAM.
- Figure 8–25 shows the DSP DMA transceiver and parity generator.
- Figure 8–26 shows the DMA address drivers.
- Figure 8–27 shows the VAX-to-DSP 1-way mirror register.
- Figure 8–28 shows the rtVAX 300 and DSP CSR.
- Figure 8–29 shows the DSP DMA controller.
- Figure 8–30 shows the D/A and A/D interface.
- Figure 8–31 shows rtVAX 300 I/O pin connectors.
- Figure 8–32 shows the decoupling caps.

Figure 8–11 I/O Device Interfacing: Address Decoder and Power-On Reset



Note: The rtVAX 300 uses CMOS ACTQ245 drivers for the DAL lines and ACTQ244 drivers for the control lines. These drivers have very fast rise and fall times which can generate a fair amount of undershoot. Some PAL devices and RAM chips may malfunction when exposed to excessive overshoot and undershoot. It may be necessary to isolate these devices from the rtVAX 300 signal lines with TTL buffers or provide series termination resistors for these lines.

Figure 8–12 I/O Device Interfacing: Address Latches

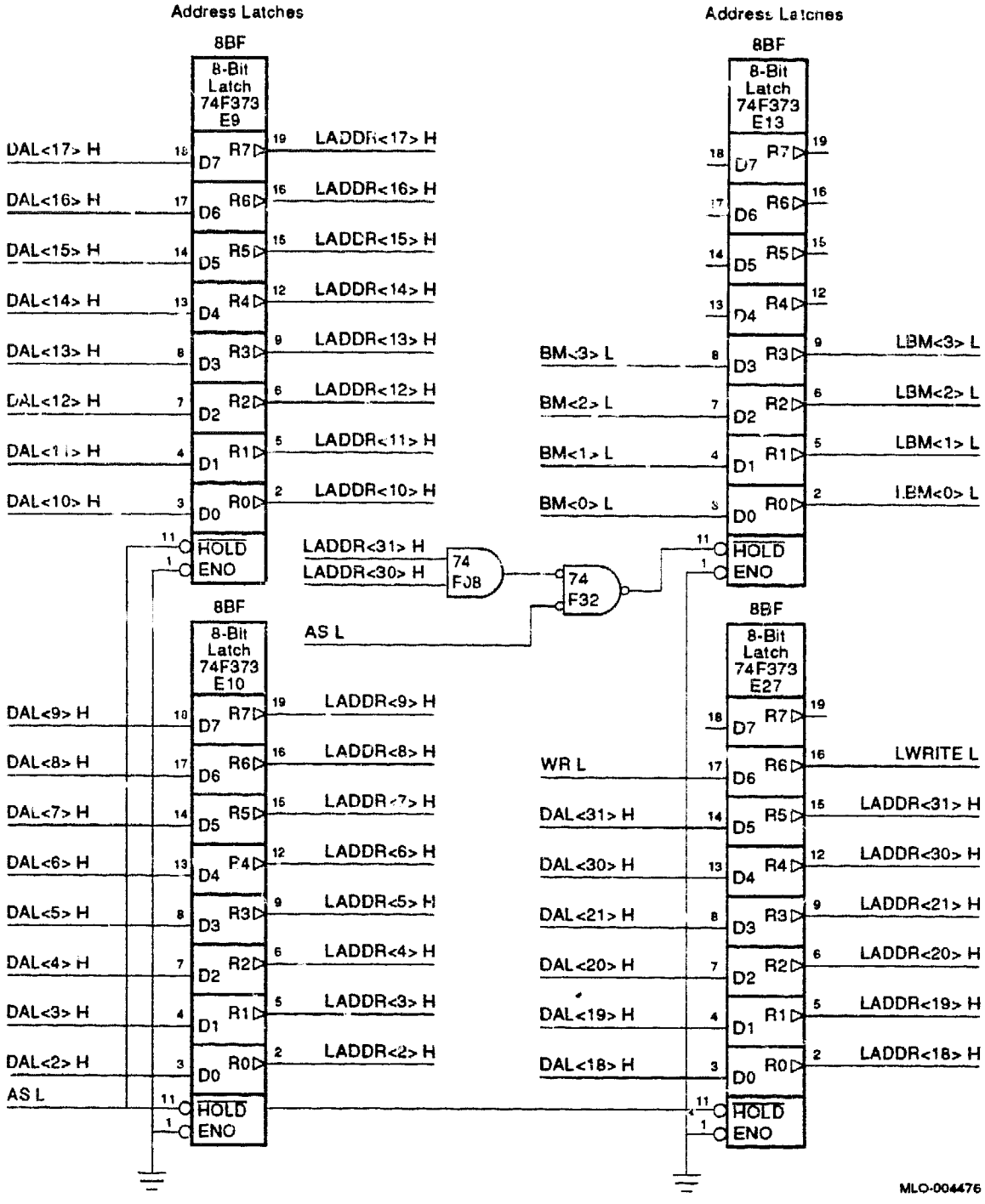


Figure 8–13 I/O Device Interfacing: DRAM Address Path

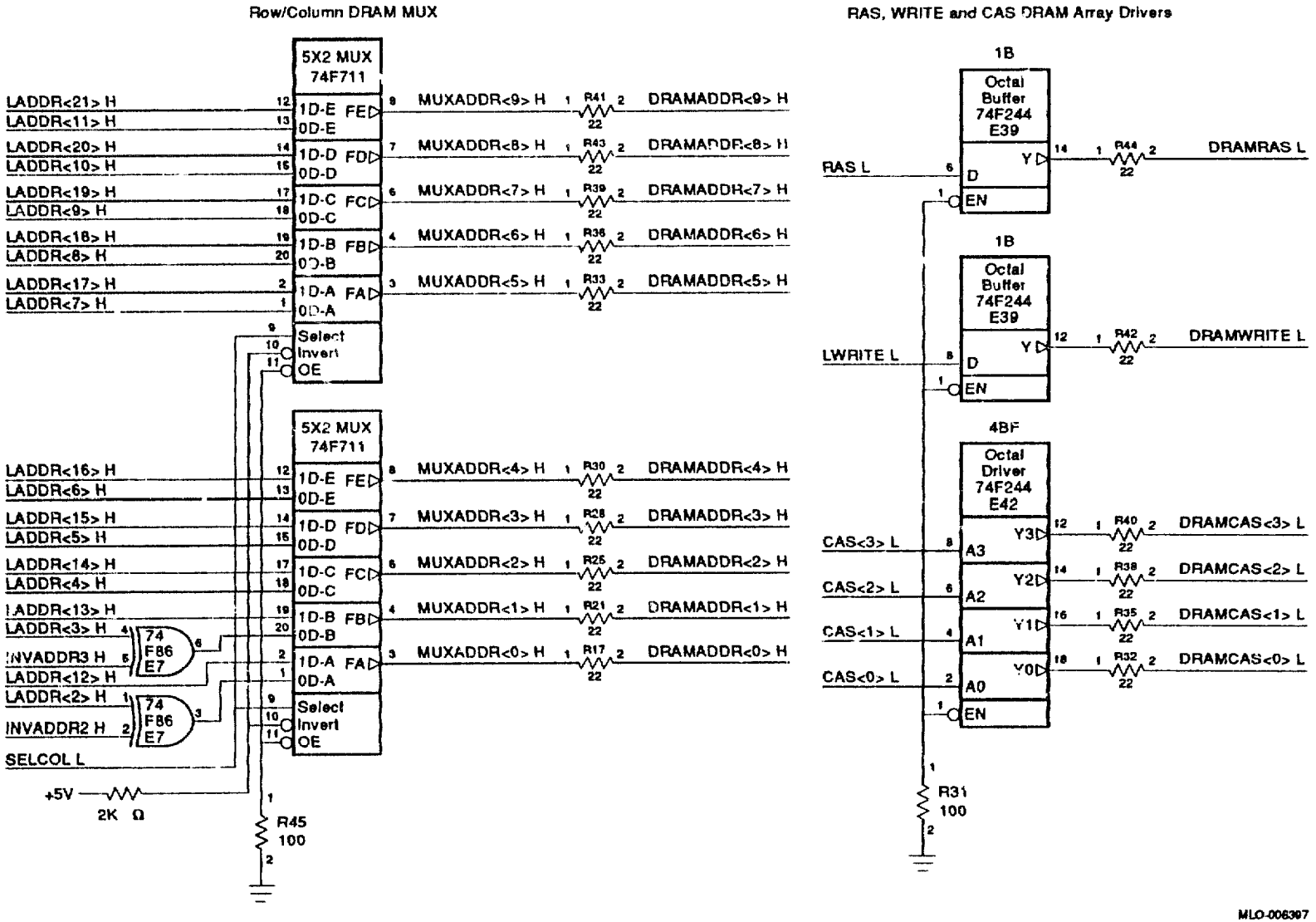


Figure 8–14 I/O Device Interfacing: DRAM Memory Array (1)

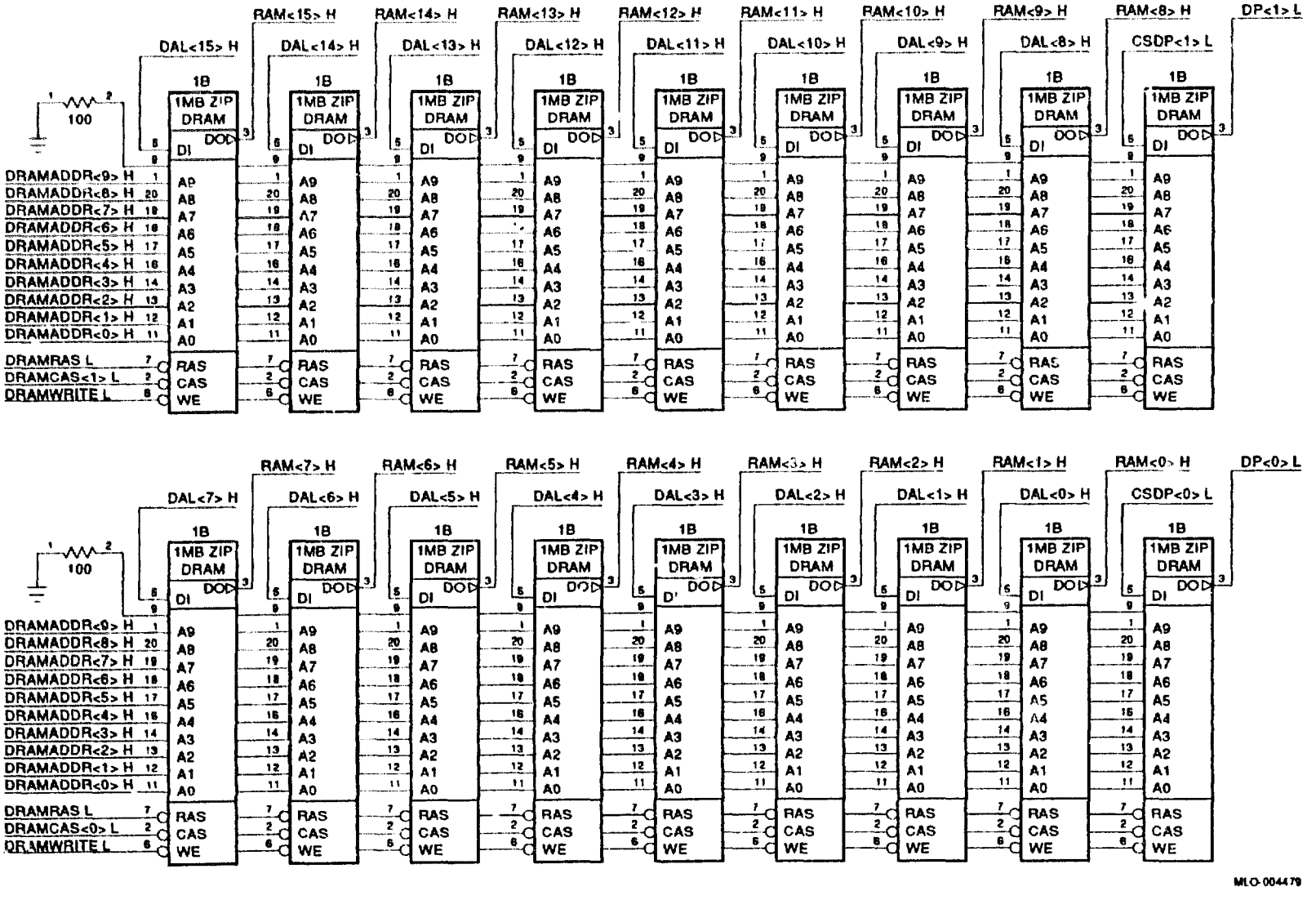


Figure 8–15 I/O Device Interfacing: DRAM Memory Array (2)

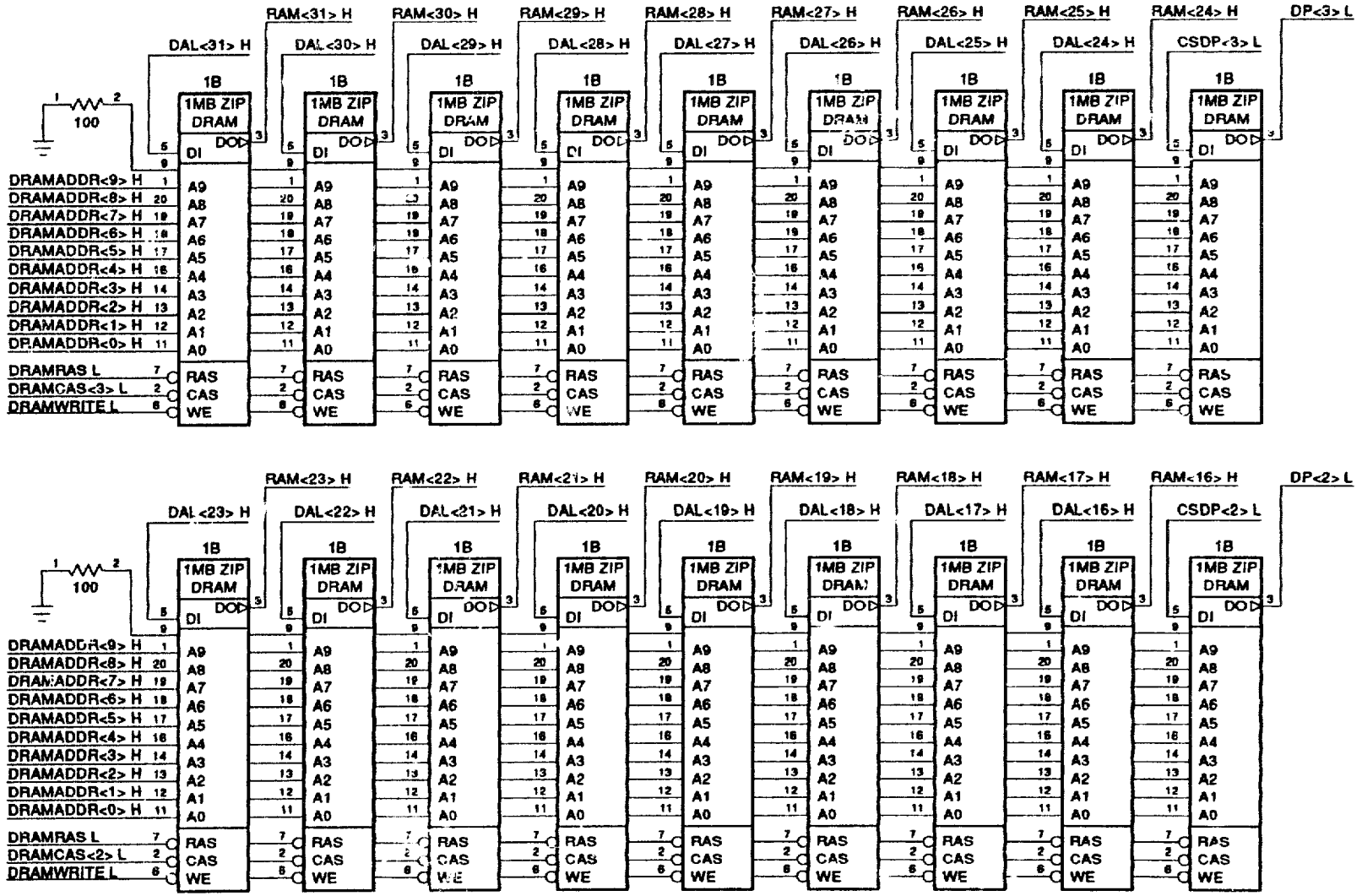


Figure 8–16 I/O Device Interfacing: RAM Data Latches

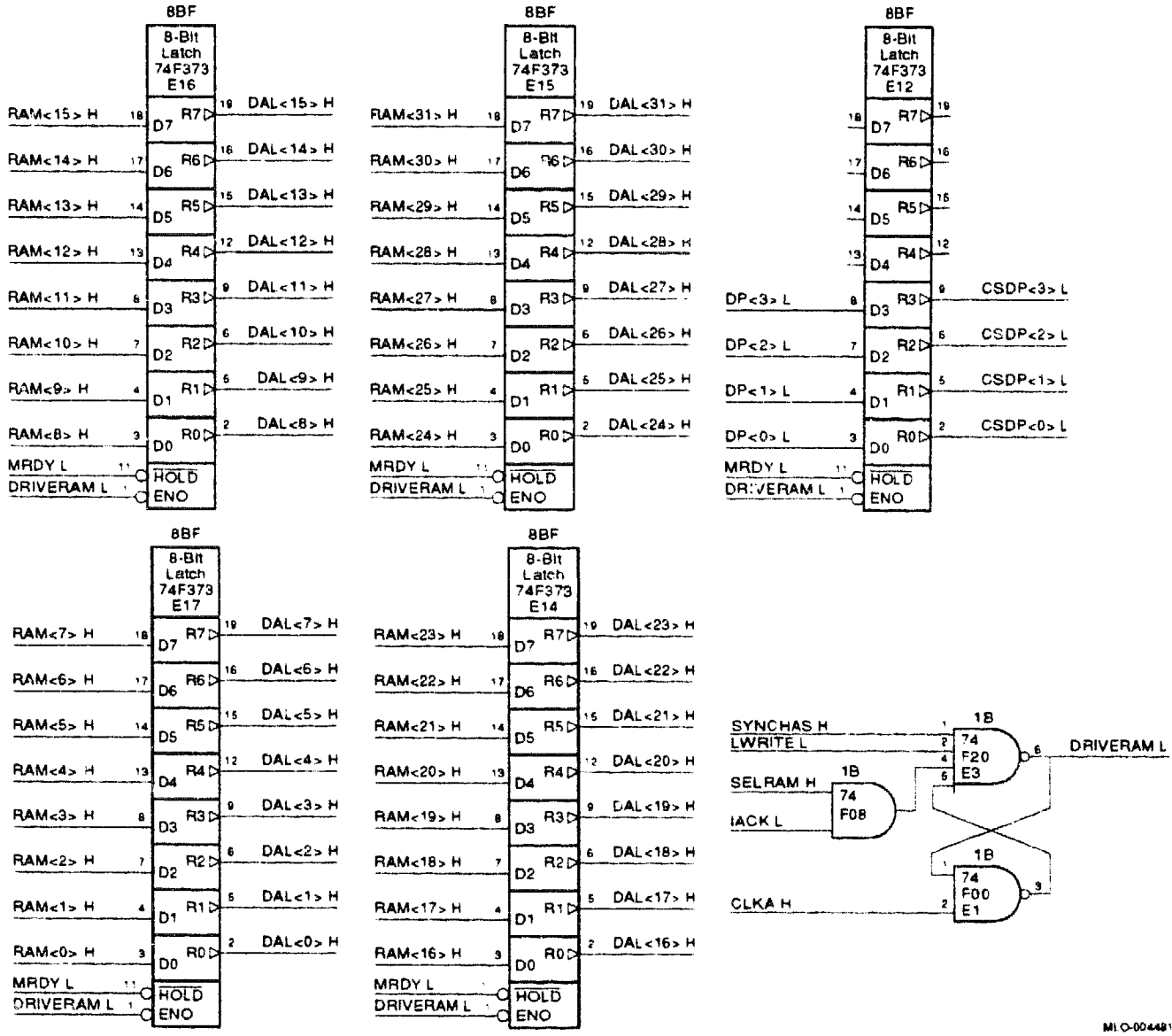


Figure 8–17 I/O Device Interfacing: DSP PGM Loader ROM

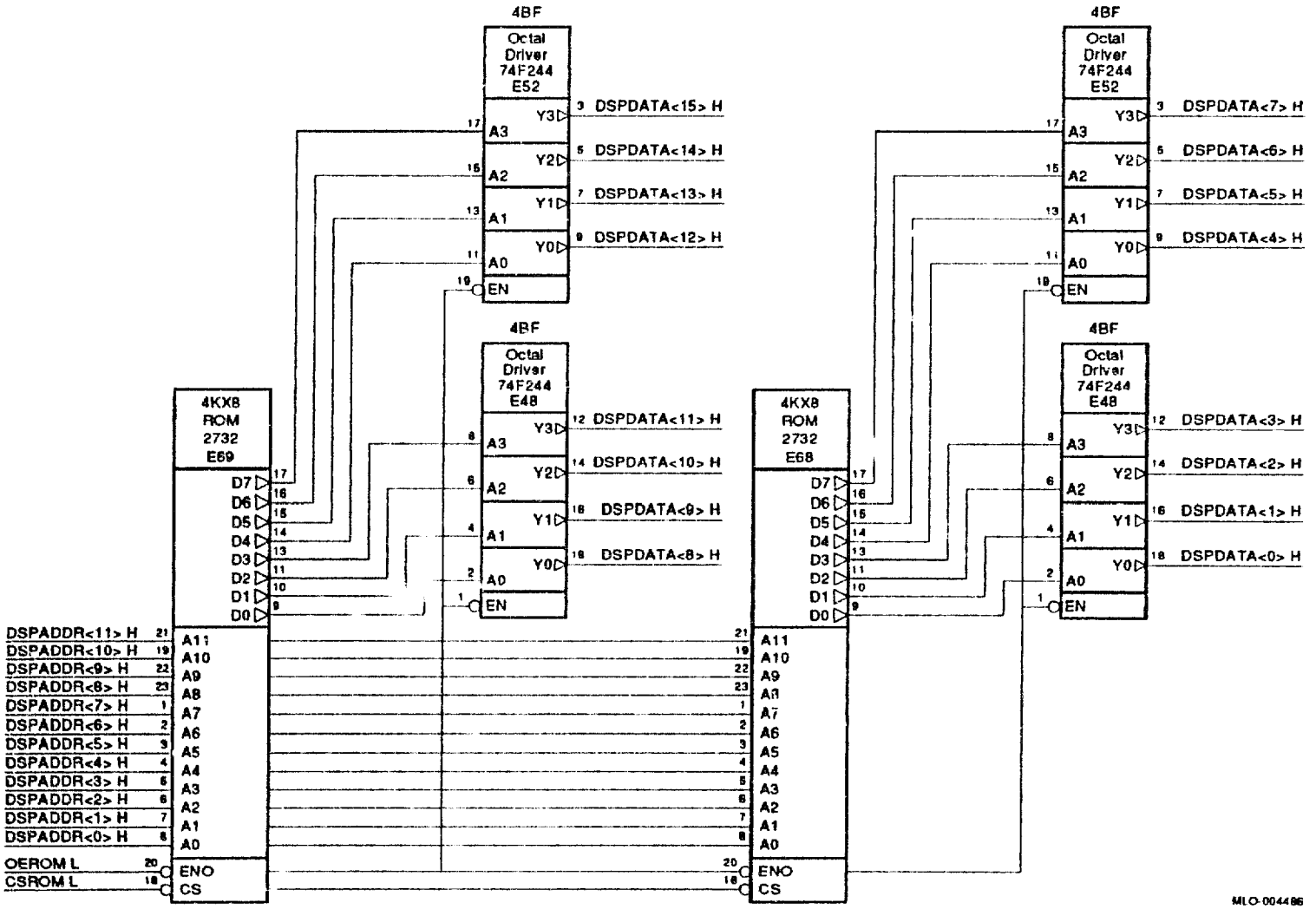
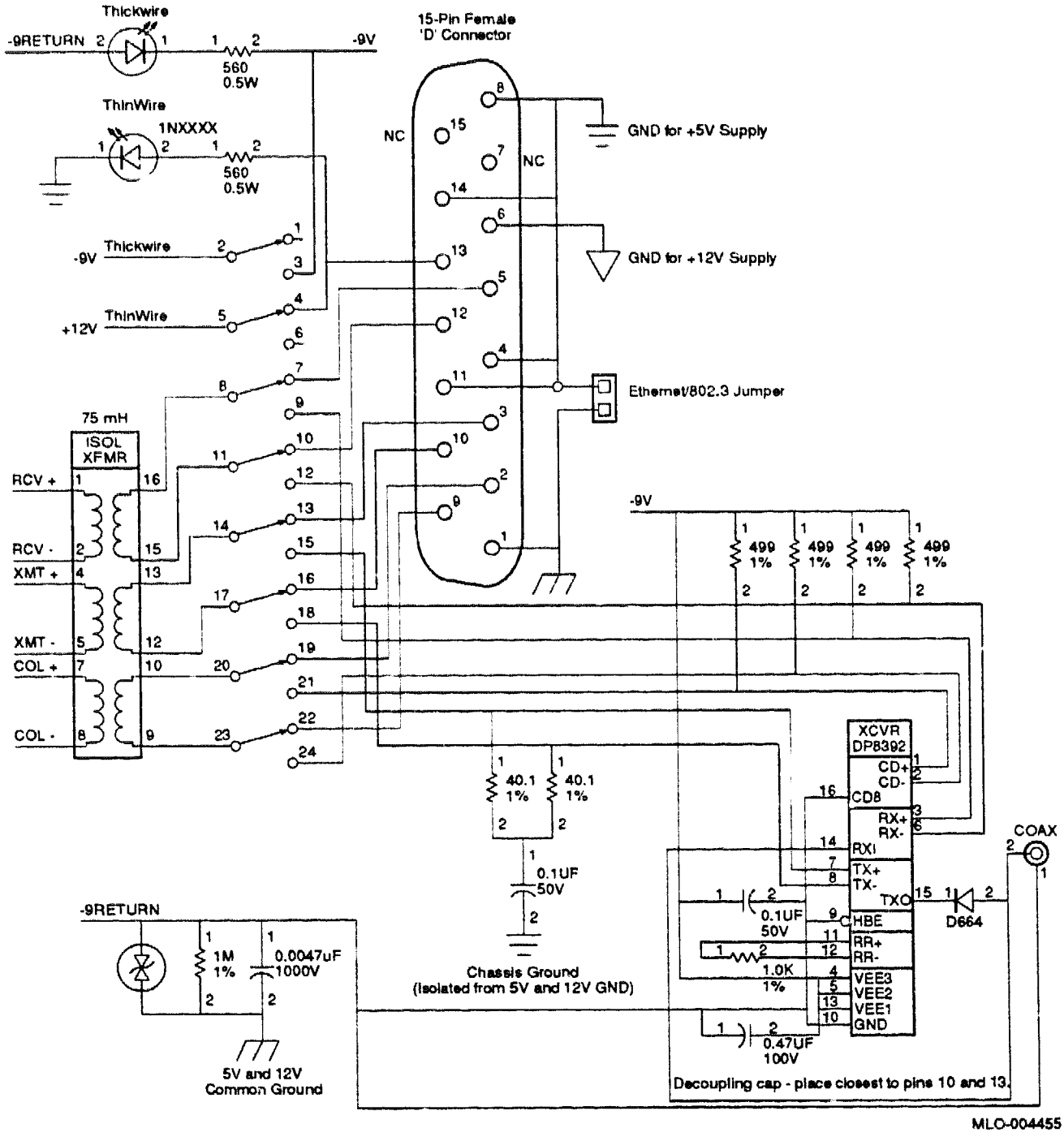
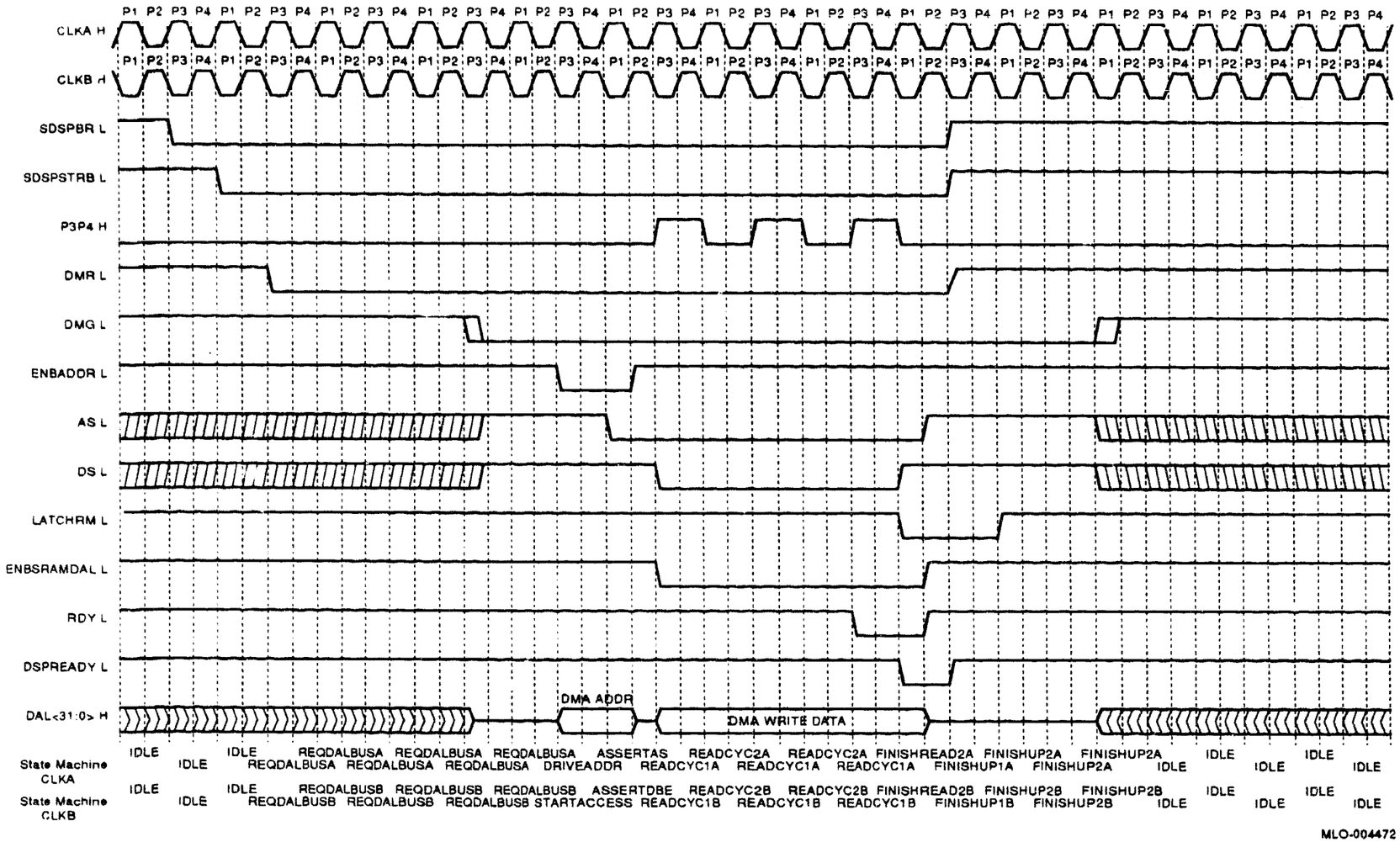


Figure 8–18 I/O Device Interfacing: rtVAX 300 ThinWire/Thickwire Network Connections



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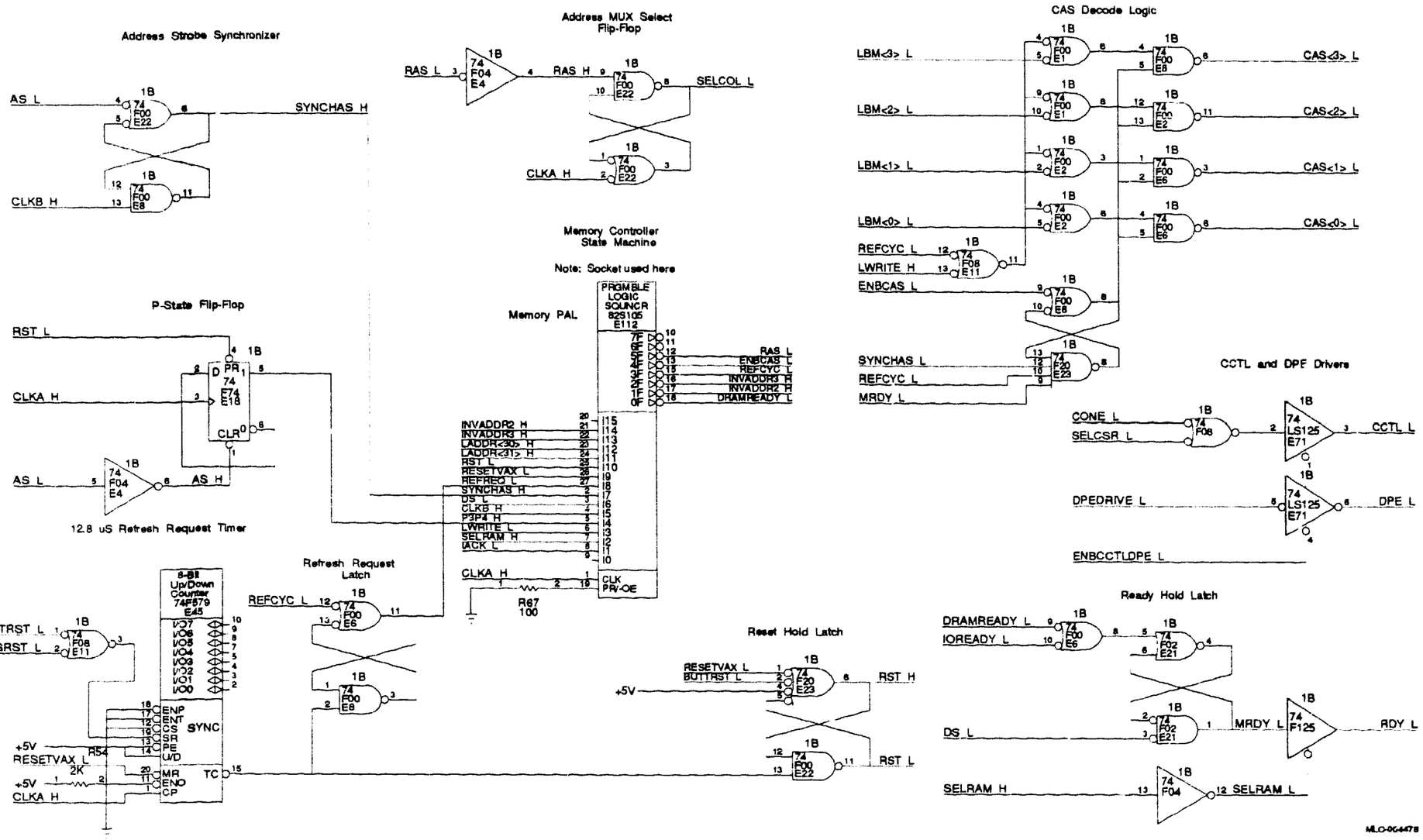
Figure 8–19 I/O Device Interfacing: DMA Write Cycle Timing



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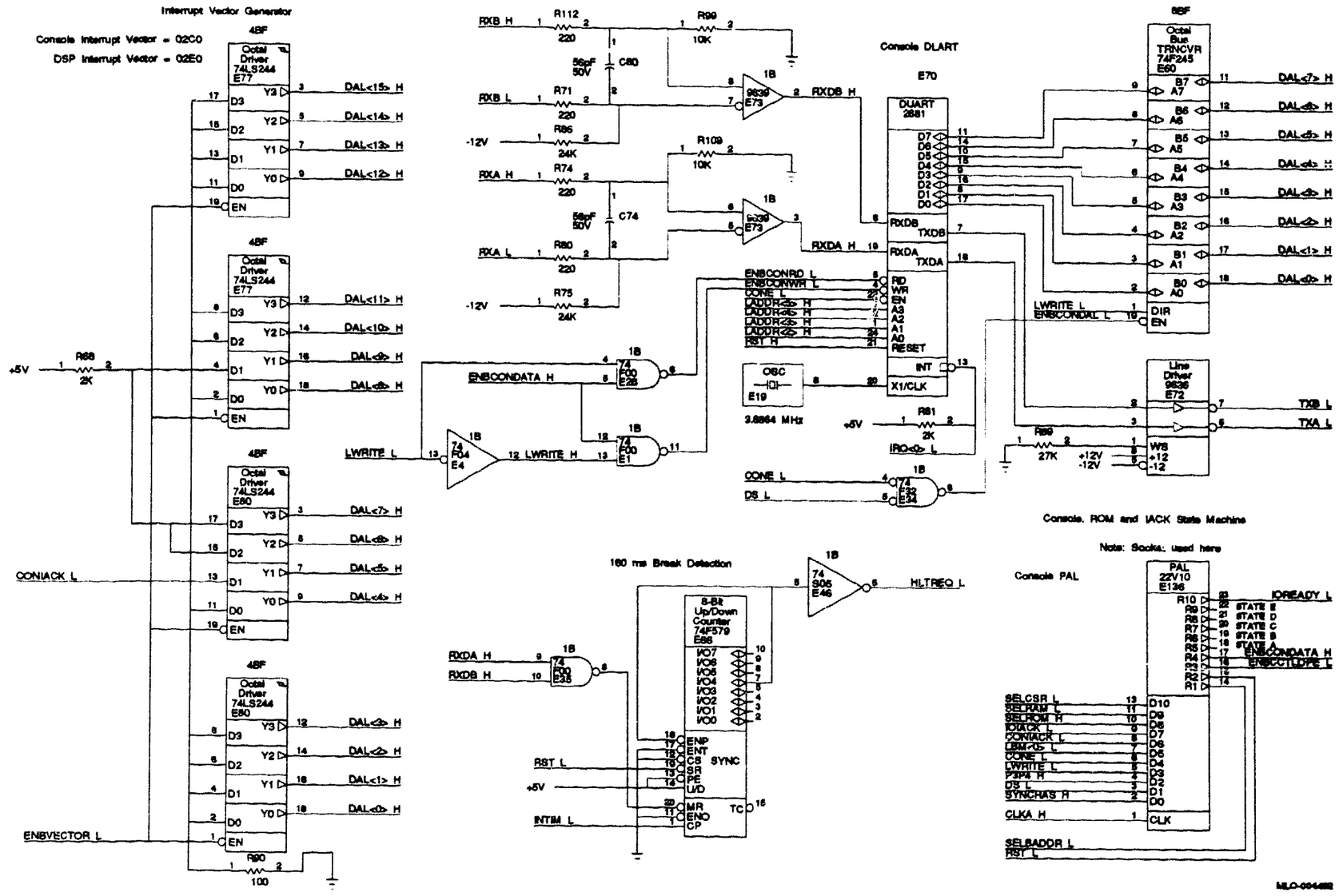
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Figure 8–20 I/O Device Interfacing: Memory Controller



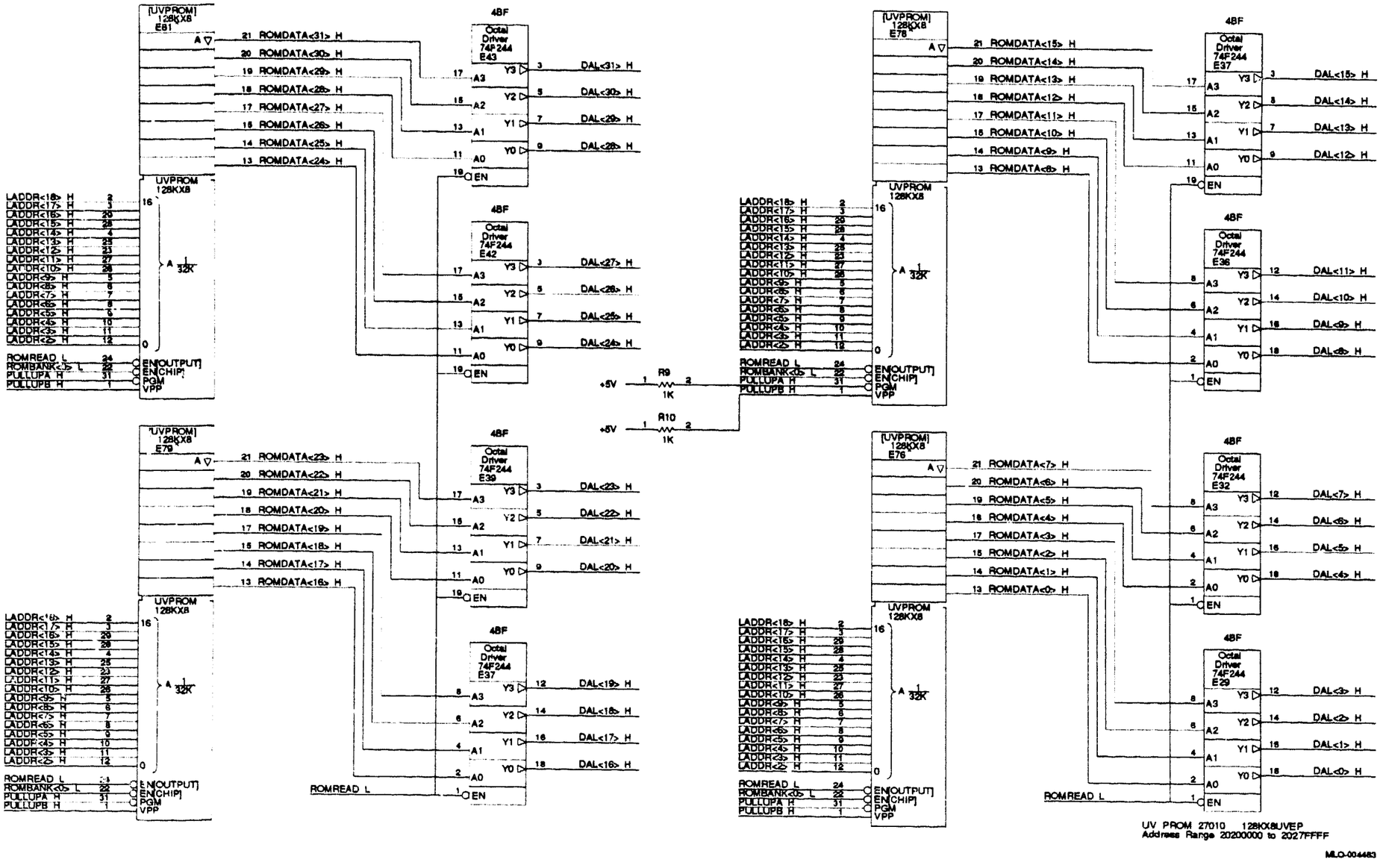
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Figure 8–21 I/O Device Interfacing: Console Interface



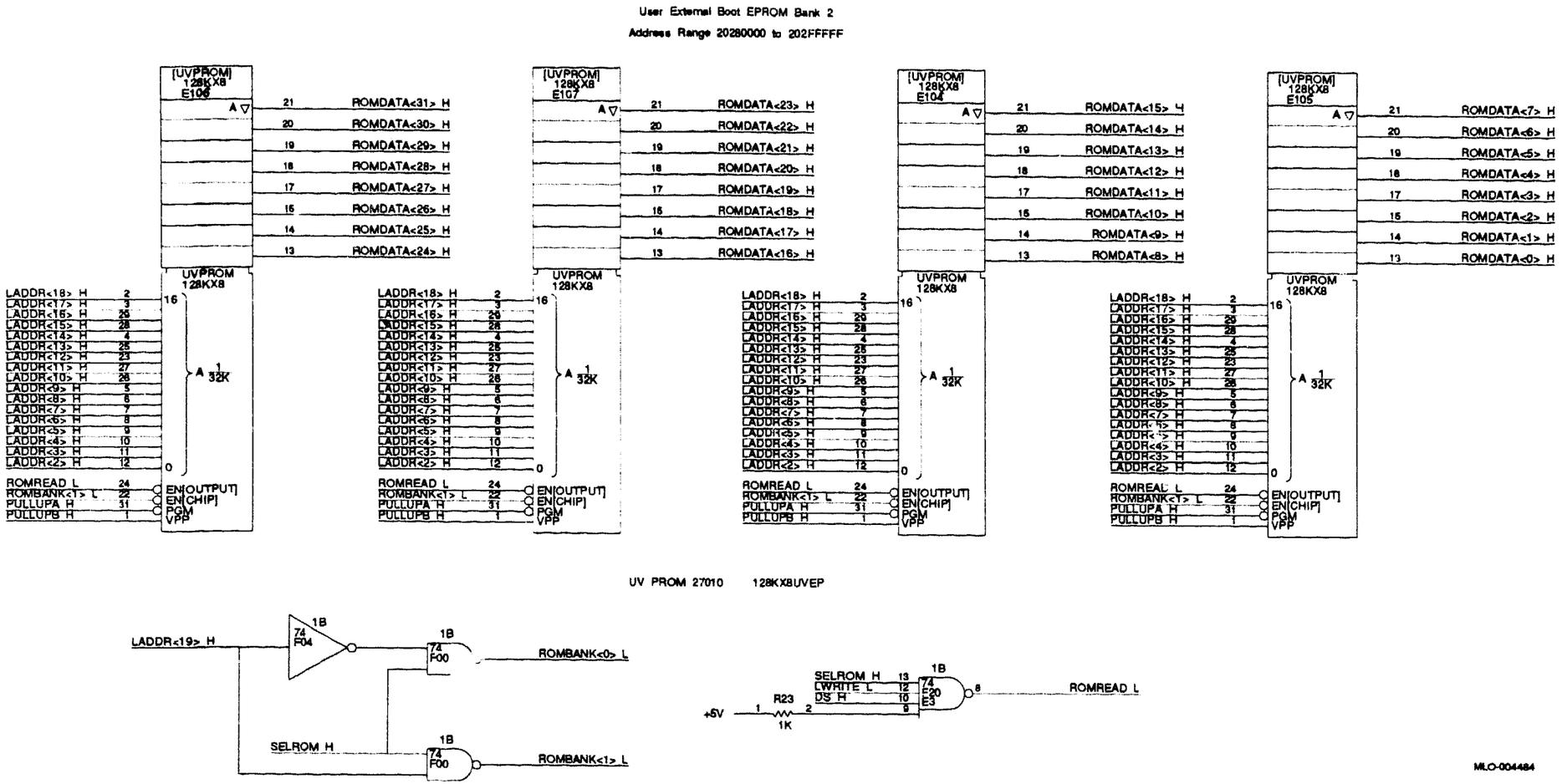
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Figure 8–22 I/O Device Interfacing: User Boot ROM Bank 1 with Drivers



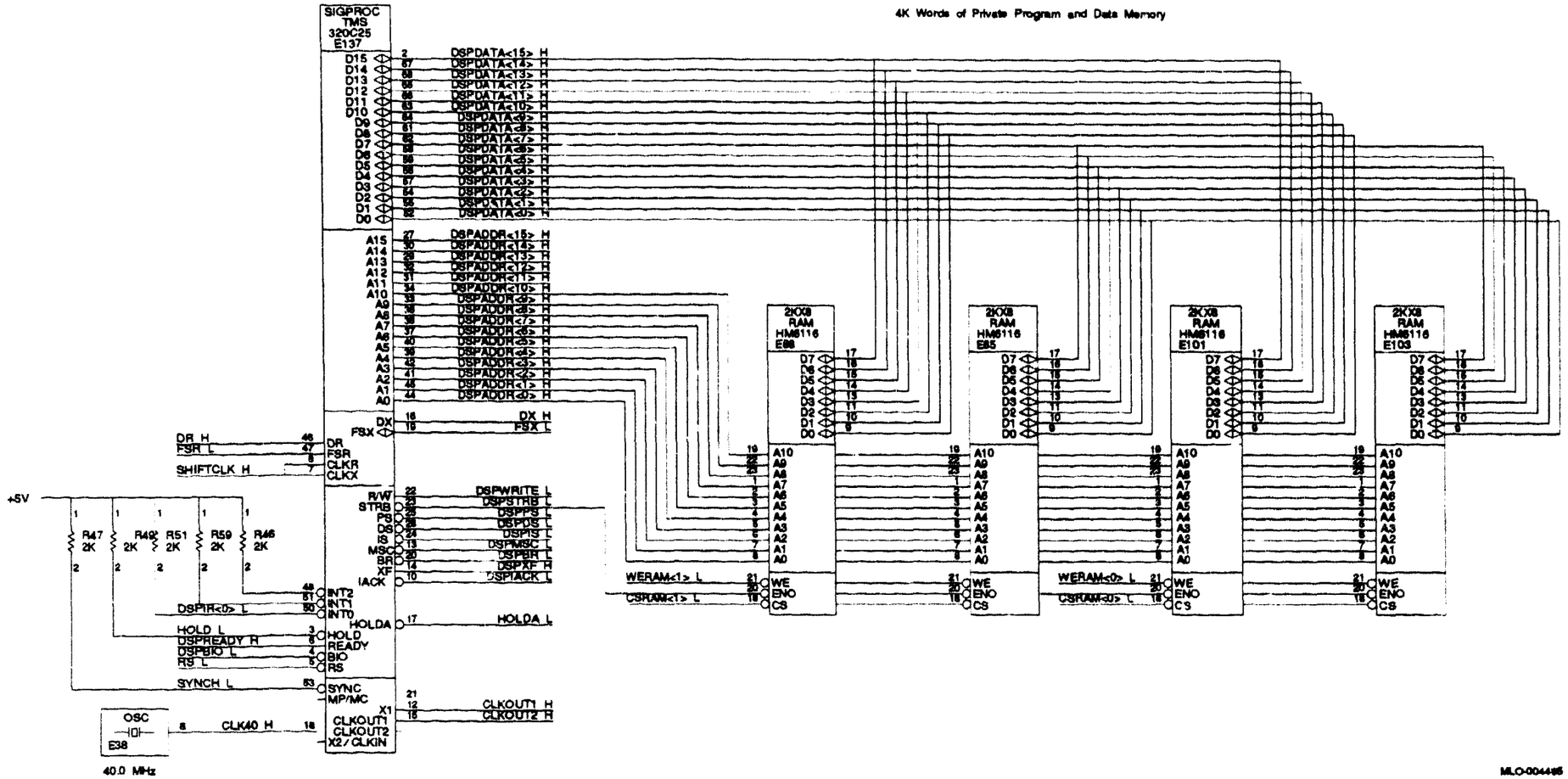
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Figure 8–23 I/O Device Interfacing: User Boot ROM Bank 2



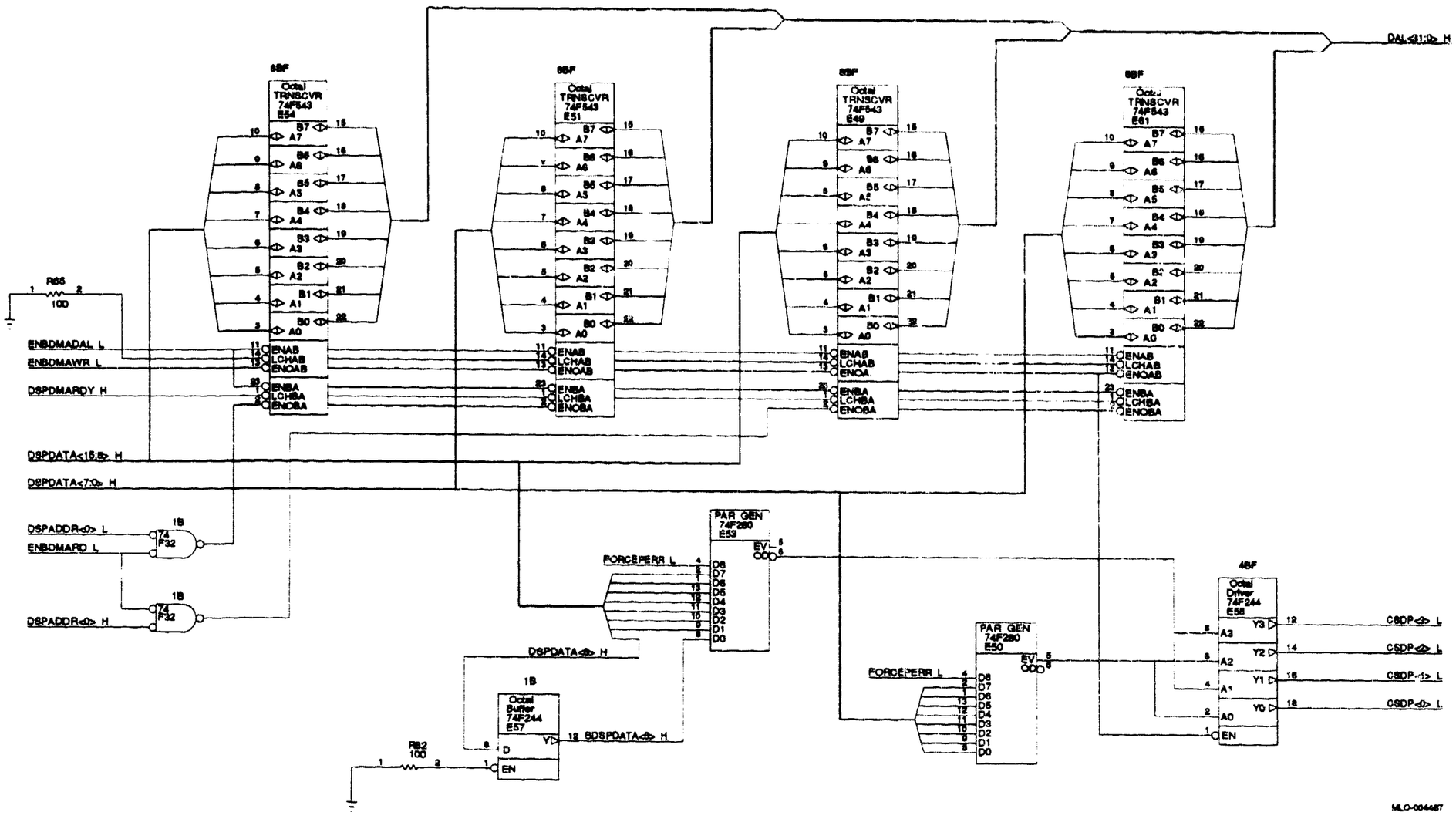
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Figure 8–24 I/O Device Interfacing: DSP and Private RAM



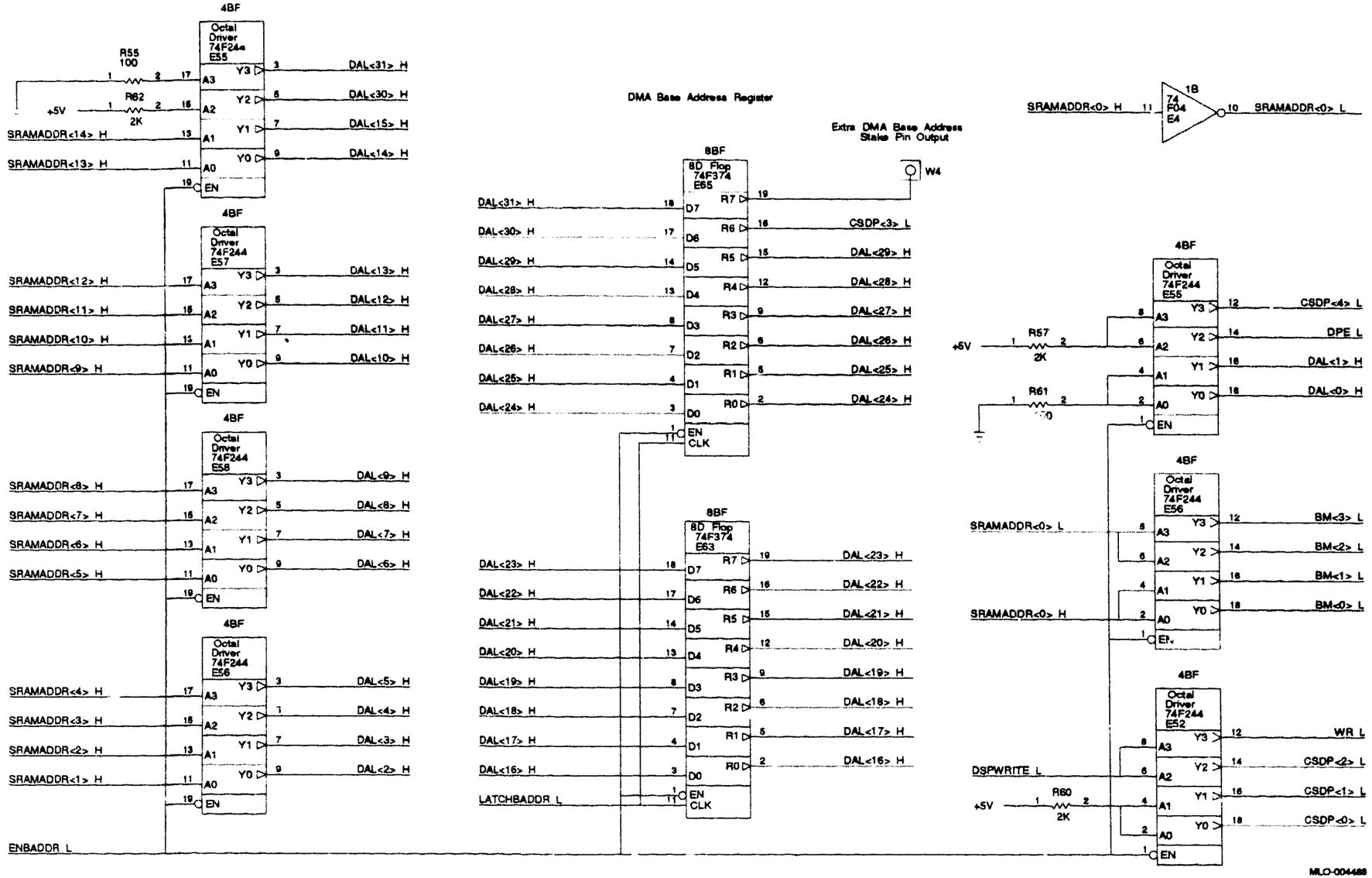
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Figure 8–25 I/O Device Interfacing: DSP DMA Transceiver and Parity Generator



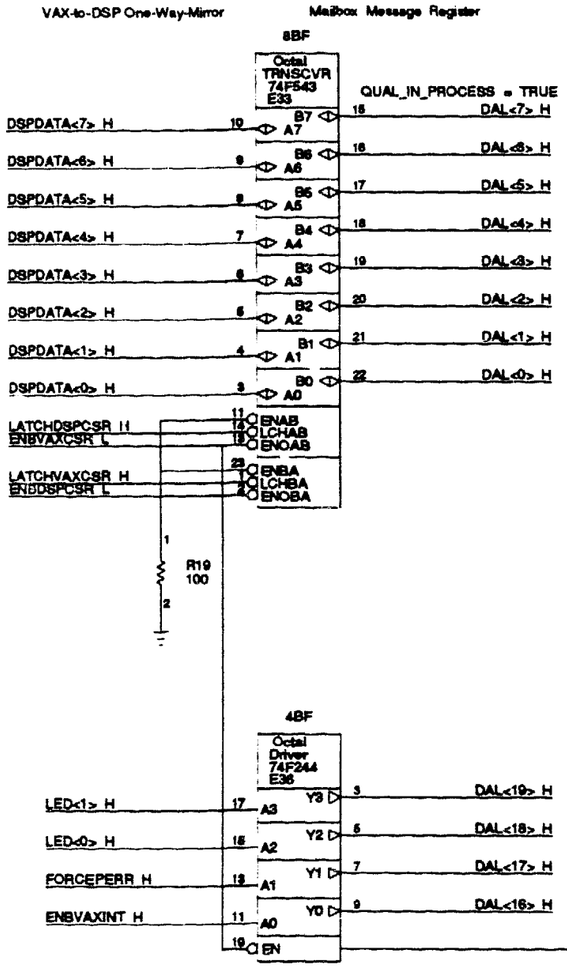
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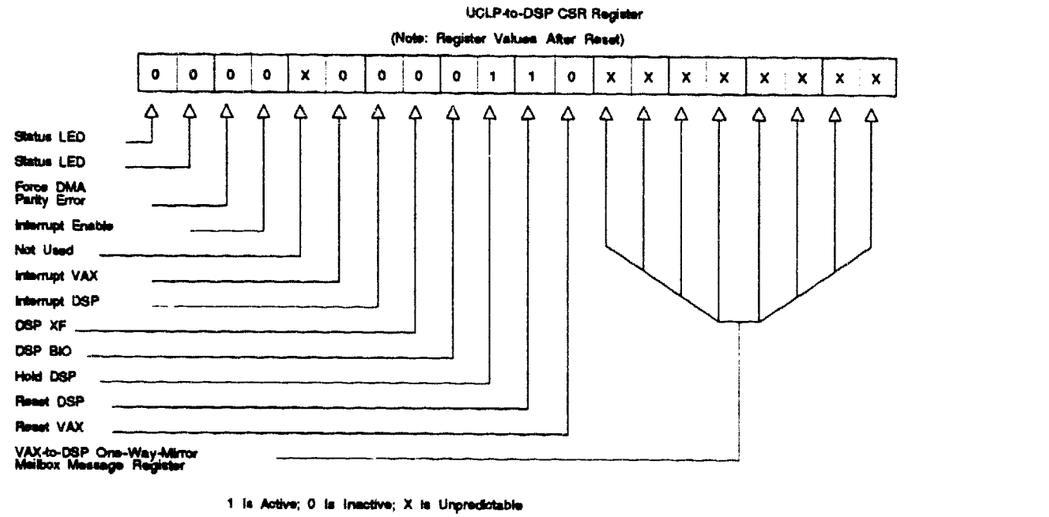
Figure 8–26 I/O Device Interfacing: DMA Address Drivers



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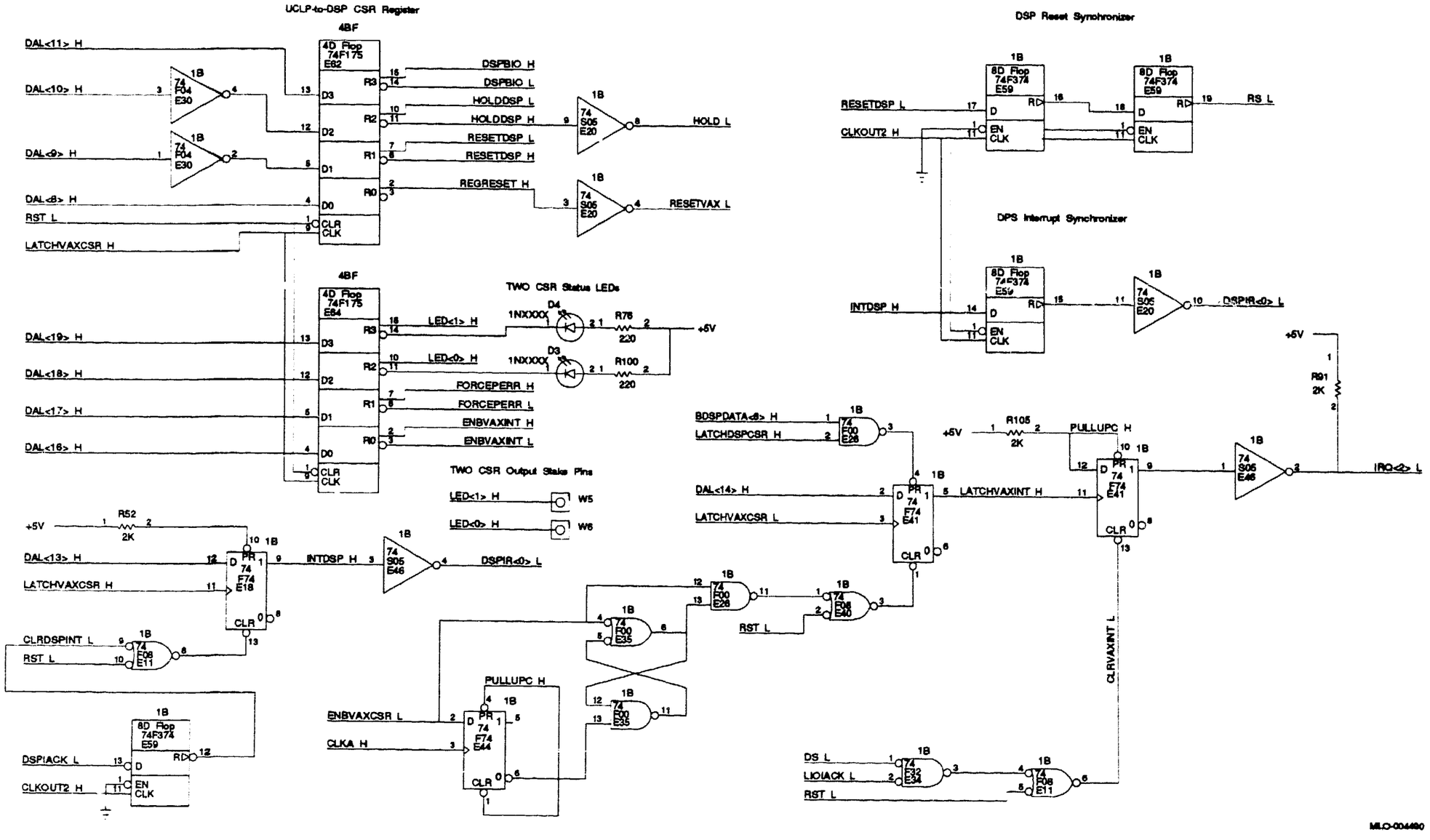
Figure 8–27 I/O Device Interfacing: VAX-to-DSP 1-Way Mirror Register





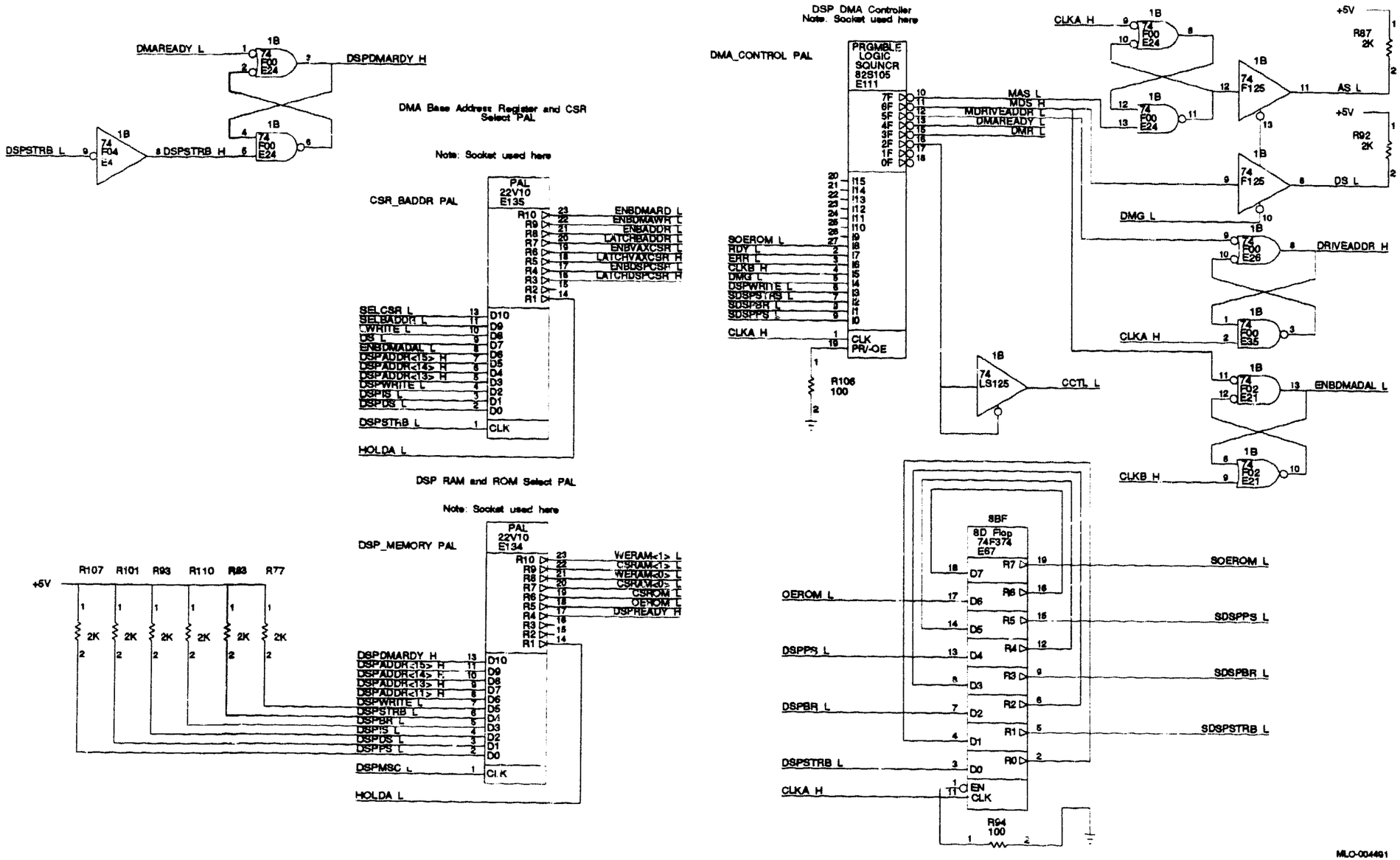
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Figure 8–28 I/O Device Interfacing: rtVAX 300 and DSP CSR



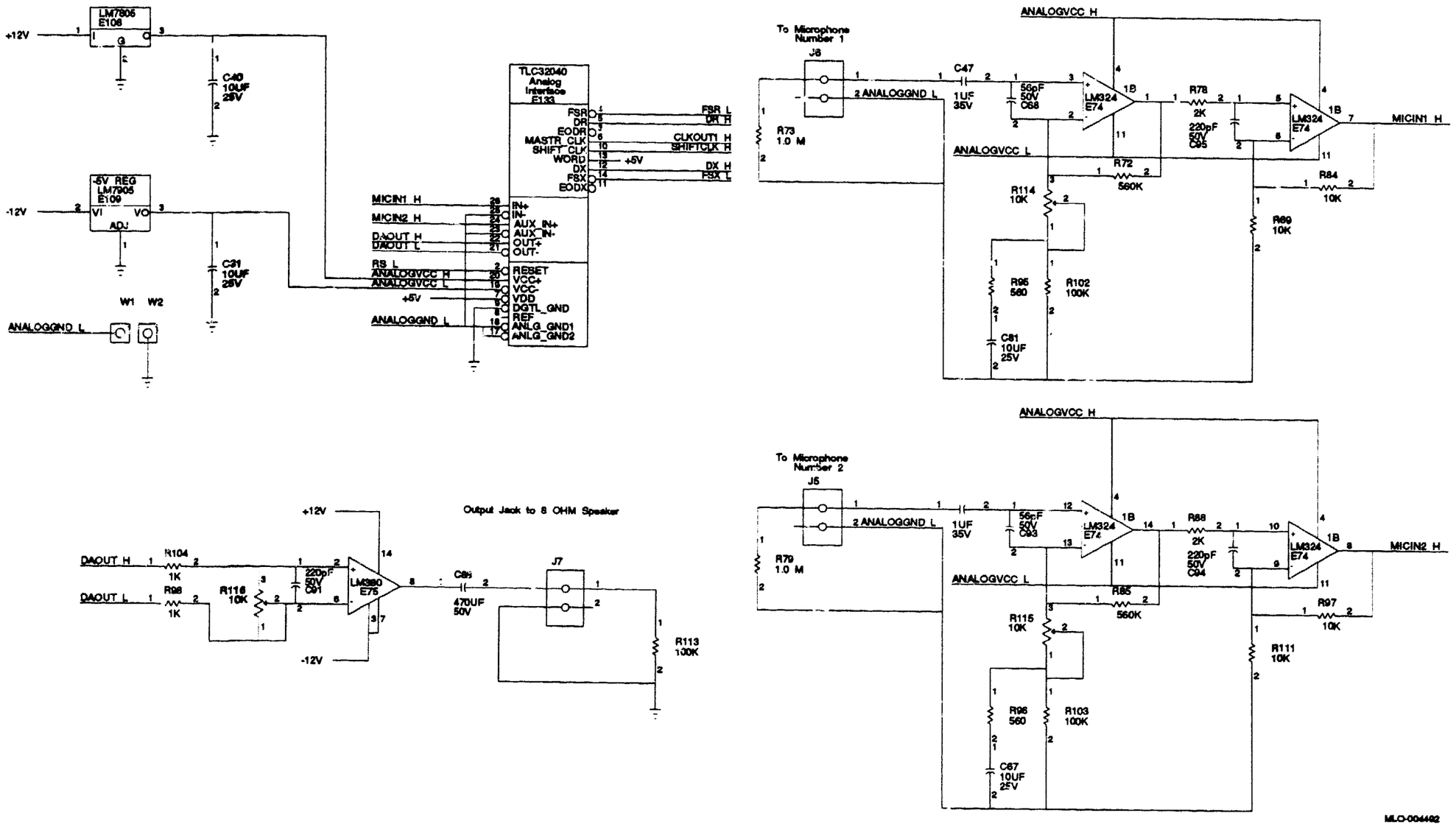
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Figure 8–29 I/O Device Interfacing: DSP DMA Controller



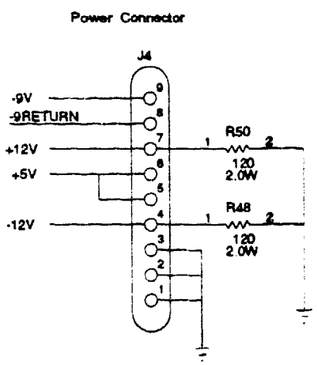
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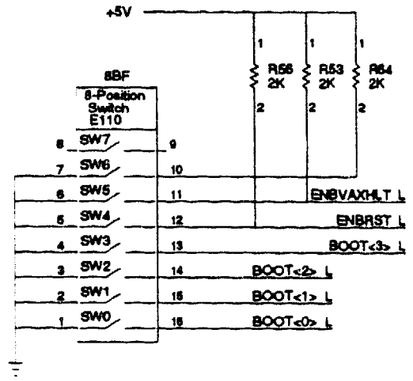
Figure 8–30 I/O Device Interfacing: D/A and A/D Interface

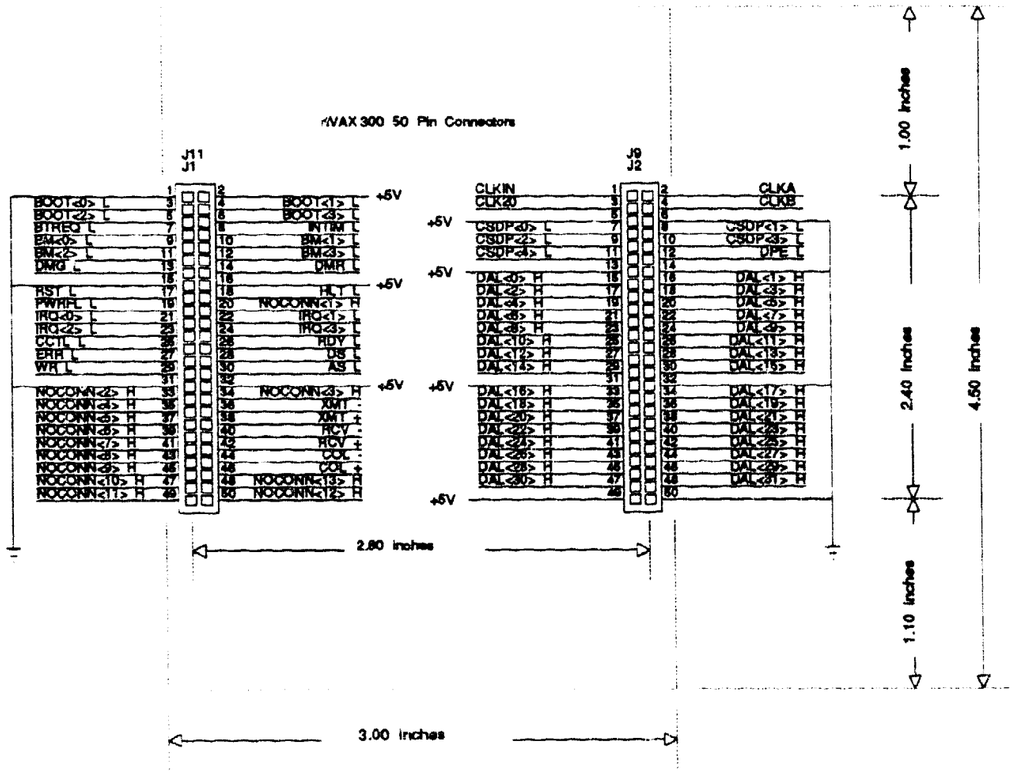


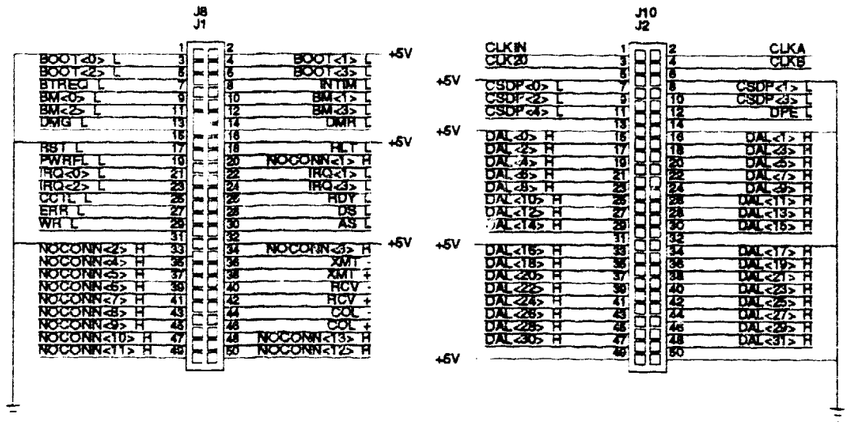
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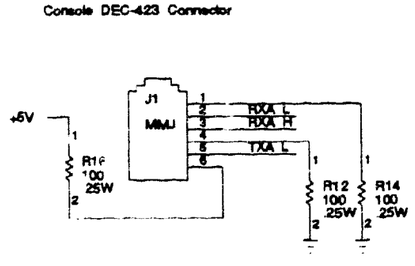
Figure 8–31 I/O Device Interfacing: rtVAX 300 I/O Pin Connectors

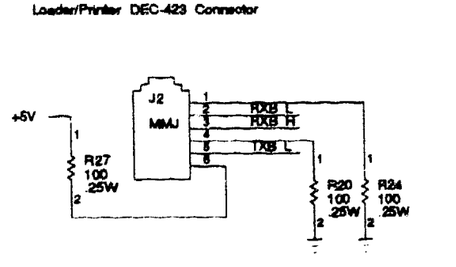








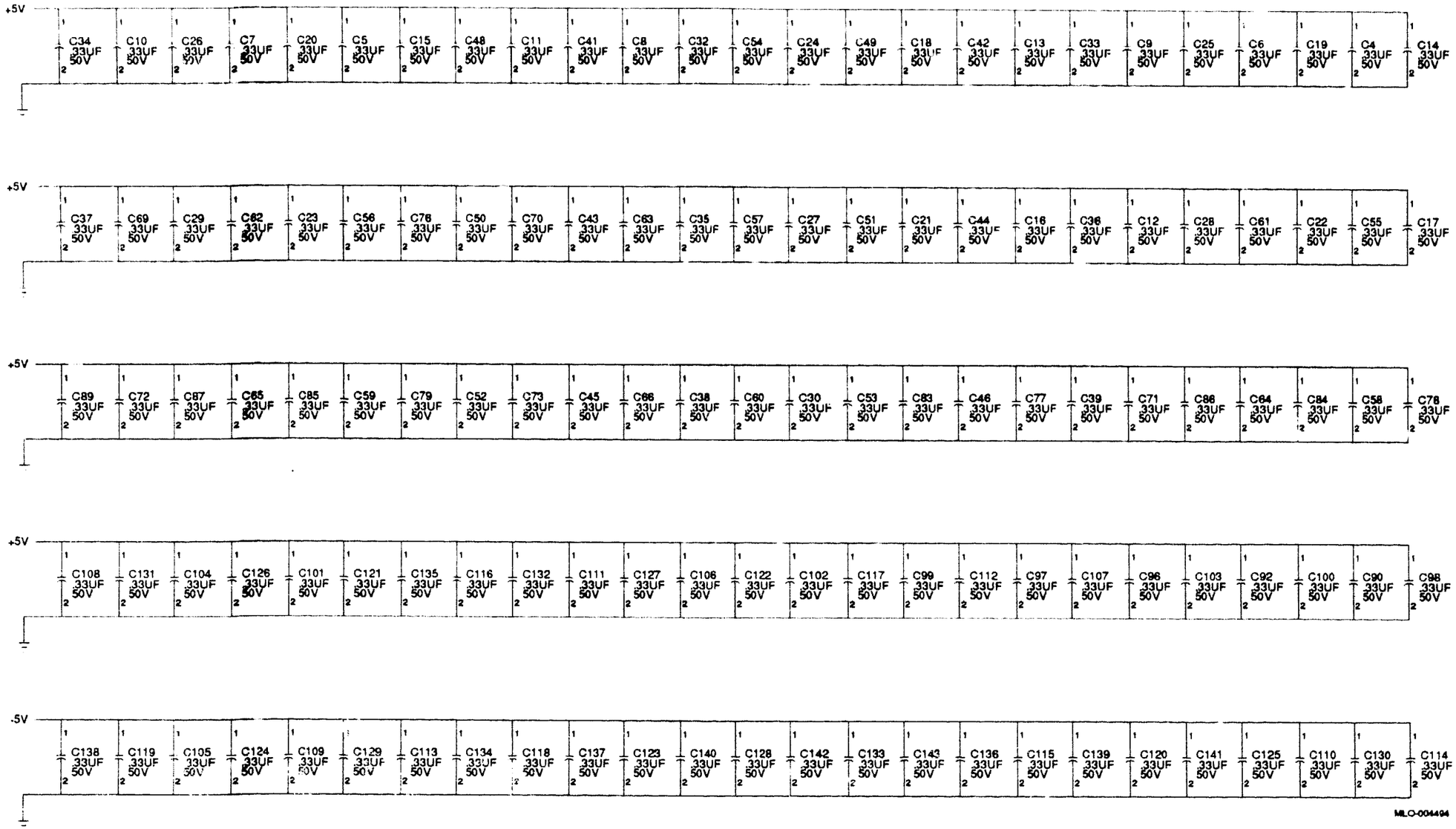


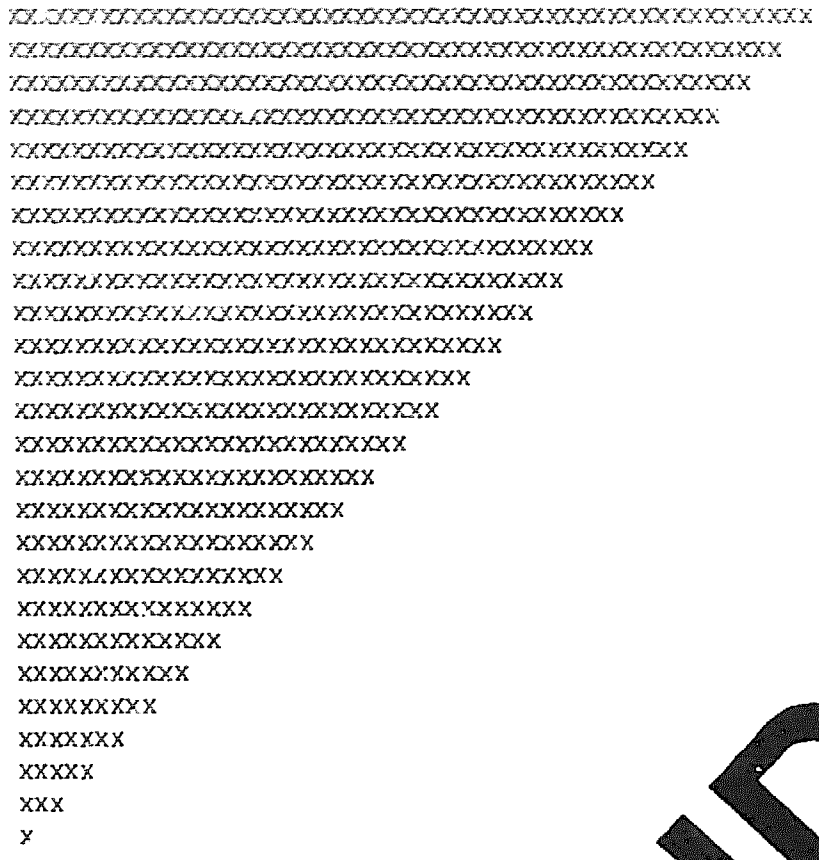


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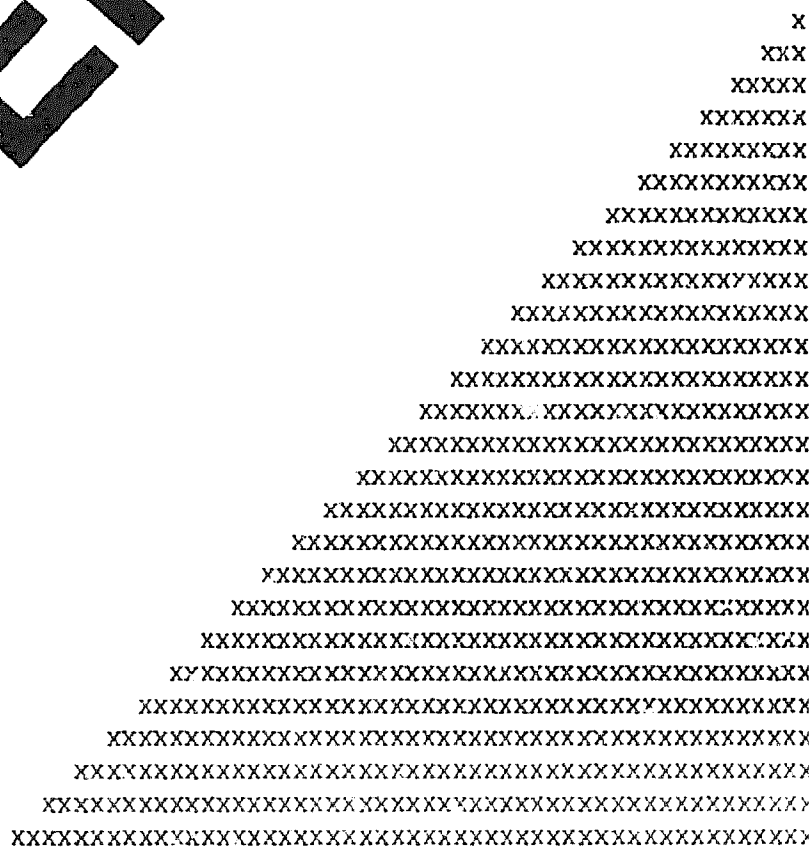
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Figure 8–32 I/O Device Interfacing: Decoupling Caps





APPENDIX-A



A

Physical, Electrical, and Environmental Characteristics

This appendix discusses the following topics:

- Physical characteristics (Section A.1)
- Electrical characteristics (Section A.2)
- Environmental characteristics (Section A.3)

A.1 Physical Characteristics

The rtVAX 300 processor is a 117 mm x 79 mm (4.61 in. x 3.11 in.) module encapsulated in a black painted metallic body. The body acts as a heat sink to dissipate the heat generated by the rtVAX 300. The rtVAX 300 weighs 142 g (5.0 oz) ±10%.

The rtVAX 300 has four mounting holes, one on each corner. Each hole is threaded for a 4-40 (U.S.A.) screw. You can use these holes either to bolt the rtVAX 300 to the mother board by using up to four screws or to provide extra grounding for the rtVAX 300 and its cover, which can help reduce electromagnetic interference (EMI). The recommended torque on the screws is 0.50 N m (4.5 in-lb) ±20%.

You can connect the rtVAX 300 connectors to other modules by means of its 100 square 0.635 mm x 0.635 mm (0.025 in. x 0.025 in.) pins.

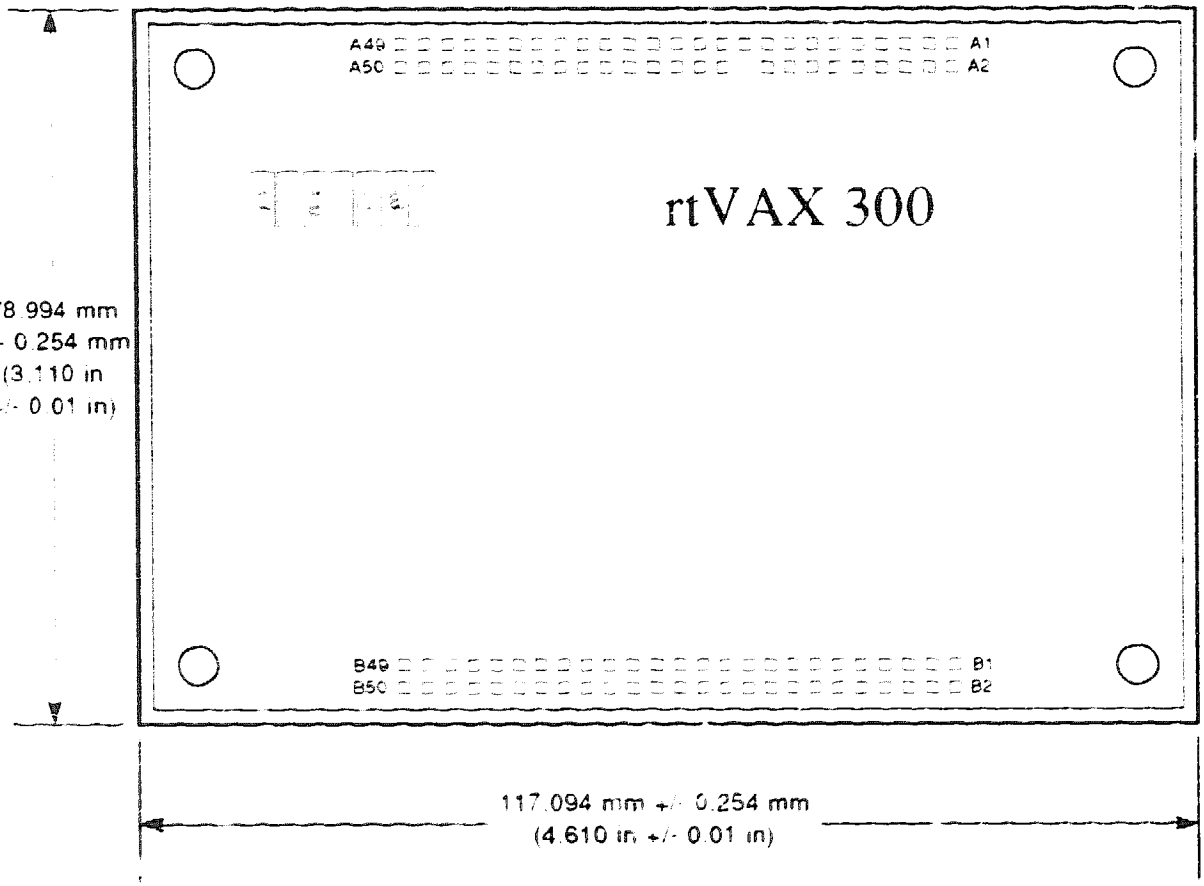
You can mount the rtVAX 300 on another module either by using standard sockets, for example, Digital part number 12–11004–05, or by soldering. Refer to Figure A–2 for footprint dimensions.

Figure A–1, Figure A–2, and Figure A–3 show a top, bottom, and side view of the rtVAX 300, respectively.

Caution

The pin face of the rtVAX 300 module has conductive components. Design the mounting to provide positive control of at least 0.010 in. clearance between these components of the rtVAX 300 module and the application module.

Figure A–1 rtVAX 300 Top View



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Figure A–2 rtVAX 300 Bottom View

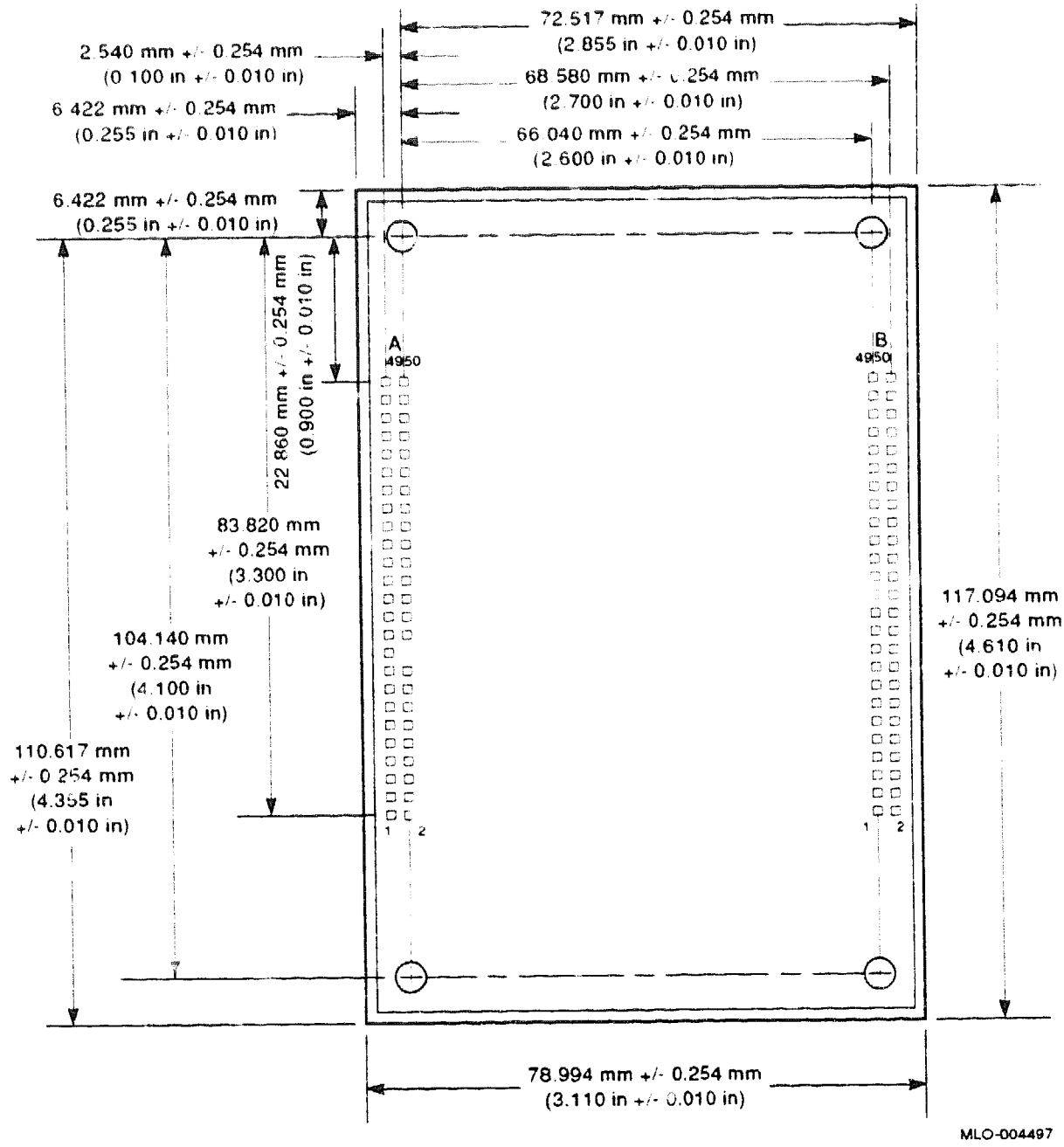
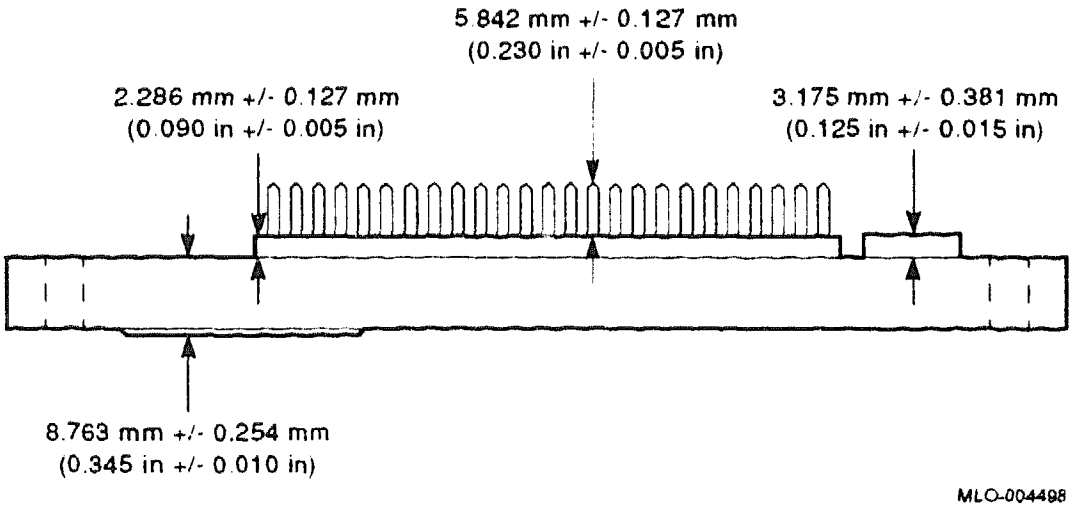


Figure A–3 rtVAX 300 Side View



A.2 Electrical Characteristics

The following tables summarize the rtVAX 300 processor's electrical characteristics:

- Table A–1—Recommended operating conditions
- Table A–2—DC characteristics
- Table A–3—AC characteristics

Table A–1 Recommended Operating Conditions

Symbol	Parameter	Minimum	Typical	Maximum	Units
Vcc	Power supply voltage	4.75	5.0	5.25	VDC
Vi	Input voltage	0		Vcc	VDC
Vo	Output voltage	0		Vcc	VDC
Ta	Operating free air temperature	0	+25.0	+ 70.0[1]	C

[1] To operate at temperatures above 50°C, the rtVAX 300 requires an airflow of at least 508 mm/s (100 LFM) across the processor.

Table A–2 DC Characteristics

Symbol	Parameter	Minimum	Maximum	Units
Vih	High-level input	2.00	–	V
Vil	Low-level input	–	0.8	V
Voh	High-level output (Ioh = 24 mA)	3.76	–	V
Vol	Low-level output (Ioh = 24 mA)	–	0.36	V
Ii	Input leakage current	–	0.1	μA
Ioz	Tri-state output off-state current	–	0.5	μA
Icc	Active supply current	–	2000	mA

Table A–3 AC Characteristics

Number	Name	Description	Minimum	Maximum	Units
1	t_{ASD}	Address strobe assertion delay	0	23	ns
2	t_{DALD}	DAL address setup/ WR assertion delay	2p–27	2p	ns
3	t_{DALH}	DAL address hold	p+6	–	ns
4	t_{DALZ}	DAL address to high impedance state	p+2	p+25	ns
5	t_{BM}	Byte mask setup	9	p	ns
6	t_{DSD}	DS strobe assertion delay	2p	2p+27	ns
7	t_{DS}	DAL data setup	28	–	ns
8	t_{DH}	DAL data hold	5	–	ns
9	t_{DZ}	DAL data to high impedance state	40	–	ns
10	t_{DPS}	Parity setup	26	–	ns
11	t_{SWS}	RDY and ERR sample window setup	23	–	ns
12	t_{SWH}	RDY and ERR sample window hold	5	45	ns
13	t_{DSID}	DS strobe deassertion delay	0	25	ns
14	t_{ASID}	AS strobe deassertion delay	p	p+28	ns
15	t_{DALIZ}	DAL undefined delay	p+28	p+51	ns
16	t_{BMH}	BM hold	2p	–	ns
17	t_{WRH}	WR hold	p	–	ns
18	t_{DPES}	DPE setup	10	p	ns
19	t_{DPEH}	DPE hold time	p	–	ns
20	t_{DMGSD}	DMG assertion delay	0	43	ns
21	t_{SHLZ}	Strobe high impedance delay	0	27	ns
22	t_{DSDLY}	DS delay after DMG	6p	–	ns
23	t_{DALHLZ}	DAL high impedance delay	–	42	ns
24	t_{SYNS}	Asynchronous input setup	23	–	ns
25	t_{SYNH}	Asynchronous input hold	23	–	ns
26	t_{ASADRH}	DAL hold during cache invalidate	20	–	ns
27	$t_{CCTLCYC}$	CCTL cycle time during octaword invalidate	11p	–	ns

(continued on next page)

Table A–3 (Cont.) AC Characteristics

Number	Name	Description	Minimum	Maximum	Units
28	t_{ASDLY}	AS delay from asserting CCTL during cache invalidate	0	4p	ns
29	t_{ASADRS}	DAL setup during cache invalidate	25	–	ns
30	t_{DMRG}	DMR maximum assertion after DMG	–	6000	ns
31	t_{RSTW}	Reset assertion width	30p	–	ns
32	t_{RSTD}	Strobe delay after reset	0	25	ns
33	t_{RSTS}	Reset input setup prior to P1	20	2p–10	ns
34	t_{INTASD}	Initial AS delay	40p	–	ns
35	t_{ZRDY}	Z-state RDY to RDY H	11	–	ns
36	t_{RDYZ}	RDY deasserted to RDY Z	–	2p	ns
37	t_{CS4S}	CSDP<4> setup time	2p–42	2p	ns
38	t_{ASWO}	Minimum AS assertion time for octaword cache invalidation	21p	–	ns
39	t_{ASWQ}	Minimum AS assertion time for quadword cache invalidation	10p	–	ns

Note: p = 0.25 microcycle = 0.50 CLKA cycle = 25 ns for 20 MHz

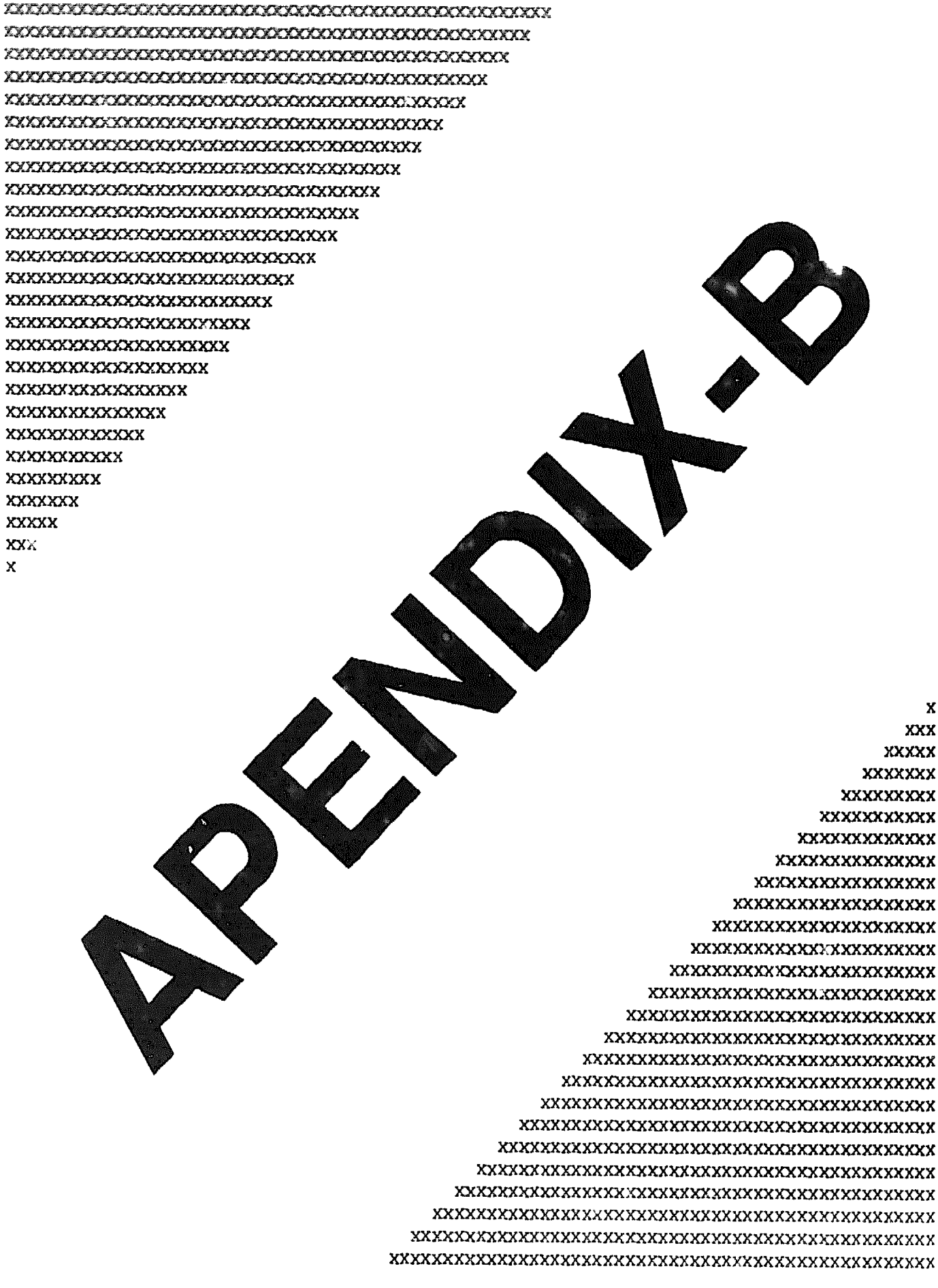
A.3 Environmental Characteristics

Environmental characteristics include:

- Temperature—Operating temperature 0°C to 70°C, with the following restrictions:
  - 0°C to 50°C—No fan required, natural convection cooling.
  - 50°C to 70°C—Fan required with at least 508 mm/s (100 LFM) across the rtVAX 300 processor.

  The rtVAX 300 has no preferred orientation for cooling with fan-assisted convection. When natural convection cooling is employed, the rtVAX 300 processor should be mounted with the internal circuit board in a vertical plane.
- Relative humidity
  - Operating: 10% to 90%, noncondensing.
  - Storage: 10% to 95%, noncondensing.
- Altitude—Operating and storage as they relate to altitude (standard atmosphere and standard gravity) are as follows:
  - Operating: The rtVAX 300 can operate at an altitude of up to 2.4 km.
  - Storage: The rtVAX 300 is not mechanically or electrically damaged at altitudes of up to 4.9 km.
- Shock and vibration—Nonoperating tolerances are as follows:
  - Mechanical shock: 30 G, 11 ms, 1/2 sine pulses.
  - Vibration sine: 5 G peak, up to 2000 Hz.
  - Vibration random: 0.032 g^2/Hz, up to 2000 Hz.

    where g^2 = the gravitational acceleration constant squared, where the gravitational constant is 9.8 meters/sec/sec (32.2 feet/sec/sec)
- Contamination—The rtVAX 300 should be stored and used in a noncaustic environment.


APENDIX-B

B

Acronyms

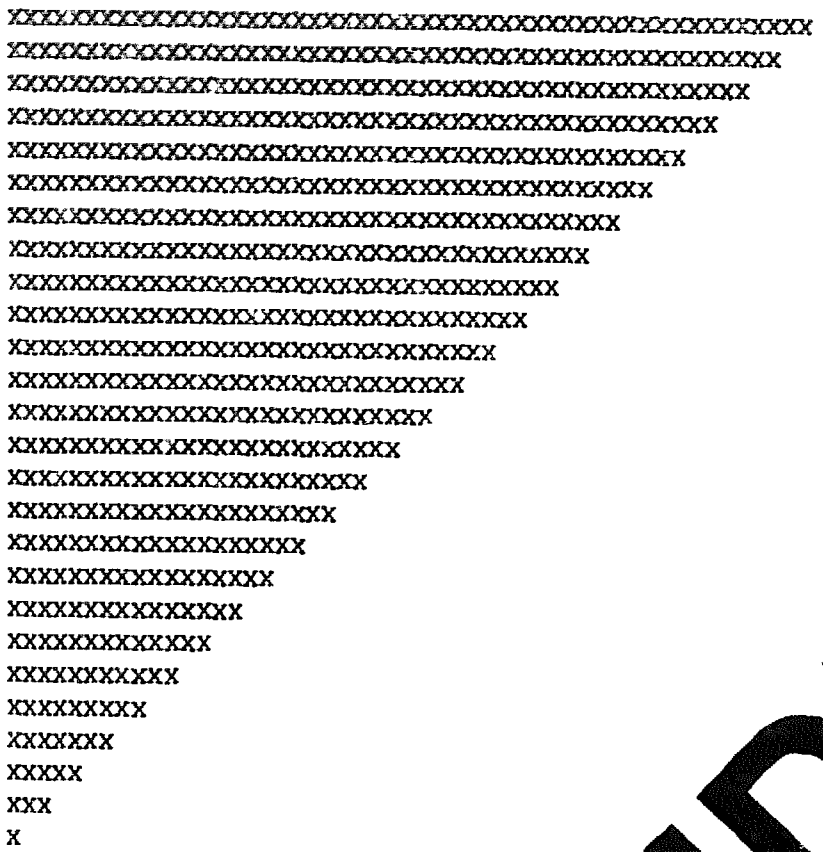
This appendix defines tne acronyms used most frequently in this guide.

Acronym	Definition
+5V	+5 V dc power
20MHz	20 MHz clock output
ACR	DUART auxiliary control register
AS	Address strobe bus interface signal
ASTLVL	AST level internal processor register
BM	Byte masks
BTREQ	Request reboot output from Ethernet controller signal
CADR	Cache disable internal processor register
CAS	Column address strobe
CCTL	Cache control bus interface signal
CFPA	CVAX's floating-point coprocessor
CLKA	CPU clock outputs bus interface signal
CLKB	CPU clock outputs bus interface signal
CLKIN	System clock input signal
CLK20	20 MHz clock output bus interface signal
COL	Ethernet collision detect bus interface signal
CONE	Console enable signal
CRA	DUART channel A command register
CRB	DUART channel B command register
CSDP	Cycle status/data parity bus interface signal
CSRA	DUART channel A clock select register
CSRB	DUART channel B clock select register

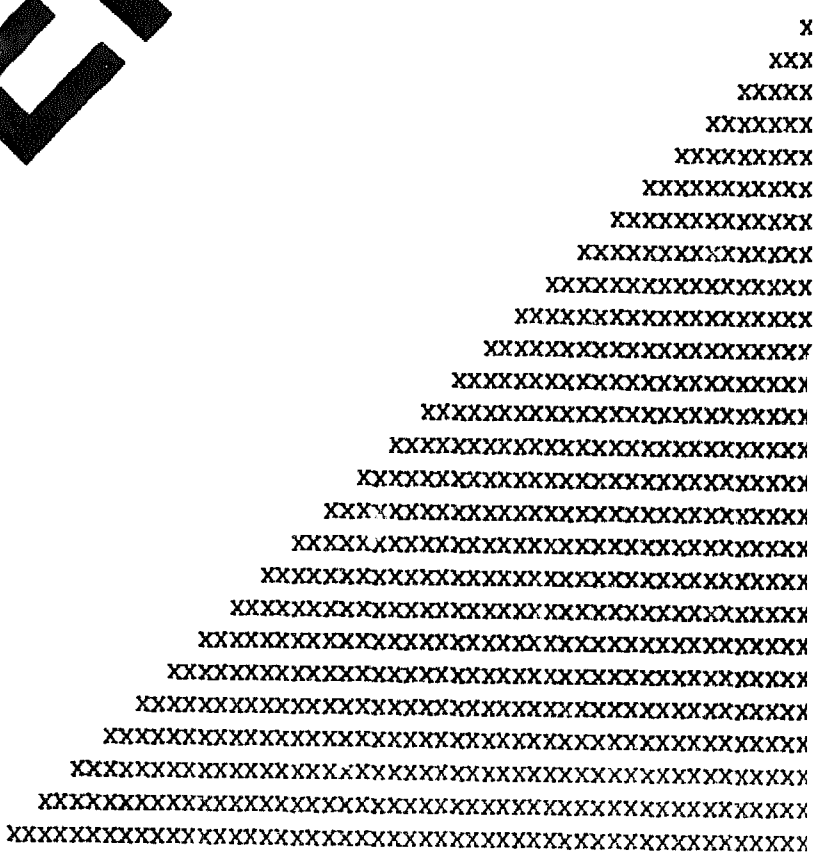
Acronym	Definition
CTL	DUART counter/timer register (lower)
CTU	DUART counter/timer register (upper)
CVAX	CMOS VAX microprocessor, the rtVAX 300 processor's CPU
DAL	Data and address lines
DMA	Direct memory access
DMG	DMA grant bus interface signal
DMR	Direct memory request bus interface signal
DPE	Data parity enable bus interface signal
DRAM	Dynamic, random-access memory
DS	Data strobe bus interface signal
DSP	Digital signal processor
DUART	Dual universal asynchronous receiver/transmitter
ERR	Bus error input interface signal
ESP	Executive stack pointer internal processor register
GND	5V ground (return) signal
HLT	Halt processor bus interface signal
ICCS	Interval clock control and status internal processor register
IMR	DUART channel A and B interrupt mask/status register
IPCR	DUART input port change register
IPL	Interrupt priority level
IPR	Internal processor register
IRQ	Interrupt request bus interface signal
ISP	Interrupt stack pointer internal processor register
ISR	Interrupt status register; interrupt service routine
KSP	Kernel stack pointer internal processor register
MAPEN	Memory management enable internal processor register
MRA	DUART channel A mode registers
MRB	DUART channel B mode registers
MSER	Memory system error internal processor register
NI	Network Interface
OPCR	DUART output port configuration register

Acronym	Definition
P0BR	P0 base internal processor register
P0LR	P0 length internal processor register
P1BR	P1 base internal processor register
P1LR	P1 length internal processor register
PCBB	Process control block base, internal processor register
PPTE	Processor page table entry, processor PTE
PTE	Page table entry, entry in page table of memory map
PWRFL	Power failure interrupt bus interface signal
QMR	Q22-bus map register
RAM	Random-access memory
RAS	Row address strobe
RCV	Ethernet receive data bus interface signal
RDY	Bus ready input interface signal
RHRA	DUART channel A Rx holding register
RHRB	DUART channel B Rx holding register
ROM	Read-only memory
RST	Reset bus interface signal
SAVPC	Console saved PC internal processor register
SAVPSL	Console saved PSL internal processor register
SBR	System base internal processor register
SCBB	System control block base internal processor register
SGEC	Second-generation Ethernet coprocessor
SLA	Serial interface adapter
SID	System identification internal processor register
SIRR	Software interrupt request internal processor register
SISR	Software interrupt summary internal processor register
SLR	System length internal processor register
SLU	Serial-line unit
SRA	DUART channel A status register
SRAM	Static random-access memory
SRB	DUART channel B status register

Acronym	Definition
SSP	Supervisor stack pointer internal processor register
TBCHK	Translation buffer check internal processor register
TBIA	Translation buffer invalidate all internal processor register
TBIS	Translation buffer invalidate single internal processor register
THRA	DUART channel A Tx holding register
THRB	DUART channel B Tx holding register
USP	User stack pointer internal processor register
WR	Write line bus interface signal
XMT	Ethernet transmit data bus interface signal



APPENDIX-C



C

Address Assignments

This appendix covers the following topics:

- Memory space (Table C–1)
- Input/output space (Table C–2)
- Local register input/output space (Table C–3)

Table C–1 Memory Space

Address Range	Contents
00000000—0FFFFFFF	Cached read/write memory space (256M bytes)
10000000—1FDFFFFF	Cached read-only memory space (254M bytes)
1FE00000—1FFFFFFF	Reserved memory space (2M bytes)

Table C–2 Input/Output Space

Address Range	Contents
20000000—201FFFFF	Local register I/O space (2M bytes)
20200000—3FFFFFFF	User I/O space (510M bytes)

Table C–3 Local Register Input/Output Space

Address Range	Contents
20000000—20007FFF	Reserved local register I/O space
20008000—2000803F	Ethernet coprocessor register I/O space
20008040—2000FFFF	Reserved local register I/O space
20010000—20011007F	Network interface address ROM I/O space
20010080—2003FFEB	Reserved local register I/O space
2003FFEC—2003FFFF	Boot register
20040000—2007FFFF	rtVAX 300 boot/diagnostic ROM space
20080000—200FFFFF	User boot/diagnostic ROM space
20100000—2010003F	Console DUART register I/O space
20100040—2010FFFF	Reserved local register I/O space
20110000—20110003	Memory system control/status register
20110004—201FFFFB	Reserved local register I/O space
201FFFFC—201FFFFF	LED display/status register

APPENDIX-D

D

User Boot/Diagnostic ROM Sample

This appendix contains a template of the functions that might be incorporated in a user-supplied boot and diagnostic ROM.

```
        .title  300USERROM - rtVAX 300 User Boot/Diagnostic Firmware
        .ident  /rtVAX 300 V1.0-00/

;
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; by Digital Equipment Corporation, Maynard, Massachusetts
;
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;
; Digital assumes no responsibility for the use or reliability of its
; software on equipment which is not supplied by Digital.
;
```

```
; ++
; FACILITY:
;
;    rtVAX 300 User Boot/Diagnostic Firmware
;
; ABSTRACT:
;
;    This module contains routines to provide user-defined  rtVAX 300
;    ROM-based board-level initialization and diagnostics.
;
;    It is a template intended to serve as  the  starting  point  for
;    implementing  rtVAX 300 User Boot and Diagnostic routines.  When
;    used as a template, the code  and  definitions  for  the  sample
;    routines should be modified and expanded as needed.
;
;    Assemble ROM-based firmware modules as follows:
;
;    $ MACRO/LIST/OBJECT 300USERROM.MAR+KERMAC.MLB/LIBRARY
;
;    Note that the above assumes that KERMAC.MLB macro library can be
;    found in your default directory.
;
;    Build an executable image by specifying the ROM's  base  address
;    as follows:
;
;    $ LINK/SYSTEM:%X20080000/MAP/FULL 300USERROM.OBJ
;
; AUTHOR:
;
;    Realtime Software Engineering,  CREATION DATE: 15-Feb-1991
;
; MODIFIED BY:
;
;    modifier's name,   dd-mmm-yyyy,  VERSION: svv.u-ep
; 01 - modification description
;
; --

        .sbttl  Module Declarations

;
; INCLUDE FILES:
;

        ; 'kermac' library symbol definitions

        $cpu300def                      ; define rtVAX 300 specific offsets,
                                        ; registers, etc.

        ; 'starlet' library symbol definitions

        $dscdef                         ; define memory bitmap descriptor
```

```
;
; MACROS:
;

        ; macro to define rom code or read-only data program section

        .macro  usrom_share psect_alignment=long
                .psect  usrom$zcode,pic,rd,nowrt,quad
                .list   meb
                .align  psect_alignment
        .endm           usrom_share

;
; EQUATED SYMBOLS:
;

        ; rtVAX 300 board-level test flagword fields

        $vield  _300,0,<                - ; define test flagword fields
                  <btf_testcmd,1,m>,    - ; explicitly invoked by TEST command
                  <btf_powerup,1,m>,    - ; test invoked by power-up sequence
                  <btf_fatlerr,1,m>,    - ; test returns control immediately
                                        - ; upon failure
                  <btf_consdev,1,m>,    - ; console slu is present
                  <btf_dsply,  1,m>,    - ; led display is present
                  <           ,27,>,    - ; reserved (always read as 0's)
                >

        ; rtVAX 300 console program read/write data offsets

        _300$b_cpmbx    =  0            ; console program mailbox
        _300$b_cpflg    =  1            ; console program flags
        _300$b_bootdev  =  2            ; default boot device

        ; rtVAX 300 user boot/diagnostic ROM offsets

        $defini _300$usrom,LOCAL,0                  ;
        $def    _300$l_usrom_reserved_1 .blkb 28 ; reserved area
        $def    _300$l_usrom_board_init .blkl 1  ; address of board-level init
        $def    _300$l_usrom_test_8     .blkl 1  ; address of board-level test
        $def    _300$l_usrom_test_9     .blkl 1  ; address of board-level test
        $def    _300$l_usrom_test_10    .blkl 1  ; address of board-level test
        $def    _300$l_usrom_test_11    .blkl 1  ; address of board-level test
        $def    _300$l_usrom_test_12    .blkl 1  ; address of board-level test
        $def    _300$l_usrom_test_13    .blkl 1  ; address of board-level test
        $def    _300$l_usrom_test_14    .blkl 1  ; address of board-level test
        $def    _300$l_usrom_reserved_2 .blkb 4  ; reserved area
        $def    _300$l_usrom_shared     .blkb 0  ; start of board-level init an
                                                 ; diagnostic testing code/data
        $defend _300$usrom                       ;
```

```
;
; LOCAL STORAGE:
;

        ; rtVAX 300 user boot/diagnostic rom entry points

        .psect  usrom$ycode,pic,rd,nowrt,quad

_300$al_usrom_vector::
        .long   ^x0003101               ; reserved
        .byte   00,01,02,03             ; rom index numbers
        .byte   02,02,02,02             ; reserved
        .quad   0                       ; reserved
        .quad   0                       ; reserved (mbz)
        assume  <.-_300$al_usrom_vector> eq _300$l_usrom_board_init
        .address _300$usrom_board_init  ; address of board-level initialization
        assume  <.-_300$al_usrom_vector> eq _300$l_usrom_test_8
        .address _300$usrom_test_8      ; address of board-level test 8
        assume  <.-_300$al_usrom_vector> eq _300$l_usrom_test_9
        .address _300$usrom_test_9      ; address of board-level test 9
        assume  <.-_300$al_usrom_vector> eq _300$l_usrom_test_10
        .address _300$usrom_test_10     ; address of board-level test 10
        assume  <.-_300$al_usrom_vector> eq _300$l_usrom_test_11
        .address _300$usrom_test_11     ; address of board-level test 11
        assume  <.-_300$al_usrom_vector> eq _300$l_usrom_test_12
        .address _300$usrom_test_12     ; address of board-level test 12
        assume  <.-_300$al_usrom_vector> eq _300$l_usrom_test_13
        .address _300$usrom_test_13     ; address of board-level test 13
        assume  <.-_300$al_usrom_vector> eq _300$l_usrom_test_14
        .address _300$usrom_test_14     ; address of board-level test 14
        .long   0                       ; reserved (mbz)
        assume  <.-_300$al_usrom_vector> eq _300$l_usrom_shared

;
; EXTERNAL REFERENCES:
;

        ; no external data/routines directly referenced in this module

        .sbttl          rtVAX 300 Board-level Initialization
```

```
; ++
; FUNCTIONAL DESCRIPTION:
;
;    This routine  (user-supplied) is called by the rtVAX 300's  resident
;    firmware at system power-on to do any board-level initialization. It
;    is called at IPL 31, in kernel mode with memory management disabled.
;
; CALLING SEQUENCE:
;
;    calls  #3,_300$usrom_board_init
;
; INPUT PARAMETERS:
;
;    cpmbx    -  address of console mailbox
;    bitmap   -  address of memory bitmap descriptor
;    scratch  -  address of scratch memory area
;
; IMPLICIT INPUTS:
;
;    ** None **
;
; OUTPUT PARAMETERS:
;
;    ** None **
;
; IMPLICIT OUTPUTS:
;
;    ** None **
;
; ROUTINE VALUE:
;
;    ** None **
;
; SIDE EFFECTS:
;
;    ** None **
;
; --

        ; board-level initialization argument block offsets

        offset  <-
                cpmbx,                  - ; address of console mailbox
                bitmap,                 - ; address of memory bitmap descriptor
                scratch                 - ; address of scratch memory area
                >

        usrom_share  byte

_300$usrom_board_init::
        .word       ^m<>
        ret                             ; return to caller
```

```
        .sbttl      rtVAX 300 Board-level Test 8

; ++
; FUNCTIONAL DESCRIPTION:
;
;    This routine  (user-supplied) is called by the rtVAX 300's  resident
;    firmware at system power-on to do board-level test 8.   It is called
;    at IPL 31, in kernel mode with memory management disabled.
;
; CALLING SEQUENCE:
;
;    calls  #5,_300$usrom_test_8
;
; INPUT PARAMETERS:
;
;    scratch        -  address of scratch memory area
;    failing_pc     -  address of longword to store failing pc
;    expected_data  -  address of quadword to store expected data
;    actual_data    -  address of quadword to store actual data
;    flags          -  board-level test flags
;
; IMPLICIT INPUTS:
;
;    ** None **
;
; OUTPUT PARAMETERS:
;
;    r0  -  test results
;
; IMPLICIT OUTPUTS:
;
;    ** None **
;
; ROUTINE VALUE:
;
;    -1  -  device not present or untestable
;    0   -  test failed
;    1   -  test passed
;
; SIDE EFFECTS:
;
;    ** None **
;
; --

        ; board-level test 8 argument block offsets
```

```
        offset  <-
                scratch,                - ; address of scratch memory area
                failing_pc,             - ; address of longword to store failing
                                        - ; pc if test fails
                expected_data,          - ; address of quadword that test can
                                        - ; store expected data if test fails
                actual_data,            - ; address of quadword that test can
                                        - ; store actual data if test fails
                flags                   - ; board-level test flags
                >

        usrom_share  byte

_300$usrom_test_8::
        .word       ^m<>
        ret                             ; return to caller

        .sbttl      rtVAX 300 Board-level Test 9

; ++
; FUNCTIONAL DESCRIPTION:
;
;    This routine  (user-supplied) is called by the rtVAX 300's  resident
;    firmware at system power-on to do board-level test 9.   It is called
;    at IPL 31, in kernel mode with memory management disabled.
;
; CALLING SEQUENCE:
;
;    calls  #5,_300$usrom_test_9
;
; INPUT PARAMETERS:
;
;    scratch        -  address of scratch memory area
;    failing_pc     -  address of longword to store failing pc
;    expected_data  -  address of quadword to store expected data
;    actual_data    -  address of quadword to store actual data
;    flags          -  board-level test flags
;
; IMPLICIT INPUTS:
;
;    ** None **
;
; OUTPUT PARAMETERS:
;
;    r0  -  test results
;
; IMPLICIT OUTPUTS:
;
;    ** None **
;
; ROUTINE VALUE:
;
;    -1  -  device not present or untestable
```

```
;    0   -  test failed
;    1   -  test passed
;
; SIDE EFFECTS:
;
;    ** None **
;
; --

        ; board-level test 9 argument block offsets

        offset   <-
                scratch,                - ; address of scratch memory area
                failing_pc,             - ; address of longword to store failing
                                        - ; pc if test fails
                expected_data,          - ; address of quadword that test can
                                        - ; store expected data if test fails
                actual_data,            - ; address of quadword that test can
                                        - ; store actual data if test fails
                flags                   - ; board-level test flags
                >

        usrom_share  byte

_300$usrom_test_9::
        .word       ^m<>
        ret                             ; return to caller

        .sbttl      rtVAX 300 Board-level Test 10
```

```
; ++
; FUNCTIONAL DESCRIPTION:
;
;    This routine  (user-supplied) is called by the rtVAX 300's  resident
;    firmware at system power-on to do board-level test 10.  It is called
;    at IPL 31, in kernel mode with memory management disabled.
;
; CALLING SEQUENCE:
;
;    calls  #5,_300$usrom_test_10
;
; INPUT PARAMETERS:
;
;    scratch         -  address of scratch memory area
;    failing_pc      -  address of longword to store failing pc
;    expected_data   -  address of quadword to store expected data
;    actual_data     -  address of quadword to store actual data
;    flags           -  test flags
;
; IMPLICIT INPUTS:
;
;    ** None **
;
; OUTPUT PARAMETERS:
;
;    r0  -  test results
;
; IMPLICIT OUTPUTS:
;
;    ** None **
;
; ROUTINE VALUE:
;
;    -1  -  device not present or untestable
;    0   -  test failed
;    1   -  test passed
;
; SIDE EFFECTS:
;
;    ** None **
;
; --

        ; board-level test 10 argument block offsets
```

```
        offset  <-
                scratch,                - ; address of scratch memory area
                failing_pc,             - ; address of longword to store failing
                                        - ; pc if test fails
                expected_data,          - ; address of quadword that test can
                                        - ; store expected data if test fails
                actual_data,            - ; address of quadword that test can
                                        - ; store actual data if test fails
                flags                   - ; board-level test flags
                >

        usrom_share  byte

_300$usrom_test_10::
        .word       ^m<>
        ret                             ; return to caller

        .sbttl      rtVAX 300 Board-level Test 11

; ++
; FUNCTIONAL DESCRIPTION:
;
;    This routine  (user-supplied) is called by the rtVAX 300's  resident
;    firmware at system power-on to do board-level test 11.   It is called
;    at IPL 31, in kernel mode with memory management disabled.
;
; CALLING SEQUENCE:
;
;    calls  #5,_300$usrom_test_11
;
; INPUT PARAMETERS:
;
;    scratch        -  address of scratch memory area
;    failing_pc     -  address of longword to store failing pc
;    expected_data  -  address of quadword to store expected data
;    actual_data    -  address of quadword to store actual data
;    flags          -  board-level test flags
;
; IMPLICIT INPUTS:
;
;    ** None **
;
; OUTPUT PARAMETERS:
;
;    r0  -  test results
;
; IMPLICIT OUTPUTS:
;
;    ** None **
;
; ROUTINE VALUE:
;
;    -1  -  device not present or untestable
```

```
;    0   -  test failed
;    1   -  test passed
;
; SIDE EFFECTS:
;
;    ** None **
;
; --

        ; board-level test 11 argument block offsets

        offset          <-
                scratch,                - ; address of scratch memory area
                failing_pc,             - ; address of longword to store failing
                                        - ; pc if test fails
                expected_data,          - ; address of quadword that test can
                                        - ; store expected data if test fails
                actual_data,            - ; address of quadword that test can
                                        - ; store actual data if test fails
                flags                   - ; board-level test flags
                >

        usrom_share  byte

_300$usrom_test_11::
        .word           ^m<>
        ret                                 ; return to caller

        .sbttl          rtVAX 300 Board-level Test 12
```

```
; ++
; FUNCTIONAL DESCRIPTION:
;
;    This routine  (user-supplied) is called by the rtVAX 300's  resident
;    firmware at system power-on to do board-level test 12.  It is called
;    at IPL 31, in kernel mode with memory management disabled.
;
; CALLING SEQUENCE:
;
;    calls  #5,_300$usrom_test_12
;
; INPUT PARAMETERS:
;
;    scratch         -  address of scratch memory area
;    failing_pc      -  address of longword to store failing pc
;    expected_data   -  address of quadword to store expected data
;    actual_data     -  address of quadword to store actual data
;    flags           -  board-level test flags
;
; IMPLICIT INPUTS:
;
;    ** None **
;
; OUTPUT PARAMETERS:
;
;    r0  -  test results
;
; IMPLICIT OUTPUTS:
;
;    ** None **
;
; ROUTINE VALUE:
;
;    -1  -  device not present or untestable
;    0   -  test failed
;    1   -  test passed
;
; SIDE EFFECTS:
;
;    ** None **
;
; --

        ; board-level test 12 argument block offsets
```

```
        offset  <-
                scratch,                - ; address of scratch memory area
                failing_pc,             - ; address of longword to store failing
                                        - ; pc if test fails
                expected_data,          - ; address of quadword that test can
                                        - ; store expected data if test fails
                actual_data,            - ; address of quadword that test can
                                        - ; store actual data if test fails
                flags                   - ; board-level test flags
                >

        usrom_share  byte

_300$usrom_test_12::
        .word       ^m<>
        ret                             ; return to caller

        .sbttl      rtVAX 300 Board-level Test 13

; ++
; FUNCTIONAL DESCRIPTION:
;
;    This routine  (user-supplied) is called by the rtVAX 300's  resident
;    firmware at system power-on to do board-level test 13.  It is called
;    at IPL 31, in kernel mode with memory management disabled.
;
; CALLING SEQUENCE:
;
;    calls  #5,_300$usrom_ est_13
;
; INPUT PARAMETERS:
;
;    scratch        -  address of scratch memory area
;    failing_pc     -  address of longword to store failing pc
;    expected_data  -  address of quadword to store expected data
;    actual_data    -  address of quadword to store actual data
;    flags          -  board-level test flags
;
; IMPLICIT INPUTS:
;
;    ** None **
;
; OUTPUT PARAMETERS:
;
;    r0  -  test results
;
; IMPLICIT OUTPUTS:
;
;    ** None **
;
; ROUTINE VALUE:
;
;    -1  -  device not present or untestable
```

```
;    0   -  test failed
;    1   -  test passed
;
; SIDE EFFECTS:
;
;    ** None **
;
; --

        ; board-level test 13 argument block offsets

        offset  <-
                scratch,                - ; address of scratch memory area
                failing_pc,             - ; address of longword to store failing
                                        - ; pc if test fails
                expected_data,          - ; address of quadword that test can
                                        - ; store expected data if test fails
                actual_data,            - ; address of quadword that test can
                                        - ; store actual data if test fails
                flags                   - ; board-level test flags
                >

        usrom_share  byte

_300$usrom_test_13::
        .word       ^m<>
        ret                             ; return to caller

        .sbttl      rtVAX 300 Board-level Test 14
```

```
; ++
; FUNCTIONAL DESCRIPTION:
;
;    This routine  (user-supplied) is called by the rtVAX 300's  resident
;    firmware at system power-on to do board-level test 14.  It is called
;    at IPL 31, in kernel mode with memory management disabled.
;
; CALLING SEQUENCE:
;
;    calls  #5,_300$usrom_test_14
;
; INPUT PARAMETERS:
;
;    scratch         -  address of scratch memory area
;    failing_pc      -  address of longword to store failing pc
;    expected_data   -  address of quadword to store expected data
;    actual_data     -  address of quadword to store actual data
;    flags           -  board-level test flags
;
; IMPLICIT INPUTS:
;
;    ** None **
;
; OUTPUT PARAMETERS:
;
;    r0  -  test results
;
; IMPLICIT OUTPUTS:
;
;    ** None **
;
; ROUTINE VALUE:
;
;    -1  -  device not present or untestable
;    0   -  test failed
;    1   -  test passed
;
; SIDE EFFECTS:
;
;    ** None **
;
; --

        ; board-level test 14 argument block offsets
```

```
        offset  <-
                scratch,                - ; address of scratch memory area
                failing_pc,             - ; address of longword to store failing
                                        - ; pc if test fails
                expected_data,          - ; address of quadword that test can
                                        - ; store expected data if test fails
                actual_data,            - ; address of quadword that test can
                                        - ; store actual data if test fails
                flags                   - ; board-level test flags
                >

        usrom_share  byte

_300$usrom_test_14::
        .word       ^m<>
        ret                             ; return to caller

        .end
```

APPENDIX-E

E

Sample C Program to Build Setup Frame Buffer

Example E–1 shows a C program to create the setup frame buffer for the hashing filtering mode.

Example E–1 Hash Filtering Setup Frame Buffer Creation C Program

```
/*
** This program builds the setup frame buffer for the SGEC imperfect
** filtering.
**
** The addresses are read, in the IEEE 802 address display format
** (xx-xx-xx-xx-xx-xx), from the file specified in the in_filename argument.
**
** The setup frame is writen in the file specified by the out_filename
** argument. If missing, the setup frame is sent to the standart output.
**
** Each multicast address generates a hit in the hash filter.
** The first read physical addresses is kept as the physical address
** following the hash filter.Subsequent non multicast addresses, if any,
** are ignored.
**
** The address crc is generated by the crc polynomial specified by the
** IEEE 802.3 standard:
**
**           32   26   23   22   16   12   11   10   8   7   5   4   2
** FCS(X) = X  + X  + X  + X  + X  + X  + X  + X  + X + X + X + X + X + X + 1
**
*/

#include <stdio>

main(argc,argv)

int argc;
char *argv[];
```

(continued on next page)

Example E–1 (Cont.) Hash Filtering Setup Frame Buffer Creation C Program

```
{
    FILE *fopen(),*fin,*fout;
    unsigned char  address[6],
                   setup_frame[128],
                   line[80],
                   physical_cnt = 0;
    int            i, hash_index;

if (argc < 2) {
   printf ("\n Usage: program in_filename {out_filename}\n");
   exit(1);
   }

if (!(fin = fopen(argv[1],"r"))){
      printf ("\n Error: %s cannot be open for read\n",argv[1]);
      exit (1);
      }

if (argc >= 3)
   if (!(fout = fopen(argv[2],"w"))){
      printf ("\n Error: %s cannot be open for write\n",argv[2]);
      fclose(fin);
      exit (1);
      }

/* initialize the setup buffer */

for (i=0; i<128; i++)
   setup_frame[i]=0;

while (1) {

  /*get a Ethernet address */

  if (!fgets(line,80,fin)) break;

  sscanf(line,"%2X-%2X-%2X-%2X-%2X-%2X",
         &address[0],&address[1],&address[2],
         &address[3],&address[4],&address[5]);

  /* check the address type */

  if (address[0] & 1){

    /* multicast address */
    /* calculate the hash_index */
    hash_index = crc_address(&address[0]);

    /* update the hash_filter */
    setup_frame[hash_index>>3] |= (1 << hash_index%8) ;
    }
```

(continued on next page)

Example E–1 (Cont.) Hash Filtering Setup Frame Buffer Creation C Program

```
  else {

    /* physical address */

    if (!physical_cnt)
      for (i=0; i<6; i ++)
         setup_frame[64+i] = address[i];
    physical_cnt++;
    continue;
    }

  }

/*
** send a warning message if no, or more than one, physical addresses
** have been found
*/

if (!physical_cnt)
   printf ("\nWarning: %s does not contain a physical address !\n\n",
           argv[1]);
else if (physical_cnt > 1)
   printf ("\nWarning: %s contains more than one (%d) physical address !\n\n",
           argv[1],physical_cnt);


/*
**store the setup buffer in the specified out file
*/

if (argc >= 3)
  for (i=0; i<18; i++)
     fprintf(fout,"%02X%02X%02X%02X\n",
             setup_frame[i*4+3],setup_frame[i*4+2],
             setup_frame[i*4+1],setup_frame[i*4]);
else
  for (i=0; i<18; i++)
     printf("%02X%02X%02X%02X\n",
            setup_frame[i*4+3],setup_frame[i*4+2],
            setup_frame[i*4+1],setup_frame[i*4]);

fclose(fin);
fclose(fout);

}

int crc_address(addr)

char *addr;
```

(continued on next page)

Example E–1 (Cont.) Hash Filtering Setup Frame Buffer Creation C Program

```
{
 int            i,k,m,
                hash = 0;
 unsigned char mean,
                crc[33];

/* Init CRC to all 1's */

for (i=0;  i<33;  i++)
   crc[i] = 1;

/* Compute the address CRC by running the CRC 48 steps */

for (i=0;  i<6;  i++)
   for (k=0;  k<8;  k++){

      mean = crc[32] ^ ((*(addr+i)>>k) & 1);
      for(m=32; m>=2; m--)
         crc[m]  = crc[m-1];
      crc[27] = crc[27] ^ mean;
      crc[24] = crc[24] ^ mean;
      crc[23] = crc[23] ^ mean;
      crc[17] = crc[17] ^ mean;
      crc[13] = crc[13] ^ mean;
      crc[12] = crc[12] ^ mean;
      crc[11] = crc[11] ^ mean;
      crc[09] = crc[09] ^ mean;
      crc[08] = crc[08] ^ mean;
      crc[06] = crc[06] ^ mean;
      crc[05] = crc[05] ^ mean;
      crc[03] = crc[03] ^ mean;
      crc[02] = crc[02] ^ mean;
      crc[01] = mean;
      }

/*
** Extract the hash_index from the CRC residue
** (warning: the bits are mirrored into the CRC :
**  the msb bit of CRC residue is the lsb bit of the hash_index)
*/

   for (k=24;  k<33;  k++)
        hash = hash<<1 | crc[k];
   return (hash & 0x1FF);
}
```


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